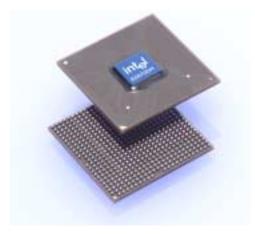


Intel[®] E8870 Scalable Node Controller (SNC) Datasheet

Product Features

- Intel[®] Itanium[®] 2 Processor System Bus
 - Itanium 2 processor system bus interface (44-bit address, 128-bit data) at 400 MHz data bus frequency
 - Full multiprocessor support for up to four Itanium 2 processors on the system bus
 - Parity protection on address and control signals
 - ECC protection on each 64-bit chunk of the 128-bit data signals on the Itanium 2 processor system bus
 - Eight-deep in-order queue
 - Non-blocking transaction handling:: Transactions receive Normal Completion, Retry, or Defer; All transactions normally deferred; No chipset snoop stalls
 - GTL+ bus driver technology
 - Chipset adds only one load to the system bus
- PC1600 DDR SDRAM Memory via DDR Memory Hub (DMH)
 - Supports up to four DMHs
 - 1, 2, 3, or 4 different types of DIMMs per branch channel
 - Supports 128-, 256-, 512-, 1024-Mb devices in X4 and X8 configurations
 - Supports from 512 MB (128 Mb devices) to 128 GB (1 Gb devices) of memory in 128 MB increments

- 6.4 GB/s peak bandwidth
- Server Error Correction Code corrects for any single failed X4 memory device, and limited correction on data errors from X8 memory devices
- ECC with error correction and periodic scrubbing of the memory
- Scalability Port (SP)
 - Two SPs with 3.2 GB/s peak bandwidth per direction per SP
 - Bidirectional SPs for a total bandwidth of 12.8 GB/s
- Firmware
 - Firmware hub interface for processorspecific firmware
- Reliability, Availability, and Serviceability (RAS)
 - Sideband access to configuration registers via SMBus or JTAG.
 - End-to-end ECC for all interfaces
 - Fault detection and logging
 - Signal connectivity testing via boundary scan
- Packaging
 - 49.5mm x 49.5mm
 - 1357-pin organic LAN grid array (OLGA) package-2B



Document Number: 251112-001 August 2002



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Introduction 1

1.1 Overview

The Intel[®] E8870 chipset delivers new levels of availability, features and performance for servers. It provides flexible common modular architecture support for the Intel[®] Itanium[®] 2 processors. The Intel E8870 chipset supports up to four processors, and up to eight processors with the Scalability Port Switch (SPS) component, delivering stability to the platforms through reuse and common architecture support.

The component names used throughout this document refer to the component markings listed in Table 1-1.

Table 1-1. Chipset Component Markings

Component Name	Product Marking
SNC	E8870
SIOH	E8870IO
SPS	E8870SP
DMH	E8870DH
P64H2	82870P2
ICH4	82801DB
FWH	82802AC

1.2 Scalable Node Controller (SNC) Overview

The SNC is the processor system bus interface and memory controller for the E8870 chipset. It supports the Itanium 2 processors, DDR SDRAM main memory, a firmware hub interface to support multiple firmware hubs, two scalability ports (SPs) for access to I/O and coherent memory on other nodes.

The SNC may be connected to a SPS for scaling to large systems as shown in Figure 1-1. The SNC is connected directly to an SIOH for single-node system implementations.



Itanium® 2 Processor Itanium ®2 Itanium®2 Itanium ® 2 Itanium®2 Itanium ® 2 Itanium® 2 Itanium®2 Processor Processor Processor Processor Processor Processor Processor SNC SNC Flash Flash (Scalable Node (Scalable Node Memory Memory **BIOS BIOS** Controller) Controller) SP (Scalability Port) SP (Scalability Port) Switch Switch HI 1.5 SIOH SIOH Port Flash ICH4 (Server Input/Output (Server Input/Output BIOS I/O Bridge Hub) Hub) ∏∏ 32-bit, 33MHz PCI Super I/O 4x HI 2.0 4x HI 2.0 Ports Ports USB 2.0 IDE CD-ROM P64H2 P64H2 PCI/PCI-X PCI/PCI-X **BMIDE HDDs** Bridge Bridge 64-bit, 33/66/ 64-bit, 33/66/ 100/133 MHz 100/133 MHz 001247

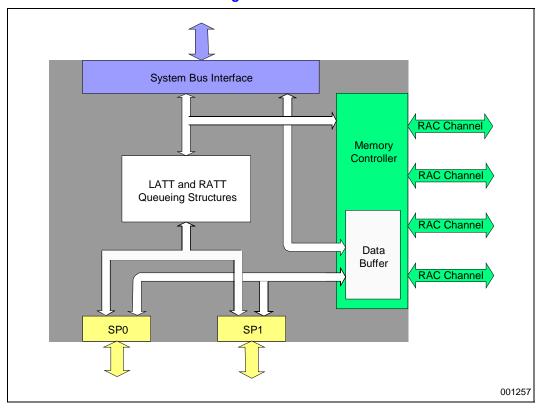
Figure 1-1. Typical Itanium® 2-Based Server Configuration



1.3 Architectural Overview

Figure 1-2 is a conceptual depiction of the SNC's queueing structures. The system bus logic includes the In Order Queue (IOQ) that tracks pipelined in order transactions.

Figure 1-2. Scalable Node Controller Queueing Structures



The local access transaction tracker (LATT) is a buffer that holds processor requests until they are completed. The LATT then converts processor requests into scalability port (SP) requests, which it inserts into the SP Request Out Queue for SP0 or SP1. The response returns in the SP Response In Queue on the same SP. The LATT picks a request from one SP or the other, and sends it to the processor system bus interface. See Section 1.4.3 for more information on SP queues.

The remote access transaction tracker (RATT) pulls SP requests from the SP Request In Queue from one SP or the other. The request is stored in the RATT until completed.

Requests entering the SNC are presented to *Conflict Resolution* logic one at a time to resolve coherency races. If a request is to the same address as a request already stored in the LATT or RATT, *Conflict Resolution* logic blocks progress of one request or another until ordering is resolved.

Memory writes from the various sources are posted in the Write Post Queue, and reads into the Read Re-ordering Queue. From there, the memory controller selects them for issue to maximize memory performance. See Chapter 5, "Memory Subsystem" for more information on the queueing structures in the memory controller.

All data passes through the data buffer when it moves between the processor system bus, memory and the SPs. The LATT provides configuration register access for processors, and the RATT provides access from the SP port.

Introduction



000631a

1.4 Interfaces

Figure 1-3 illustrates the SNC and all of its interfaces, which consist of the processor system bus, four main channels, a firmware hub interface, two scalability ports as well as JTAG and SMBus ports. The processor system bus interfaces with one to four processors. The two SPs interface to the scalability port switch or SIOH. Each of the main channels interface to the DMH for DDR-SDRAM support.

Itanium® 2 Processor 400 MHz 6.4 GB/s **RAC Channels FWH** System Bus JTAG 800 MHz SNC Memory 6.4 GB/s **SMBus** Scalability Ports 800 MHz 800 MHz 6.4 GB/s 6.4 GB/s

Figure 1-3. Scalable Node Controller Interfaces

1.4.1 Intel[®] Itanium[®] 2 Processor System Bus

The SNC will support up to four Itanium 2 processors. The processor bus consists of 128 bits of data and 16 bits of ECC. It supports 128-byte cache lines, and with 6.4 GB/s peak bandwidth.

1.4.2 Main Channel

The four main channels on the SNC are extended Direct RAMBUS* channels. The interface has three row request, five column request, and 18 data signals. Packets up to eight transfers long are driven on these lines at 800 MT/s. A lower frequency serial chain runs along each channel.

Propagation delays on the main channels can exceed one clock cycle. The channel is divided into domains of one clock period. When given a serial command, all devices within a domain delay their transmit data so that it arrives at the domain edge at the same time. Software then determines the domain of each device by write/read trial and error. Software configures each device with a coarse delay corresponding to its domain so that data from all devices arrive at the channel master at the same time.



A clock generator must be provided for each channel that is compliant with the *Direct RAMBUS Clock Generator Specification*. The SNC will provide a pair of clock phase references for each of the four main channels. An external clock generator will use these references to generate the 400 MHz differential clock to master (CTM) so that it arrives at the SNC co-incident with the SNC core clock.

1.4.3 Scalability Port (SP) Interface

The scalability port interface is a high speed interface for connecting the SNC to other chipset components such as the SIOH. The SP interface serves as a link to I/O when connected to an SIOH.

As the name implies, the SP also allows a system to scale beyond one node. This is done by connecting a scalability port switch (SPS) to the SNC's SP interface. Refer to Figure 1-1 "Typical Itanium[®] 2-Based Server Configuration" for example interconnect schemes.

There are two SPs per SNC. Each SP interface contains a *Request Out* and *Response In* queue to pass data to and from the LATT and a *Request In* and *Response Out* queue to pass data to and from the RATT. These queues are 20 entries deep.

The SP uses SBD signaling technology, which allows simultaneous transmission of information in both directions on the same wire, providing a peak bandwidth of 6.4 GB/s per port (3.2 GB/s in each direction).

1.4.4 Low Pin Count/Firmware Hub Interface

The SNC interfaces directly to a firmware hub (FWH) component. The low cost FWH interface comprises four address/data pins (LAD[3:0]) and one framing signal (LFRAME#). Electrically and with regards to timing, these signals comply with 33 MHz, 3.3V PCI requirements (refer to the *PCI Local Bus Specification*, Rev. 2.2).

The firmware hub/low pin count (FWH/LPC) interface supports up to four loads using two clocks, one clock output per two FWH or LPC components. The SEL_LPC strapping pin selects either the LPC or FWH protocol for this port.

The SNC supports only slave components. The purpose of this interface is to provide for local firmware for the processors interfacing to this particular SNC component. Any connected firmware hub devices must adhere to the *Intel*[®] 82802AB/82802AC Firmware Hub (FWH) Specification.

This interface is only accessible from the processor bus, not the scalability port, JTAG, or SMBus. The cooperation of a local processor is required to perform firmware updates or check firmware version.

The LPC features clock speeds of up to 33 MHz and IO/memory/DMA/bus master cycle support. The LPC interface on the SNC will only support flash devices. The SNC will not tolerate 5V levels on the LPC interface.

1.4.5 JTAG Interface

This port is used for component configuration and testing. In Boundary Scan testing, system clocks are not running, so all events are synchronous to the JTAG clock.

In system debug, this port is controlled by the in-target probe (ITP), which is a PCI card driven by an application running on a PC. JTAG runs asynchronously to the system clocks at no more that 1/8th the bus clock frequency.



1.4.6 SMBus Slave Interface

This port is controlled by an autonomous platform manager during system operation. The chipset will support serial data transfers at 100 kHz. The chipset is designed to limit the worst case probability of metastability on SMBus command transfers to less than one in 10^{11} .

1.5 Terminology

Address Bit Permuting Address bits are distributed among channel selects, DRAM

selects and bank selects so that a linear address stream

accesses these resources in a certain sequence.

Bit Interleave The way the bits in a cache line are mapped to channels,

devices, banks, rows, columns (RDRAM) or stacks, banks,

rows, columns (DDR SDRAM) of memory.

Cache Line Interleave The way a series of cache lines are mapped to DRAM

devices.

Critical Word First The SNC will deliver the words of a cache line in a particular

order such that the word addressed in the request appears in

the first data transfer.

DDR SDRAM
DIMM
Dual-in-Line Memory Module

DMH DDR Memory Hub

Device Row A set of devices that provide a cache line. Since the second

64 bytes of a 128-byte line are from a page hit on the same devices, the device row is the same for 64-byte lines and

128-byte lines.

A 4-bit DDR SDRAM device row consists of eight sets of 18 devices that respond to a main channel request. Typically, these would appear on one side of a DIMM. An 8-bit DDR SDRAM device row consists of eight sets of nine devices on

each DIMM that respond to a main channel request.

DRAM Page (Row) The DRAM cells selected by the row address.

DRCG/DMCG Direct RAMBUS Clock Generator.

Dirty Node The node which owns a modified cache line.

Direct Connect/Single Node Up to 4-way Intel Itanium 2/ E8870 platform configuration

that consists of one SIOH and SNC that are directly

connected by Scalability Ports.

Explicit Write-Back (EWB) The transaction issued by a processor evicting a cache line.

Home Node The SNC that controls the memory on which a particular

cache line resides.

Host, Processor, CPU

The E8870 chipset supports Itanium 2 processor.



Implicit Write-Back (IWB)

IWB is used to describe the hit-modified-snoop response to a

processor bus request. Although this is a response, it

modifies the handling of the original read. The new behavior is independent of the original read type. In effect, the SNC converts the original request into an IWB. A hit to a modified

line in the SIOH can also be called an IWB.

Inbound (IB)/Outbound (OB) Upstream/Downstream, Northbound/Southbound, Upbound/Downbound Up, North, or Inbound is in the direction of the processor. Down, South, or Outbound is in the direction of I/O.

Line Cache line.

Local Requests that are initiated by processors on the same bus as a

given SNC.

Main Channel The RAC memory interface used by SNC.

Master Abort A response to an illegal request. Reads receive all 1's data.

Writes have no effect.

Memory Data Quantum The smallest memory access for the E8870 chipset. Each of

the four main channels deliver 16B on an access. This 64byte quantity is a quanta. Memory error correction is applied

on a quantum basis.

MDFC Memory Device Failure Correction

Nodes Two uses: The first is in the context of the scalability port

agent, i.e. SNC, SPS or SIOH. The second refers to processor

nodes only (e.g. single node system).

Page Replace (Page Miss), Row

Hit/Page Miss

An access to a row that has another page open. The page must be transferred back from the memory devices to the

array, and the bank must be precharged.

Page Hit An access to an open page, or DRAM row. For the Itanium 2

processor, the E8870 chipset makes two 64B accesses for a cache line. The two halves of the cache line are always placed on the same page, so that only one row command is used. Outside of a cache line the E8870 chipset maps address bits to optimize random accesses, at the expense of page hits.

Thus page hits outside a cache line are rare.

Page Miss (Empty Page) An access to a page that is not buffered in sense amps and

must be fetched from DRAM array.

with the RAMBUS devices using RSL signaling. The RAC

communicates to the RMC.

Remote Requests that enter the SNC from a SP.

RSL RAMBUS signaling level is the name of the signaling

technology used by SNC on the main channel.

RCLK The period of the CTM and CFM clocks at 2.5 ns.

SEC/DED Single Error Correct/Double Error Detect

SIOH The Intel E8870IO server input/output hub: connects two

SPs to five hub interface ports.

Introduction



SNC Scalable Node Controller. This chipset component interface

with the Itanium 2 processor, main memory, and SP links.

SPS Intel E8870SP Scalability Port Switch. The crossbar/central

snoop filter that connects the SNCs and SIOHs.

SPP Scalability Port Protocol Logic. The SNC cluster that

controls sequencing of coherent requests.

SSO Simultaneous Switching Output

System Bus A generic term used to refer to the Itanium 2 processor

system bus (128 bits wide).

Virtual Channel Requests and responses on the SP are time multiplexed on

the SP wires, but separate flow control is provided so that one channel makes progress even if the other is blocked. The logical effect is as if there were separate "virtual channels"

for requests and responses.

DEN#,HITM#,ADS#,A[44:0]# Processor bus signals.

1.6 References

The reader of this specification should also be familiar with material and concepts presented in the following documents:

- IEEE 1149.1a-1993
- Jedec Standard 79 (JESD79)
- PCI Local Bus Specification, Rev. 2.2
- Intel[®] Itanium[®] 2 Processor Datasheet
- Intel® E8870IO Server I/O Hub (SIOH) Datasheet
- Intel® E8870DH DDR Memory Hub (DMH) Datasheet
- Intel® 82802AB/82802AC Firmware Hub (FWH)
- LPC Interface Specifications, Rev. 1.0

1.7 Revision History

Revision Number	Description	Date
-001	Initial release of this document.	August 2002



Signal Description

2.1 Conventions

The terms *assertion* and *deassertion* are used extensively when describing signals, to avoid confusion when working with a mix of active-high and active-low signals. The term *assert*, or *assertion*, indicates that the signal is active, independent of whether the active level is represented by a high or low voltage. The term *deassert*, or *deassertion*, indicates that the signal is inactive.

Signal names may or may not have a "#" appended to them. The "#" symbol at the end of a signal name indicates that the active, or asserted state occurs when the signal is at a low voltage level. When "#" is not present after the signal name the signal is asserted when at the high voltage level.

When discussing data values used inside the component, the logical value is used. For instance., a data value described as "1101b" would appear as "1101b" on an active-high bus, and as "0010b" on an active-low bus. When discussing the assertion of a value on the actual signal, the physical value is used; i.e. asserting an active-low signal produces a "0" value on the signal.

Table 2-1 and Table 2-2 list the reference terminology used later for buffer technology types (e.g. LVTTL, etc.) used and buffering signal types (e.g. input, output, etc.) used.

Table 2-1. Buffer Technology Types

Buffer	Buffer Type	Description
AGTL+	1.2 V	Open drain Advanced GTL+ interface.
SBD	1.3 V	Simultaneous Bi-Directional.
Differential	LVHSTL	Itanium [®] 2 processor-based system low voltage differential input clock.
CMOS1.3	1.3 V	CMOS, push/pull, type I/O or I.
CMOS1.5	1.5 V	CMOS, push/pull, type I/O or I.
CMOS3.3	3.3V	CMOS, push/pull, type I/O or I.
CMOS1.5OD	1.5 V	Open-Drain CMOS type I/O.
CMOS3.3OD	3.3 V	Open-Drain CMOS type I/O.
CMOS1.8	1.8 V	CMOS, push/pull, type I/O.
RCMOS1.8	1.8 V	CMOS, push/pull, type I/O or O. No boundary scan on output, boundary-scan only on input in the main channel interface.
LPC	LPC	LPC I/O input with a voltage level of 3.3V and max. frequency of 33 MHz.
RSL	RSL	High-speed (800 MHz) RAMBUS ASIC Cell (RAC) I/O with differential inputs. XOR-tree instead of boundary-scan.
SSTL_2	SSTL-2	DDR bus interface signal type.
JTAG	JTAG	Open-drain CMOS type I/O at 1.5V, without boundary scan logic.
Analog	Analog	Typically a voltage reference or specialty power supply.



Table 2-2. Buffer Signal Directions

Buffer Direction	Description
I	Input signal.
0	Output signal.
OD	Output open drain.
I/O Bidirectional (input/output) signal.	
SBD	Simultaneous Bi-directional signal.

Some signals or groups of signals have multiple versions. These signal groups may represent distinct but similar ports or interfaces, or may represent identical copies of the signal used to reduce loading effects. Table 2-3 shows the conventions SNC use.

Table 2-3. Signal Naming Conventions

Convention	Expands To
RR{0/1/2}XX	Expands to: RR0XX, RR1XX, and RR2XX.
RR[2:0]	Expands to: RR[2], RR[1], and RR[0]. This denotes a bus.
RR# or RR[2:0]#	Denotes an active low signal or bus.

Only the PLL power-supply signals are listed. No other power-supplies are listed.

Typically, upper case groups, ("A, B, C") represent functionally similar but logically distinct signals. Each signal provides an independent control and may or may not be asserted at the same time as the other signals in the grouping. In contrast, lower case groups, ("a, b, c") typically represent identical duplicates of a common signal. Such duplicates are provided to reduce loading.

2.2 SNC Signal List

Table 2-4 lists all of the SNC signals.

Table 2-4. SNC Signal List

Signal	Туре	Frequency	Description
Main Channels 0, 1, 2	2, 3		
R{0/1/2/3}DQA[8:0]	I /O RSL	800 MHz	RAMBUS Data(A) Data signals used for read and write operations on RAMBUS data bus "A".
R{0/1/2/3}DQB[8:0]	I/O RSL	800 MHz	RAMBUS Data(B) Data signals used for read and write operations on RAMBUS databus "B".
R{0/1/2/3}RQ[7:0]	O RSL	800 MHz	Request Control Signals R{0/1/2/3}RQ[7:0] are used for sending control packets on RAMBUS channel. The RAMBUS specification defines the mapping of RAMBUS packets to these lines for RDRAM. The DMH Component Specification defines the mapping for DDR.
R{0/1/2/3}EXRC	O RSL	800 MHz	Row Expansion Signal These signals are not used by SNC.



Table 2-4. SNC Signal List (Continued)

Signal	Туре	Frequency	Description	
Main Channels 0, 1, 2	Main Channels 0, 1, 2, 3 (continued)			
R{0/1/2/3}EXCC	O RSL	800 MHz	Column Expansion Signal These signals are not used by SNC.	
R{0/1/2/3}CTM	l RSL	400 MHz	Clock to Master One of the two differential transmit clock signals used for RDRAM operations on the corresponding RAMBUS channel. It is input to SNC and is generated by an external clock generator.	
R{0/1/2/3}CTMN	l RSL	400 MHz	Clock to RAMBUS Master Complement One of the two differential transmit clock signals used for RDRAM operations on the corresponding RAMBUS channel. It is complement of clock signal R{0/1/2/3}CTM.	
R{0/1/2/3}CFM	O RSL	400 MHz	Clock from Master One of the two differential signals used to clock RAMBUS packets driven by the SNC. These signals are of type I/O in the RTL as defined by RAMBUS.	
R{0/1/2/3}CFMN	O RSL	400 MHz	Clock from Master Complement One of the two differential signals used to clock RAMBUS packets driven by the SNC. These signals are of type I/O in the RTL as defined by RAMBUS.	
R{0/1/2/3}SYNCLKN	O RCMOS1.8	33 MHz	Phase Detect Signal This signal is sent to DRCG for generating 400 MHz clock. This signal is generated from SYNCLKN of the corresponding RAC. This signal trace must be delay matched with R{0/1/2/3}PCLKM trace.	
R{0/1/2/3}PCLKM	O RCMOS1.8	33 MHz	Phase Detect Signal This signal is sent to the DRCG for generating the 400 MHz clock. This signal is generated from the SNC core clock.	
R{0/1/2/3}SCK	O RCMOS1.8	1 MHz or 100 MHz	Serial Clock Clock source used for timing of the R{0/1/2/3}SIO and R{0/1/2/3}CMD signals.	
R{0/1/2/3}SIO	I/O RCMOS1.8	1 MHz or 100 MHz	Serial Input/Output Chain Bi-directional serial data signal used for reading and writing control registers.	
R{0/1/2/3}CMD	O RCMOS1.8	1 MHz or 100 MHz	Serial Command Serial command input used for control register read and write operations.	
R{0/1/2/3}VREF[1:0]	I Analog	N/A	Voltage Reference Supplies Vref for input buffers.	
Scalability Port 0, 1				
SP{0/1}ZUPD[1:0]	l Analog	N/A	Impedance Update Used to adjust the impedance of I/O drivers CMOS1.5	
SP{0/1}SYNC	I/O CMOS1.3	N/A	Reset Synchronization Provides synchronization between ports for impedance control and reference voltage adjustment. This signal is also used by the SP reset logic to determine when SP comes out of reset. SP{0/1}SYNC is released when ports at both ends of the link are ready.	
SP{0/1}PRES	I CMOS1.3	N/A	ready. Scalability Port Present Signals the scalability port of an impending hot plug event	
SP{0/1}AVREFH[3:0]	I/O Analog	N/A	Strand A Voltage reference 3/4 VCC-SP Reference	
SP{0/1}AVREFL[3:0]	I/O Analog	N/A	Strand A Voltage Reference 1/4 VCC-SP Reference	
SP{0/1}ASTBP[1:0]	I/O SBD	400 MHz	P Strobes Positive phase data strobes for strand A to transfer data at the 2x rate (800 MHz)	



Table 2-4. SNC Signal List (Continued)

Signal	Туре	Frequency	Description
Scalability Port 0, 1 (c	continued)		
SP{0/1}ASTBN[1:0]	I/O SBD	400 MHz	N Strobes Negative phase data strobes for strand A to transfer data at the 2x rate (800 MHz)
SP{0/1}AD[15:0]	I/O SBD	800 MHz	Data Bus 16 bits of the data portion of a phit on strand A. These bits are SSO encoded. SP{0/1}ASSO determines if these are out of an inverter or not. SP{0/1}BD[15:0]=DATA[31:16].
SP{0/1}AEP[2:0]	I/O SBD	800 MHz	Parity/ECC Two of these signals carry the ECC information for the data flits. There are four bits of ECC for each data phit. The header flits are not ECC protected. The third signal is for parity. Each phit is always protected by two bits of parity. SP{0/1}AEP[1:0] = GEP[1:0]. AEP[2]=TEP[0].
SP{0/1}ALLC	I/O SBD	800 MHz	Link Layer Control For each PHIT these signals carry two of the four bits of link layer control information.
SP{0/1}ASSO	I/O SBD	800 MHz	SSO Encode This signal is asserted to indicate that the data bits over Strand A are inverted.
SP{0/1}ARSVD	I/O SBD	800 MHz	Reserved
SP{0/1}BVREFH[3:0]	I/O Analog	N/A	Strand B Voltage reference 3/4 VCC Reference
SP{0/1}BVREFL[3:0]	I/O Analog	N/A	Strand B Voltage Reference 1/4 VCC Reference
SP{0/1}BSTBP[1:0]	I/O SBD	400 MHz	P Strobes Positive phase data strobes for strand B to transfer data at the 2x rate (800 MHz)
SP{0/1}BSTBN[1:0]	I/O SBD	400 MHz	N Strobes Negative phase data strobes for strand B to transfer data at the 2x rate (800 MHz)
SP{0/1}BD[15:0]	I/O SBD	800 MHz	Data Bus 16 bits of the data portion of a PHIT on strand B. These bits are SSO encoded. SP{0/1}BSSO determines if these are out of an inverter or not. SP{0/1}BD[15:0]=DATA[31:16].
SP{0/1}BEP[2:0]	I/O SBD	800 MHz	Parity/ECC Two of these signals carry the ECC information for the data flits. There are four bits of ECC for each data PHIT. The header flits are not ECC protected. The third signal is for parity. Each PHIT is always protected by two bits of parity. SP{0/1}BEP[1:0] = GEP[3:2]. SP{0/1}BEP[2]=TEP[1].
SP{0/1}BLLC	I/O SBD	800 MHz	Link Layer Control For each PHIT these signals carry two of the four bits of link layer control information.
SP{0/1}BSSO	I/O SBD	800 MHz	SSO Encode This signal is asserted to indicate that the data bits over Strand B are inverted.
SP{0/1}BRSVD	I/O SBD	800 MHz	Reserved



Table 2-4. SNC Signal List (Continued)

Signal	Туре	Frequency	Description		
Scalability Port 0, 1	Scalability Port 0, 1 (continued)				
SP{0/1}GPIO[1:0]	I/O CMOS1.5 OD	N/A	Scalability Port General Purpose I/O These pins are asynchronous open drain I/O signals. To filter glitches on the inputs, the value of the input only changes when the same value has been sampled over four consecutive 200 MHz clock cycles. Similarly, to ensure accurate sampling of these signals by other devices, the output value will be asserted for a minimum of 6 consecutive 200 MHz cycles.		
LPC I/O Interface					
LAD[3:0]	I/O LPC	33 MHz	Multiplexed Address, Command and Data LAD[3:0] are used to communicate: Start of a cycle Transfer type (Memory or I/O) Read or Write Address Data Stop (abort a cycle)		
LFRAME#	O LPC	33 MHz	Frame SNC asserts this signal to indicate the start of a LPC or FWH cycle and termination of an aborted cycle.		
LRESET#	O LPC	33 MHz	LPC Reset LPC I/O reset. The SNC drives this signal during a hard reset to initialize devices on the LPC interface.		
LPCCLKOUT0	O LPC	33 MHz	LPC Clock Out Clock generated from the core clock to FWH or LPC device. This signal trace is delay matched with the other two LPCCLKOUT signals.		
LPCCLKOUT1	O LPC	33 MHz	LPC Clock Out Clock generated from the core clock to FWH or LPC device. This signal trace is delay matched with the other two LPCCLKOUT signals.		
LPCCLKOUT2	O LPC	33 MHz	LPC Clock Out Clock generated from the core clock to SNC. This signal trace is delay matched with the two LPCCLKOUT signals and is connected to the LCLK input.		
LPCSEL	I CMOS1.5	N/A	When set to '1' SNC generates LPC I/O reads and writes; when set to '0' SNC generated FWH I/O reads and writes.		
LPCEN	I CMOS1.5	N/A	When set to '1' enables support of an LPC or FWH device attached to the LPC I/O interface.		
LCLK	I LPC	33 MHz	LPC Clock In Clock input for the LPC I/O interface that is asynchronous to the SNC core clock This input may change asynchronous to BUSCLK.		
Performance, Debug	g, and Error Sign	als			
NODEID[4:0] / DBG[4:0]#	I/O CMOS1.5	N/A	NodeID Strap bits that indicate the NodeID of this SNC. The NodeID is captured on the rising edge of RESETI# and stored in the CBC register. The captured value is sent on the IDLE flits. For E8870 chipset-based systems, NodeID[4:3] should always be set to "11". When the SNC is connected to switches other than the SPS, NodeID[4:3] may be set to other values. For Itanium 2 processor-based systems supporting the SAPIC model, each SNC must have a unique NodeID. BusID is not examined when routing SAPIC interrupts. These signals should be pulled up or down with weak resistors that		
			will not draw more than the specified I _{OL} or I _{OH} of these signals when they are driven with debug values after reset.		



Table 2-4. SNC Signal List (Continued)

Signal	Туре	Frequency	Description		
Performance, Debug	Performance, Debug, and Error Signals (continued)				
			BusID Strap bits that indicate the configuration bus number of this SNC. These bits are captured by the CBC register on the rising edge of RESETI#. The captured value is sent on the IDLE flits.		
BUSID[2:0] / DBG[7:5]#	I/O CMOS1.5	N/A	For E8870 chipset systems, BusID should always be set to "111". When the SNC is used with switches other than the SPS, BusID may be set to other values.		
			These signals should be pulled up or down with weak resistors that will not draw more than the specified I_{OL} or I_{OH} of these signals when they are driven with debug values after reset.		
DBG[7:0]#		N/A	Debug Bus These bits form part of an 8-bit debug bus. Once the NodeID is captured after hard reset, debug signals selected by the DEVT register may be driven on these signals.		
INT_OUT#	O CMOS1.5 OD	200 MHz	Interrupt Request This signal is asserted by SNC when the SPINCO register sets a flag that has been configured to request an interrupt. The SNC drives this signal for a minimum of 6 cycles.		
BINITIN#	I CMOS1.5	200 MHz	Assert BINIT This signal is driven by the system logic. When asserted, the SNC should drive BINIT# on the processor bus according to protocol. This signal must be sampled at the same value four consecutive cycles before changing state. This input may change asynchronous to BUSCLK.		
BERRIN#	I CMOS1.5	200 MHz	Assert BERR This signal is driven by the system logic. When asserted, the SNC should drive BERR# on the processor bus according to protocol. This signal must be sampled at the same value four consecutive cycles before changing state. This input may change asynchronous to BUSCLK.		
BINITOUT#	O CMOS3.3	200 MHz	Processor asserted BINIT The SNC asserts this signal for at least 12 cycles when BINIT# is sampled asserted, but not driven by the SNC.		
BERROUT#	O CMOS3.3	200 MHz	Processor asserted BERR The SNC asserts this signal for at least 12 cycles when BERR# is sampled asserted, but not driven by the SNC.		
ERR[2:0]#	I/O	200 MHz	Error Code The SNC drives and samples error information on these signals. ERR[0] is asserted for correctable errors. ERR[1] is asserted for non-correctable errors. ERR[2] is asserted for fatal errors.		
C	CMOS1.5 OD		The FERRST register samples these signals up till the cycle before the SNC drives. The SNC drives these for a minimum of 12 cycles. The input must be sampled at the same value four consecutive cycles before changing state. This input may change asynchronous to BUSCLK.		
EV[3:0]#	I/O CMOS1.5 OD	200 MHz	Events These signals are driven and sampled by performance monitoring and debug logic. The SNC drives these for a minimum of 12 cycles. The input must be sampled at the same value four consecutive cycles before changing state. This input may change asynchronous to BUSCLK.		



Table 2-4. SNC Signal List (Continued)

Signal	Type	Frequency	Description
Clocking			
BUSCLK	l Differential	200 MHz	Bus Clock This is one of the two differential reference clock inputs to the Phase Locked Loop (PLL) in the SNC core. The circuit board transmission line driving this signal must be delay-matched to the corresponding processor clock signal generated by the system board logic.
BUSCLK#	l Differential	200 MHz	Bus Clock Complement This is the other one of the two differential reference clock inputs to the PLL in the SNC core. The circuit board transmission line driving this signal must be delay-matched to the corresponding processor clock signal generated by the system board logic.
VCCAFSB	I Analog	N/A	VCC PLL Analog Voltage for the processor bus PLL.
VCCASP	I Analog	N/A	VCC PLL Analog Voltage for the SP PLL.
VCCACORE	I Analog	N/A	VCC PLL Analog Voltage for the core PLL.
VSSAFSB	I Analog	N/A	VSS PLL Analog Ground for the processor bus PLL.
VSSASP	I Analog	N/A	VSS PLL Analog Ground for the SP PLL.
VSSACORE	I Analog	N/A	VSS PLL Analog Ground for the core PLL.
System Manageme	ent		
SPDCLK	I/O CMOS3.3 OD	SPDCLK	SMBus for Serial Presence Detect Clock. Unused.
SPDDA	I/O CMOS3.3 OD	SPDCLK	SMBus for Serial Presence Detect Address/Data. Unused.
SCL	I/O CMOS3.3 OD	SCL	SMBus Clock This input may change asynchronous to BUSCLK.
SDA	I/O CMOS3.3 OD	SCL	SMBus Address/Data This input may change asynchronous to BUSCLK.
TDIOANODE	I/O Analog	N/A	Thermal Diode Anode This is the anode of the thermal diode.
TDIOCATHODE	I/O Analog	N/A	Thermal Diode Cathode This is the cathode of the thermal diode.
Reset			
CPUPRES#	I CMOS1.5	N/A	CPU Present When asserted, at least one CPU is present. Requires external pull-up. This is tied to all CPUPRES# signals of the Itanium 2 processor socket.
PWRGOOD	I CMOS1.5	N/A	Power Good Clears the SNC. This signal is held low until all power supplies are in specification. This signal may be pulsed after power-up to completely reset the SNC.
RESETI#	I CMOS1.5	N/A	Reset Input This is the hard reset input to the SNC. This input may change asynchronous to BUSCLK.
RESET#	O AGTL+	N/A	CPU Reset This signal is the processor bus reset. Asserted due to RESETI#, or writes to SYRE register.
RESETO#	O CMOS1.5	N/A	Reset Output Asserted when system hard reset field in SYRE register is written. May be routed by the system to the component that asserts reset.



Table 2-4. SNC Signal List (Continued)

Signal	Type	Frequency	Description
Reset (continued)	•	•	
MEMRST0#	O CMOS1.8	N/A	Memory Subsystem Reset This signal is asserted by SNC to reset the DMHs (DDR Memory Hubs). It is pulsed just after the deassertion of RESETI#. This is pulsed on every SNC RESETI# deassertion.
MEMRST1#	O CMOS1.8	N/A	Memory Subsystem Reset This is the same as MEMRST0#. This is used so that MEMRST0# is not overloaded.
COMPCNTRL[1:0]#	I CMOS1.5	N/A	Bit 0 :ITPODTDIS# On-die-termination disable on RESET# and BPM[5:0]#, to allow connection of an In-Target-Probe to those processor bus pins. Bit 1 :COMPCNTRL[1]# Enables glitch filters on STBP[7:0]# and STBN[7:0]#. Recommend being able to strap either way.
FSBSLWCRES[1:0]	I Analog	N/A	Compensation Resistors Compensation Resistors for the processor bus slew rate.
FSBODTCRES[1:0]	I Analog	N/A	Compensation Resistors Compensation Resistors for the processor bus on-die termination.
RACODTCRES[1:0]	I Analog	N/A	Compensation Resistors Compensation Resistors for the RAC on-die termination.
RACODTEN[1:0]	I CMOS1.5	N/A	On-die Termination RAC on-die termination enable.
LVHSTLODTEN	I CMOS1.5	N/A	On-die Termination BUSCLK and BUSCLK# on-die termination enable.
Power			
VTTMK	I Analog	N/A	Itanium 2 Processor Bus Termination Voltage (67 occurrences)
VCCSP	I Analog	N/A	Scalability Port Supply Voltage (34 occurrences)
VCCRIO	I Analog	N/A	RAMBUS Termination Voltage (24 occurrences)
VCCRA	I Analog	N/A	RAC DLL Supply Voltage (8 occurrences)
VCC3.3LPC	I Analog	N/A	LPC I/O Supply Voltage (2 occurrences)
VCCI2C	I Analog	N/A	SMB and miscellaneous 3.3-volt I/O supply voltage.
Test Access Port (JT	AG)		
тск	I JTAG	тск	JTAG Test Clock Clock input used to drive Test Access Port (TAP) state machine during test and debugging. This input may change asynchronous to BUSCLK.
TDI	I JTAG	тск	JTAG Test Data In Data input for test mode. Used to serially shift data and instructions into TAP.
TDO	O JTAG	тск	JTAG Test Data Out Data output for test mode. Used to serially shift data out of the TAP.
TMS	I JTAG	тск	JTAG Test Mode Select This signal is used to control the state of the TAP controller.
TRST#	I JTAG	N/A	JTAG Test Reset This signal resets the TAP controller logic. It should be pulled down unless TCK is active. This input may change asynchronous to BUSCLK.



Table 2-4. SNC Signal List (Continued)

Signal	Type	Frequency	Description
Itanium [®] 2 Process	sor Bus	1	,
A[43:3]#	I/O AGTL+	200 MHz	Address Signals Processor Address Bus. During processor cycles these are inputs. SNC drives A[43:3]# for transactions originating from SP and for deferred reply transactions.
ADS#	I/O AGTL+	200 MHz	Address/Data Strobe Indicates the first cycle of any request phase. This signal is driven and sampled by SNC.
AP[1:0]#	I/O AGTL+	200 MHz	Address Parity Parity protection on the address bus. SNC will generate AP[1:0]# for its own transactions. SNC will also monitor AP[1:0]# for all transactions and check parity on the address bus.
BERR#	I/O AGTL+	200 MHz	Bus Error BERR# indicates unrecoverable bus protocol violation. SNC will sample and drive BERR#. SNC will drive BERR# according to the protocol when the signal BERRIN gets asserted.
BINIT#	I/O AGTL+	200 MHz	Bus Initialization This signal is asserted to reinitialize bus state machines. SNC will terminate any ongoing transactions at this time. This signal does not affect the state of configuration registers and error logging registers.
BNR#	I/O AGTL+	200 MHz	Block Next Request SNC will assert this signal when it runs out of internal resources while a locked transaction is in progress. SNC may also assert this signal during a hard reset sequence. SNC will also monitor this signal when driven by a processor to block any of its transactions from being issued on the bus.
			SNC asserts BNR# for debug.
BPM[5:0]#	I/O AGTL+	200 MHz	Breakpoint/Debug Bus This group of signals is used by the system debug logic and SNC for communicating debug information. SNC drives BPM[3:0]# and BPM[5]#. BPM[4]# is not driven by SNC.
BPRI#	O AGTL+	200 MHz	Priority Agent Bus Request SNC asserts this signal to drive requests originating from SP and to issue a deferred reply transaction in some special cases. SNC will also assert this signal to block the processors from issuing transactions. BPRI# assertion will have the same effect as BNR# assertion in this case with the exception that SNC will drive its snoop requests on the processor bus. Symmetric agents do not drive this signal. This signal is sampled by SNC internally.
BREQ0#	I/O AGTL+	200 MHz	Physical Bus Request SNC drives BREQ[0]# during reset and deasserts it one clock after SNC samples reset deasserted.
BREQ[3:1]#	I AGTL+	200 MHz	Physical Bus Request SNC does not drive BREQ[3:1]#. SNC observes active BREQ[3:0]# from processors to determine deassertion of BPRI# to transfer bus ownership to the processor.
D[127:0]#	I/O AGTL+	400 MHz	Data Bus 128 bits of data driven by the agent responsible for driving the data during the Data phase.
DBSY#	I/O AGTL+	200 MHz	Data Bus Busy Indicates that the data bus is owned by the agent responsible for driving the data during the Data phase. DBSY# assertion does not imply that data is being transferred that cycle.
DEFER#	O AGTL+	200 MHz	Defer SNC asserts DEFER# for all processor initiated transactions with DEN# on. SNC will also generate deferred responses for these transactions except for the cases when an in-order retry is forced.



Table 2-4. SNC Signal List (Continued)

Signal	Туре	Frequency	Description
Itanium [®] 2 Process	or Bus (continue	ed)	
DEP[15:0]#	I/O AGTL+	400 MHz	Data Bus ECC ECC coverage for 128 bits of data. SNC generates this ECC when it drives data during the Data phase. SNC also checks ECC for incoming data.
DRDY#	I/O AGTL+	200 MHz	Data Ready Indicates that data is valid on the data bus during any cycle DRDY# is asserted. SNC asserts DRDY# for each valid data transfer.
GSEQ#	O AGTL+	200 MHz	Guaranteed Sequentially SNC asserts this signal along with DEFER# to guarantee that the chipset will maintain the order of writes.
HIT#	I/O AGTL+	200 MHz	Snoop Hit SNC captures the value of HIT# for transactions that are deferred and returns it using DHIT# during the Deferred Phase. SNC asserts HIT# to initiate a HIT# or snoop stall for debug (HIT# and HITM# asserted together). SNC does not drive HIT# during normal operation.
HITM#	I/O AGTL+	200 MHz	Snoop Hit with Modified SNC observes HITM# and when asserted drives TRDY# for implicit writeback. SNC asserts HITM# to initiate a snoop stall for debug (HIT# and HITM# asserted together). SNC does not drive HITM# during
ID[9:0]#	O AGTL+	200 MHz	normal operation. Transaction Identifier These are driven during the Deferred Phase and indicate the transaction ID of the deferred transaction. On the second clock of the deferred phase (IDS# +1), IDb[1:0]# carries the parity for the ID signals. IDb[2]# renamed as DHIT# is asserted by SNC if the snoop phase of the original transaction resulted in HIT#.
IDS#	O AGTL+	200 MHz	Transaction Identifier Strobe IDS# is asserted by SNC to indicate the first cycle of the deferred phase.
INIT#	O AGTL+	200 MHz	Initialization Signal INIT# is asserted to initiate soft reset of the processors.
LOCK#	I AGTL+	200 MHz	Bus Lock Indicates atomicity of transactions. SNC will never assert LOCK#.
REQ[5:0]#	I/O AGTL+	200 MHz	Request Command Asserted during both clocks of the Request phase. During the first clock, these signals carry enough information to initiate a snoop request. In the second clock these signals carry additional information to completely define the transaction type.
			These are sampled and driven by SNC.
RP#	I/O AGTL+	200 MHz	Request Command Parity Parity protection on ADS# and REQ[5:0]# signals. RP# is driven by SNC for its own transactions. RP# is also sampled by SNC to check parity on the Request phase signals.
RS[2:0]#	O AGTL+	200 MHz	Response Status Indicates the types of response generated by SNC. Valid responses are Hard Fail, Implicit Writeback, Normal, No Data, Deferred and Retry.
RSP#	O AGTL+	200 MHz	Response Status Parity Parity protection on RS[2:0]#
SBSY#	I/O AGTL+	200 MHz	Strobe Bus Busy Indicates that Strobes are used by an agent. It is driven by an agent transferring data when it owns the strobe bus. SBSY# is driven and sampled by SNC.



Table 2-4. SNC Signal List (Continued)

Signal	Туре	Frequency	Description
Itanium [®] 2 Processo	r Bus (continue	d)	
STBN[7:0]#	I/O AGTL+	200 MHz	Data Strobes Used to transfer data at the 2x rate. STBn[7:0]# is the negative phase data strobe. Data transfer occurs when the voltage levels of STBn and STPp are equal. SNC drives and samples STBn[7:0]#.
STBP[7:0]#	I/O AGTL+	200 MHz	Data Strobes Used to transfer data at the 2x rate. STBp[7:0]# is the positive phase data strobe. Data transfer occurs when the voltage levels of STBn and STPp are equal. SNC drives and samples STBp[7:0]#.
			TLB Purge Not Done
TND#	I/O AGTL+	200 MHz	SNC asserts TND# at the requesting node until the Purge TC is completed globally.
			SNC observed TND# to determine completion of Purge TC.
TRDY#	O AGTL+	200 MHz	Target Ready Indicates that the target for the host transaction is able to enter the data transfer phase.

Signal Description





Configuration Registers

3.1 Access Mechanisms

The SNC configuration registers can be accessed from the following sources:

- Configuration Read and Write from either scalability port (SP)
- System Management Bus (SMBus)
- JTAG

Table 3-1. Register Attributes Definitions

Attribute	Abbrevi- ation	Description
Read Only	RO	The bit is set by the hardware only and software can only read the bit. Writes to the register have no effect. A hard reset will set the bit to its default value.
Read/Write	RW	The bit can be read and written by software. A hard reset will set the bit to its default value.
Read/Write Once	RWO	The bit can be read by software. It can also be written by software but the hardware prevents writing it more than once without a prior reset. Since the smallest register access is one byte, this protection applies on a byte-by-byte basis. That is, if only one byte of a field is written, only that byte will be locked. The other byte has separate write protection.
Read/Clear	RC	The bit can be either read or cleared by software. In order to clear an RC bit, the software must write a one to it. Writing a zero to an RC bit will have no effect. A hard reset will set the bit to its default value.
Sticky	RWS, RCS, ROS	The bit is "sticky" or unchanged by a hard reset. Read/Write, Read/Clear, and Read Only bits may be sticky. These bits are only reset with PWRGOOD.
Reserved	RV	This bit is reserved for future expansion and must not be written. The <i>PCI Local Bus Specification, Revision 2.2</i> requires that reserved bits must be preserved. Any software that modifies a register that contains a reserved bit is responsible for reading the register, modifying the desired bits, and writing back the result.
Unique	*	Any attribute with an asterisk (*) suffix indicates an unique behavior. Please consult the associated description for details.

3.2 SNC Fixed Memory Mapped Registers

These registers are mapped into the "SNC Memory Mapped Configuration Register Range" shown in Table 4-6, "Address Disposition for Processor." These appear at fixed addresses to support the boot process. These registers also appear in the SNC configuration space. This mechanism is independent of the more general Memory Mapped Configuration mechanism.



3.2.1 SPADA: Scratch Pad Alias

This is a memory mapped alias of the register described in Section 3.8.4, "SPAD: Scratch Pad." This register may be read or written only by 4-byte accesses.

Memory Address:FE60_C400h				
Bit	Attr	Default	Description	
31:0	RW	0	Scratch pad for system.	

3.2.2 SPADSA: Sticky Scratch Pad Alias

This is a memory mapped alias of the register described in Section 3.8.5, "SPADS: Sticky Scratch Pad." This register may be read or written only by 4-byte accesses.

Memory Address:FE60_C800h						
Bit	Attr	Attr Default Description				
31:0	RWS	0	Sticky Scratch pad for system.			

3.2.3 BOFLA: Boot Flag Alias

Only 4-byte reads may be made to this register. Writes will have no effect.

Memory Address:FE60_7400h
See Section 3.8.6, "BOFL: Boot Flag."

3.2.4 CBCA1: Chip Boot Configuration Alias

This register may be read or written only by 4-byte accesses.

Memory Address:FE62_7400h

Bits 31:0 of the register described in Section 3.8.7, "CBC: Chip Boot Configuration."

3.2.5 CBCA2: Chip Boot Configuration Alias

This register may be read or written only by 4-byte accesses.

Memory Address:FE62_7800h

Bits 63:32 of the register described in Section 3.8.7.



3.2.6 CBCA3: Chip Boot Configuration Alias

This register may be read or written only by 4-byte accesses.

Memory Address:FE62_7C00h

Bits 95:64 of the register described in Section 3.8.7.

3.3 SNC I/O Space Registers

3.3.1 CFGADR: Configuration Address Register

CFGADR is written only when a processor I/O transaction to CF8 is:

- · Referenced as a Dword.
- The **Bus Number** field matches the **Bus** field in the CBC register.
- The **Device Number** matches the **NodeID** field in the CBC register.

A Byte or Word reference will not access this register, but will generate a I/O read and write on SP. If the reference is Dword, but the Bus Number and Device Number do not match, a configuration read/write on the SP will be sent out. The **CFGADR** register contains the **Bus Number, Device Number, Function Number**, and Register Number for which a subsequent **CFGDAT** access is intended.

I/O Addı	VO Address:CF8h			
Bit	Attr	Default	Description	
31	RW	0	CFGE Configuration Enable Unless this bit is set, accesses to the CFGDAT register will not produce a configuration access, but will be treated as other I/O accesses. This bit is strictly an enable for the CFC/CF8 access mechanism and is not forwarded to PCONR/W address.	
30:24	RV	0	Reserved	
23:16	RW	0	Bus Number Compared against CBC.Bus to define local SNC configuration space.	
15:11	RW	0	Device Number Compared against CBC.NodeID to define local SNC configuration space.	
10:8	RW	0	Function Number This field is used to select the function of a locally addressed register. If this field is 0, 1, 2, or 3, this field specifies the SNC function of the addressed register. Otherwise, writes will be discarded and reads will return all ones as defined by the PCI specification.	
7:2	RW	0	Register Offset If this register specifies an access to SNC registers, this field specifies a group of four bytes to be addressed. The bytes accessed are defined by the Byte enables of the CFGDAT register access. Otherwise, writes will be discarded and reads will return all 0s as defined by the PCI specification.	
1:0	RW*	0	Writes to these bits will have no effect; reads return 0.	



3.3.2 CFGDAT: Configuration Data Register

CFGDAT provides data for the four bytes of configuration space defined by CFGADR. This register is only accessed if there is an access to I/O address CFCh on the processor bus and CFGADR.CFGE is set. The byte enables with the I/O access define how many configuration bytes are accessed.

I/O Address:CFCh			
Bit	Attr	Default	Description
31:0	RW	0	Configuration Data Window The data written or read to the configuration register (if any) specified by CFGADR.

3.4 SNC Configuration Registers

The SNC is viewed by the system as a single PCI device with four different functions. Offsets 0 to 40h are used for the standard PCI header as defined in *PCI Local Bus Specification*, Rev. 2.2.

Table 3-2 lists the configuration address maps for each function of the SNC.

Configuration reads to other functions return all 1's. Reads to undefined (reserved) registers return all 0's. Writes to other functions and undefined registers are dropped.

Table 3-2. Register Grouping by Function

Function	Types of Registers
0	Processor bus control.
1	Memory controller.
2	Scalability Port 0 and registers common to both SPs.
3	Scalability Port 1 and global performance monitoring.

3.5 PCI Standard Registers

3.5.1 VID: Vendor Identification Register

This register identifies Intel as the manufacturer of the SNC. Writes to this register have no effect.

Device: Function Offset:	: 0,1,2	NodelD 0,1,2,3 00 - 01h		
Bit	Attr	Default	Description	
15:0	RO	8086h	Vendor Identification Number This is the standard 16-bit value assigned to Intel.	



3.5.2 DID: Device Identification Register

This register combined with the Vendor Identification register uniquely identifies the SNC. Writes to this register have no effect.

Device: NodelD Function: 0,1,2,3 Offset: 02 - 03h			
Bit	Attr Default		Description
15:0	RO	Fixed Value (see Description)	Device Identification Number Identifies each function of the SNC. 0500h: SNC Function0 0501h: SNC Function1 0502h: SNC Function2 0503h: SNC Function3 0508h: Reserved 0509h: Reserved 050Ah: Reserved 050Bh: Reserved

3.5.3 CCR: Class Code Register

This register contains the Class Code for the SNC, specifying the device function.

Device: Function Offset:	Function: 0,1,2,3				
Bit	Attr	Default	Description		
23:16	RO	06h	Base Class This field indicates the general device category. For the SNC, this field is hardwired to 06h, indicating it is a "Bridge Device."		
15:8	RO	0	Sub-Class This field qualifies the Base Class, providing a more detailed specification of the device function. For the SNC, this field is hardwired to 00h, indicating it is a "Host Bridge."		
7:0	RO	0	Register-Level Programming Interface This field identifies a specific programming interface that device independent software can use to interact with the device. There is no such interfaces defined for host bridge, and this field is hardwired to 00h.		



3.5.4 RID: Revision Identification Register

This register contains the revision number of the SNC.

Device: Function Offset:	Function: 0,1,2,3				
Bit	Attr	Attr Default Description			
7:0	RO	See Description	Revision Identification Number 00h = A0 stepping 01h = A1 stepping 02h = A2 stepping 03h = A3 stepping 10h = B0 stepping 20h = C0 stepping		

3.5.5 HDR: Header Type Register

This register identifies the header layout of the configuration space.

Device Functi Offset:			
Bit	Description		
7	RO	1	Multi-function Device This bit indicates if the SNC is a multi-function device. The SNC has more than 256 bytes of configuration registers alloted to a single function. Therefore, the SNC is defined to be a multifunction device, and this bit is hardwired to 1.
6:0	RO	0	Configuration Layout This field identifies the format of the standard PCI configuration header space (10h through 3Fh space). The SNC uses header type "00". These bits are hardwired to 00h.

3.5.6 SVID: Subsystem Vendor Identification Register

This register identifies the manufacturer of the system. This 16-bit register, combined with the Device Identification Register, uniquely identifies any PCI device.

Functi	Device: NodelD Function: 0,1,2,3 Offset: 2Ch				
Bit	Attr	Default Description			
15:0	RWO	8086h	Vendor Identification Number The default value specifies Intel as the subsytem vendor ID for the SNC. Each byte of this register will be writable once. Second and successive writes to a byte will have no effect.		



3.5.7 SID: Subsystem Identity

This register identifies the system.

Function	Device: Node_ID Function: 0, 1, 2, 3 Offset: 2Eh				
Bit	Attr	Default	Default Description		
15:0	RWO	8086h	Subsystem Identification Number The default value specifies Intel as the system ID for the SNC. Each byte of this register will be writable once. Second and successive writes to a byte will have no effect.		

3.6 Address Mapping Registers

3.6.1 MAR[5:0]: Memory Attribute Region Registers

This register defines the memory attributes on the 11 memory segments in the 512 Kbyte to 1 MByte address range. These attributes determine whether the SNC routes a processor request to main memory or to the compatibility bus. The SNC takes no special action if the request is to be routed to memory. If the request is to be routed to the compatibility bus, it is directed out to the scalability port as if it were a remote memory read, but with a attribute field set to CB. Each register holds the attributes for two segments (see Table 4-6 "Address Disposition for Processor"). Table 3-3 shows the MAR registers and the associated attribute bits.

Software on Itanium 2 processors must map C_0000-F_FFFFh to main memory for the SNC.

Device: Function Offset:	Function: 0				
Bit	Attr	Default	Description		
7:6	RV	0	Reserved		
5	RW	0	WE1: Segment 1, Write Enable When set, route write requests to main memory. Otherwise, route to compatibility bus.		
4	RW	0	RE1: Segment 1, Read Enable When set, route write requests to main memory. Otherwise, route to compatibility bus.		
3:2	RV	0	Reserved		
1	RW	0	WE0: Segment 0, Write Enable When set, route write requests to main memory. Otherwise, route to compatibility bus.		
0	RW	0	RE0: Segment 0, Read Enable When set, route write requests to main memory. Otherwise, route to compatibility bus.		



Table 3-3. MAR Register Mappings

Register	Bits		Attribu	ite Bits		Memory Segment	Default
MAR0 (54h)	3:0					Reserved	0
WARU (3411)	7:4	-	-	WE	RE	0F0000h - 0FFFFFh	0
MAR1 (55h)	3:0	-	-	WE	RE	0C0000h - 0C3FFFh	0
WART (5511)	7:4	-	-	WE	RE	0C4000h - 0C7FFFh	0
MAR2 (56h)	3:0	-	-	WE	RE	0C8000h - 0CBFFFh	0
WAR2 (3011)	7:4	-	-	WE	RE	0CC000h - 0CFFFFh	0
MAR3 (57h)	3:0	-	-	WE	RE	0D0000h - 0D3FFFh	0
WARS (3711)	7:4	-	-	WE	RE	0D4000h - 0D7FFFh	0
MAR4 (58h)	3:0	-	-	WE	RE	0D8000h - 0DBFFFh	0
WAIX4 (3011)	7:4	_	_	WE	RE	0DC000h - 0DFFFFh	0
MAR5 (59h)	3:0	_	_	WE	RE	0E0000h - 0E7FFFh	0
WARS (3911)	7:4	_	_	WE	RE	0E8000h - 0EFFFFh	0

3.6.2 ASE: Address Space Enable Register

This register defines the Video Graphics Adapter and Monochrome Display Address ranges. Table 4-6 define the usage of these bits.

Device: Function Offset:	Function: 0				
Bit	Attr	Default	Description		
7:3	RV	0	Reserved		
2	RW	0	ISAEN: ISA Aliasing Enable If set, I/O addresses X100 - X3FFh, X500 - X7FFh, X900 - XBFFh, and XD00 - XFFFh may be redirected to compatibility bus.		
1	RW	0	MDASE: Monochrome Display Adapter Space Enable This bit affects the attribute field and request type applied to outbound SP requests for memory addresses in the range B_0000 - B_7FFFh and I/O requests to 3B4h, 3B5h, 3B8h, 3B9h, 3BAh and 3BFh.		
0	RW	0	VGASE: VGA I/O Space Enable This bit affects the attribute field and request type applied to outbound SP requests for memory addresses in the range (A_0000 - B_FFFFh) and I/O addresses in the (03B0h - 03BBh and 03C0h - 03DFh) ranges.		

3.6.3 MMIOH: High Memory Mapped I/O Space Register

This register defines the High Memory Mapped I/O space. It starts at FF_FFFF_FFFFh and extends downward in 4-GB increments to a minimum lower limit of 1_0000_0000h.



Processor requests to this space are directed to a particular SP port as a function of the SPINCO and AGP1 registers. This routing forces a single path to each Memory Mapped I/O location. This enables writes to be pipelined while maintaining sequential order.

Processor requests to this range are non-coherent. Non-coherent Read/Write are issued on the SP.

An address is in the High MMIO space if:

• (A[43:40] = 0h) AND (A[39:32] > BASE)

Device: Function Offset:	Node n: 0 60h	eID	
Bit	Attr	Default	Description
15:8	RV	0	Reserved
7:0	RW	FFh	BASE Defines the lower limit of High MMIO range. These bits are compared against A[39:32]. This field is one less than A[39:32] for the lowest address in the High MMIO range. If FFh, this range is disabled. This register should be set to the same value as the MMIOBH register in the SIOH.

3.6.4 MMIOL: Low Memory Mapped I/O Space Register

This register defines the Low Memory Mapped I/O space. It starts at FDFF_FFFFh and extends downward in 16MB increments to a minimum value of 64MB. This region is described in "High and Low Memory Mapped I/O (MMIO)" in Chapter 4, "System Address Map."

Processor requests to this space are directed to a particular SP port as a function of the SPINCO and AGP1 registers. This routing forces a single path to each Memory Mapped I/O location. This enables writes to be pipelined while maintaining sequential order.

Processor requests to this range are non-coherent. Non-coherent Read/Write are issued on the SP.

The memory behind this range can be recovered using reflection. The SNC will not scrub any memory mapped to this range and will only scrub the memory recovered from this range in MIRs with the RFLCT bit set. See Section 5.2.1, "Scrub Address Generation."

An address is in the Low **MMIO** space if:

• (A[43:32] = 000h) AND (FDh >= A[31:24] > BASE)

Device: Function Offset:	Node n: 0 64h	eID	
Bit	Attr	Default	Description
15:8	RV	0	Reserved
7:0	RW	FFh	Defines the lower limit of the Low MMIO range. These bits are compared against A[31:24]. This field is one less than A[31:24] for the lowest address in the Low MMIO range. If >= FDh, this range is disabled. This register should be set to the same value as the MMIOBL register in the SIOH.



3.6.5 AGP1: Advanced Graphics Port Sub-Range 1 Register

In general, transactions to the High and Low MMIO range are routed out the default SP. This register defines a sub-range within either the High or Low MMIO range, which is routed out the non-default SP to balance loading. An enabled AGP1 range must be configured to fall within either the High or Low MMIO range (see Section 3.6.3, "MMIOH: High Memory Mapped I/O Space Register" and Section 3.6.4, "MMIOL: Low Memory Mapped I/O Space Register"). Otherwise, this range is considered null.

An address falls in AGP1 range if:

HI/LO AND A[43:40]=0h AND (MMIOH.BAS <= AGP1.BAS < A[39:32] <= AGP1.LIM) OR !HI/LO AND A[43:32] =000h AND (MMIOL.BAS <= AGP1.BAS < A[31:24] <= AGP1.LIM <= FDh)

Device: Function Offset:	Function: 0					
Bit	Attr	Default	Description			
24:16	RV	0	Reserved			
16	RW	0	HI/LO If set, the AGP1 range falls in the High MMIO range. Otherwise it falls in the low MMIO range. If in the high range, AGP1_LIM and AGP1_BASE are compared against A[39:32], otherwise A[31:24].			
15:8	RW	0	LIM This field specifies the upper limit for the AGP1 sub-range within an MMIO region. This field is A[39:32] (High MMIO) or A[31:24] (Low MMIO) for the highest address in the AGP1 range.			
7:0	RW	0	BAS This field specifies the lower limit for the AGP1 sub-range within an MMIO region. This field is one less than A[39:32] (High MMIO) or A[31:24] (Low MMIO) address bits for the lowest address in the AGP1 range.			

3.6.6 MMCFG: Memory Mapped Configuration Space Register

This register defines the Memory Mapped Configuration space. This space maps the entire PCI configuration space into memory. This space is relocatable in 64 MB increments above 4 GB (1_0000_0000h). It may not overlap MMIOH. It may not overlap High MMIO or any other space. To avoid race conditions, software may only modify this register by CF8/CFC. Software must also guarantee that there is no race between issue of MMCFG requests and changes in this register. That is, all MMCFG accesses that expect the old register value must be completed before any write to this register is issued, and the register write must complete on the processor bus before any MMCFGs are issued that expect the new register value. See Table 4-8, "Address Disposition for Inbound Transactions."

The address of requests in this range are compared against CBC.NodeID and CBC.Bus to determine whether the request accesses registers on this SNC. If not, it is converted into a non-coherent configuration Read/Write and issued on one of the SPs.

An address is in the MMCFG space if:

- The space is enabled: (**BASE** > 03Fh)
- A[43:26] == BASE



Device: NodelD Function: 0 Offset: 50h				
Bit	Attr	Default	Description	
31:18	RV	0	Reserved	
17:0	RW	0	BASE Defines the lower limit of MMCFG range. These bits are compared against A[43:26]. If less than 40h, this range is disabled.	

3.6.7 IORD: I/O Redirection Register

This register is used to redirect I/O segments to the compatibility PCI bus. Certain I/O addresses (e.g. MDA,VGA,CFC/CF8) are not redirected according to this register. Section 4.3.2.1, "Outbound I/Os" defines the types of I/O accesses that are not governed by this register. Each bit in this register corresponds with a 4-KB I/O segment.

Device: Function Offset:	Function: 0				
Bit	Attr	Default	Description		
15:0	RW	0	I/O Redirection Bits Each bit corresponds with a 4-KB I/O segment. Bit 0 corresponds with the lowest 4 KBs, Bit 1 corresponds with the next 4 KBs, etc. If an IORD bit is asserted, requests to the corresponding addresses will have a Attr field of the SP I/O Read/Write request be set to CB.		

3.6.8 SMRAM: SMM RAM Control Register

This register must be programmed consistently with the SMRAM register in the SIOH. As the Itanium 2 processor does not support SMM, undefined system operation will result if this register is written. The default value leaves SMM space disabled.

Device: NodelD Function: 0 Offset: 5C - 5Fh				
Bit	Attr	Default	Description	
31:0	RV	0	Reserved	



3.6.9 MIR[9:0]: Memory Interleave Range Registers

These registers define 10 ranges in which all the main memory supported by this SNC falls. Collectively, all the MIRs that cover a range and the Memory Interleave Technology (MIT) associated with them define a *cache line interleave*. The cache line interleave is the repeating sequence of channels, devices, and internal banks over which a linear stream of cache line accesses cycle.

The MIRs on an SNC define whether an access is directed to local memory or sent to a scalability port switch for further routing. The MIRs on the SP switch define the SNC that services each cache line of memory. There is not a 1:1 association of SP switch MIRs with SNC MIRs. Multiple SNC MIRs may cover the same range as one way of an SP switch MIR. One SNC MIR may describe a contiguous address range covered by a series of SP switch MIRs.

All the memory covered by an SNC MIR must be the same technology. There is one Memory Interleave Technology (MIT) Register in each SNC associated with each MIR. The MIT defines the number of rows, columns, and banks addressed. The MIR and MIT jointly define how cache lines are interleaved across devices, channels, and banks.

To support interleave across different technologies, up to four MIRs on the same or different SNCs may be set to the same address range. The *ways* field of each MIR is used to divide cache lines among the MIRs sharing an address range. Each MIR may cover 1, 2, or 4 *ways*. The remainder of the 32-way interleave is across devices, banks, or channels of identical technology as defined by the MIT registers and the address bit assignments in Section 5.3.2.5, "DDR Address Bit Mapping."

The WAYS, BASE and SIZE fields define the existence and extent of this interleave. An address falls in this interleave if:

• WAYS[A[8:7]] AND [BASE \leq A[43:27] \leq BASE $+ 2^{SIZE}$]

Device: NodeID Function: 1 Offset: 60h,64h,68h,6Ch,70h,74h,78h,7Ch,C4h,C8h					
Bit	Attr	Default	Description		
31:26	RV	0	Reserved		
25:9	RW	0	BASE This defines the lowest address in the interleave. These bits are compared against A[43:27]. This field must be set to a multiple of the Interleave size defined below.		
8:4	RW	0	SIZE 2 SIZE is the number of 128-MB blocks in the interleave range. To describe all the memory supported by a given set of devices. For example, for DDR this field should be set according to the contents of the MIT register with the same index as follows: MIR[i].SIZE = 32B (bytes per quantum) • 4 (Banks) • MIT[i].NUMROW • MIT[i].NUMCOL • MIT[i].SIDES • MIR[i].W • MIT[i].DIV Where MIR[i].W is 4 divided by the number of ones in the WAYS field, below. (This memory can also be divided among multiple MIRs covering different ranges.) MIT[i].DIV should be interpreted to have values 1, 1/2, or 1/4. The MIR used to recover memory by reflection will not follow the equation above. It should have a size field as small as possible to cover maximum anticipated expansion of the reflected region.		



Device: Function Offset:	Function: 1					
Bit	Attr	Default	Description			
3:0	RW	0	WAYS If the bit in this field selected by A[8:7] is set, the access is sent to the devices described by the corresponding MIT register. Each way bit of every Memory Interleave Range must be set in exactly one MIR. [3] = Selected if A[8:7] = 11 [2] = Selected if A[8:7] = 10 [1] = Selected if A[8:7] = 01 [0] = Selected if A[8:7] = 00 Any MIR can cover 1, 2, or 4 ways of an interleave. Only certain combinations are consistent with the address bit mapping described in Table 5-5 "DDR Address Bit Mapping" and Table 5-6, "Interleave Field Mapping for DDR." 0000 Range disabled: This SNC has no memory in this range. 0001 This MIR decodes way 0 - (A[8:7]=00) 0010 This MIR decodes way 1 - (A[8:7]=10) 1000 This MIR decodes way 2 - (A[8:7]=11) 0101 This MIR decodes way 0 and 2 - (A[7]=0) 1010 This MIR decodes way 1 and 3 - (A[7]=1) 1111 This MIR decodes all ways in this range.			

3.7 Memory Controller Registers

3.7.1 MC: Memory Control Settings

Device: Function Offset:	Function: 1				
Bit	Attr	Default	Description		
15:13	RV	0	Reserved		
12	RW	0	RROE: DDR Read to Read Optimization 0 = STM.Trr determines the spacing between any read on the same DDR channel. This setting must be used when some DRAM devices do not support concurrent auto-precharge. The lack of concurrent auto-precharge support can be inferred from DRAM specification that mention an "access period" following RDA or WRA. 1 = Back-to-back Reads can be made to the same DDR device. STM.Trr determines the spacing between reads to different devices on the same DDR channel.		
11:8	RV	0	Reserved		
7	RW	0	MWBL: Minimum Write Burst Length Enable The minimum number of writes required for issue. Prior to normal operation, this bit should be 0, so that all writes flush in the absence of reads. In normal operation, this bit should be set to 1 so that incoming reads are not delayed by write unnecessary write flushes. 0 = Writes are issued in the absence of reads 1 = Writes are not issued unless four are posted. Up to three posted writes may persist in the SNC indefinitely.		



Device: **NodelD** Function: 1 Offset: 40h (Continued) Default Attr **Description MECBD: Memory Error Correction Bypass Disable** 0 = Normal Operation: Correction path is not taken unless correction is 6 RW 0 required. 1 = All data is forced through the correction path. **MECE: Memory Error Correction Enable** 0 = No memory read errors are corrected. Logging is unaffected, but poisoning will not occur. Good SEC/DED will be generated for all memory 5 RW 0 1 = Enable Error correction (see Section 5.2, "Error Correction"). This bit should not be set if MECBD=1. MT: Memory Type RW 0 = Reserved 1 = Synchronous DDR DRAM. 3:0 RV 0 Reserved

3.7.2 MIT[9:0]: Memory Interleave Technology Registers

These registers define the mapping of address bits to DDR channels, devices, internal banks, rows, and columns for this node. Each MIT groups together similar devices to maximize interleave across channels, devices and banks.

There is one MIT for each memory range defined by the MIRs. All devices covered by one MIT must be the same size and technology. If the ways field of the associated MIR indicates that this interleave is disabled, the settings of this MIT are not applied.

Table 3-4. MIT Definition for DDR SDRAM

Device: Function Offset:	Function: 1				
Bit	Attr	Default	Description		
31:19	RV	0	Reserved		
18	RW	0	RFLCT: MIR used for Reflection If set, this Memory Interleave Range is used to recover memory behind MMIOL. In this MIR, the SNC will only scrub locations in the recovered range (see Section 5.2.1, "Scrub Address Generation"). If this bit is set, the corresponding MIR.SIZE may not cover the entire DIMM, but should be 4GB maximum.		
17:15	RV	0	Reserved		
14	RW	0	Channel Defines the DDR channel this DIMM occupies. Modifies the Channel number in the MCP.		



Table 3-4. MIT Definition for DDR SDRAM (Continued)

Device: NodelD Function: 1

Offset:	A0h	A0h,A4h,A8h,ACh,B0h,B4h,B8h,BCh,CCh,D0h (Continued)		
Bit	Attr	Default	Description	
13:11	RW	0	RAFIX This field defines which portion of the DIMM is mapped by this register. This is accomplished by assigning fixed values to the most significant Row address bits for this technology. The same half or quarter of a DIMM should not be mapped by different MITs. Table 5-7 "MCP Bits Forced by RAFIX and DIV Fields for DIMM Splitting" defines how this affects address bit mapping. 0 = This MIR/MIT maps the first quarter or first half of the DIMM 1 = This MIR/MIT maps the second quarter of the DIMM 2 = This MIR/MIT maps the third quarter or second half of the DIMM 3 = This MIR/MIT maps the fourth quarter of the DIMM	
10:9	RW	0	ROW Defines the Chip Selects (CS) connected to this DIMM. Together with the SIDES field, determines the chip select fields in the MCP. Single-sided DIMMs are only connected to the first CS of the pair. 0 = CS0 and CS1 1 = CS2 and CS3 2 = CS4 and CS5 3 = CS6 and CS7	
8	RV	0	Reserved	
7	RW	0	SIDES Defines the number of sides this DIMM has. Modifies the Interleave field mapping to ping-pong across Chip Selects as defined in Table 5-6, "Interleave Field Mapping for DDR." 0 = single-sided 1 = double-sided	
6:5	RW	0	DIV This field can be set to split a DIMM among 2, 3, or 4 MIR/MIT pairs. The different portions can be assigned to independent address ranges as defined by the RAFIX field. Table 5-7 "MCP Bits Forced by RAFIX and DIV Fields for DIMM Splitting" defines how this affects address bit mapping. 0 = This MIR/MIT maps the entire DIMM 1 = Reserved 2 = This MIR/MIT maps 1/2 of the DIMM 3 = This MIR/MIT maps 1/4 of the DIMM	
			NUMROW: Technology – Number of Rows	
4:3	RW	0	The number of rows within the devices of this interleave. See Section 5-4, "Bits Used in MCP Packet for Different DDR Technologies" for legal combinations with other fields. 0 = 4096 1 = 8192 2 = 16384	
			NUMCOL: Technology – Number of Columns	
2:0	RW	0	The number of columns within the devices of this interleave. See Section 5-4 for legal combinations with other Technology fields. 0 = 512 1 = 1024 2 = 2048 3 = 4096 4 = 8192	



A MIT may not describe more than one DIMM. Multiple MITs can apply to the same DIMM if the associated MIR registers define different address ranges.

The DMH specifies the correlation between CS to SPD address bits on DIMMs and the format of the Memory Control Packets (MCP).

3.7.3 STM: DDR-SDRAM Timing Register

This register defines timing parameters that work with all DDR SDRAMs in the memory subsystem. The parameters for these devices can be obtained by serial presence detect (see Section 3.7.5, "RCD: RAMBUS* Configuration Data Register"). This register must be set to provide timings that satisfy the specifications of all DRAMs detected. If DRAMs present have different Tcas, the maximum should be used to program this register.

Consult DDR SDRAM specifications for the technology of the devices in use. Consult the Northbridge Levelization Procedure section of the *Intel*[®] *E8870DH DDR Memory Hub (DMH) Datasheet* for procedures to set these timing parameters.

Device: Function Offset:	Function: 1			
Bit	Attr	Default	Description	
31	RV	0	Reserved	
30:27	RW	2h	TRD: Read MCP to Data Delay TRD defines the delay from the beginning of a read/write MCP to first data sample in RClk resolution. Read to data delay = 2 • t _{RD} +20; (20-46) Write to data delay = 2 • t _{RD} +17; (17-43) legal values are 0000 through 1101 The tcwd (DMH Main channel Write delay) parameter in the DMH should be set to 2 • t _{RD} +13.	
26:22	RV	0	Reserved	
21:20	RW	3h	TRQ: RAC RQ Transmit Timing Selects one of the four programmable timing points within SyncClk period (10ns) for transmitting RQ. The four timing points are identical to the Tselect timing in the Direct RAC Data Sheet. TRQ should always be set to 11. 0 0 Reserved 0 1 Reserved 1 0 Reserved 1 1 Transmit RQData with Tselect = 1000 timing	
19:18	RW	2h	TRW: Read to Write Delay The minimum delay from the Read command to the next Write command on the same branch DDR channel. This parameter is varied to avoid data strobe protocol violations on the DIMM data bus. Table 3-5 defines the settings of this parameter as a function of DMH parameters. 0 0 30 ns 0 1 40 ns 1 0 50 ns 1 1 60 ns	



Device:	NodelD
Function:	1
Offset:	C0h (Continued)

Offset:	C0h	(Continued)	
Bit	Attr	Default	Description
17:16	RW	1h	TWR: Write to Read Delay The minimum delay from the Write command to the next Read command on the same branch DDR channel. This parameter is varied to avoid data strobe protocol violations on the DIMM data bus. Table 3-5 defines the settings of this parameter as a function of DMH parameters. 0 0 10 ns 0 1 20 ns 1 0 30 ns 1 1 40 ns
15	RW	0	RWAC: Read or Write during Write Access Period This bit may be set if all the DRAM controlled by the SNC can perform concurrent auto-precharge operations to different banks. If 0, the maximum rate of auto-precharge writes to a DIMM will be one write every 50ns. The MC.RROE bit should be set to limit reads and writes during read access periods. O Some DIMMs do not support reads or writes during write access period. All DIMMs support reads or writes during write access period.
14	RV	0	Reserved
13:12	RW	2h	TRR: Read to Read Delay The minimum delay from one Read command to another Read command on a channel. MC.RROE determines whether this applies to all reads on a channel or just reads to a different DIMM on the same channel. This parameter is varied to avoid data strobe protocol violations on the DIMM data bus. 0 0
11:10	RW	1h	TWW: Write to Write Delay The minimum delay from the Write command to the next Write command on the same branch DDR channel. 0 0 Reserved. 0 1 20 ns 1 0 30 ns (Supported only for memory initialization) 1 1 40 ns
9:8	RW	0	TRCD: Ras to Cas Delay The minimum delay from the RAS to a subsequent CAS to the same DIMM Row. This parameter is programmed according to the highest tRCD and tRAP parameters of the DDR DIMMs present. 0 0 20 ns (tRCD= tRAP) 0 1 30 ns (tRCD< tRAP) 1 0 Reserved. 1 1 Reserved.
7:6	RW	0	TRA: Read to Activate Delay The minimum delay from the Read command to the next ACT command to the same bank. This parameter is programmed according to the timing calculation: tRAS + tRP - tRCD. Refer to DDR AC Characteristics specification for the timing parameters in the calculations. 0 0 50 ns 0 1 60 ns 1 0 Reserved 1 1 Reserved



Device: **NodelD Function:** Offset: C0h (Continued) Default Attr **Description** TWA: Write to Activate Delay The minimum delay from the Read command to the next ACT command to the same bank. This parameter is programmed according to the DIMM timing parameters: tWR + tRP + 30ns5:4 RW 2h Refer to DDR AC Characteristics specification for the timing parameters in the calculations. 00 60 ns 0 1 10 70 ns 11 Reserved TRFC: Auto Refresh to Act Delay The minimum delay from the Auto Refresh command to the next ACT command to the same device. This parameter is set to the largest tRFC of the DIMMs present. 000 70 ns RW 001 80 ns 3:1 1h 90 ns 0 1 0 0 1 1 100 ns 100 120 ns 101 130 ns 110 140 ns 160 ns 111

Table 3-5 defines the legal combinations for TRW, TWR as a function of DIMM data bus timing parameters configured in the DMH. There may be a small variation across DMHs and across the DIMMs on each DMH in the sum of $t_{CL} + t_{DPL} + t_{DSD}$. The maximum must be used.

The minimum delay from the Act command to the next ACT command to the same device. This parameter is programmed according to the largest tRRD of

Note: t_{CL} is the DIMM CAS Latency. t_{DPL} is the DIMM Path Latency, and t_{DSD} is DIMM Strobe Offset.

TRC: Act to Act Delay

the DIMMs present.

10 ns 20 ns

Table 3-5. Legal Combinations of TRW, TWR

RW

1h

0

DMH Maximum t _{CL} + t _{DPL} + t _{DSD}	TRW (STM[19:18])	TWR (STM[17:16])
15-17.5ns (6-7 Rclks)	01	10
20-25ns (8-11 Rclks)	10	01
27.5-35ns (12-15 Rclks)	11	00

3.7.4 DRC: DRAM Maintenance Control Register

The Refresh Value field specifies the number of cycles (nominally 5ns) between refreshes. Since refreshes are generated for all 16 supported DIMM sides, the refresh interval for any given DIMM is 16 times as long as the Refresh Value field. A value of 195 sets the DIMM refresh interval to the standard value of 15.6 us.



A value of 0 indicates that refreshes should not be generated. For more information on refresh see Section 5.3.4, "DDR Maintenance Operations."

Device: Function Offset:	Function: 1				
Bit	Attr	Default	Description		
15:12	RV	0	Reserved		
11:0	RW	0	Refresh Value For DDR, the number of cycles between refreshes. For testing purposes, this field may be set from 0 to 50.		

3.7.5 RCD: RAMBUS* Configuration Data Register

This register is used with the SCC register to access DMH registers or serial presence detect information. This register is written for write data and holds the result of any operation specified by the SCC register. Each operation is shifted out the serial interfaces for each RAMBUS concurrently. There is one 16-bit field in this register for the data to/from each RAMBUS.

Device: Function: Offset:	NodelD 1 48h		
Bit	Attr	Default	Description
63:48	RW	0	R3D: RAMBUS 3 data.
47:32	RW	0	R2D: RAMBUS 2 data.
31:16	RW	0	R1D: RAMBUS 1 data.
15:0	RW	0	R0D: RAMBUS 0 data.

3.7.6 SCC: DDR SDRAM Configuration Command Register

This register is used with the RCD register to access DDR SDRAM and DMH control registers or serial presence detect information. The SCC specifies the command to be executed. Writing this register causes transactions on the RAMBUS serial control bus which may be translated by expanders into serial presence detect transactions. The data for operations comes from, or is returned to the RCD register. The frequency of SCLK never exceeds 1MHz.

Device: Function Offset:	Function: 1				
Bit	Attr Default Description				
31:30	RV	0	Reserved		
29	RW	0	MOE: Maintenance Operation Enable When set, the SNC issues maintenance operations such as refresh, temperature calibration, etc. This bit defaults to 0 so that these operations will not interfere with initialization operations controlled by this register. When memory initialization is complete, software must set this bit. It may be up to 100 ms before this bit takes effect.		

Configuration Registers



Device: NodelD Function: 1 Offset: 54h (Continued)

Offset:	54h (Continued)			
Bit	Attr	Default	Description	
28:26	RV	0	Reserved	
			IIO: Initiate Initialization Operation	
25	RW	0	When set to 1, the execution of the initialization operation specified by the IOP starts. After the execution is completed, the SNC clears this bit to 0. The software must check to see if this bit is 0 before writing to this bit. The operations which specify register data read from the DDR-SDRAM will have the data valid in the RCD register when this is cleared to 0.	
24	RV	0	Reserved	
23:21	RW	0	CID Select one out of one DMH on amain channel. CID will appear in the packet and will not affect chipset operation.	
			ВА	
20	RW	0	This field enables the DMH on every main channel. BA will appear in the packet and will not affect chipset operation.	
19	RV	0	Reserved	
18:11	RW	0	MRA: DMH Register Address This field specifies the register address for the register read and write operations and the byte address for Serial Presence Detect Operations.	
10:5	RW	0	DIMM This field specifies the DIMM to be addressed by Serial Presence Detect IOPs. The mapping of values in this field to DIMMs is as specified in the Intel® E8870DH DDR Memory Hub (DMH) Datasheet. "Correspondence between SPD DIMM numbers and DIMM Rows in MIT register" defines how the values in this field map to those in the MIT register.	
			IOP: Initialization Opcode	
			This field specifies the initialization operation to be done on DDR SDRAM or DMH. Bits[4:0] Operation Specified 00000 DMH Register Read 00001 DMH Register Write	
4:0	RW	0	01001 DMH SIO reset 01101 Serial Presence Detect Write 01110 Serial Presence Detect Read 11000 SNC RACs Manual Current Calibration 11001 SNC RAC Load RAC 0 Config Register 11010 SNC RAC Load RAC 1 Config Register 00011 SNC RAC Load RAC 2 Config Register 00111 SNC RAC Load RAC 3 Config Register 11011 SNC RAC Load RAC 3 Config Register 11011 SNC RAC Initialize 11100 SNC RAC Auto Current Calibration 11101 SNC RAC Thermal Calibration 11110 DMH Time Sync	
			Refer to Intel® E8870DH DDR Memory Hub (DMH) Datasheet.	
			All combinations not shown above are reserved.	



Table 3-6. DDR IOP Decodes

Operation Name	Details
DMH Register Read	The serial read of the DMH register specified by the MRA field. The data read will be available in RCD register when IIO bit is cleared by hardware to 0.
DMH Register Write	The serial write of the DMH register specified by the MRA field. The write data is provided in the RCD register.
DMH SIO Reset	A SIO pin initialization sequence is sent to the DMH. When this operation occurs, the DMH serial interface is reset. This does not affect DMH configuration.
Serial Presence Detect Write	Initiate a SPD register write via the serial I/O to the DMH. This will cause an SPD operation to the DIMM specified by the DIMM field. The SNC also issues an SPD write on the SMBus. The MRA field specifies the byte addressed.
Serial Presence Detect Read	Initiate a SPD register read via the serial I/O to the DMH. This will cause an SPD operation to the DIMM specified by the DIMM field. The SNC also issues an SPD write on the SMBus. The MRA field specifies the byte addressed.
SNC RAC Manual Current Calibration	Loads all four RAC Current Control Registers with the values in the RCD register.
Load SNC RAC[n] Configuration Register	Loads the least significant 32 bits in the RCD register into the RAC config register within RAC[n]. n may be one of 0, 1, 2, 3.
SNC RAC Initialize	Initiate Power-up sequence, Current Calibration, and Temperature Calibration of SNC RACS. This sequence takes about 250us. This operation will only be executed once after each PWRGOOD deassertion. Subsequent RAC initialize operations will have no effect other than to set the IIO flag to indicate completion.
SNC RAC Auto Current Calibration	Initiate the Automatic Current Control Sequence defined by RAMBUS.
SNC RAC Thermal Calibration	Perform Slew Rate operation defined by RAMBUS.
DMH Time Synch	Send a Time Synchronization packet to the DMH.

3.7.7 MTS: Memory Test and Scrub Register

This register is used to control an engine that initializes, tests, and corrects errors in memory.

Device: NodeID Function: 1 Offset: 58h				
Bit	Attr	Default	Description	
31	RV	0	Reserved	
30	RW	0	Validation Mode 0 = Counter increments by 1. 1 = For validation purposes, counter increments by 128 MB.	
29	RW	0	Scrub Enable 0 = Test mode: When the Go bit is set, the engine performs the block copies described in Section 5.2.6, "Memory Test." 1 = Thirty-two data buffers are reserved for memory test. 1 = Scrub mode: the engine will continuously read then write each address described by the MIR registers. See Section 5.2, "Error Correction."	



Device: **NodelD** Function: 1 Offset: 58h (Continued) Default **Description** Go Used only in test mode. When set, initiates the test. When the test is complete, the SNC will reset this 28 RW 0 bit. This bit can therefore be polled to determine when the test is complete. Writing a 1 to this bit while it is already set will have no effect. Writing a 0 to this bit will have no effect. **Reduce Test Range** This field is used for validation. It must be set to 000 in scrub mode. 000 Test entire range defined by MIR 27:25 RW 0 Test only the lowest 512K defined by the MIR 100 010 Test only the lowest 64K defined by the MIR 001 Test only the lowest 16K defined by the MIR 24:4 RV0 Reserved MIRNUML 3:0 RW 0 Identifies the index of the Memory Interleave Range to be tested. See Section 3.6.9, "MIR[9:0]: Memory Interleave Range Registers."

3.7.8 XTPR[7:0]: External Task Priority Register

These registers define the redirectable interrupt priority for APIC agents on the node. The contents of these registers are modified by the xTPR_Update transaction on the processor bus. Index into the XTPR registers is defined by Ab[23:21]#. These registers are used for lowest priority delivery through interrupt redirection by the chipset. Whenever this register is updated, the Logical Submode bit in the FSBC register is also updated.

Device: NodelD Function: 0 Offset: 0:A4h,1:A8h,2:ACh,3:B0h,4:B4h,5:B8h,6:BCh,7:C0h					
Bit	Attr	Default	Description		
31:8	RV	0	Reserved		
7	RW	0	EN: TPR Enable This bit reflects the value of Ab[31]#. When Ab[31]# is asserted, the value of this bit will be 0.		
6:4	RV	0	Reserved		
3:0	RW	0	TPR: Task Priority The processor with the lowest enabled value will be assigned the re-directable interrupt. This field is updated with Ab[30:27]# of the xTPR_Update transaction.		



3.8 Reset, Boot and Control Registers

3.8.1 SYRE: System Reset

This register controls SNC reset behavior. Any resets produced by a write to this register must be delayed until the configuration write is completed on the initiating interface (SP, processor bus, SMBus, JTAG).

Device: Function Offset:	Node n: 0 40h	eID	
Bit	Attr	Default	Description
15:14	RV	0	Reserved
			SAVCFG: Preserve Configuration When this bit is set, SNC configuration register contents (except for this bit and
13	RW*	0	SAVMEM) are not cleared by hard reset. As this bit is cleared by reset, software must set it after each reset if this behavior is desired for the next reset. If this bit is set, BOFL will not be cleared by reset. Software should use the Boot Flag Reset bit to re-enable the BOFL mechanism.
			SAVMEM: Preserve Memory
			This bit must not be set unless the SCC.MOE is set to enable the memory operation timers. Otherwise, the SNC will not complete its reset procedure, and a PWRGOOD pulse will be required to recover.
12	RW*	0	When this bit is set, memory contents are preserved through hard reset. The registers in Section 3.7, "Memory Controller Registers" retain their values through reset. As this bit is cleared by reset, software must set it after each reset if this behavior is desired for the next reset.
			This bit should not be set unless the SCC.MOE bit is set to enable memory maintenance operations.
	RW*	0	Boot Flag Reset
11			When this bit is set, the boot flag register (BOFL) is returned to its default value. The SNC will clear this bit once this action is complete.
			SNC Reset
10	RW*	N* 0	The rising edge on this bit will initiate the Hard Reset sequence. The SNC will clear this bit once Hard Reset is asserted.
		0	Node Soft Reset
9	RW*		The rising edge on this bit will lead to the assertion of the INIT# pin for four cycles. The SNC will clear this bit once this action is complete.
			System Hard Reset
8	RW*	o	The rising edge on this bit will lead to the assertion of the RESETO# pin. Depending on system reset routing, this reset can be used to reset just the local node, or the entire system. The SNC will clear this bit once this action is complete. The timing of this RESETO# assertion should not be affected by Hard Reset.
7:0	RV	0	Reserved
			ļ

3.8.2 CVDR: Configuration Values Driven on Reset

The SNC drives the contents of this register on A[31:3]# whenever it asserts RESET# due to hard reset deassertion. These values are driven during RESET# assertion, and for two host clocks past the trailing edge of RESET#. The bit numbers in this register correspond to the index of the address bit driven. For example, if CVDR[10] is set, A[10]# will be asserted.

Configuration Registers



This register is sticky through reset; that is, the contents of the register remain unchanged during and following a Hard Reset. This allows system configuration software to modify the default values and reset the system to pass those values to all host bus devices. The default values shown above represent the state of the register following a *power-good* reset.

The CVDR bits do not affect SNC operation except for driving A[31:3]#. In order to enable external system logic to override the values driven by the SNC, the values captured from A[31:3]# affect SNC operation.

Device: Function Offset:	Node n: 0 44h	eID		
Bit	Attr	Default	Description	
31:28	RWS	0	SNC: CPU Kill When set, these bits disable the corresponding processor so that the remainder of the machine may be rebooted. The Agent numbers are those established by BR[0]# rotation. In systems that use on die termination for the processor bus, the CPU providing the termination should not be disabled. It is permissible to set the CPU Kill bits when the corresponding processor is not present so that the corresponding bits in the CVCR register reflect the number of working processors on the node. The Itanium 2 processor uses Agent[2:1]. A[31]# Tristate Agent 6,7 A[30]# Tristate Agent 4,5 A[29]# Tristate Agent 2,3 A[28]# Tristate Agent 0,1	
27:22	RWS /RV	0	A[27:22]# Value The use of these address bits during reset is reserved by the processor.	
21:17	RWS	0	Processor Core to Bus Clock Ratio A[21:17]# define the bus to core clock ratio for the Itanium 2 processor.	
16	RV	0	Reserved	
15	RWS	0	Request Bus Parking Enable If A[15]# is set, Itanium 2 processors may park on the system bus. This should not be set if FSBC.ASOEN is set.	
14:13	RWS /RV	0	Drive A[14:13]# The use of these address bits during reset is reserved.	
12:11	RWS	0	APIC Cluster ID This value is driven on A[12:11]#. It is easier for firmware to directly configure the APIC ID register than to set these bits and reset.	
10	RWS	0	Enable BINIT# Observation If set A[10]# will be asserted and All host bus agents will enable BINIT# observation logic.	
9	RWS	0	Enable BERR# Input If set, A[9]# will be asserted and all host bus agents will enable BERR# observation by the processors.	
8	RWS	0	Drive A[8]# If set, A[8]# will be asserted.	
7	RWS	0	In-order Queue Depth 1 If set, A[7]# will be asserted, and all agents on the host bus will limit their In-Order Queue Depth to 1.	
6	RWS	0	1 MEG Power-on Reset Vector If set, A[6]# will be asserted, and all agents on the host bus will begin fetching code below 1MB (000F_FFF0h) instead of below 4GB (00_FFFF_FF0h).	



Device: Function Offset:		eID (Continued)	
Bit	Attr	Default	Description
5:4	RWS /RV	0	Drive A[5:4]# The use of these address bits during reset is reserved by the processor.
3	RWS /RV	0	Drive A[3]# The use of these address bits during reset is reserved by the processor.
2:0	RV	0	Drive A[34:32]# The use of these address bits during reset is reserved by the processor.

3.8.3 CVCR: Configuration Values Captured on Reset

This register holds the values of A[31:3]# sampled. The sampled values are driven by the SNC according to the CVDR register. Whereas the CVDR register only affects the pins driven at reset, SNC operation is affected by some of the sampled values. The default values shown above represent the state of the register following a *power-good* reset.

Device: Functio Offset:	Node n: 0 48h	eID			
Bit	Attr	Default	Description		
31:28	RO	0	CPU Kill Captured from the A[31:28]# pins. When set, these bits indicate that the corresponding CPU has been disabled since the last reset. Software may use these bits to determine the number of working processors on the node. A[31]# Tristate Agent 6,7 A[30]# Tristate Agent 4,5 A[29]# Tristate Agent 2,3 A[28]# Tristate Agent 0,1		
27:22	RV	0	A[27:22]# Value Captured from A[27:22]#. The use of these address bits during reset is reserved.		
21:16	RO	0	Processor Core to Bus Clock Ratio This field is set to the values of A#[21:16] sampled on RESET#. Bits 21:17 define the bus to core clock ratio for the Itanium 2 processor. Bit 16 should not be set in the Itanium 2 processor-based systems. SNC operation is not affected by this field. The default value of 0 will select the lowest clock frequency so that any speed processor will be able to execute following PWRGD reset.		
15	RO	0	Request Bus Parking Enable Captured from A[15]#. This bit, when set, indicates that the Itanium 2 processors will park on the system bus. This bit should not be set if the FSBC.ASOEN is set. SNC operation is not affected by this bit.		
14:13	RO	0	A[14:13]# Value Captured from A[14:13]#. The use of these address bits during reset is reserved by the processor. SNC operation is not affected by this bit.		
12:11	RO	0	APIC Cluster ID Captured from A[12:11]#. This field represents the APIC Cluster identifier.		
10	RO	0	Enable BINIT# Input Captured from A[10]#. If set, the SNC will enable BINIT# logic.		



Device: Function Offset:	Function: 0				
Bit	Attr	Default	Description		
9	RO	0	Enable BERR# Input Captured from A[9]#. If set, the SNC will enable BERR# reporting.		
8	RO	0	A[8]# Value Captured from A[8]#. The use of these address bits during reset is reserved.		
7	RO	0	In-order Queue Depth 1 Captured from A[7]#. If set, the SNC will limit its In-Order Queue Depth to 1, instead of the usual 8.		
6	RO	0	1 MEG Power-on Reset Vector Captured from A[6]#. Indicates that all agents on the host bus will begin fetching code below 1MB (000F_FFF0h) instead of below 4GB (00_FFFF_FF0h).		
5:4	RO/ RV	0	A[5:4]# Value Captured from A[5:3]#. The use of these address bits during reset is reserved.		
3	RO/ RV	0	Capture A[3]# The use of these address bits during reset is reserved by the processor.		
2:0	RO/ RV	0	Capture A[34:32]# The use of these address bits during reset is reserved by the processor.		

3.8.4 SPAD: Scratch Pad

This register provides 32 bits of storage for power-on software usage before memory is configured. This register is used during the boot process and SP Hot-Plug. This register is also memory mapped. See Section 3.2, "SNC Fixed Memory Mapped Registers."

Device: NodelD Function: 0 Offset: C4h			
Bit	Attr	Default	Description
31:0	RW	0	Scratch pad value.

3.8.5 SPADS: Sticky Scratch Pad

This register provides 32 bits of sticky storage for power-on software usage before memory is configured. The content of this register remains sticky through reset. This regster is used during the boot process and SP Hot-Plug. This register is also memory mapped. See Section 3.2, "SNC Fixed Memory Mapped Registers."

Device: Function Offset:	Function: 0			
Bit	Attr	Default	Description	
31:0	RWS	0	Scratch pad value The contents of this register is sticky.	



3.8.6 BOFL: Boot Flag

This register is used to select boot strap CPU. The first time this register is read, it will return a non-zero signature. All reads thereafter will return 0s. This register can be re-initialized to the default value by the Boot Flag Reset bit in the **SYRE** register. This register is also memory mapped. See Section 3.2, "SNC Fixed Memory Mapped Registers."

Device: Function Offset:	Function: 0			
Bit	Attr Default Description			
31:8	RV	0	Reserved	
7:0	RO* (see Description)	A5h	Signature	

3.8.7 CBC: Chip Boot Configuration

This register is used to relocate E8870 chipset's configuration space to a different PCI bus. Information captured from the idle flits is valid only when the Idle detected bit in the SPINCO register is set. The default value may be overwritten with any value before becoming valid. The bus [7:0] may not be written to 0, which is reserved for the compatibility bus.

Device: NodeID Function: 2 Offset: 74h(31:0), 78h(63:32),7Ch(71:64)					
Bit	Attr	Default	Description		
95:79	RV	0	Reserved		
78	RO	CPUPRES Pin	CPU Present This bit reflects the state of the CPUPRES pin. 0 = No CPU is present on this node 1 = at least one CPU is present		
77	RW	0	Node Initialization Done When set, local node initialization is done by the node BSP.		
76:72	RW	NODEID Pins at Reset	Node ID [4:0] Those bits define the device number of this SNC. The default value is captured from the NODEID pins on the rising edge of RESETI#. This information is used for configuration accesses steering and to set fields in the SP packet. They are sent in the SP idle flits to connected components.		
71:67	RW	11111	Bus [7:3] The top five bits of this chip's configuration bus number. They are sent in the SP idle flits to connected components. This value should not be changed for E8870 chipset-based systems. This value may be overwritten if the SNC is used in other systems.		
66:64	RW	BUSID Pins at Reset	Bus [2:0] The lower three bits of this chip's configuration bus number. The default value is captured from the BUSID pins on the rising edge of RESETI#. See device mapping for details. They are sent in the SP idle flits to connected components.		
63:45	RV	0	Reserved		



Device: **NodelD** Function: 2 74h(31:0), 78h(63:32),7Ch(71:64) (Continued) Offset: **Default Description** SP1 Node ID [4:0] 44:40 RO 11111 Device # received from SP1's idle flits. SP1 Bus [7:0] 39:32 RO FFh Bus # received from SP1's idle flits. 31:16 RV 0 Reserved StopOnErr 0 - An agent will send idle or info flits when in RETRY_LOCAL_IDLE state. RWS 15 0 1 - If an agent has detected an error and has sent an LLRReq and its local retry state machine is in RETRY_LOCAL_IDLE state, then it should not send any info or idle flits and sends a Ctrl flit with LLRIdle. SndMultAck 0 - 0 or 1 ACK is sent in LCC[7] of idle flits. Byte D = 0. 14 **RWS** 0 1 - LCC[7] = 0. Up to 25 ACKs will be sent in Byte D[4:0] of idle flits. Idle flits are forced whenever there are multiple acks to RcvMultAck 0 - 0 or 1 ACK is extracted from LCC[7] of idle flits. 13 **RWS** 1 - Up to 25 ACKs may be extracted from idle flits. Ack[4:0] = LCC[7] || Byte D[4:0]. Any particular idle flit will use either LCC[7] or Byte D, but not both. SP0 Node ID [4:0] 11111 RO 12:8 Device number received from SP0's idle flits. SP0 Bus [7:0] 7:0 RO FFh Bus number received from SP0's idle flits.

3.8.8 SPC: Scalability Port Control Register

This register controls the SP cluster.

NodelD Device: Function: 2 Offset: 70h Bit Attr **Default Description** 31:1 RV 0 Reserved SPBS: Single Processor Bus System This bit should be set when the SNC is directly connected to an SIOH. The 0 RW SNC must order coherency operations according to the processor bus order, rather than rely on the SPS to provide ordering information.



3.8.9 FSBC: Processor Bus Control Register

Device: Function Offset:	Function: 0				
Bit	Attr	Default	Description		
15	RW	0	BERRINDIS: BERRIN# Disable If 0, SNC drives BERR# when BERRIN# is driven. If 1, SNC never drives BERR#.		
14:11	RV	0	Reserved		
10	RW	0	SST: Anti-Starvation Service Entry Threshold 0 = The "service entry threshold" is 1. The first retry issued by the SNC while in normal mode will be considered the "first retry" for service. 1 = The SNC will remain in watch mode until it retries a given agent 32 consecutive times.		
9	RW	0	FEATEN: Feature Space Enable This bit defines the value of A[22]# on the LPC/FWH interface. If set, A[22]# should be 0. If clear A[22]# should be 1. This bit must be set to allow access to 82802 Feature space to unlock blocks so flash can be modified.		
8	RW	0	16BEN: Enable 16-byte FWH Reads If set, the SNC will perform 16-byte FWH reads for processor reads to local firmware range with a length of 16 bytes or more. If this bit is cleared, all local firmware reads will be performed as single-byte reads.		
7:5	RV	0	Reserved		
4	RW	0	GSEQ# Drive Enable When set, the SNC may assert GSEQ#.		
3:0	RV	0	Reserved		

3.8.10 FWHSEL: FWH Device Select

This register defines how the SNC translates addresses to IDSEL field for FWH cycles. This register applies only to FWH devices. It has no effect if LPC flash devices are used.

Device: Function Offset:	Function: 0						
Bit	Attr	Default	Description				
31:28	RW	0	IDSEL for F8 Range IDSEL for the local firmware address range FFF8_0000h - FFFF_FFFFh.				
27:24	RW	0	IDSEL for F0 Range IDSEL for the local firmware address range FFF0_0000h - FFF7_FFFFh.				
23:20	RW	0	IDSEL for E8 Range IDSEL for the local firmware address range FFE8_0000h - FFEF_FFFFh.				
19:16	RW	0	IDSEL for E0 Range IDSEL for the local firmware address range FFE0_0000h - FFE7_FFFFh.				



Device: Functior Offset:		eID Continued)	
Bit	Bit Attr Default		Description
15:12	RW	0	IDSEL for D8 Range IDSEL for the local firmware address range FFD8_0000h - FFDF_FFFFh.
11:8	RW	0	IDSEL for D0 Range IDSEL for the local firmware address range FFD0_0000h - FFD7_FFFFh.
7:4	RW	0	IDSEL for C8 Range IDSEL for the local firmware address range FFC8_0000h - FFCF_FFFFh.
3:0	RW	0	IDSEL for C0 Range IDSEL for the local firmware address range FFC0_0000h - FFC7_FFFFh.

3.8.11 SNCINCO: SNC Interface Control

This register controls all the physical interfaces of the chip except SP.

Device: Function Offset:	Function: 0						
Bit	Attr	Default	Description				
15:8	RV	0	Reserved				
7	RW	0	Default SP All SNCs must have the same default switch network This bit affects SP request routing. SP0 is selected. SP1 is selected.				
6	RV	0	Reserved				
5	RWS	0	Disable Processor Bus Interface When set, this bit will tri-state all processor bus outputs and mask all inputs. Any snoop requests required by the SP should return clean responses.				
4	RO	0	LPCSEL Allows software to inspect the state of the LPCSEL strap pin. This strap pin defines the protocol of devices on the LPC/FWH interface. Use FWH protocol to access the flash devices. Use LPC protocol to access the flash devices.				
3:2	RV	1	LPC Clock Ratio Those bits determines the clock divide ratio of central clock vs. LPC clock. The initial central clock is assumed to be 200 MHz. Note: Writing this field has no effect. Only the 6:1 encoding is supported.				
1	RWS	0	LPCDIS: Disable LPC Interface Allows software to disable LPC/FWH interface. Table 3-7 defines the effect of this bit on the LPC/FWH interface.				
0	RO	0	LPCENPIN: LPC Strap Disable Allows software to inspect the state of the LPCEN strap pin. The polarity of this bit is inverted relative to the pin. Table 3-7 defines the effect of this bit on the LPC/FWH interface.				



Table 3-7. Enabling the LPC/FWH Interface

LPCEN Pin	SNCINCO Bit[0]: LPCENPIN	SNCINCO Bit[1]: LPCDIS	LPC
0	1	1	Tri-state all LPC outputs and mask all
0	1	0	inputs. All LPC traffic (accesses to BIOS/PAL/SAL and FWH feature space)
1	0	1	are routed to the SP.
1	0	0	LPC/FWH is enabled.

3.8.12 SP0INCO, SP1INCO: SP Interface Control

These registers are common across all E8870 chipset components, and they provide the control and status for each SP. Associated with each SP are two GPIO pins (GPIO[1:0]). These pins are open drain, and are observable and controllable from this register.

The SNC uses the **Enable_SP** field to override internal assignment of transactions to ports. A transaction targeted toward one SP will be re-routed to the other SP if the targeted SP is disabled. If neither of the SPs are enabled, all transactions sent to SP's are master-aborted.

	Device: NodeID Function:2 for SP0INCO, 3 for SP1INCO Offset: C0h					
Bit	Attr	Default	Description			
31:26	RWS	0	Scratch Bits These bits may be used by software to record information specific to this SP. For example, hot-plug sequencing history.			
25	RO	GPIO1	GPIO1 STATE This bit is used to monitor the state of the SPGPIO1 pin. 0 = GPIO1 pin is high (inactive) 1 = GPIO1 pin is low (active)			
24	RO	GPIO0	GPIO0 STATE This bit is used to monitor the state of the SPGPIO0 pin. 0 = GPIO0 pin is high (inactive) 1 = GPIO0 pin is low (active)			
23	RWS	0	GPIO1 EN This bit is used to control the state of the SPGPIO1 pin. 0 = Do not drive the GPIO1 pin (input only) 1 = Drive the GPIO1 pin low (open drain output)			
22	RWS	0	GPIO0 EN This bit is used to control the state of the SPGPIO0 pin. 0 = Do not drive the GPIO0 pin (input only) 1 = Drive the GPIO0 pin low (open drain output)			
21	RW	0	INT_OUT 0 = This port does not drive the INT_OUT# pin low. 1 = Drive the INT_OUT# pin low (open drain output)			
20:19	RO	0	SPAlign The value of this field reflects the staging delays through the scalability port input mux to frame the transfer of data from the SP source synchronous data transfer to the core clock of the component.			

Configuration Registers



Device: NodeID Function:2 for SP0INCO, 3 for SP1INCO Offset: C0h (Continued)

Offset:	C0h	(Continued)	
Bit	Attr	Default	Description
18:16	RWS	101	Response Credits Credits supported by this SP port on the response VC. Credit = 2 ^{size} except that when size >= 101, credit = 25 instead of 32. These bits are sent in the idle flits. Must be set to a value <= to 25 for reliable SP operation.
15:13	RWS	101	Request Credits Credit supported by this SP port on request VC. Credit = 2 ^{size} except that when size >= 101, credit = 25 instead of 32. These bits are sent in the idle flits. Must be set to a value <= 25 for reliable SP operation.
12	RW	0	Disable SP Link Level Retry (LLR) When set, this bit will disable link level retry on SP. Note: SP LLR is always disabled during framing/initialization.
11:9	RO	0	Connecting SP Response Credits Credits supported by the response VC of the device connected to this SP port. Credit = 2 ^{size} except that when size= 101, credit = 25 instead of 32. This field is captured and updated from the idle flits.
8:6	RO	0	Connecting SP Request Credits Credits supported by the request VC of the device connected to this SP port. Credit = 2 ^{size} except that when size = 101, credit = 25 instead of 32. This field is captured and updated from the idle flits.
5	RW	!LPCEN OR'ed !CPUPRES Pins	Enable SP 0 = The port is disabled. The outputs of the SP excluding SPSync are tristated. Deassertion will cause the port to deassert SPSync and enter initialization sequence. Disabling an SP should not be done with a configuration transaction from the same SP as the one being disabled. The configuration write will not complete. 1 = Enable SP output drivers. The port must complete initialization and framing before data can be transferred.
4	RO	0	Idle Flit Acknowledgment Detected Detected idle_ack from the idle flits received by this SP. This bit is cleared at the beginning of the initialization sequence.
3	RO	0	Idle Flit Detected Set during framing when 256 valid idle flits in a row are detected by the SP receiver. This bit is cleared at the beginning of the initialization sequence.
2	RW	0	Interrupt on SP Idle Flit State Change 1 = A 0->1 transition of the Idle-flit-detected bit in the above field will trigger an interrupt from this chip via INT_OUT#. 0 = Deassert the interrupt request controlled by this bit. The open drain interrupt pin (INT_OUT#) may remain asserted if other interrupt conditions exist. Note: The detection mechanism is initialized at the start of port framing only.
1	RO	SP_PRES	SP_PRES State This bit follows the SP_PRES pin associated with this SP. When deasserted, the output of the SP are tri-stated, and transactions targeting the SP are master-aborted.
0	RW	0	Interrupt on Pin SP_PRES State Change 1 = A 0->1 or 1->0 transition in the above field will trigger an interrupt from this chip (via INT_OUT#). 0 = Deassert the interrupt request controlled by this bit. The open drain interrupt pin (INT_OUT#) may remain asserted if other interrupt conditions exist.



3.9 Error Registers

3.9.1 ERRCOM: Error Command

This register enables error checking and flagging on various error conditions.

Device: Function Offset:	Function: 2					
Bit	Attr	Default	Description			
31:9	RV	0	Reserved			
8:4	RV	11111	Reserved			
3	RV	0	Reserved			
2	RW	0	FTLFRZ: Error Freeze on Fatal Error 0 = Normal operation. 1 = Disable processor and SP interfaces when a Fatal error is observed or signaled on the error pins.			
1	RW	0	NCOFRZ: Error Freeze Upon Non-correctable Error 0 = Normal operation. 1 = Disable processor and SP interfaces when a non-correctable error is observed or signaled on the error pins.			
0	RW	0	CORFRZ: Error Freeze Upon Recoverable Error 0 = Normal operation. 1 = Disable processor and SP interfaces when a correctable error is observed or signaled on the error pins.			

3.9.2 FERRST: First Error Status

Errors are classified into two basic types: fatal (or non-recoverable) and non-fatal (or recoverable). Non-fatal errors are further classified into correctable and non-correctable errors. First fatal and/or non-fatal errors are flagged in the FERRST register. At most, two errors can be reported by the FERRST; one for non-recoverable (or fatal) errors, one for recoverable (or uncorrectable and correctable) errors. If errors of the same type (non-recoverable or recoverable) are detected simultaneously, the error with the more significant bit is flagged.

Associated with some of the errors flagged in the FERRST register are control and data logs. When an error is detected by an SP, a field in the FERRST register identify which SP has the corresponding error log. Once a first error for a type of error has been flagged (and logged), the log registers for that error type remain fixed until either the bit associated with the error type in the FERRST is cleared or a power-up reset (See 8.2.1, *Power-up Reset Sequence*). Contents of the error logs are not reliable unless an error associated with the log is reported in FERRST.

When the first error of a type is detected (fatal, uncorrectable, correctable), the value of the error status pin associated with the error type is latched in the FERRST register.

See Chapter 6, "Reliability, Availability, and Serviceability" for detailed description of each error, the response, what is logged, and the name of the log register.

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Device: **NodelD** Function: 2 80h(31:0), 84h(63:32), 88h(96:64) Offset: **ERR** Default Bit Attr Description **Type** Last ERR[2]# Value If set, the ERR[2]# was asserted for four cycles before the SNC drives ERR[2]# for the first fatal error. This implies that some other component drove ERR[2]# first. If this bit is clear, but set in all other components, this component ROS 95 0 N/A drove ERR#[2] first. When all fatal bits are cleared in this register, ERR[2]# sampling is re-This bit does not get cleared automatically, but is cleared by writing a "1" to it. Last ERR[1]# Value If set, the ERR[1]# pin was asserted for four cycles before the SNC drives ERR[1]# for the first non-fatal error. This implies that some other component drove ERR[1]# first. If this bit is clear, but set in all other components, this component ROS 94 0 N/A drove ERR[1]# first. When all uncorrectable bits are cleared in this register, ERR[1]# sampling is re-enabled. This bit does not get cleared automatically, but is cleared by writing a "1" to it. Last ERR[0]# Value If set, the ERR[0]# pin was asserted for four cycles before the SNC drives ERR[0]# for the first non-fatal error. This implies that some other component drove ERR[0]# first. If this bit is clear, but set in all other components, this component 93 ROS 0 N/A drove ERR[0]# first. When all correctable bits are cleared in this register, ERR[0]# sampling is re-enabled. This bit does not get cleared automatically, but is cleared by writing a "1" to it. **Processor Bus Errors** 92 **RCS** Fatal F1: Illegal or Unsupported Transaction F2: Bus Protocol Error RCS Fatal 91 0 Set if the SNC observes HITM on explicit write-back. F3: BINIT# Observed 90 **RCS** 0 Fatal Set when the signal is asserted by any bus agent. F4: System Bus Address Parity Error **RCS** 89 0 Fatal The address may be corrupted, but if the request is without error, the SNC will complete the request. 88 **RCS** 0 Fatal F5:Bus Request Parity Error F6:Outbound Multi-Bit ECC Error Outbound Multi-Bit ECC Error on FWH write 87 **RCS** Unc 0 The SNC will generate poisoned ECC and forward to the SP, memory, or FWH bus. Section 6.1.1, "End-to-end Error Correction" describes the action taken at these interfaces. 86 RV 0 Unc Reserved



Device: NodeID Function: 2 Offset: 80h(31:0), 84h(63:32), 88h(96:64) (Continued)					
Bit	Attr	Default	ERR Type	Description	
Process	or Bus E	rrors (Con	itinued)		
85	RCS	0	Unc	F8:BERR# Observed	
				Set when the signal is asserted but not driven by the SNC. F9:Partial Merge Multi-Bit ECC error on IWB	
84	RCS	0	Unc	A multi-bit error was detected when merging a partial memory write with the rest of the line supplied by IWB. The write must be less than 8 bytes and the error must have been in that 8-byte boundary. The error may have been in the initiator supplied data or the IWB. ECC checking, correction and/or poisoning is done within the 8-byte boundary of the partial write.	
83	RCS	0	Corr	F10:Outbound Single-Bit ECC Error Error in data from processor bus.	
82	RV	0	Corr	Reserved	
81	RCS	0	Corr	F12:Illegal Outbound Address MIR miss when SPBS=1, SPS not connected.	
				F13:Partial Merge Single-Bit ECC Error on IWB	
80	RCS	0	Corr	A single-bit error was detected when merging a partial memory write with the rest of the line supplied by IWB. The write must be less than 8 bytes and the error must have been in that 8-byte boundary. The error may have been in the initiator supplied data or the IWB. ECC checking, correction and/or poisoning is done within the 8B boundary of the partial write.	
LPC Erro	ors				
79	RCS	0	Fatal	L1: LPC SYNC LPD slave device indicates error of sync/response handshake in error.	
78	RCS	0	Corr	L2: LPC Time-out Set if no LPC/FWH device drives a valid SYNC after four consecutive clocks.	
Memory	Errors			,	
77:40	RV	0	N/A	Reserved	
				M1: Multi-Bit Memory ECC Error on Write	
39	RCS	0	Unc	The SNC has poisoned the 32-byte memory ECC codeword that contains the error and written the data to memory. See Section 5.2, "Error Correction."	
38	RCS	0	Unc	M2: Uncorrectable Memory ECC Error on Read For confirmed memory reads, the SNC has returned data with poisoned SEC/DED ECC to the processor bus or SP. All four of the 8-byte SEC/DED codewords that came from the Memory ECC codeword in error will be poisoned. For this reason, both FERRST and SERRST register bits will be set in any component that detects the poisoned SEC/DED codewords. If the memory read was speculative, and never confirmed, the data will have been discarded and no other errors indicated. If the memory read is part of the read-modify write for a partial write, the 32-byte memory ECC codeword that contains the error is poisoned when the data is written to memory. Section 5.2, "Error Correction."	

Configuration Registers



Device: **NodelD** Function: 80h(31:0), 84h(63:32), 88h(96:64) (Continued) Offset: **ERR** Bit Default Description **Type Memory Errors (Continued)** M3: Uncorrectable Memory ECC Error on Memory Scrub The SNC has poisoned the Memory ECC codeword that contained 37 **RCS** 0 Unc the error and written the data back to memory. See Section 5.2, "Error Correction.' M4: Partial Merge Multi-Bit Data ECC Error A multi-bit error was detected when merging a partial memory write with the rest of the line read from memory. The write must be less 36 **RCS** 0 Unc than 8 bytes and the error must be in that 8-byte boundary. The error may be in the initiator supplied data. The 32-byte Memory ECC codeword that contains the error is poisoned when the data is written to memory. RV Corr 35 0 Reserved M6: Single-Bit Memory ECC Error on Write 34 **RCS** 0 Corr The SNC has corrected the error and generated valid chipset Memory ECC for the data in memory. M7: Correctable Memory ECC Error on Read or Memory Scrub For memory reads, the SNC has returned corrected data with 33 **RCS** Corr O SEC/DED ECC to the processor bus or SP. For Scrubs, the SNC has corrected the error and generated valid chipset Memory ECC for the data in memory. M8: Partial Merge Single-Bit DATA ECC Error A single-bit error was detected when merging a partial memory write with the rest of the line read from memory. The write must be less 32 RCS 0 Corr than 8 bytes and the error must be in that 8-byte boundary. The error may be in the initiator supplied data or the read data. The SNC has corrected the error and generated valid chipset Memory ECC for the data in memory. **Scalability Port Physical Layer Errors** 31:24 RVN/A Reserved **SPL Fatal Error Pointer** If an SPL has reported the first fatal error, this field indicates which 23 ROS 0 N/A scalability port has reported the error. 0 = Scalability Port 0 1 = Scalability Port 1 **SPL Uncorrectable Error Pointer** If an SPL has reported the first non-fatal error and the error is an 22 ROS 0 N/A uncorrectable error, this field indicates which SP has reported the **SPL Correctable Error Pointer** 21 ROS 0 N/A If an SPL has reported the first non-fatal error and the error is a correctable error, this field indicates which SP has reported the error. S1: Link Error 20 **RCS** 0 Fatal A parity error was detected in an incoming flit and Link Level Retry was disabled or the maximum number of retries was exceeded.



Device: Function Offset:	Function: 2					
Bit	Attr	Default	ERR Type	Description		
Scalabil	ity Port P	hysical La	yer Error	s (Continued)		
				S2: SP Multi-Bit Data ECC Error		
19	RCS	0	Unc	An uncorrectable ECC error was detected in data on an incoming flit. The uncorrected data will be passed to the processor bus, memory interface or configuration space. Section 6.1.1, "End-to-end Error Correction" describes the action taken at these interfaces.		
				S3: Idle Flit Duplication Error		
18	RCS	0	Corr	When a link is not carrying requests or responses, it is sending an idle pattern. This bit is set when an error is detected in the pattern. It is an indication of signaling problems on the link, but no information is lost.		
				S4: Parity Error on the Link		
17	RCS	0	Corr	A parity error was detected in an incoming flit. If the Link Error bit is not also set, Link Level Retry is in progress or has succeeded.		
				S5: SP Single-Bit Data ECC Error		
16	RCS	0	Corr	An correctable ECC error was detected in data on an incoming flit. It is not corrected at this point, but passed to the processor bus, memory interface or configuration space. Section 6.1.1, "End-to-end Error Correction" describes the action taken at these interfaces.		
Scalabil	ity Port P	rotocol La	yer Error	s		
15:10	RV	0	NA	Reserved		
9	RCS	0	Fatal	P1: SP Protocol Error		
D	ROS	U	Гаца	Log request header.		
8	RV	0	NA	Reserved		
7	RCS	0	Fatal	P3: Received Failed or Unexpected Unsupported SP Request Response Status		
				P5: Strayed Transactions		
6	RCS	0	Fatal	Set when strayed transactions (responses with no matching requests) are detected by the cluster.		
5	RCS	0	Unc	P6: Partial Merge Multi-Bit Data ECC Error		
	1100	Ů	0110	Set when a multi-bit ECC error is detected on a remote partial write.		
4	RCS	0	Corr	P9: Partial Merge Single-Bit Data ECC Error		
				Set when a single-bit ECC error is detected on a remote partial write.		
				P8: Illegal SP Address Error		
3	RCS	0	Corr	This includes access to SP port that is disabled or inoperative, inbound SP requests with illegal attributes. See Section 4.5.3, "Scalability Port Requests."		
				P10: Received Master Abort Response		
				The SNC received a Response with status = "master abort." The SNC will complete processor reads with all 1's and drop any state associated with writes.		
2	RCS	0	Corr	If the response type in the RECSPP is PSNRM, the error should be considered fatal rather than correctable. This response cannot be generated by working hardware. After receiving this response, the SNC does not guarantee continued operation.		
				If a request was generated to an inoperative or disabled SP port, the SNC may have generated the master abort internally.		



Device: Function Offset:	Function: 2						
Bit	t Attr Default ERR Type Description						
Configur	ation Ac	cess Erro	rs				
1	RCS	0	Fatal	C1: Multi-Bit Data ECC Error on Configuration Write The SNC will complete the configuration write on all interfaces, but not perform the register write.			
0	RCS	0	Corr	C2: Single-Bit Data ECC Error on Configuration Write The SNC will correct the error and perform the register write.			

3.9.3 SERRST: Second Error Status

This register is used to report subsequent fatal and non-fatal errors. Multiple bits can be set in this register. This register has the same format as register **FERRST**.

	Device: NodelD Function: 2 Offset:8Ch(31:0), 90h(63:32), 94h(95:64)							
Bit	Attr	Default	Description					
95:93	RV	0	Reserved					
92:78	RCS	0	See register FERRST for the definition of each bit.					
77:40	RV	0	Reserved					
39:32	RCS	0	See register FERRST for the definition of each bit.					
31:24	RV	0	Reserved					
23:16	RCS	0	See register FERRST for the definition of each bit.					
15:10	RV	0	Reserved					
9:0	RCS	0	See register FERRST for the definition of each bit.					

3.9.4 ERRMASK: ERRST MASK

The bit assignments of this register matches the format of FERRST register. Each bit in this register will mask the corresponding bit in FERRST and SERRST. "Mask" here means that while the corresponding bit in FERRST or SERRST register can still be set or cleared, but does not trigger assertions on ERR pins. The default value is set so that no error is signalled after reset. This prevents a cycle in which an error detected before this register can be written causes system logic to assert RESETI#, restarting the sequence that caused the error which causes RESETI#.

	Device: NodelD Function: 2 Offset:98h(31:0), 9Ch(63:32), A0h(71:64)					
Bit	Attr	Default	Description			
95:93	RV	0	Reserved			
92:78	RW	1	0 = no effect. 1 = mask the corresponding bit in FERRST and SERRST.			



Device: NodeID Function: 2 Offset:98h(31:0), 9Ch(63:32), A0h(71:64) (Continued)					
Bit	Bit Attr Default Description				
77:40	RV	0	Reserved		
39:32	RW	1	0 = no effect. 1 = mask the corresponding bit in FERRST and SERRST.		
31:21	RV	0	Reserved		
20:16	RW	1	0 = no effect. 1 = mask the corresponding bit in FERRST and SERRST.		
15:10	RV	0	Reserved		
9:0	RW	1	0 = no effect. 1 = mask the corresponding bit in FERRST and SERRST.		

3.9.5 RECFSB: Recoverable Error Control Information of Processor Bus

This register latches control information in the response phase of the first non-fatal processor bus error detected by the SNC. For LPC time-out errors, only the address, write, and read fields will be logged. The contents of this register is only valid when one of the errors that set this register is logged in the FERRST register.

Device: Functio Offset:	Function: 0				
Bit	Attr	Default	Description		
95:77	RV	0	Reserved		
76	ROS	0	SNC initiated this transaction		
75	ROS	0	Write		
74	ROS	0	Read		
73	ROS	0	Special transaction		
72	ROS	0	Clean Line Replace		
71	ROS	0	Purge Translation Cache		
70	ROS	0	Bus Invalidate Line		
69	ROS	0	SNC deferred		
68	ROS	0	SNC asserted GSEQ.		
67	ROS	0	Received HITM Snoop Result.		
66	ROS	0	SNC issued Hardfail Response.		
65	ROS	0	SNC issued Deferred Response.		
64	ROS	0	SNC issued No Data Response.		
63	ROS	0	SNC issued Retry Response.		
62:60	ROS	0	Data length.		
59:52	ROS	0	Byte enables.		
51	ROS	0	SNC will assert TRDY#.		



Device: NodeID Function: 0 Offset: CCh(31:0), D0h(63:32), D4h(95:64) (Continued)					
Bit	Attr	Default	Description		
50:41	ROS	0	Defer ID.		
40:0	RWS/ ROS	0	A[43:3]: This field is used for address logging and is not writable. For non-coherent and I/O write transactions on the SP, this address is the same as the one in the SP request packet. A[6:3]#, A[5:3]#, A[4:3]#, or A[3]# may be zeroed to satisfy burst ordering requirements.		

3.9.6 NRECFSB: Non-recoverable Error Control Information of Processor Bus

This register latches the control information for the first fatal processor bus error detected by the SNC. For LPC synch errors, only the address, write, and read fields will be logged. This register is not valid until 10 cycles after the response phase of the transaction logged. The contents of this register is only valid when one of the errors that set this register is logged in the FERRST register.

Device: NodeID Function: 0 Offset: DCh(31:0), E0h(63:32), E4h(95:64)					
Bit	Attr	Default	Description		
95:77	RV	0	Reserved		
76	ROS	0	SNC initiated this transaction		
75	ROS	0	Write		
74	ROS	0	Read		
73	ROS	0	Special transaction		
72	ROS	0	CLR		
71	ROS	0	Purge TC		
70	ROS	0	BIL		
69	ROS	0	SNC deferred		
68	ROS	0	SNC asserted GSEQ		
67	ROS	0	Received HITM Snoop Result		
66	ROS	0	SNC issued Hardfail Response		
65	ROS	0	SNC issued Deferred Response.		
64	ROS	0	SNC issued No Data Response.		
63	ROS	0	SNC issued Retry Response.		
62:60	ROS	0	Data length.		
59:52	ROS	0	Byte enables.		
51	ROS	0	SNC will assert TRDY#.		



Device: NodeID Function: 0 Offset: DCh(31:0), E0h(63:32), E4h(95:64) (Continued)				
Bit	Attr	Default	Description	
50:41	ROS	0	DID[9:0].	
40:0	RWS/ ROS	0	A[43:3]: This field is used for address logging and is not writable. For non-coherent and I/O write transactions on the SP, this address is the same as the one in the SP request packet. A[6:3]#, A[5:3]#, A[4:3]#, or A[3]# may be zeroed to satisfy burst ordering requirements.	

3.9.7 RECSPP: Recoverable Error Control Information of SPP

This register latches control information for the first non-fatal error detected in the scalability port protocol layer and configuration accesses. The contents of this register is only valid when one of the errors that set this register is logged in the FERRST register.

Function	Device: NodelD Function: 2 Offset: 40h(31:0), 44h(63:32)			
Bit	Attr	Default	Description	
63:0	ROS	0	SP request/response header or internal request/response header.	

3.9.8 NRECSPP: Non-recoverable Error Control Information of SPP

This register latches control information for the first fatal error detected in the scalability port protocol layer and configuration accesses. The contents of this register is only valid when one of the errors that sets this register is logged in the FERRST register. Not all errors have logs (See Table 6-1 "Intel® E8870 Chipset Errors").

	Function: 2				
Bit	Attr	Default	Description		
63:0	ROS	0	SP request/response header or internal request/response header.		

3.9.9 RED: Non-Fatal Error Data Log

This register latches information for the first data error detected by the SNC that is not an SP physical layer or memory read error. See Section 6.5, "Chipset Error Record" for a listing of the errors that use this log.

The contents of this register is only valid when one of the errors that set this register is logged in the FERRST register. The contents of this register is defined 10 clocks after the error is detected, and is not changed until the bit is cleared from the FERRST register.



Device: NodelD Function: 2 Offset: 50h(31:0), 54h(63:32),58h(71:64)				
Bit	Attr	Default	Description	
71:64	ROS	0	DEP[7:0]	
63:0	ROS	0	D[63:0] Data in error. This could be the upper half or the lower half of the data bus.	

3.9.10 REDSPL[1:0]: SP Non-fatal Error Data Log

This register latches Syndrome and ECC information for the first ECC error detected on incoming SP data. See Section 6.5, "Chipset Error Record" for a listing of the errors that use this log.

The contents of this register is only valid when one of the errors that set this register is logged in the FERRST register. The contents of this register is defined 10 clocks after the error is detected, and is not changed until the bit is cleared from the FERRST register.

Device: NodelD Function: 2 (REDSLP0), 3(REDSPL1) Offset: CCh				
Bit	Attr	Default	Description	
15:8	ROS	0	Syndrome This field is the calculated syndrome. This field points to the error type (multi or single bit) and the data bit in error for single-bit errors.	
7:0	ROS	0	ECC This field is the ECC packet received on the SP for the flit in error.	

3.9.11 RECSPL[1:0]: Recoverable Error Control Information of SP[1:0]

This register latches the control information for the first non-fatal error detected by the physical layers of Scalability Ports 0 and 1. The contents of this register is only valid when one of the errors that set this register is logged in the FERRST register.

Device: NodelD Function: 2(SP0), 3(SP1) Offset: C4h(31:0), C8h(63:32)					
Bit	t Attr Default Description				
63:0	ROS	0	SP request/response header or SP PHIT#, PHIT parity and PHIT, SP LLR retry counts.		



3.9.12 RECMEM: Recoverable Error Control Information of Memory

This register latches control information for the first non-fatal memory error detected by the SNC. The address of the error can be inferred from the MIR and MIT register settings. The contents of this register is only valid when one of the errors that set this register is logged in the FERRST register.

Device: Function Offset:	Function: 1			
Bit	Attr	Default	Description	
63:40	RV	0	Reserved	
39	ROS	0	Channel This identifies one of the two DDR channels on each DMH on which the error occurred.	
38:34	ROS	0	Device This identifies the DIMM selected by each DMH in which the error occurred	
33:28	ROS	0	Bank	
27:13	ROS	0	Row See Table 5-4, "Bits Used in MCP Packet for Different DDR Technologies."	
12:0	ROS	0	Column See "Fixed Field" in Section 5.3.2.5, "DDR Address Bit Mapping." CA[10] is always set to indicate auto-precharge.	

3.9.13 REDMEM: Memory Read Data Error Log

This register latches data information for the first memory read error detected by the SNC. The contents of this register must be valid when a memory read or scrub error is logged in the FERRST. The contents of this register is defined 10 clocks after the error is detected, and is not changed until the bit is cleared from the FERRST register.

The code used to protect memory is the Server ECC code described in Section 5.2.4, "Memory Error Correction Code."

Device: NodeID Function: 1 Offset:D4h(31:0), D8h(63:32), DCh(95:66)			
Bit	Attr	Default	Description
95:66	RV	0	Reserved
65:64	ROS	0	Checkword Identifies the checkword in error. Table 3-8 defines the encodings. The SNC transfers critical 64-bytes first, so the half of the cacheline containing the requested address will be in the first transfer.



Device: NodeID Function: 1 Offset:D4h(31:0), D8h(63:32), DCh(95:66) (Continued)			
Bit	Attr	Default	Description
			Syndrome
63:32	ROS	0	The bit in error can be calculated from this field and the Locator field. Section 5.2.4, "Memory Error Correction Code" describes the H matrix used for this calculation.
31:0	ROS	0	Locator The Server ECC Locator which identifies the symbol in error for correctable errors. Exactly one bit should be set if the error is correctable. Bit Symbol 0 RAMBUSO, Symbol A 1 RAMBUSO, Symbol B 2 RAMBUSO, Symbol C 7 RAMBUSO, Symbol H 8 RAMBUS1, Symbol A 31 RAMBUS3, Symbol H

Table 3-8. Checkword Encoding

Checkword	SNC
00	First checkword in first transfer.
01	Second checkword in first transfer.
10	First checkword in second transfer.
11	Second checkword in second transfer.

3.10 Performance Monitoring Registers

3.10.1 PERFCON: Performance Monitor Master Control

The PERFCON register is a global register used to indicate event status of the performance counter logic in the component and provides global control of the counters. Event count status bits are cleared via the associated PMR register for the counter, or by starting a new sample. PERFCON also provides the ability to control the EV pins from the SNC. The event pins are bidirectional open drain signals, so that any component or external test device can drive the pin active (low state). These pins may be connected to interrupts within the system. A usage model for the event pins is for one event pin (EV0) to be used as the control to start and stop the sample interval, and another event pin (EV1) to be used to report overflow or max count compare status, for all enabled counters throughout the E8870 chipset-based system.



Device: NodelD Function: 3 Offset: 50h

Offset:	50h		
Bit	Attr	Default	Description
15:10	RV	0	Reserved
9	RO	0	SPPM Count Status The OR of both Event Status bits reported by either SPPM module for an overflow or max comparison condition, i.e., SPPMR[0].EventStatus[0] OR SPPMR[0].EventStatus[1] OR SPPMR[1].EventStatus[0] OR SPPMR[1].EventStatus[1] The status condition can be cleared by writing zeros to the Event Status field of the affected PMR register.
8	RO	0	FSBPM Count Status The OR of both Event Status bits reported by either FSBPM module for an overflow or max comparison condition, i.e., FSBPMR[0].EventStatus[0] OR FSBPMR[0].EventStatus[1] OR FSBPMR[1].EventStatus[0] OR FSBPMR[1].EventStatus[1] The status condition can be cleared by writing zeros to the Event Status field of the affected PMR register.
7	RO	0	Hot Page Status Status reported by Hot Page (see HPPMR) module for a timer completion or max comparison condition. HPPMR[0].Max Count Compare Status OR HPPMR[0].Timer Completion Status OR HPPMR[1].Max Count Compare Status OR HPPMR[1].Timer Completion Status The status condition can be cleared by writing zeros to the Max Count Compare Status field and the TimerCompletion Status field of the HPPMR register.
6	RO	0	Timer Completion Status This is a duplication of the Timer Completion Status bit of the PTCTL register. It is cleared by writing a'0' to the Timer Completion Status bit in the PTCTL register.
5:2	RW	0	EV[3:0]# Control A'1' will activate the associated event signal, and '0' will inactivate the signal. When using the Interval Timer this field must be set to the inactive state "0000". xxx1 Drives EV[0]# event signal active x1x Drives EV[1]# event signal active x1xx Drives EV[2]# event signal active 1xxx Drives EV[3]# event signal active.



	Device: NodeID Function: 3 Offset: 50h (Continued)				
Bit	Attr	Default	Description		
1	RW	0	Local Count Enable Setting this bit to a '1' will enable any counter on this component which has "local count enable" assigned as the enable source in the CE_Src field of its individual PMR register. Writing a '0' to this bit will disable the counters. Note: When using the Interval Timer this field must be set to '0'.		
0	RW	0	Reset Setting this bit to a '1' will reset all perfmon registers in this component to the default state. This includes timer registers, hotpage registers, and PM module registers. This bit is automatically cleared to '0' by hardware after the registers are reset. Note: This register is not affected.		

3.10.2 PTCTL: Timer Control

The countdown timer can be used to control the sample interval for the SNC, as well as throughout the chipset. The timer can be programmed to assert an EV pin when active (see **Timer Control Output** field), and counters in the chipset can be programmed to be enabled on the same EV pin. This type of control allows fine-grained sampling (at levels that cannot be accomplished by a software-only control).

The timer can also be placed in a repetitive mode where the sample interval is repeated (until the timer is disabled). This feature is used in conjunction with the max-compare (CMP) capabilities in the event modules provides the capability of gathering data on event frequencies over discrete time intervals.

The timer can be set to increment for each clock, or a multiple of clock periods (see **Timer Prescale** field). The maximum increment is 128 cycles, providing a total timer period of approximately 40 minutes.

Device: NodelD Function: 3 Offset: 52h			
Bit	Attr	Default	Description
15	RW	0	Timer Status Output Enable 1 = Enable Timer Status Output as defined in bits 5:4 of this register.
14	RV	0	Reserved
13:11	RW	0	Timer Disable Source This field selects a source to disable the interval timer. The "Timer Enable" control (bit 0) and "Repetitive Mode" control (bit 7) will be disabled if the selected signal is activated. The activation of the selected signal will disable the interval timer, i.e. the control is edge sensitive. OOO No disable source OO1 Any local counter status condition on this component O10 GE0 (Global DFT/Debug Event 0) O11 GE1 (Global DFT/Debug Event 1) 100 EV[0]# 101 EV[1]# 110 EV[2]# 111 EV[3]#



Device: NodelD Function: 3

Bit	Attr	Default	Description
10:8	RW	0	Timer Prescale This field determines the rate at which the timer will count in terms of the SNC internal clock. 000 1x 001 2x 010 4x 011 8x 100 16x 101 32x 110 64x 111 128x
7	RW	0	Repetitive Mode Setting this bit to '1' enables the interval timer repetitive mode. In the repetitive mode, when the interval timer completes a time interval, it automatically restarts another time interval after a delay of 12 clocks. This is repeated continuously until this bit is cleared to a '0' or a signal selected by the Timer Disable Source field becomes active, which will clear this bit to a '0'. The interval timer is loaded with the contents of the PMINIT register at the start of each time interval. Timer Completion Status is not reported nor is the Timer Enable bit cleared in repetitive mode when the interval timer completes a time interval.
6	RW	0	Timer Completion Status 0 - Timer sample period not complete or is inactive 1 - Timer sample period complete This bit is sticky in that once the timer completion occurs, it remains active until it is cleared by writing a'0' to this bit, or when another time interval is started by setting the Timer Enable bit in this register. This timer status is also visible in the PERFCON register.
5:4	RW	0	Timer Status Output When not in repetitive mode, timer completion status is reported in PERFCON. In addition, timer completion status can be driven on an event pin. The "Timer Status Output Enable" control in bit 15 of this register must be set, otherwise no event pins will be driven. 00 - timer completion status driven on EV[0]# 01 - timer completion status driven on EV[1]# 10 - timer completion status driven on EV[2]# 11 - timer completion status driven on EV[3]#
3:1	RW	0	Timer Control Output This field selects how the Interval Timer controls the enables to the counters. When the timer is > 0 and the timer is enabled, this field allows the timer to control the EV pins or the "local count enable." The PERFCON register is not used for control when using the timer. 000 "Local Count Enable" active when "Timer Enable" and Timer value > 0 001 Reserved 010 Reserved 011 Reserved 100 EV[0]# active when "Timer Enable" and Timer value > 0 101 EV[1]# active when "Timer Enable" and Timer value > 0 101 EV[2]# active when "Timer Enable" and Timer value > 0 110 EV[3]# active when "Timer Enable" and Timer value > 0 111 EV[3]# active when "Timer Enable" and Timer value > 0
0	RW	0	Timer Enable This bit is set to enable the counter. This is cleared by hardware when the contents of the timer underflows and repetitive mode is disabled. In repetitive mode, software must clear this bit to disable counting.



3.10.3 PMINIT: Timer Initial Value Register

The contents of this register is preloaded into the Interval Timer at the start of each sample period. A sample period is initiated by setting the Timer Enable bit in the PTCTL register or is automatically re-initiated in the repetitive mode after the completion of each sample interval.

Device: I Function Offset:			
Bit	Attr	Default	Description
31:0	RW	FFFF_FFFFh	Initial value of the Countdown Timer This value is loaded when the contents of the timer is 0 and the timer is enabled. This field, together with the PTCTL Timer Prescale field define the sample interval.

3.10.4 PMTIM: Timer Current Value

This is the value of the Interval Timer. After reset, it will have a value of FFFF_FFFFh, and after a timer sample interval has expired, it will have a value of 0000_0000h. The actual count value of the timer is reflected in this register during the sample interval.

Device: NodelD Function: 3 Offset: 58h			
Bit	Attr	Default	Description
31:0	RO	FFFF_FFFFh	Current Value of the Countdown Timer.

3.10.5 FSBPMD[1:0]: Processor Bus Performance Monitor Data

This is the performance monitor counter. The overflow bit can be cleared via the PMR register without perturbing the value of the counter. This counter is reset at the beginning of a sample period unless preloaded since a prior sample. Therefore, the counter can be preloaded to cause an early overflow, otherwise it will be reset at the start of a sample period.

Device: NodeID Function: 3 Offset: A8h (FSBPMD0), E8h(FSBPMD1)			
Bit	Attr	Default	Description
31	RW	0	Overflow.
30:0	RW	0	Current Counter Value.

3.10.6 FSBPMC[1:0]: Processor Bus Performance Compare

The compare register can be used in three different ways as selected in the "Compare Mode" field of the PMR register. First, when PMD is incremented, the value of PMD is compared to the value of PMC. If PMD is greater than PMC, this status is reflected in the PERFCON register and/or on EV pins as selected in the "Event Status Output" field of the PMR register. Secondly, update the PMC register with the value of PMD if the PMD register exceeds the contents of PMC.



Note: For these first two methods, bit 31 of the PMC should typically be set to 0. The comparison does include bit 31 (overflow) of the PMD counter, but since the overflow sets the counter status, a subsequent comparison will not affect the status condition.

The third mode is an address comparison mode. PMD0 compares on addresses greater than the PMC0 register and PMD1 compares on addresses less than or equal to PMC1. The "AND" of these two comparisons is the address range comparison and qualifies the other match event conditions for both counters. Note that the contents of PMC is compared to A[38:7]#.

Device: NodelD Function: 3 Offset: A4h (FSBPMC0), E4h(FSBPMC1)			
Bit	Attr	Default	Description
31:0	RW	FFFF_FFFFh	Counter Compare Value.

3.10.7 FSBPMR[1:0]: Processor Bus Performance Monitor Response

The PMR register controls operation of its associated counter, and provides overflow or max compare status information.

Device: NodelD Function: 3 Offset: A0h (FSBPMR0), E0h(FSBPMR1)						
Bit	Bit Attr Default Description					
31:26	RV	0	Reserved			
25:24	RW	0	Event Group Selection Selects which PME register to use for event decodes 00 - Bus events (FSBPMEH and FSBPMEL registers) 01 - Resource events (FSBPMER register) 10 - Resource utilizations (FSBPMEU register) 11 - Reserved			

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Device: NodelD Function: 3 Offset: A0h (FSBPMR0), E0h(FSBPMR1) (Continued)

Bit	Attr	Default	Description
			Compare Mode
			This field defines how the PMC (compare) register is to be used.
			00 - Compare mode disabled (PMC register not used)
			01 - Max compare only: The PMC register value is compared with the counter value. If the counter value is greater, the Count Compare Status (bit 13) of the "Event Status" field of this register will be set.
			Note: Bit 31 of the PMC should typically be set to '0'. The comparison does include bit 31 (overflow) of the PMD counter, but since the overflow sets the counter status, a subsequent comparison will not affect the status condition.
23:22	RW	0	10 - Max compare with update of PMC at end of sample: The PMC register value is compared with the counter value, and if the counter value is greater, the PMC register is updated with the counter value.
23.22	KVV		Note: The Event Status field is not_affected in this mode. Bit 31 of the PMC should typically be set to '0'. The comparison does include bit 31 (overflow) of the PMD counter, but since the overflow sets the counter status, a subsequent comparison will not affect the status condition.
			11 - Address compare mode where the PMC register is compared with the address field. Counter 0 of a counter pair will compare on an address greater than the register, and counter 1 will compare on an address equal to or lesser than the register (inverse of greater than). When both comparisons are valid, an address range comparison qualification is generated. This mode will cause the results of the address range comparison to be AND'ed with the event qualification specified in the selected PME register of each counter. The Event Status field is not_affected in this mode.
			Note: Address comparison range is A[38:7]#.
		0	Reset Event Select
			Counter and event status will reset and counting will continue.
			Note: Delay from an event causing an EV pin activation until reset of the counter is 13 clocks.
			000 - No reset condition
	RW		001 - Partner event status: When the partner counter causes an event status condition to be activated, either by a counter overflow or max comparison,
21:19			then this counter will reset and continue counting.
			010 - Partner PME register event: When the partner counter detects a match
			condition which meets its selected PME register qualifications, then this counter will reset and continue counting.
			011 Reserved
			100 EV[0]# 101 EV[1]#
			101
			111 EV[3]#
18:16			Count Event Select
			Selects the condition for incrementing the performance monitor counter.
			000 PME register event 001 Partner event status (max compare or overflow)
	RW	0	010 All clocks when enabled
			011 Reserved
			100 EV[0]# 101 EV[1]#
			110 EV[2]#
			111 EV[3]#



Device: NodeID
Function: 3
Offset: A0h (FSBPMR0), E0h(FSBPMR1) (Continued)

D:4	A 44	Dofoult	Deceriation
Bit	Attr	Default	Description
			Count Mode
			00 - Count event selected by Count Event Select field.
			01 - Count clocks after event selected by Count Event Select field.
15:14	RW	0	10 - Count transaction length, in quad words, of event defined by the Bus Events PME registers (FSBPMEL and FSBPMEH.)
			Note: The Count Event field and Event Group Selection fields should select the Bus Events PME registers. 11 - Reserved
			Event Status
			This status bit captures an overflow or count compare event. The Event Status Output field can be programmed to allow this bit to be driven to an external event pin.
			00 - No event
40.40	DW		x1 - Overflow – The PMD counter overflow status. (Write'0' or start an interval to clear.)
13:12	RW	0	1x - Count compare – PMD counter greater than PMC register when in compare mode. (Write'0' or start an interval to clear.)
			This bit is sticky in that once an event is reported the status remains even though the original condition is no longer valid. This bit can be cleared by software or by starting a sample. Event status is always visible in the PERFCON register, except if "Event Status Output" field is in cascade mode.
			Note: If in address compare mode (compare mode = 11), the count compare bit is not activated.
			Event Status Output
		0	This field selects where the event status is reported.
11:9	RW		000 Event status reported only in PERFCON register (address comparison not reported) 001 Cascade mode, status not reported 100 Event status or address comparison in PERFCON and on EV[0]# pin 101 Event status or address comparison in PERFCON and on EV[1]# pin 110 Event status or address comparison in PERFCON and on EV[2]# pin 111 Event status or address comparison in PERFCON and on EV[3]# pin
			CD_Src: Counter Disable Source
			These bits control which input disables the counter.
8:5	RW	w 0	Note: If the "Enable Source" is inactive counting is also disabled. (Delay from an event causing an EV pin activation until disable of the counter is 13 clocks.)
			1xxx EV[3]# pin x1xx EV[2]# pin xx1x EV[1]# pin xxx1 EV[0]# pin
			CE_Src: Counter Enable Source
4:2		RW 0	These bits identify which input enables the counter. Default value disables counting. 000 Disabled
	RW		001 PERFCON local_count_enable field 010 Partner event status (max compare, overflow, cascade) 011 Reserved 100 EV[0]# pin 101 EV[1]# pin 110 EV[2]# pin 111 EV[3]# pin



Device: NodeID Function: 3 Offset: A0h (FSBPMR0), E0h(FSBPMR1) (Continued) Default **Description Clear Overflow** This bit clears overflow bit in associated PMD counter. The counters RW 0 continues counting. This bit is cleared by hardware when the operation is complete. Reset Setting this bit resets all registers associated with this counter to the default state. It does not change this PMR register since any desired value can be loaded while setting the Reset bit. This Reset bit will by cleared after the reset RW 0 is completed. For diagnostic purposes, the contents of the other registers can be read to verify operation of this bit. Note: There is also a reset bit in the PERFCON register which clears all counter registers including the PMR.

3.10.8 FSBPMEL[1:0]: Processor Bus Performance Monitor Events LO

This register is the least significant of the two used to select bus events. Use of the event registers is mutually exclusive with other processor bus event registers. Each major bit field in this register is AND'ed with other major bit fields (in both the FSBPMEL and FSBPMEH registers) to select the event. If one field does not match, then the counter will not count.

	Device: NodeID Function: 3 Offset: ACh (FSBPMEL0), ECh(FSBPMEL1)				
Bit	Attr	Default	Description		
31:30	RW	0	LOCK 01 - select unlocked cycles 10 - select locked cycle		
29:23	RW	0	Snoop Phase Signals (AND'ed Group) 1xxxxxx normal inorder (no snoop signals during snoop phase) x1xxxxx HITM xx1xxxx HIT xxx1xxx DHIT (Deferred Phase Data Hit – cache cannot go owned. OR'ed with other group qualifications, not AND'ed) xxxx1xx DEFER (Signal) xxxxx1xx VSBL (Write visibility guaranteed) xxxxxx1x TND (Purge TC Not Done)		
22:18	RW	0	Completion Status (AND'ed Group) 1xxxx Retried – all x1xxx Retried – address collision xx1xx In Order (Non-deferred) xxx1x Deferred xxxx1 Hard Failure		



Device: NodeID Function: 3 Offset: ACh (FSBPMEL0), ECh(FSBPMEL1) (Continued)				
Bit	Attr	Default	Description	
			Request Type (AND'ed Group)	
17:5	RW	0	1xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx	
4:0	RW	0	Cycle Length (AND'ed Group) 1xxxx	

3.10.9 FSBPMEH[1:0]: Processor Bus Performance Monitor Events HI

This register is the most significant one of the two used to select bus events. Use of the event registers is mutually exclusive with other processor bus event registers. Each major bit field in the register is AND'ed with other major bit fields to select the event. If one field does not match, then the counter will not count.

Device: Function Offset:	Function: 3				
Bit	Attr	Default	Description		
31:19	RV	0	Reserved		
18:15	RV	0	Reserved		
14:13	RW	0	Processor Thread (If Supported by Processor) Note: If Threads are not supported by the processor select "11" for this field. 01 - Thread0 10 - Thread1		
12:11	RW	0	Core ID (If Supported by Processor) Note: If Core ID is not supported by the processor select "11" for this field. 01 - Core 0 10 - Core 1		
10:9	RW	0	Local or Remote Local node access versus remote node accesses from the processor bus. 01 - local only 10 - remote only		



Device: NodelD **Function:** Offset: B0h (FSBPMEH0), F0h(FSBPMEH1) (Continued) Default **Description** Agent IDs (AND'ed Group) 1xxxx SNC CPU/Package 3 x1xxx8:4 RW xx1xx CPU/Package 2 CPU/Package 1 xxx1x CPU/Package 0 xxxx1 **Extended Functions (AND'ed Group)** Note: "0000" will match anything. EXF4 1xxx RW 3:0 0 EXF3 x1xx EXF2 xx1x xxx1 EXF1

3.10.10 FSBPMER[1:0]: Processor Bus Performance Monitor Resource Events

This register is used to select resource events. Use of this event register is mutually exclusive with other processor bus event registers. Match results from each field of this register are OR'ed to select the event.

Device: Function Offset:	Function: 3					
Bit	Attr	Default	Description			
31:11	RV	0	Reserved			
10	RW	0	Copy Hit Indicates a Read transaction hit an entry in the Write Buffer and was copied rather than accessing memory.			
9	RW	0	Snoop Stall Event This is the event of a processor bus snoop stall, i.e. HIT and HITM active concurrently. Note: Only one event is recorded when HIT and HITM continue to be active every other clock, indicating one snoop stall event.			
8	RW	0	BNR Event This is the event of a BNR activation on the bus. Note only one event is recorded when BNR is continuously active for multiple clocks.			



Device: NodeID Function: 3 Offset: B4h (FSBPMER0), F4h(FSBPMER1) (Continued)					
Bit	Attr	Default	Description		
			Queue Events		
			This field selects a queue to monitor and which event measurement to make for that queue. The "no measurement" selection should be selected to disable this measurement.		
		0	7:6 - Queue selection		
			00 - In Order Queue		
			01 - Read Queue		
7:4	RW		10 - Write Queue		
			11 - SP Output Request Queue		
			5:4 - Queue measurement		
			00 - No measurement		
			O1 - Input Arrival		
			10 - Output Arrival		
			11 - Output Departure		
		0	Data Buffer Allocation Event (OR'ed group)		
3:0			This register selects the destination and cycle type when a transaction is allocated to the data buffer.		
	RW		1xxx Remote Write x1xx Remote Read xx1x Local Write		

3.10.11 FSBPMEU[1:0]: Processor Bus Perform Monitor Utilization Events

Local Read

xxx1

This register is used to select bus related utilization events, (i.e., to count number of clocks the selected comparison is active). Use of this event register is mutually exclusive with other processor system bus event registers. Each of these bit fields are OR'ed together, except the Threshold Comparison field, which is a comparison value for the Queue of Buffer Select field. In all cases the clock frequency used to measure a clock count is the system clock (200 MHz).

Device: NodelD Function: 3 Offset: B8h (FSBPMEU0), F8h (FSBPMEU1)					
Bit	Bit Attr Default Description				
31:23	RV	0	Reserved		
22:20	RW	0	This field selects the queue or buffer to compare with the Threshold Comparison field. Clocks are counted (utilization), if the number of entries in the queue are greater than the value in the Threshold Comparison field. OOO None OO1 In Order Queue O10 Memory Read Queue O11 Memory Write Queue 100 Data Buffer 101 LATT – Local Address Transaction Table 110 RATT – Remote Address Translation Table 111 SP Outbound Request Queue		

Configuration Registers



Device: NodelD Function: 3

Bit	Attr	Default	Description
			Threshold Comparison
19:13	RW	0	Value compared against number of entries in the selected queue of buffer. Clocks are counted (utilization), if the number of entries in the queue are greater than the value in the Threshold Comparison field.
12	RW	0	TRDY Utilization
12	KVV	0	Number of clocks TRDY# is active
11	RW	0	DRDY Utilization
11	KVV	0	Number of clocks DRDY# is active
10	RW	0	DBSY Utilization
10	RVV	0	Number of clocks DBSY# is active
0	DW	0	BNR Utilization
9	RW	0	Number of clocks BNR# is active
8	RW	0	BPRI Utilization
0	KVV	0	Number of clocks BPRI# is active
7	RW	0	Processor bus Data Bus Utilization
′	KVV		This is the number of clocks when DBSY# or DRDY# are active.
		0	Processor Bus Address Bus Utilization
6	RW		Selected by "Bus Select." Approximated by three clocks for the Itanium 2 processor per ADS, plus BNR# utilization.
5	RW	0	Memory Row Address Busy
3	INV		Utilization count due to the memory row address bus in use.
4	RW	eW 0	Memory Column Address Busy
4	INV		Utilization count due to the memory column address bus in use.
3	RW	0	Memory Data Bus Busy
3	IXVV	U	Utilization of actual data transfers on the memory data bus.
2	RW	0	Memory Precharge Stall
2	IXVV	0	Utilization count during time RAS is held off due to precharge conditions.
			Read or Copy Queue Stall
1	RW	N 0	Utilization count when the number of read queue entries available are below the processor bus stall threshold of the copy queue is full – BNR# is issued to the system bus.
			Write Buffer Stall
0	RW	0	Utilization count when the number of write posting buffer entries available are below the processor bus stall threshold – BNR# is issued to the system bus.



3.10.12 SPPMD[1:0]: SP Performance Monitor Data

This is the performance monitor counter. The overflow bit can be cleared via the PMR register without perturbing the value of the counter. This counter is reset at the beginning of a sample period unless preloaded since a prior sample. Therefore, the counter can be preloaded to cause an early overflow, otherwise it will be reset at the start of a sample period.

Device: NodeID Function: 2 Offset: E8h (SPPMD0), F8h (SPPMD1)					
Bit	Attr	Default	Description		
31	RW	0	Overflow.		
30:0	RW	0	Current Counter Value.		

3.10.13 SPPMC[1:0]: SP Performance Compare

The compare register can be used three ways as selected in the "Compare Mode" field of the PMR register. First, when PMD is incremented, the value of PMD is compared to the value of PMC. If PMD is greater than PMC, this status is reflected in the PERFCON register and/or on EV pins as selected in the "Event Status Output" field of the PMR register. Secondly, update the PMC register with the value of PMD if the PMD register exceeds the contents of PMC.

Note: For these first two methods, bit 31 of the PMC should typically be set to 0. The comparison does include bit 31 (overflow) of the PMD counter, but since the overflow sets the counter status, a subsequent comparison will not affect the status condition.

The third mode is an address comparison mode. PMD0 compares on addresses greater than the PMC0 register and PMD1 compares on addresses less than or equal to PMC1. The "AND" of these two comparisons is the address range comparison and qualifies the other match event conditions for both counters. Note that the contents of PMC is compared to A[38:7]#.

Device: NodeID Function: 2 Offset: E4h (SPPMC0), F4h			(SPPMC1)
Bit	Attr	Default	Description
31:0	RW	FFFF_FFFFh	Counter Compare Value.



3.10.14 SPPMR[1:0]: SP Performance Monitor Response

The PMR register controls operation of its associated counter, and provides overflow or max compare status information.

	Device: NodeID Function: 2 Offset: E0h (SPPMR0), F0h(SPPPMR1)			
Bit	Attr	Default	Description	
31:26	RV	0	Reserved	
25	RW	0	Req/RspType Bus Select 0 = Request Bus 1 = Response Bus	
24	RW	0	This bit has no effect on SNC operation.	
23:22	RW	0	Compare Mode This field defines how the PMC (compare) register is to be used. 00 - compare mode disabled (PMC register not used) 01 - Max compare only: The PMC register value is compared with the counter value. If the counter value is greater then Count Compare Status (bit 13) of the "Event Status" field of this register will be set. Note: Bit 31 of the PMC should typically be set to'0'. The comparison does include bit 31 (overflow) of the PMD counter, but since the overflow sets the counter status, a subsequent comparison will not affect the status condition. 10 - Max compare with update of PMC at end of sample: The PMC register value is compared with the counter value, and if the counter value is greater, the PMC register is updated with the counter value. The Event Status field is not affected in this mode. 11 - Address compare mode where the PMC register is compared with the address field. Counter 0 of a counter pair will compare on an address greater than the register, and counter 1 will compare on an address equal to or lesser than the register (inverse of greater than). When both comparisons are valid, an address range comparison qualification is generated. This mode will cause the results of the address range comparison to be AND'ed with the event qualification specified in the selected PME register of each counter. The Event Status field is not affected in this mode. The address comparison range is A[38:7]#.	
21:19	RW	0	Reset Event Select Counter and event status will reset and counting will continue. 000 No reset condition 001 Partner's event status: When the partner counter causes an event status condition to be activated, either by a counter overflow or max comparison, then this counter will reset and continue counting. 010 Partners PME register event: When the partner counter detects a match condition which meets its selected PME register qualifications, then this counter will reset and continue counting. 011 Reserved 100 EV0 pin 101 EV1 pin 110 EV2 pin 111 EV3 pin	



Device: NodeID Function: 2 Offset: E0h (SPPMR0), F0h(SPPPMR1) (Continued)

Bit	Attr	Default	Description
			Count Event Select
			This field determines the counter enable source.
			000 PME register event
			001 Partner event status (max compare or overflow)
18:16	RW	0	010 All clocks when enabled
			011 Reserved 100 EV0 pin
			101 EV1 pin
			110 EV2 pin
			111 EV3 pin
			Count Mode
			00 = count event selected by Count Event Select field.
15:14	RW	0	01 = count clocks after event selected by Count Event Select field.
			10 = count transaction length of event, selected by SPPME register.
			11 = Reserved
			Event Status
			This status bit captures an overflow or count compare event. The Event Status Output field can be programmed to allow this bit to be driven to an
			external EV pin.
			00 - no event
			x1 - overflow – The PMD counter overflow status. (Write'0' or start an interval
		0	to clear.)
13:12	RW		1x - count compare – PMD counter greater than PMC register when in
			compare mode. (Write'0' or start an interval to clear.)
			This bit is sticky in that once an event is reported the status remains even though the original condition is no longer valid. This bit can be cleared by
			software or by starting a sample. Event status is always visible in the
			PERFCON register, except if Event Status Output field is in cascade mode
			If in address compare mode (compare mode = 11), the count compare bit is not activated.
			Event Status Output
		1	This field selects where the event status is reported.
			000 Event status reported only in PERFCON register
			(address comparison not reported)
11:9	RW	0	001 Event status (overflow) reported to partner only; used for cascading event counters
			100 Event status or address comparison on PERFCON and EV0 pin
			101 Event status or address comparison on PERFCON and EV1 pin
		1	110 Event status or address comparison on PERFCON and EV2 pin 111 Event status or address comparison on PERFCON and EV3 pin
			CD_Src: Counter Disable Source These bits control which input disables the counter.
		V 0	Note: If the "Enable Source" is inactive counting is also disabled.
8:5	RW		1xxx EV3 pin
	1	1	x1xx EV2 pin
	1		xx1x EV1 pin
			x x1x EV0 pin



Devises MedelD					
	Device: NodeID Function: 2 Offset: E0h (SPPMR0), F0h(SPPPMR1) (Continued)				
Bit	Attr	Default	Description		
			CE_Src: Counter Enable Source		
			These bits identify which input enables the counter. Default value disables counting.		
			000 Disabled		
4:2	RW	000	001 PERFCON local_count_enable field 010 Partner event status (max compare, overflow, cascade)		
			011 Reserved		
			100 EV0 pin 101 EV1 pin		
			110 EV2 pin		
			111 EV3 pin		
			Clear Overflow		
1	RW	0	This bit clears overflow bit in associated PMD counter. The counters continues counting. This bit is cleared by hardware when the operation is complete.		
			Reset		
0	RW	0	Setting this bit resets all registers associated with this counter to the default state. It does not change this PMR register since any desired value can be loaded while setting the Reset bit. This Reset bit will by cleared after the reset is completed. For diagnostic purposes, the contents of the other registers can be read to verify operation of this bit. There is also a reset bit in the PERFCON register that clears all counter registers including the PMR.		

3.10.15 SPPME[1:0]: SP Performance Monitor Events

The SP performance counter logic provides the ability to monitor those packets that are received by the SP interface of the SNC. Events related to inbound requests packets such as processor bus snoop and/or memory requests generated by the SPS or SIOH can be monitored. Responses to earlier SNC SP requests can also be monitored (i.e. outbound read completions).

The PME register is divided into major sub-groups. For some sub-groups, the events within a group are OR'd together. Each major group is AND'ed together to select the event.

Device: NodeID Function: 2 Offset: ECh (SPPMD0), FCh(SPPMD1)					
Bit	Attr	Default	Description		
31:28	RV	0	Reserved		
27:25	RW	0h	DLEN Field Selects the data length of the transaction. 111 Any length 000 0-8 bytes 001 16 bytes 010 32 bytes 011 64 bytes 100 128 bytes 101 - 110 Reserved		
24:21	RW	0	Attribute 1111 All attributes selected xxxx Matches the attribute field of the packet (except 1111)		



Device: Function Offset:	Function: 2				
Bit	Attr	Default	Description		
20:16	RW	0	Packet Src Node 1111 All sources xxxxx Src Node ID (except 11111)		
15:14	RW	0	SP Port Select x1 - SP0 1x - SP1		
Packet 1	Гуре Ѕе	lection Group			
13:7	RW	0	Type Data XXXXYYC For request packets, the fields are: [13:10] - XXXX is the request type major encoding [9:8] - YY is the request type minor encoding [7] - C is the coherency bit For response packets, the fields are: [13:10] - XXXX is the response type [9:8] - YY indicates the completion bit value (0Y) [7] - C is the coherency bit		
6:0	RW	0	Type_Mask This is a mask field for the Type Data field. It determines which bits of the Type_Data field to be used in selecting the event. A '1' in a bit position will "don't care" that bit, therefore a value of 7Fh (all 1's) selects all packets regardless of the value of the Type Data field.		

3.10.16 HPPMR: Hot Page Control and Response

The PMR register controls operation of the Hot Page counters and provides max count and counter index status.

Device: Function Offset:	NodeID n: 3 60h		
Bit	Attr	Default	Description
31:21	RO	0	Hot Page RAM Index Pointer to the entry that exceeded the comparison conditions.
20	RW	0	AutoRange Mode 1 - AutoRange mode active. Note: The Comparison Mode field should be enabled in one of the three active modes.
19:18	RW	0	Comparison Mode This field defines how the HPCMP register is used: 00 - Disabled. (No comparison with the HPCMP register. 01 - Compare count with HPCMP register for Local or Remote accesses. 10 - Compare count with HPCMP register for Remote accesses only. 11 - Update HPCMP register when count is greater.

Configuration Registers



Device: NodelD Function: 3

Bit	Attr	Default	Description
17:15	RW	0	Resolution Determines the address range for each counter 000 64-bytes 001 4 KB 010 128 KB 011 8 MB 100 256 MB
14	RW	0	Filter Select (Conditioned Addresses) 0 = All transaction types. The retried transactions are also counted. To filter retried transactions, set this bit and use the FSBPME0 "completion status" field to eliminate retried cycles. 1 = Transactions qualified with the event selection of Processor Bus Performance Module 0.
13	RW	0	Max Count Compare Status This bit is sticky in that once an event is reported the status remains even though the original condition is no longer valid. This bit can be cleared by software (write a '0') or by starting a sample. Hot Page Max Count status is always visible in the PERFCON register.
12	RO	0	Timer Completion Status This bit is a reflection of the Timer Underflow Status bit in the PTCTL register (bit 6). It can be cleared by writing a '0' to bit 6 of the PTCTL register.
11:9	RW	0	Event Status Output This field selects how the Timer Completion Status is reported. O00 Hot Page status reported only in PERFCON register 100 Hot Page status on EV[0]# pin 101 Hot Page status on EV[1]# pin 110 Hot Page status on EV[2]# pin 111 Hot Page status on EV[3]# pin
8:5	RW	0	CD_Src: Counter Disable Source These bits control which input disables the counter. Note: If the "Enable Source" is inactive counting is also disabled. 1xxx EV3 pin x1xx EV2 pin xx1x EV1 pin xxx1 EV0 pin
4:2	RW	0	CE_Src: Counter Enable Source These bits identify which input enables the counter. Default value disables counting. 000 Disabled 001 PERFCON or PTCTL Local Count Enable field 010 Reserved 011 Enable. (writing a one causes the Hot Page counters to be enabled immediately.) 100 EV0# pin 101 EV1# pin 110 EV2# pin 111 EV3# pin
1	RW	0	AutoZero Writing a '1 will clear all SRAM entries. This bit is reset to zero after the operation is complete.
0	RW	0	Reset Set hotpage registers to default values: 1 = reset. Does not reset this register nor the counter array. This bit is cleared by hardware.



3.10.17 HPADDR: Hot Page Index

This register is used in conjunction with the HPDATA register to access the Hot Page Counter Array. It contains the index used to access the array. If the most significant bit is set, the index is automatically incremented after each access to the HPDATA register. The size of the Hot Page counter array is 2KB.

Device: NodeID Function: 3 Offset: 64h				
Bit	Attr	Default	Description	
15	RW	0	Array Index Auto-increment If set, the Hot Page counter array index is automatically incremented to the next address each time after the Hot Page Data register (HPDATA) is accessed. In this mode, the entire Hot Page counter array can be read without having to modify the index.	
14:11	RV	0	Reserved	
10:0	RW	0	Hot Page Counter Array Index.	

3.10.18 HPDATA: Hot Page Data

This register is used in conjunction with the HPADDR register to access the Hot Page Counter Array. When read, the contents of the counter array entry as indicated by HPADDR is returned. When written, the counter array entry will be updated.

Device: NodelD Function: 3 Offset: 68h				
Bit	Attr	Default	Description	
31:0	RW	0	Hot Page Data.	

3.10.19 HPCMP: Hot Page Count Compare

This register contains the maximum comparison value for the AutoRange feature. It also is used in the update mode to capture the largest count that occurred during the sample interval. The comparison is true when the count is greater than the compare value in the register; e.g. for a compare value of "0", the comparison will be true when the count is "1".

Device: NodelD Function: 3 Offset: 6Ch				
Bit	Attr	Default	Description	
31:0	RW	FFFF_FFFFh	Compare Value.	



3.10.20 HPBASE: Hot Page Range Base

This register contains the base address used to index the Hot Page counter array. A 2K-entry counter array can scan up to 512 GB of contiguous physical addresses when the address resolution is 256 MB.

Device: Function Offset:	Function: 3				
Bit	Attr	Default	Description		
31:27	RV	0	Reserved		
26:0	RW	0	Base Address of the Counter Array Corresponds to A[43:17]#. The least significant bits are ignored dependent on the resolution: A[43:17]# valid when the resolution is 64 Bytes A[43:23]# valid when the resolution is 4 KBytes A[43:28]# valid when the resolution is 128 KBytes A[43:34]# valid when the resolution is 8 MBytes A[43:39]# valid when the resolution is 256 MBytes		

3.10.21 HPMAX: Hot Page Max Range Address

This register contains the maximum range address used to index the Hot Page counter array when in the AutoRange mode. When the Hot Page Range counter exceeds this value, the Range counter is reloaded with the value in the Hot Page Range Base register (HPBASE).

Device: Function Offset:	Function: 3				
Bit	Attr	Default	Description		
31:27	RV	11111	Reserved		
26:0	RW	7FF_FFFFh	Maximum Base Address of the Counter Array Corresponds to A[43:17]#. The least significant bits are ignored dependent on the resolution: A[43:17]# valid when the resolution is 64 Bytes A[43:23]# valid when the resolution is 4 KBytes A[43:28]# valid when the resolution is 128 KBytes A[43:34]# valid when the resolution is 8 MBytes A[43:39]# valid when the resolution is 256 MBytes		



3.10.22 HPRCTR: Hot Page Range Counter

This register contains the value of the Range counter which is used in the AutoRange mode. This counter is initially loaded with the Hot Page Base (HPBASE) register. After each sample interval, defined by the interval timer, the Range Counter is incremented to the next range of 512 address blocks. When the Range Counter is incremented to an address higher than the HPMAX register then the counter is pre-loaded with the value in the Hot Page Base register.

Device: NodelD Function: 3 Offset: 78h						
Bit	Attr	Default	Description			
31:27	RV	0	Reserved			
26:0	RO	0	AutoRange Counter Address of the Counter Array Corresponds to A[43:17]#. Note: Least significant bits are ignored dependent on the resolution. Therefore, A[43:17]# valid when the resolution is 64 Bytes A[43:23]# valid when the resolution is 4 KBytes A[43:28]# valid when the resolution is 128 KBytes A[43:34]# valid when the resolution is 8 MBytes A[43:39]# valid when the resolution is 256 MBytes			

Configuration Registers





intel® System Address Map

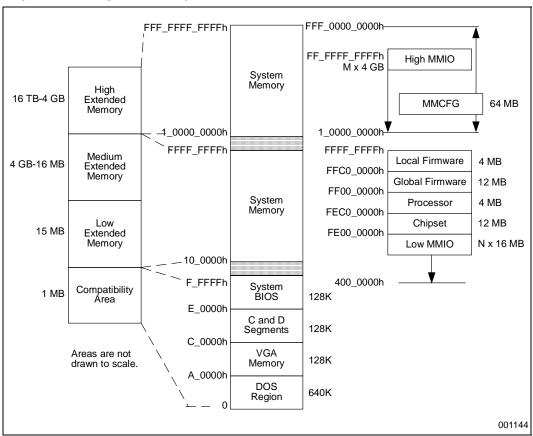
Memory Map 4.1

The Itanium 2 processor provides address bits for a 50-bit address space. The SNC support 44 bits of addressing 1

The E8870 chipset treats accesses to several address ranges in different ways. There are fixed ranges like the compatibility region below 1 MB, interrupt delivery range, and the system region located in the 32 MB directly below 4 GB. In addition, there is a variable region for memorymapped I/O. The locations of these ranges in the memory map are illustrated in Figure 4-1.

In this chapter, we are going to use the Intel E8870SP scalability port switch (SPS) as an example to illustrate one possible implementation. Other SP switches will have different implementations.

Figure 4-1. System Memory Address Space



^{1.} The SNC does not connect to A[49:44]. An illegal address (A[49:44] > 0) may not be detected by the SNC.



4.1.1 Compatibility Region

This is the range from 0 to 1 MB (0_0000h to F_FFFFh). Requests to the compatibility region are directed to main memory, the compatibility bus, or the VGA device. Physical DRAM addressed by requests in this region that are mapped to the compatibility bus is not recovered.

This region is divided into four ranges. Regions below 1MB that are mapped to memory are accessible by the processors and by any PCI bus.

Note: DRAM that has a physical address between 0 and 1 MB must not be recovered, relocated or reflected. This range must always be available to the OS as DRAM, even if addresses in this range are sent to the compatibility bus or VGA or other non-DRAM areas at times.

4.1.1.1 DOS Region

DOS applications execute in the lowest 640 KB, in the address range 0h to 9_FFFFh. This range is always mapped to main memory. Note that older chipsets allowed the range from 8_0000h to 9_FFFFh to be mapped to the compatibility bus. The E8870 chipset does not support this legacy feature.

4.1.1.2 VGA Memory Range

The 128 KB Video Graphics Adapter Memory range (A_0000h to B_FFFFh) can be mapped to the VGA device that may be on any Hub Interface, or it can be mapped to main memory. This space is mapped to main memory at power-on.

BIOS must explicitly enable the VGA range before it can be used. This region can be redirected by BIOS to point to any bus that has a VGA card. Only one bus per domain may be enabled for VGA.

4.1.1.3 MDA Memory Range

This is the range from B_0000h to B_7FFFh and is used for the monochrome region. If the MDA is enabled, all requests in this range are sent to the SP with Attr = CB. If MDA is not enabled, this is part of VGA space. The monochrome display adapter is always on the compatibility bus.

4.1.1.4 C and D Segments

Writes and reads may be directed to different destinations in the range C_0000h to D_FFFFh. Typically, these blocks were used to shadow ISA device's BIOS code. For the E8870 chipset, these regions are used to provide address space to PCI devices requiring memory space below 1MB. The range is divided into eleven subranges. There is one MAR field for each subrange that defines the routing of reads and writes.

Table 4-1. MAR Settings

MAR value	Writes Go To	Reads Go To	Result
00	Compatibility Bus	Compatibility Bus	Mapped to the Compatibility PCI
01	Compatibility Bus	Main Memory	Memory Write Protect
10	Main Memory	Compatibility Bus	In-line Shadowed
11	Main Memory	Main Memory	Mapped to main memory



The default for these segments at power-on is that they are mapped read/write to the compatibility bus. Software should not set cacheable memory attributes for any of these ranges unless both reads and writes are mapped to main memory. In the write protect case, the E8870 chipset cannot guarantee write protection if an Implicit write-back occurs. This will result in a write-back to memory. If a Bus Read Invalidate Line or explicit write-back is issued, the E8870 chipset will malfunction.

In the In-Line-Shadowed case, the E8870 chipset will complete operations, but does not guarantee coherency. The E8870 chipset will complete, but does not guarantee the atomicity of locked access to this range when writes and reads are mapped to separate destinations.

For Itanium 2-based systems, SNC MAR registers must be configured to map this range to main memory.

4.1.1.5 System BIOS (E and F Segments)

The 128 KB region from E0000h to F_FFFFh is treated as a single block. Read/write attributes defined in the MAR registers may be used to direct accesses to the compatibility bus or main memory. At power-on, this area is mapped read/write to the firmware hub devices on the SNC. When this region is mapped to the local FWH, this region is only accessible from the processors on that node and not from processors on a different node, PCI or any other I/O device. When this region is mapped to the ICH4 FWH, it may be accessed from any processor bus, but inbound accesses will access main memory. This main memory would not be used in this case. When accesses are directed to the SNC FWH port, this region addresses the same range as FFFE_0000h-FFFF_FFFh. This means A[31:20]# will be active on the LPC interface.

The default for these segments at power-on is that they are mapped read/write to the compatibility bus. Software should not set cacheable memory attributes for any of these ranges unless both reads and writes are mapped to main memory. In the write protect case, the E8870 chipset cannot guarantee write protection if an implicit write-back occurs. This will result in a written back to memory. If a Bus Read Invalidate Line or explicit write-back is issued, the E8870 chipset will malfunction.

In the In-Line-Shadowed case, the E8870 chipset will complete operations, but does not guarantee coherency. The E8870 chipset will complete, but does not guarantee the atomicity of locked access to this range when writes and reads are mapped to separate destinations.

For Itanium 2-based systems, SNC MAR registers must be configured to map this range to main memory.

4.1.2 System Region

The System Region occupies the 32 MB directly below the 4-GB address. It consists of sub-regions for firmware, processor memory mapped functions, and E8870 chipset specific registers. All memory in this system region must not be marked as write-back.

4.1.2.1 Local Firmware Range

The E8870 chipset supports 4 MB of firmware on the SNC FWH port. Processor requests in the address range FFC0_0000h to FFFF_FFFFh are sent to the SNC FWH port if it is enabled. Otherwise, the request is sent to the compatibility bus. Inbound accesses will be master aborted. Only 4 MB is addressable on this interface, and only A[21:0]# are mapped to this interface. A[31:23]# are set high except for A[22]#, which is controlled by the Feature Space Enable bit in the SNC FSBC register.





Some FWH components implement more than 4 MB of firmware space. These components support internal paging registers to allow software to map the SNC 4MB window into the larger component. In other words, software will first program the paging register to move the base address and subsequent accesses to the firmware will be offset by that amount.

Only single-byte writes are supported to this range. These writes are interpreted as commands by the Flash device. Locked accesses to this range are not supported.

Figure 4-2 depicts the E8870 chipset firmware map using 82802 firmware hub devices as an example for Local Firmware Range enabled. Figure 4-3 depicts the E8870 chipset firmware map using 82802 Flash devices as an example for Local Firmware Range disabled.

4.1.2.2 Global Firmware Range

The Global Firmware Range (12 MB) lies from FF00_0000h to FFBF_FFFFh if Local Firmware Range is enabled (see Figure 4-2). If Local Firmware is disabled (see Figure 4-3), Global Firmware range includes the FFC0_0000 to FFFF_FFFFh address range. Requests in this range are directed to the compatibility bus. The ICH4 will route these to its FWH interface. This range is accessible from any processor bus and can be written inbound.

4.1.2.3 Processor Specific Region

This 4-MB range is used for processor-specific applications. It lies between FEC0_0000h and FEFF_FFFFh, and is split into four 1MB segments.

Interrupt Range

Requests to the address range FEE0_0000h to FEEF_FFFFh are used to deliver interrupts. Memory reads or write transactions to this range are illegal from the processor. The processor issues interrupt transactions to this range. Inbound interrupts in the form of memory writes to this range are converted by the SIOH to non-coherent memory writes in SP, with Attr = INT.

Reserved Ranges

The E8870 chipset will master abort requests to the FEF0_0000h - FEFF_FFFFh or FED0_0000h - FEDF FFFFh ranges.

I/O APIC Controller and Hot-Plug Controller Range (SAR)

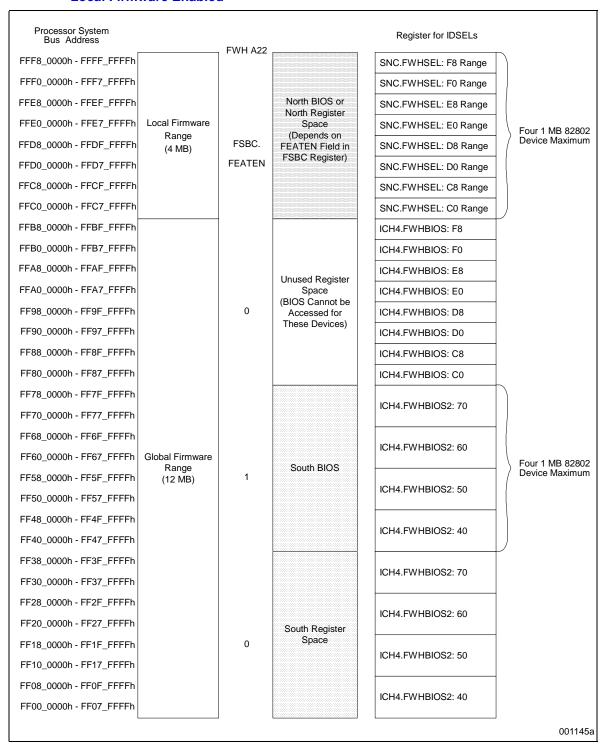
This address range FEC0_0000h to FECF_FFFFh is used to program the IOAPIC controller in the P64H2 and for targeted EOI writes. The FECx_xxxxh area is also used for the Hot Plug controller in the P64H2. The attribute field in request packets to this range is set to MMIO.

In a multi-node environment, this region can be partitioned into two contiguous sub-ranges, one for each SIOH. The SIOH with the compatibility bus must be assigned the lowest sub-range, since the Interrupt Re-direction Register in the ICH4 is hard-coded to the FECO_0000h address. These subranges may be divided into nine sub-ranges, which may be allotted to the different PCI buses connected to the hublinks.

The SIOH supports a relocatable IOAPIC register range, but the SNC does not.



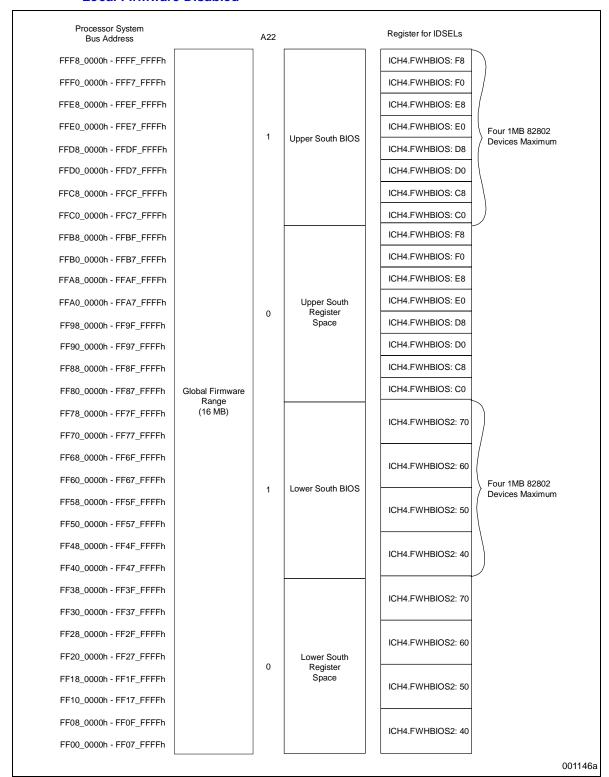
Figure 4-2. Firmware Map Example using Intel® E8870 Chipset and Intel 82802 FWH with Local Firmware Enabled



North BIOS: Elements of system BIOS that reside in the FWH device(s) connected to the SNC. South BIOS: Elements of system BIOS that reside in the FWH devices connected to the ICH4.



Figure 4-3. Firmware Map Example using Intel[®] E8870 Chipset and Intel 82802 FWH with Local Firmware Disabled





4.1.2.4 Chipset Specific Range

The address range FE00_0000h - FFBF_FFFFh region is reserved for chipset specific functions. FE60_0000h - FE6F_FFFFh is used for memory mapped SNC registers. They are accessible only from the processor bus on that SNC. The E8870 chipset will master abort requests to the remainder of this region.

4.1.3 High and Low Memory Mapped I/O (MMIO)

Two variable-sized MMIO regions are directed to I/O buses. The Low MMIO region starts at 4 GB to 32 MB (FDFF_FFFFh), and may extend downward no lower than 64 MB (400_0000h). The High MMIO region starts below 1 TB (FF_FFFF_FFFh) and may extend downward in 4-GB increments no lower than 4 GB (1_0000_0000h). Thus, neither MMIO region overlaps any fixed regions. No addresses in these regions may have the write-back or write-through cacheability attribute, but cache flushes to this region are possible. The size of the region is defined by MMIOL and MMIOH registers in the SNC.

These regions can be divided in half by the SP switches if two SIOHs are present. The MMIOL register divides the MMIOL region with 64-MB granularity. The MMIOH register divides the MMIOH region in half with 4-GB granularity.

The subrange assigned to each SIOH can be sub-divided into variable sized spaces for each Hub Interface. Each Hub Interface can be allocated a multiple of 16 MB (for MMIOL) or 64 MB (for MMIOH). The subranges allotted to all Hub Interfaces connected to a particular SIOH must be contiguous. They must also be assigned in this order (highest to lowest) for the SIOH: HI0,HI1,HI2,HI3,HI4. The subranges allotted to all PCI buses connected to a particular Hub Interface must be contiguous. The subranges allotted to all PCI buses connected to a particular Hub Interface device (e.g. P64H2) must be contiguous. This subdivision is controlled by the MMIOBL, MMIOBH, and MMIOLH registers in the SIOH.

MMIO also includes the ranges for the Hot-plug controller of the P64H2 and the SAPIC addresses.

Addresses in this range will not be interleaved like memory accesses, but will be directed to one SPS to enable ordering. For this reason, the SNC routes most addresses in this range to the default SP.

SNC MMIO Routing Registers in the SNC define the High and Low MMIO ranges. Any

processor request (SNC should not receive SP requests to this range) to either of these regions is directed out the default scalability port with a

destination of MMIO in the Attr field.

SPS MMIO Routing The SPS routes requests with Attr = MMIO one of two SIOHs. For each

domain, the MMIO range may be directed to one SIOH or the other, or split between the two. Therefore, each SPS port has a set of registers for the high and low MMIO ranges (MMIOLS and MMIOHS) that define boundaries between the subranges routed to each SP port. The MMIOLS registers are applied if the address is below 4G. Otherwise, MMIOHS

registers are applied.

SIOH MMIO Routing The SIOH has registers that define the MMIO range and the subranges

routed to each Hub Interface. A request from a Hub Interface that falls in a local Hub Interface subrange is routed there. A Hub Interface request that falls in the MMIO range, but is not mapped to any Hub Interface in that SIOH will be sent to a scalability port with Attr = MMIO. The SPS will route it to the other SIOH. An SP requests that falls in a local Hub



Interface subrange is routed there. An SP request that falls in the MMIO range, but is not mapped to any Hub Interface in that SIOH will be master aborted.

4.1.4 Memory Mapped Configuration Space

The entire PCI configuration space is mapped into the MMCFG address range of the SNC. The processor bus address defines the configuration register to be accessed and the processor bus data either returns or provides register contents. As opposed to CF8/CFC-based configuration accesses, this mechanism is atomic. This space is 64 MB in size, must be above 4 GB, and may not overlap High MMIO. Physical memory that is mapped to this range may not be used or recovered. Accesses to this range must be 1, 2, 3, or 4 bytes in length. Only UC memory attribute is supported in this range.

This space is not accessible inbound, only by processors. Inbound accesses to this range will reach the SNC. If no main memory exists in this space, the SNC will provide a master abort response status. If (unused) main memory does exist in this space, that memory will be accessed. This access will not affect other system operations.

If a processor request falls in this range, it may access a configuration register in the SNC or be converted into a configuration Read/Write to SP. The configuration Read/Write to SP from MMCFG are routed to an E8870 chipset component configuration register or out a hub interface like any other configuration Read/Write to SP.

4.1.5 Main Memory Region

4.1.5.1 Application of Coherency Protocol

Table 4-6 defines the conditions under which processor transactions are routed to main memory. Table 4-8 defines the conditions under which inbound transactions are routed to main memory. There may be differences in the range C_0000h-F_FFFFh and SMM range. The E8870 chipset applies the coherency protocol to any accesses to main memory. The E8870 chipset may malfunction if processors issue.

Software must not set cacheable attributes for these areas. However, processors belonging to the Itanium processor family may flush a cache prior to making a range non-cacheable, whether it had ever been cacheable before or not. Therefore, the SNC will drop any BILs to non-coherent space. Although it is illegal, the E8870 chipset will complete certain coherent operations in the MAR regions. See Section 4.1.1.4, "C and D Segments" and Section 4.1.1.5, "System BIOS (E and F Segments)."

The Memory Interleave Range (MIR) registers define the mapping of address space to physical memory. The MIRs can be programmed to map physical memory contiguously or sparsely. Any address that is directed with Attr = DRAM that doesn't map within the MIR region is sent to CB for a master abort.

4.1.5.2 Routing Memory Requests Initiated on a Processor Bus

When a request appears on the processor bus of a node, and it does not fall in any special region, it is compared against the MIRs on an SNC. Those registers describe all the memory addressed by that SNC. If the address is mapped to that node, the request is routed to local memory. If no MIR matches, the request is directed to the scalability port. Any region of main memory may be mapped local or remote. In single node systems, all memory is local. In multiple processor bus systems,



memory is generally global. Multiple processor bus systems use local memory while booting, however. Local memory can be defined during system operation in multiple processor bus systems, but this possibility is not validated for E8870 chipset-based systems.

4.1.5.3 Routing Memory Requests Initiated on a Hub Interface

When a request appears on a Hub Interface, and it does not fall in any special region, the request is directed to the scalability port (SP) with Attr = DRAM. That is, the SIOH routes to SP by subtractive decode.

4.1.5.3.1 SPS Memory Request Routing

Each port in the scalability port switch (SPS) has a set of MIR registers, which enable different main memory maps to be defined for each domain. If the destination of a request is DRAM, the request is compared against the SPS MIRs. The SPS MIRs define the home of each cache line. The request is directed to the SP specified by the matching MIR. (To minimize decoding time, MIRs define physical SP numbers rather than node numbers.) If no MIR matches, the SPS will route the transaction to the node identified by MIR0/Way0.

4.1.5.3.2 Handling Memory Requests at the Home Node

Requests entering the SP to the home SNC are compared against the MIRs to determine local interleave. The address of a remote request that fails to match a MIR will be captured, and the illegal address flag will be set in the FERRST register. A response status of master abort is returned.

4.1.5.3.3 Node Interleaving

Memory covered by each MIR may be interleaved across up to four nodes in two granularities: at the 128-byte level or at blocks. If the GRAN bit in a MIR specifies 128-byte granularity, bytes 0 to 127 would be located on one node, 128 to 255 on the next node, 256 to 383 on the next, and so on. If the GRAN bit specifies Block interleaving, the range is divided into four equal-sized blocks, each of which can be assigned to a different node. For example, 0h to 3FFF_FFFFh of a 4-GB Memory Interleave range would be located on one node, 4000_000h to 7FFF_FFFFh on the next node, and so on.

Both granularities can be used in different ranges at the same time. The 128-byte granularity is used to distribute memory bandwidth in ranges where a very localized area of memory may sometimes get very heavy utilization. The Block granularity is used when it is desirable to associate different ranges with particular nodes (for non-uniform memory access optimizations, or in systems that support hot add/removal).

4.1.5.3.4 Limitations

- Memory Interleave Range must be a power of two in size and start on a multiple of its size. That is, a 2-GB range can only start at 2 GB, 4 GB, 8 GB, etc.
- Each SPS MIR defines four nodes that can be interleaved by blocks or at 128-byte granularity.
- Each SNC has eight Memory Interleave Range registers, SPS's have six MIRs.
- SNC MIRs can define no more than one DDR DIMM row. However, a DDR DIMM row can be split between multiple MIRs. When this happens, address restrictions apply to the split interleaves.



4.1.5.3.5 128-byte Interleave Example

Figure 4-4 describes the 128-byte interleaving of 16 GB of memory in a single-domain system with various amounts of memory and different technologies on each node. The SPS MIRs define global interleave ranges. An address range and the nodes assigned to each of the four ways is associated with each SPS MIR. SNC MIRs define local interleaves. Each SNC MIR defines an address range and specifies a range of memory of a given technology, size and the ways it owns.

16 GB MIR[5] MIR[3] 2 GB 1 GB, Tech C 0, 3, 0, 3 01, 11 MIR[3] 14 GB 2 GB, Tech A MIR[2] MIR[4] 00, 10 500 MB, Tech E 1 GB 01.11 0, 3, 0, 3 13 GB MIR[3] MIR[3] 1 GB 500 MB, Tech B 0, 1, 0, 1 01, 11 12 GB MIR[2] MIR[2] 1 GB, Tech A MIR[2] 2 GB 00, 10 1 GB, Tech B 0, 1, 0, 1 01, 11 10 GB MIR[1] MIR[1] 500 GB, Tech A MIR[1] MIR[1] MIR[3] 2 GB 00 500 MB, Tech B 500 MB, Tech D 500 MB, Tech G 0, 1, 3, 5 01 8 GB MIR[2] 500 MB, Tech H 11 MIR[0] MIR[0] MIR[0] MIR[1] MIR[0] 2 GB, Tech A 8 GB 2 GB, Tech B 2 GB, Tech C 500 MB, Tech G 00 0, 1, 3, 5 01 10 11 MIR[0] GB, Tech F O SPS SNC 0 SNC 1 SNC 2 SNC₃ All Ports 5.5 GB 4 GB 4 GB 2.5 GB 001147

Figure 4-4. Use of MIRs to Interleave Blocks of Varying Size Across Different Nodes

Cases that illustrate particular MIR limitations or flexibility are in **bold**.

Global interleave range 0 extends from 0 to 8 GB. It consists of four 2-GB blocks interleaved across SNC0, 1, 2, 3.

- Way 00 belongs to SNC0. The remaining memory on SNC0 is all Technology A, but must be split into many local interleaves since it is included in other global interleaves. These other global interleaves assign SNC0 different ways.
- Ways 01 and 10 belong to SNC1 and SNC2.
- Way 11 belongs to SNC3. Three different local interleaves (different technologies) on SNC3 are included in global interleave 0.

Global interleave range 1 extends from 8 to 10 GB. It consists of four 500-MB blocks interleaved across SNC0, 1, 2, 3. SNC3 has run out of memory, so the remainder of memory cannot be interleaved four ways.



Global interleave range 2 extends from 10 to 12 GB. It consists of two 1-GB blocks interleaved across SNCs 0 and 1. Even ways 00 and 10 belong to SNC0. Odd ways 01 and 11 belong to SNC1.

Global interleave range 3 extends from 12 to 13 GB. It consists of two 500-MB blocks interleaved across SNCs 0 and 1. **SNC0 MIR[3] defines a local interleave that spans multiple global interleaves.** This is possible whenever a single technology can occupy the same way in consecutive global interleaves.

Global interleave range 4 extends from 13 to 14 GB. It consists of two 500 MB blocks interleaved across SNCs 0 and 2. Although the memory in Global interleave 5 is interleaved the same way, a new MIR must be used because global interleave 4 started at 13 GB. To satisfy the rule that a MIR must start at a multiple of its size, the maximum size of Global Interleave 4 is 1 GB.

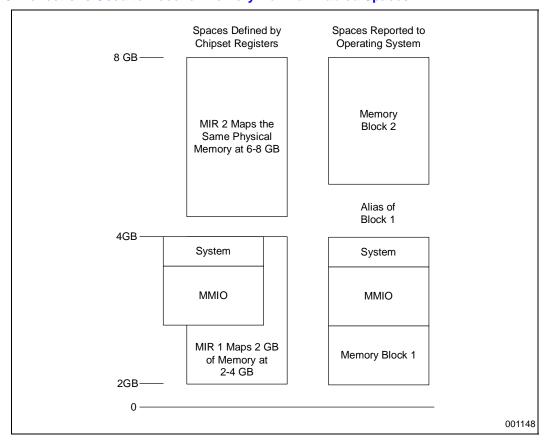
Global interleave range 5 extends from 14 GB to 16 GB. It consists of two 1-GB blocks interleaved across SNCs 0 and 3.

4.1.5.4 Recovering Main Memory Behind Other Regions: Reflections

To recover the memory behind the range from MMIOL to 4GB, MIRs can be used to map physical memory to multiple addresses (reflection).

Figure 4-5 illustrates how memory lost behind System and MMIO spaces can be recovered in the second image of a given interleave range. In this example, Firmware and MMIO cover portions of the Memory Interleave Range (defined by MIR1) between 2 and 4 GB. The memory behind these spaces is unusable at these addresses.

Figure 4-5. Reflections Used to Recover Memory Behind Enabled Spaces





To avoid memory scrubbing problems, reflection size must be 4 GB maximum. The highest address of the reflection is restricted to end on a 4-GB boundary. Both the highest address in the MIR and the reflection of address FFFF_FFFFh must appear just below a 4-GB boundary (Nx4GB - 1). This ensures that the address bits A[31:0]# are the same for the reflection of an address and the original.

The physical memory mapped by MIR1 to 2 to 4 GB can also be mapped to 6 to 8 GB by MIR2. MIR2/MIT2 is programmed identically to MIR1/MIT1 except for a start address of 6 GB. BIOS only informs the O/S about the memory in the lower image that is not covered by Firmware or MMIO, and the remaining physical memory in the upper image. The physical memory "behind" MMIO and System space in the lower image can be addressed in the upper image. The O/S will not allocate memory for the regions that are not reported. If an address were (illegally) generated for the lower portion of MIR2, it would address the same locations as Memory Block1. To improve the ability of the E8870 chipset to detect illegal addresses, the size of the reflection should be no larger than required to accommodate MMIOL expansion.

The interleaving used behind MMIOL must be the same as the interleaving in the reflected range. For example, if the memory behind MMIOL is interleaved across four DIMMs, the same four DIMMs must be mapped in the reflection. This requires four spare MIRs on whatever SNCs map those DIMMs.

To avoid memory scrubbing problems, reflections are limited to 4 GB in size. The highest address of the reflection is restricted to end on a 4-GB boundary. Both the highest address in the MIR and the reflection of address FFFF_FFFFh must appear just below a four GB boundary.

4.2 Memory Address Disposition

4.2.1 Registers Used for Address Routing

4.2.1.1 SNC Registers

Table 4-2. SNC Memory Mapping Registers

Name	Function	
MAR[5:0]	Defines attributes of individual Compatibility ranges. Supports shadowing by routing reads and writes to Memory or PCI.	
MIR[7:0]	Identifies cache lines located on this node.	
MMIOL_BAS,MMIOL_LIM	Defines the size of the Memory Mapped I/O Region below 4 GB.	
MMIOH_BAS,MMIOH_LIM	Defines the size of the Memory Mapped I/O Region above 4 GB.	
ASE	Contains enable bits for VGA, and other ranges and local-firmware.	
MMCFG	Defines the location of the Memory Mapped Configuration range.	

4.2.1.2 SPS Registers

Each SP has a copy of these registers. Addresses that do not hit inside the MIR are sent to the compatibility bus.



Table 4-3. SPS Memory Mapping Registers

Name	Function
MIR[5:0]	Defines the home node for each cache line of main memory.
MMIOLS	Splits the low MMIO range into subranges that are routed to different SIOHs.
MMIOHS	Splits the high MMIO range into subranges that are routed to different SIOHs.
VGA_PORT	Defines the port number of the SIOH that holds the VGA bus.
CB_PORT	Defines the port number of the SIOH that holds the compatibility bus.
SARS	Splits the SAR range into subranges that are routed to different SIOHs.
IOPORTS	Splits the I/O space into subranges that are routed to different SIOHs.
IOH_MAP	Defines the two ports that may have SIOHs attached.

4.2.1.3 SIOH Registers

Table 4-4. SIOH Memory Mapping Registers

Name	Function
MMIOSL[5:0]	Defines the range of Memory Mapped I/O Region for each Hub Interface < 4 GB.
MMIOSH[5:0]	Defines the range of Memory Mapped I/O Region for each Hub Interface > 4 GB.
MMIOBL, MMIOLL	Defines the total range of Memory Mapped I/O Region that is < 4 GB.
MMIOBH, MMIOLH	Defines the total range of Memory Mapped I/O Region that is > 4 GB.
IOCTL	Defines Compatibility and VGA Hub Interface ports.
SSEG[5:0]	Sub-divides the SAPIC range allowed to an SIOH into 9 sub-ranges. Each 16-bit Hub Interface gets two subranges, The 8-bit Hub Interface gets 1.
IOL[5:0]	Defines the range per Hub Interface port of I/O space.

4.2.1.4 Routing by SP Attribute

The E8870 chipset routes requests according to the type and address of the request and chipset configuration register settings. In order to simplify routing, some E8870 chipset components pass destination information to others in non-coherent request packets. Coherent accesses do not use the Attr field for routing. This destination information is encoded in the Attr field of the request packet. Subsequent components will route according to the Attr field. Refer to Table 4-5 for the destination encoding used for routing by the chipsets.

Table 4-5. Destinations (ATTR)

Destination	Encoding	Description
DND	0000	Destination not decoded. This field is not used for routing requests of this type.
VGA	0101	Graphics cards.
DRAM	0011	Main memory.
MMIO	0010	Memory mapped I/O.
СВ	0100	Compatibility bus.
INT	0001	Interrupt to be delivered to processor bus.



Any other encodings are treated as DND. That is, they are not used for routing. The Attr field is not used in the routing of coherent requests.

The following tables define the address disposition for the E8870 chipset. Table 4-6 defines the disposition of outbound requests entering the SNC on the processor bus. Table 4-8 defines the disposition of inbound requests entering the SIOH on hublinks.

Table 4-6. Address Disposition for Processor

Address Range	Conditions	SNC Behavior	SPS Behavior
DOS	0h to 09_FFFFh	Coherent Request to Main Memory	Route to SNC according to MIR registers. Apply Coherence Protocol.
VGA/MDA	(0A_0000h to 0A_FFFFh or 0B_8000h to 0B_FFFFh) and VGASE = 0.	Coherent Request to Main Memory	Route to SNC according to MIR registers. Apply Coherence Protocol.
	0B_0000h to 0B_7FFFh and VGASE = 0 and MDASE = 0.		
	(0A_0000h to 0A_FFFFh or 0B_8000h to 0B_FFFFh) and VGASE = 1.	Issue non-coherent Read/ Write to SP, Attr = VGA	Route to SIOH node specified by VGA_PORT register.
	0B_0000h to 0B_7FFFh and MDASE = 0 and VGASE = 1.		
	0B_0000h to 0B_7FFFh and MDASE = 1.	MDA: Issue non-coherent Read/ Write to SP, Attr = CB	Route to SIOH node in CB_PORT register.
C and D BIOS Segments	0C_0000h to 0D_FFFFh and MAR = 11	Coherent Request to Main Memory	Route to SNC according to MIR registers. Apply Coherence Protocol.
(See Table 4-1 for a definition of MAR encodings)	Write to 0C_0000h to 0D_FFFFh and MAR = 10		
	Read to 0C_0000h to 0DFFFFh and MAR = 01		
	Read to 0C_0000h to 0D_FFFFh and MAR = 10	Issue non-coherent Read/ Write to SP, Attr = CB	Route to SIOH node specified by CB_PORT register.
	Write to 0C_0000h to 0D_FFFFh and MAR = 01		
	0C_0000h to 0D_FFFFh and MAR = 00		
E and F BIOS Segments (See Table 4-1 for	0E_0000h to 0F_FFFFh and MAR=11 (SNC MARs must be set to this value.)	Coherent Request to Main Memory	Route to SNC according to MIR registers. Apply Coherence Protocol.
a Definition of MAR encodings)	Writes to 0E_0000h-0F_FFFFh and MAR = 10.		
	Reads to 0E_0000h-0F_FFFFh and MAR = 01.		
	Writes to 0E_0000h-0F_FFFFh and MAR = 01.	If LPC is enabled ^a , set A[21:20] and issue requests	Route any SP request to SIOH node specified by CB_PORT register.
	Reads to 0E_0000h-0F_FFFFh and MAR = 10.	to LPC, else, Issue non-coherent Read/	
	0E_0000h-0F_FFFFh and MAR=00	Write to SP, Attr = CB	



Table 4-6. Address Disposition for Processor (Continued)

Address Range	Conditions	SNC Behavior	SPS Behavior
Low MMIO	Above MMIOL.BASE ^b to FDFF_FFFFh.	Issue non-coherent Read/ Write to SP, Attr = MMIO	Route to SIOH according to MMIOLS.
E8870 Chipset Specific	FE00_0000h to FEBF_FFFFh AND valid SNC memory mapped register address	Issue configuration access to memory mapped register inside SNC.	N/A
	FE00_0000h to FEBF_FFFFh AND NOT a valid SNC memory mapped register address.	Issue non-coherent Read/ Write to SP, Attr = CB (Master Abort)	Route to SIOH node specified by CB_PORT register.
SAPIC Registers	FEC0_0000 to FECF_FFFFh	Issue non-coherent Read/ Write to SP, Attr = MMIO	Route to SIOH according to SARS.
Reserved	FED0_0000h to FEDF_FFFFh	Writes are dropped without SP issue. for reads: Issue non-coherent Read to SP, Attr = CB (Master Abort)	Route PRNCs to SIOH node specified by CB_PORT register.
Interrupt	Interrupt transaction to FEE0_0000h - FEEF_FFFFh (not really memory space).	See Table 4-7	See Table 4-7
	Memory transaction to FEE0_0000h to FEEF_FFFFh	Issue non-coherent Read/ Write to SP, Attr = CB (Master Abort)	Route to SIOH node specified by CB_PORT register.
Reserved	FEF0_0000h to FEFF_FFFFh	Issue non-coherent Read/ Write to SP, Attr = CB (Master Abort)	Route to SIOH node specified by CB_PORT register.
Global Firmware	FF00_0000h to FFBF_FFFFh	Issue non-coherent Read/ Write to SP, Attr = CB	Route to SIOH node specified by CB_PORT register.
Local Firmware	FFC0_0000h to FFFF_FFFFh	If LPC is enabled, issue LPC access, else, Issue non-coherent Read/Write to SP, Attr = CB	Route any SP request to SIOH node specified by CB_PORT register.
High MMIO	Enabled MMIOH.BASE ^c to FF_FFFF_FFFFh	Issue non-coherent Read/ Write to SP, Attr = MMIO	Route to SIOH according to MMIOHS.
MMCFG	64 MB above enabled MMCFG.BASE ^d .	Access SNC register, or issue configuration Read/Write to SP.	Route like any other configuration Read/Write.
Main Memory	All other Conditions	Coherent Request to Main Memory.	Route to SNC according to MIR registers. Apply Coherence Protocol.

The local firmware hub can be disabled by the LPCEN strapping pin or a bit in the SNC SNCINCO register.

See the MMIOL (Low Memory Mapped I/O Space Register) in Section 3.6.4, "MMIOL: Low Memory Mapped I/O Space Register."

See the MMIOH (High Memory Mapped I/O Space Register) in Section 3.6.3, "MMIOH: High Memory Mapped I/O Space Register."

See the MMCFG (Memory Mapped Configuration Space Register) in Section 3.6.6, "MMCFG: Memory Mapped Configuration Space Register."



Table 4-7. Intel[®] E8870 Chipset SAPIC Interrupt Message Routing and Delivery

Source	Туре	Routing
SIOH	Physical Directed	Delivered to SNC with Nodeld = A[8:4]#. Message is presented directly on processor bus.
	Physical Redirectable	Delivered to SNC with Nodeld = A[8:4]#. Redirection is performed by the SNC.
SNC, Nodeld = A[19:15]#	Physical Directed	SNC completes transaction. The interrupt is not sent to the SP, because destination node = source node of interrupt.
	Physical Redirectable	Redirection is performed by the SNC.The interrupt is not sent to the SP because destination node = source node of interrupt.
SNC, Nodeld != A[19:15]#	Physical Directed	SNC delivers to SP, where the message is delivered to SNC with Nodeld = A[8:4]#. Message is presented directly on processor bus at the destination node.
	Physical Redirectable	SNC delivers to SP, where the message is delivered to SNC with Nodeld = A[8:4]#. Redirection is performed by the SNC on the destination node.

4.2.2 Inbound Transactions to SIOH

 Table 4-8.
 Address Disposition for Inbound Transactions

Address Range	Inbound Writes	Inbound Reads	SIOH Behavior for Inbound	SPS Behavior
0h to 09_FFFFh	DRAM	DRAM	Issue Coherent Request to SP.	Route to SNC according to MIR registers. Apply Coherence Protocol.
(0A_0000h to 0A_FFFFh or 0B_8000h to 0B_FFFFh) AND (VGA_port = none)	DRAM	DRAM	Route to SPS, Attr = DRAM.	Route to SNC according to MIR registers. Apply Coherence Protocol.
(0A_0000h to 0A_FFFFh or 0B_8000h to 0B_FFFFh) AND (VGA_port = none)	Unclaimed	Unclaimed	Master Abort.	N/A
(0A_0000h to 0A_FFFFh or 0B_8000h to 0B_FFFFh) AND (VGA_port = local)	VGA Port	Unclaimed	Writes: Local peer-to-peer to VGA. Reads: Master Abort.	N/A
(0A_0000h to 0A_FFFFh or 0B_8000h to 0B_FFFFh) AND (VGA_port = remote)	VGA Port	Unclaimed	Writes: Remote peer-to-peer to VGA port. Reads: Master Abort.	Route to SIOH node specified by VGA_PORT register.
OB_0000h to OB_7FFFh and (MDA_en = 1) and (CB_local = 1)	CB Port	Unclaimed	Writes: Local peer-to-peer to CB. Reads: Master Abort.	N/A
OB_0000h to OB_7FFFh and (MDA_en = 1) and (CB_local = 0)	CB Port	Unclaimed	Writes: Remote peer-to-peer to CB port. Reads: Master Abort.	Route to SIOH node specified by CB_PORT register.
OB_0000h to OB_7FFFh and (MDA_en = 0) and (VGA_port = local)	VGA Port	Unclaimed	Writes: Local peer-to-peer to VGA port. Reads: Master Abort.	N/A
0B_0000h to 0B_7FFFh and (MDA_en = 0) and (VGA_port = remote)	VGA Port	Unclaimed	Writes: Remote peer-to-peer to VGA port. Reads: Master Abort.	Route to SIOH node specified by VGA_PORT register.
0B_0000h to 0B_7FFFh and (MDA_en = 0) and (VGA_port = none)	Unclaimed	Unclaimed	Master Abort both reads and writes.	N/A



 Table 4-8.
 Address Disposition for Inbound Transactions (Continued)

Address Range	Inbound Writes	Inbound Reads	SIOH Behavior for Inbound	SPS Behavior
0B_0000h to 0B_7FFFh and (MDA_en = 0) and (VGA_port = none)	DRAM	DRAM	Route to SPS, Attr=DRAM.	Route to SNC according to MIR registers. Apply Coherence Protocol.
0C_0000h to 0F_FFFFh	DRAM	DRAM	Issue Coherent Request to SP.	Route to SNC according to MIR registers. Apply Coherence Protocol.
10_0000h to MMIOBL	DRAM	DRAM	Issue Coherent Request to SP.	Route to SNC according to MIR registers. Apply Coherence Protocol.
10_0000h to MMIOBL	Unclaimed	Unclaimed	Master Abort.	N/A
(MMIOBL< Address <= MMIOLL) AND NOT (MMIOSL[5] < ADDRESS <= MMIOSL[0])	Peer-peer to remote SIOH	Unclaimed	Reads: Master Abort. Writes: Route to SP, Attr = MMIO.	Route to SIOH according to MMIOLS.
MMIOSL[5] < ADDRESS <= MMIOSL[0]	Peer-peer to local SIOH	Unclaimed	Reads: Master Abort. Writes: Route to correct HI based on MMIO and SAPIC range registers.	N/A
LDD rongo		Writes: Route to HI if match with SAR range, else send to SPS,	Route to node based on SARS.	
FED0_0000h to FEDF_FFFFh	Unclaimed	Unclaimed	Master Abort.	N/A
FEE0_0000h to FEEF_FFFFh	Turned into Interrupt transaction on processor bus	Unclaimed	Reads: Master Abort Writes: Forward to SP, Attr = INT.	Forward to correct node based on node ID of register CBC, this gets turned into an interrupt by SNC.
FEF0_0000h to FEFF_FFFFh	Unclaimed	Unclaimed	Master Abort.	N/A
(FF00_0000h to FFBF_FFFFh) AND CB is in local SIOH	ICH4 BIOS	Unclaimed	Reads: Master Abort. Writes: Attr = CB; send to CB based on IOCTL.	N/A
(FF00_0000h to FFBF_FFFFh) AND CB is in remote SIOH		Unclaimed	Reads: Master Abort. Writes: Route to SP, Attr = CB.	Route to SIOH node specified by CB_PORT register.
FFC0_0000h to Illegal Illegal Illegal		Illegal	Master Abort.	N/A
Above 1_0000_0000h AND DRAM DRAM Coherent Required (MMIOBH < ADDRESS <= MMOILH)		Coherent Request.	Route to SNC according to MIR registers.	
MMIOSH[5] < ADDRESS <= MMIOSH[0]	Peer-peer to local SIOH	to local Writes: Route to correct HI based		N/A
(MMIOBH< Address <= MMIOLH) AND NOT (MMIOSH[5] < ADDRESS <= MMIOSH[0])	Peer-peer to remote SIOH	Unclaimed	Reads: Master Abort. Writes: Route to SPS, Attr = MMIO.	Route to SIOH according to MMIOHS.



4.2.3 Local/Remote Decoding for Requests to Main Memory

The SNC treats all accesses to main memory as coherent. For main memory accesses, the address is compared against the local MIR registers to determine whether it accesses local memory or memory on a different node. Generally, for local accesses, the SP request is just a snoop, and any memory access is performed by the memory controller. For remote memory accesses, the SP request will include a read or write to the home node.

Local memory requests are serviced by the SNC memory controller.

4.2.4 Default SP Requirement in Single Node

The default SP port on the SNC and SIOH select which of the two SP ports is used for most I/O (including memory mapped) and special transactions. It also controls the interleaving between SP ports for coherent (to main memory) accesses.

For single node systems, the default SP that is programmed into the SNC and the SIOH need to match. While changing default SPs, there may be a small window where they are different, but software should make them the same as soon as it can. For example, if the SNCINCO.DefaultSP was changed to 1, then the default SP in the SIOH (IOCTL.Default_SP) must be changed as soon as possible after it is known to be a single node configuration. During this window, there should not be any inbound I/O activity.

4.3 I/O Address Map

4.3.1 Special I/O addresses

Three classes of I/O addresses are specifically decoded by the E8870 chipset:

- I/O addresses used for MDA controllers. These addresses are specifically decoded so they can be mapped to the CB bus.
- I/O addresses used for VGA controllers. Some of these are also MDA addresses. MDA remapping takes precedence over VGA remapping.
- I/O addresses used for the PCI Configuration Space Enable (CSE) protocol. The I/O addresses 0CF8h and 0CFCh are specifically decoded as part of the CSE protocol.

The legacy 64 KB I/O space actually was 64 KB+3 bytes. For the extra 3 bytes, A[16]# is asserted. The E8870 chipset decodes only A[15:3]# when the request encoding indicates an I/O cycle. Therefore, accesses with A[16]# asserted are decoded as if they were accesses to address 0 and have been forwarded to the compatibility bus. The full address is sent to the SIOH and the P64H2 or ICH4.

At power-on, all I/O accesses are mapped to the compatibility bus.

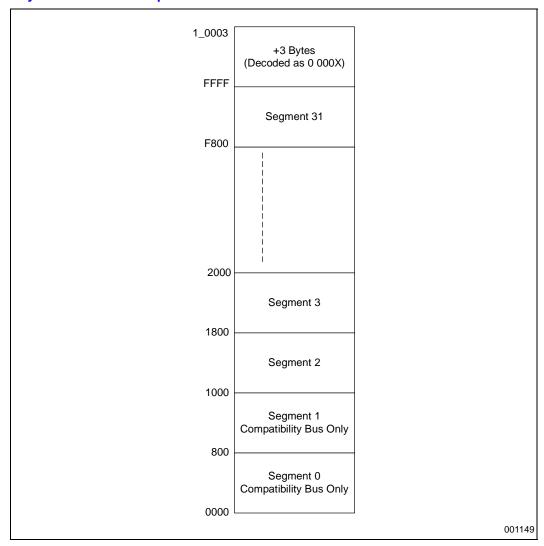
^{1.} The SNCs MIRs define local interleave ranges. The SPS's MIRs define global interleave ranges.



4.3.2 Outbound I/O Access

The E8870 chipset allows I/O addresses to be mapped to resources supported on the I/O buses underneath the E8870 chipset controller. This I/O space is partitioned into 32 2KB segments. Each of the I/O buses can have from 0 to 32 segments mapped to it. Each PCI bus gets contiguous blocks. All PCI buses on a given SIOH must be assigned contiguous blocks. The lowest block, from 0 to 0FFFh, is always sent to the compatibility bus.

Figure 4-6. System I/O Address Space



4.3.2.1 Outbound I/Os

The SNC applies these routing rules in order: (A[2:0]# for the following is not physically present on the processor bus, but are calculated from BE[7:0])

1. I/O Addresses Used for MDA Controllers:

If the MDASE bit in the ASE register is set, and any of the bytes addressed meet this test (A[15:10] are ignored for this decode): A[9:0] = 3B4h, 3B5h, 3B8h, 3B9h, 3BAh, or 3BFh, an I/O Read/Write will be sent out the default SP with Attr = CB. For example, a 4-byte read



starting at 53BCh includes 53BC-53BFh. Since A[9:0] = 3BFh for 53BFh, it should be routed to CB.

2. I/O Addresses Used for VGA Controllers:

If the VGASE bit in the ASE register is set, and each addressed byte is in the following range (A[15:10] are ignored for this decode): A[9:0] = 3B0h-3BBh, 3C0h-3DFh, an I/O Read/Write will be sent out the default SP with Attr=VGA. For example, a 2-byte read starting at 23BBh includes 23BB-23BCh. Since A[9:0] = 3BCh (not one of the VGA bytes), the access is not routed to VGA.

3. Configuration Accesses:

If a request is a DW accesses to 0CF8h (see CFGDAT register) and 1 to 4B accesses to 0CFCh with configuration space is enabled (see bit 31 of CFGADR register), the request is considered a configuration access. If the device and bus match the SNC, it will cause an internal configuration access. If not, a configuration Read/Write is sent to the SP.

4. ISA Aliases:

If the ASE.ISAEN is set, addresses X100h-X3FFh, X500h-X7FFh, X900h-XBFFh, and XD00h-XFFFh will result in a I/O Read/Write sent out the default SP with Attr = CB.

5. Redirection to Compatibility:

The SNC IORD register enables any 4KB aligned pair of 2KB segments of the I/O space to be redirected to the compatibility bus. The SNC will issue I/O Read/Write with Attr = CB.

6. Otherwise, an I/O Read/Write is sent to the SPS with Attr = DND.

The SPS will:

- Send I/O Read/Writes with a Attr of VGA to the port as determined by VGA_PORT.
- Send I/O Read/Writes with a Attr of CB to the port as determined by CB_PORT.
- Send I/O Read/Writes accesses to the correct port according to IOPORTS and SIOH_MAP registers.

The SIOH will forward accesses as follows:

- I/O Read/Writes with Attr = VGA are sent to the VGA link defined in the IOCTL register. If no VGA link is defined, the SIOH master aborts.
- I/O Read/Writes with Attr = CB are sent to the compatibility bus link. If the CB enable is not set in the IOCTL register, SIOH master aborts.
- I/O Read/Writes with Attr = DND are sent to the link defined by the IOL register. The IOL register must be configured to route addresses less than 1000h to the compatibility bus. If the request falls outside the I/O range defined by the IOL, the SIOH master aborts.

4.3.3 Inbound I/Os

Inbound I/Os are not supported. The E8870 chipset does not support peer-to-peer reads or writes to I/O space. Any Inbound I/O access that makes it to Hub Interface will receive a master abort response.

4.4 Configuration Space

The P64H2 and ICH4 will not accept PCI Configuration Cycles. The SIOH will master abort any configuration cycles on Hub Interface.



The E8870 chipset provides memory mapped configuration mechanisms. See Section 4.1.4, "Memory Mapped Configuration Space" and Section 4.1.2.4, "Chipset Specific Range."

4.5 Illegal Addresses

4.5.1 Master Abort

The term "master abort" is used in E8870 chipset specifications as shorthand for "Reads return all 1's. Writes have no effect." The SNC will master abort processor transactions by one of the following methods:

- Re-directing them to the compatibility bus. That is, a non-configuration Read/Write will be routed out an SP with the Attr field set to "CB".
- Dropping writes without SP issue or memory update.
- Dropping 0 length transactions.

When the SNC must master abort a SP request, it sets the response status bits to "master abort."

When the SNC receives a master abort response status to a read request, it must provide all 1's data on the processor bus. When a write returns a master abort response, the write is completed as usual.

4.5.2 Processor Requests

If the SNC has no memory mapped to this address in systems without an SPS (Address matches no MIR when SPBS bit in CBC register is set), memory writes and IWBs will be dropped without SP issue or memory access. Memory reads with clean snoop response will return all 1's. The Illegal Outbound Address bit will be set in the FERRST or SERRST register.

4.5.3 Scalability Port Requests

The SNC will check the address of any SP requests that may require a memory access against the MIRs. If the SP request falls outside the memory supported on that SNC, no memory access or processor bus request will be issued. If the request is a speculative memory read, it will be dropped. Any SP request that requires a response will set the response status to master abort.

A configuration Read/Write whose bus number and device ID do not match CBC.BusID and CBC.NodeID respectively will not cause a configuration access. It will receive the usual response with response status = master abort.

System Address Map



Memory Subsystem

5

The memory subsystem consists of:

- · Memory controller and data buffers
- DDR-SDRAM memory hub interface component (DMH) and DDR DIMMs

Table 5-1. General Memory Characteristics

Item	Description
DRAM Types	DDR-SDRAM
Memory Modules	72-bit DDR-SDRAM DIMMs
DRAM Technologies	128, 256, 512 Mb and 1 Gb ^a densities
Speed Grades	DDR: Tcas = 1.5, 2.0, 2.5. Trcd = 20, 30, 40 ns
Peak Bandwidth	6.4 GB/s
Interface	Four main channels operated in parallel
Maximum Memory	128 GB (1 Gb DDR-SDRAM)
Minimum Memory	512 MB (128 Mb DDR-SDRAM)

a. 1Gb devices are not validated at the time of writing.

The memory subsystem architecture requires that all memory control reside in the SNC, including memory request initiation, refresh, configuration access and power management.

The timing of all accesses is completely controlled by the SNC.

The memory controller will re-order accesses to minimize bubbles due to page replacement and read/write transitions. Reads may pass writes. Read data to the same address as a pending write will be supplied from SNC data buffers; so that the write need not be flushed to memory before issuing the read.

5.1 Memory Controller Operation

5.1.1 Memory Arbitration

Only in rare cases does arbiter bandwidth limit performance. The memory decoder can accept one request each cycle. This rate may fall behind memory issue in some circumstances since processor requests to remote memory must be discarded. For balanced loads in a four-node system, 75% of local requests may be remote. For the Itanium 2 processor, one request can be forwarded every four cycle. Memory requests can be handled by the copy engine when a read hits a posted writes, but can only dispatch one request every eight cycles.

The memory controller accepts requests from the processor bus, Remote Memory Request Queue and Local Memory Request Queue. Processor requests are granted priority access to the decoder so that processor request service is simplified by having a fixed pipeline. The processor request does not take up more than 1/3 of the decoder bandwidth because of their limited issue rates. Whenever a processor request is not present, remote and local requests are granted in a round-robin fashion.



5.1.2 Reads

5.1.2.1 Read Decoding

The request is decoded for interleave range, then for targeted memory resources (channel, device/DIMM row, DRAM row, DRAM column) and destination. If a read does not fall in a range covered by the SNC MIRs (a "MIR miss", see Section 3.6.9, "MIR[9:0]: Memory Interleave Range Registers"), the memory controller will drop the request. A MIR miss on a processor request means the addressed memory is in another SNC, or the access was a programming error. SP initiated MIR misses can only occur due to mis-configuration or address corruption.

5.1.2.2 Read to Same Line as a Posted Write

In parallel with the decode, the read address is compared against the posted writes waiting in the write request buffer. If there is a match, the data in the buffer allocated to the most recent write, which is copied to the data buffer allocated to the read.

5.1.2.3 Read Issue in the Idle Case

If the read is not to the same address as a posted write, and no older enqueued to be issued, the memory read is issued without conflict check to the memory array.

5.1.2.4 Read Cancellation

The memory controller performs speculative reads for any processor read request that decodes to local memory or whenever a speculative memory read is received on the SP. If they have not advanced beyond the arbitration stage where they are committed to issue, they may be canceled. This happens if the processor request receives an implicit write-back response or a speculative memory read cancel request on the SP. It can also happen whenever a coherency conflict is detected, or a processor transaction is retried. In the idle case, a cancellation is rarely in time to prevent issue, but under load, when reads accumulate in the re-order buffers, the cancellation can save memory bandwidth. If a cancel is issued too late, the returned data will not be used.

5.1.2.5 Read Queueing

There is a 31 entry read queue and four two-entry re-order queues. When there are 27 reads in the read queue, BPRI# will be asserted and the remote memory queue will not be popped until the level of the queue drops to 20.

5.1.2.6 Read Re-Ordering

The SNC always issues the critical main channel packet (MCP) first. That is, the addressed byte always appears in the first of the two MCP packets issued to satisfy a processor memory read.

If an older read is ready to issue, or the required memory resources are busy, the read will be sorted into one of four re-ordering queues. The reads are sorted so that all accesses with timing dependencies on each other will appear in the same queue. The reads at the head of the re-ordering queues are checked in round-robin order for resource conflicts against outstanding accesses. Requests with timing conflicts are not selected for issue.

Table 5-2 defines how the queues are indexed. The least significant index is the channel bit if the cache line interleave in the range of interest may cross channels. If the interleave stays on one DIMM, the least significant index is Bank[1].



Table 5-2. Indices to Re-Ordering Queues

Index	DDR
index	All Cases
1	Bank[0] is selected.
0	If all bits of MIR.WAY are set, Bank[1] is selected; If not, Channel[0] is selected.

5.1.3 Writes

5.1.3.1 Write Decoding

Writes are decoded for interleave range, then for targeted memory resources (channel, device/SDRAM row, DRAM row, DRAM column) and destination. If the write is not in any range described by the MIRs on that SNC (a "MIR miss", see Section 3.6.9, "MIR[9:0]: Memory Interleave Range Registers"), the memory controller will drop the request. The scalability port protocol cluster is informed of processor initiated MIR misses (must be a remote access or addressing error), so that it will request data from the other node. The scalability port protocol cluster has a dedicated copy of the MIR decoder to verify that an SP initiated write hits memory supported by that SNC. Otherwise, the Illegal Address bit in the FERRST register is set.

If no reads are ready to be issued, the memory resources accessed by the new request are compared against the resources used by outstanding transactions. If no timing conflict exists, and data is ready in the data buffer, the write request is eligible for issue to the memory array.

5.1.3.2 Write Posting Queue

If the write is not immediately issued, it is stored in a Write Posting Buffer. This buffer can hold 64 writes. If there are 60 writes in this buffer, BNR# will be asserted, and SNC will stop accepting requests. All but three posted writes are guaranteed to complete as long as the memory controller stops accepting reads (see Section 5.1.3.3, "Write Re-Ordering"). When the number of writes drops below 56, BNR# will be deasserted and the SNC will start accepting writes again.

Once SNC posts a write, it guarantees that data is provided to subsequent reads, as if the write to memory had already taken place.

Reads to the same address as a posted write are handled as described in Section 5.1.2.2, "Read to Same Line as a Posted Write."

5.1.3.3 Write Re-Ordering

Writes are selected from the posted write buffer in FIFO order and stored in one of four re-ordering queues. The writes at the head of the re-ordering queues are checked in round-robin order for resource conflicts against outstanding accesses. Since the writes in different queues are guaranteed to access independent resources, selecting them from queues in round-robin order reduces conflicts. Table 5-2 defines how the queues are indexed.

5.1.3.4 Write Flushing

The Minimum Write Burst Length bit in the Memory Control register (MC.MWBL) controls a write bursting optimization. If this bit is not set, writes are not required to meet a quota before being issued. They will be issued to the memory as long as no reads are issued.



If this bit is set, the SNC will accumulate writes before bursting them:

Whenever no reads are ready to be issued, and a sufficient interval has elapsed since the last
read to allow a write to be issued immediately, and there are four writes to flush, at least four
writes will be issued. This burst will continue until all writes are completed or a read is
accepted by the memory controller. According to this policy, up to three writes can be posted
indefinitely in the SNC.

MC.MWBL can be cleared to flush writes in the SNC.

Each DMH can hold up to eight writes. In order to flush all these writes to memory, software must issue eight writes to different cache lines. Ideally these will be full-line writes, because partials will cause a read-modify-write sequence in memory that may be undesirable. Writes to different lines will avoid processor bus retries and write combining of partials in the SNC.

5.1.3.5 Partial Writes

The SNC is optimized for cache line writes and reads. For write operations of less than a cache line in size, the SNC will perform a read-modify-write cycle in the DRAM, by merging the write data with the previously read data. The SNC only handles one partial write at a time. The SNC does not post partial writes until the merge is complete. During the merge, any processor access to the same line as a partial write will be retried.

5.2 Error Correction

To correct errors in memory, the memory controller will "walk" the MIR registers, reading, then writing each location. When an error is detected, the memory controller will log the address and syndrome, signal a correctable error on the error pins, and write back the corrected or poisoned (for non-correctable) value to memory. A non-correctable memory error uncovered by the scrub engine is not a fatal error.

Scrubbing will be disabled by default. To enable this function, the Scrub Enable bit in the MTS register (see Section 3.7.7, "MTS: Memory Test and Scrub Register") must be set.

5.2.1 Scrub Address Generation

One location is scrubbed every 64-K cycles. The scrub engine starts with MIR[0]. Base and scrubs each address defined by MIR[0]. Ways until it reaches the highest address in the Interleave Range specified by MIR[0]. Base and MIR[0]. Size. Then it scrubs the addresses covered by MIR[1] and so on, until all the addresses defined by all the MIR registers are scrubbed. Disabled MIRs (Ways=0000) are skipped. When all MIRs are scrubbed, it starts over with MIR[0].

The SNC must perform the scrub read-modify-write atomically. That is, they must be enqueued back-to-back to ensure that no system write is ordered between them. If this happens, the scrub may overwrite a system write. To detect such a conflict, addresses of scrub writes are compared against processor writes. The processor bus addresses are compared rather than the decoded memory address (row, column, bank).

When reflection is used to recover memory "behind" the range from the bottom of MMIOL to 4 GB, multiple MIRs can describe different addresses that select the same physical memory location. Section 4.1.5.4, "Recovering Main Memory Behind Other Regions: Reflections" describes this technique.



The operating system guarantees that only one of these addresses will be generated by a processor. No conflict will be detected between a processor write to the legitimate address and a scrub write to the alias. Therefore, the scrub engine must not generate writes to the aliases. Use of reflections are limited to recovering memory behind MMIOL to allow scrub hardware to identify these aliases. Then there are only two cases of aliases, addresses in the range MMIOL.BASE - 4 GB, and the complementary range in any MIRs used for the upper reflection. To avoid these aliases, the scrub engine will not generate writes to these two address ranges:

 $(A[43:32] = 000h) \ AND \ (FFh >= A[31:24] > MMIOL.BASE) \\ MIT.RFLCT \ AND \ (A[31:24] <= MMIOL.BASE)$

The MIT.RFLCT bit will be set for any MIR used for MMIOL reflection. The top of the reflection is restricted to end on a 4-GB boundary so to eliminate addresses in the reflected range which may or may not be aliases. The reflection of the range from MMIOL.BASE to 4 GB is scrubbed, but no other addresses in the reflected MIR.

5.2.2 Correction for System Accesses

Correctable errors found in normal read traffic will be corrected and forwarded to the processor bus or SP, but not written back to memory. Any error remains in memory until they are scrubbed. One data buffer will be reserved for the scrub engine, so that it does not need to perform data buffer allocation.

Data from memory normally does not flow through correction logic. If the SNC encounters an error, data flow will switch to a "correction pipe" with longer latencies. The SNC will continue to deliver data with a longer latency until a break in traffic allows data flow to be returned to the normal pipe.

5.2.3 Software Scrubs

Since read errors are not corrected immediately, one memory error may result in frequent correctable error interrupts. To reduce the possibility of a second failure producing an uncorrectable error, and to avoid performance loss until the scrub engine reaches the error, software scrub is recommended.

5.2.4 Memory Error Correction Code

The code layout is illustrated in Figure 5-1 and Figure 5-2. Each packet on the four SNC main channels is split into two codewords. The first codeword appears in transfers 0-3, and the second in transfers 4-7. The codeword spans the four SNC main channels, consisting of 32-bytes of data covered by 32 checkbits. An SNC fetch of 128-bytes will be four codewords.

The figures show the position of each data bit (D[255:0]) of the 32-bytes of data and the 32 checkbits (C[31:0]) in each codeword. The least significant 32-bytes of the 64-byte access is transferred first.

Each code word consists of 32 symbols, eight on each of the four main channels. The division of bits into symbols is the same on each channel, but checkbits are assigned to different symbols on different channels. On each main channel, symbols a, b, c, d, e, and f are 8-bit symbols, while g and h are 12-bit. One symbol in each codeword can be corrected. Errors in more than one symbol are not correctable. More than 99.9999% of errors confined to two symbols are guaranteed detected.



Figure 5-1. Error Correction Code Layout on Main Channels 0 and 1

			First Co	deword	S	Second Codeword			
		clk phase 0	clk phase 1	clk phase 2	clk phase 3	clk phase 0	clk phase 1	clk phase 2	clk phase
	—— DQB8 —	D42 g2	D45 g5	D48 g8	D51 g11	D42 g2	D45 g5	D48 g8	D51 g11
_	— DQB7 —	D54 h2	D57 h5	D60 h8	D63 h11	D54 h2	D57 h5	D60 h8	D63 h11
$R^{ig }$ $-$	— DQB6 —	D41	D44	D47	D50	D41	D44	D47	D50
_	— DQB5 —	g1 D33	94 D35	97 D37	g10 D39	g1 D33	D35	97 D37	g10 D39
A -		f1 D25	f3 D27	f5 D29	f7 D31	f1 D25	f3 D27	f5 D29	D31
C	— DQB4 —	e1 D17	e3 D19	e5 D21	e7 D23	e1 D17	e3 D19	e5 D21	e7 D23
	—— DQB3 —	d1 D9	d3	d5 D13	d7	d1 D9	d3	d5 D13	d7
C -	— DQB2 —	c1	с3	c5	c7	c1	c3		c7
$H^{ -}$	—— DQB1 —	D1 b1	D3 b3	D5 b5	D7 b7	D1 b1	D3 b3	D5 b5	D7 b7
_ _	— DQB0 —	C1 a1	C3 a3	C5 a5	C7 a7	C1 a1	C3 a3	C5 a5	C7 a7
A _	DQA8	D53 h1	D56 h4	D59 h7	D62 h10	D53 h1	D56 h4	D59 h7	D62 h10
$N _{-}$	— DQA7 —	D52	D55	D58	D61	D52	D55	D58	D61
N	— DQA6 —	h0 D40	h3 D43	h6 D46	h9 D49	h0 D40	h3 D43	h6 D46	h9 D49
E _		g0 D32	93 D34	g6 D36	99 D38	g0 D32	93 D34	96 D36	99 D38
.	—— DQA5 —	f0 D24	f2	f4	f6 D30	f0 D24	f2 D26	14 D28	f6 D30
-	—— DQA4 —	e0	D26 e2	D28 e4	e6	e0	e2	e4	e6
-	—— DQA3 —	D16 d0	D18 d2	D20 d4	D22 d6	D16 d0	D18 d2	D20 d4	D22 d6
0 —	— DQA2 —	D8 c0	D10 c2	D12 c4	D14 c6	D8 c0	D10 c2	D12 c4	D14 c6
_	— DQA1 —	D0 b0	D2 b2	D4 b4	D6 b6	D0 b0	D2 b2	D4 b4	D6 b6
	DQA0	C0 a0	C2 a2	C4 a4	C6 a6	C0 a0	C2 a2	C4 a4	C6 a6
	— DQB8 —	C10 g2	C13 g5	C16 g8	C19 g11	C10 g2	C13 g5	C16 g8	C19 g11
-	— DQB7 —	D114 h2	D117 h5	D120 h8	D123 h11	D114 h2	D117 h5	D120 h8	D123 h11
$R^{ig }$ $-$	— DQB6 —	C9 g1	C12 g4	C15 g7	C18 g10	C9 g1	C12 g4	C15	C18
A –	— DQB5 —	D105	D107	D109	D111	D105	D107	D109	g10 D111
	— DQB4 —	f1 D97	f3 D99	f5 D101	f7 D103	f1 D97	f3 D99	f5 D101	f7 D103
C		e1 D89	e3 D91	e5 D93	e7 D95	e1 D89	e3 D91	e5 D93	e7 D95
	—— DQB3 —	d1 D81	d3 D83	d5 D85	d7	d1 D81	d3 D83	d5 D85	d7
C -	—— DQB2 —	c1	c3	c5	c7	c1	c3	c5	c7
$H ^{-}$	— DQB1 —	D73 b1	D75 b3	D77 b5	D79 b7	D73 b1	D75 b3	D77 b5	D79 b7
–	—— DQB0 —	D65 a1	D67 a3	D69 a5	D71 a7	D65 a1	D67 a3	D69 a5	D71 a7
	— DQA8 —	D113 h1	D116 h4	D119 h7	D122 h10	D113 h1	D116 h4	D119 h7	D122 h10
$N _{\;-}$	— DQA7 —	D112 h0	D115 h3	D118 h6	D121 h9	D112 h0	D115 h3	D118 h6	D121 h9
N	— DQA6 —	C8	C11	C14	C17	C8	C11	C14	C17
E		g0 D104	93 D106	96 D108	g9 D110	g0 D104	D106	96 D108	g9 D110
.	—— DQA5 —	f0 D96	f2 D98	f4 D100	f6 D102	f0 D96	f2 D98	f4 D100	f6 D102
- -	—— DQA4 —	e0	e2	e4	e6	e0	e2	e4	e6
	—— DQA3 —	D88 d0	D90 d2	D92 d4	D94 d6	D88 d0	D90 d2	D92 d4	D94 d6
1 –	— DQA2 —	D80 c0	D82 c2	D84 c4	D86 c6	D80 c0	D82 c2	D84 c4	D86 c6
		D72	D74	D76	D78	D72	D74	D76	D78
-	—— DQA1 —		b2			60	b2	b4	



Figure 5-2. Error Correction Code Layout on Main Channels 2 and 3

		First Codeword				S	econd C	odewor	d
		clk phase 0	clk phase 1	clk phase 2	clk phase 3	clk phase 0	clk phase 1	clk phase 2	clk phas
	— DQB8 —	D174 g2	D177 g5	D180 98	D183 g11	D174 g2	D177 g5	D180 g8	D183 g11
_	— DQB7 —	D186	D189	D192	D195	D186	D189	D192	D195
Ы	— DQB6 —	h2 D173	D176	h8 D179	h11 D182	h2 D173	h5 D176	h8 D179	h11 D182
$R \mid -$		g1 D165	94 D167	97 D169	g10 D171	g1 D165	94 D167	97 D169	g10 D171
$A \! \mid \! -$	—— DQB5 —	f1	f3	f5	f7	f1	f3	f5	f7
C -	— DQB4 —	D157 e1	D159 e3	D161 e5	D163 e7	D157 e1	D159 e3	D161 e5	D163 e7
-	—— DQB3 —	D149 d1	D151 d3	D153 d5	D155 d7	D149 d1	D151 d3	D153 d5	D155 d7
\sim $ $ $-$	— DQB2 —	D141 c1	D143	D145 c5	D147 c7	D141 c1	D143 c3	D145 c5	D147 c7
<u></u> _	— DQB1 —	D133 b1	D135	D137 b5	D139	D133	D135	D137	D139
H _	— DQB0 —	D125	b3 D127	D129	b7 D131	D125	b3 D127	D129	b7 D131
$A \mid A$		a1 D185	a3 D188	a5 D191	a7 D194	a1 D185	a3 D188	a5 D191	D194
N	—— DQA8 —	h1	h4	h7	h10	h1	h4	h7	h10
-	— DQA7 —	D184 h0	D187 h3	D190 h6	D193 h9	D184 h0	D187 h3	D190 h6	D193 h9
$ \mathbf{N} $ –	—— DQA6 —	D172 g0	D175 93	D178 g6	D181 g9	D172 90	D175 g3	D178 g6	D181 g9
E _	— DQA5 —	D164 f0	D166 f2	D168 f4	D170 f6	D164 f0	D166 f2	D168 f4	D170 f6
L _	— DQA4 —	D156	D158	D160	D162	D156	D158	D160	D162
	— DQA3 —	e0 D148	e2 D150	D152	e6 D154	e0 D148	e2 D150	D152	e6 D154
2		d0 D140	d2 D142	D144	D146	d0 D140	d2 D142	D144	D146
2 -	—— DQA2 —	cO	c2	c4	<u></u>	co	c2	c4	<u></u>
	—— DQA1 —	D132 b0	D134 b2	D136 b4	D138 b6	D132 b0	D134 b2	D136 b4	D138 b6
	—— DQA0 —	D124 a0	D126 a2	D128 a4	D130 a6	D124 a0	D126 a2	D128 a4	D130 a6
	— DQB8 —	C22 g2	C25 g5	C28 g8	C31 g11	C22 g2	C25 g5	C28 g8	C31 g11
_	— DQB7 —	D246 h2	D249 h5	D252 h8	D255 h11	D246 h2	D249 h5	D252 h8	D255 h11
R	— DQB6 —	C21	C24	C27	C30	C21	C24	C27	C30
_		g1 D237	D239	D241	g10 D243	D237	D239	97 D241	g10 D243
$A \mid -$	— DQB5 —	f1 D229	f3 D231	f5 D233	f7 D235	f1 D229	f3 D231	f5 D233	f7 D235
C -	—— DQB4 —	e1	e3	e5	e7	e1	e3	e5	e7
-	— DQB3 —	D221 d1	D223 d3	D225 d5	D227 d7	D221 d1	D223 d3	D225 d5	D227 d7
-	— DQB2 —	D213 c1	D215 c3	D217 c5	D219 c7	D213 c1	D215 c3	D217 c5	D219 c7
—	— DQB1 —	D205 b1	D207 b3	D209 b5	D211 b7	D205 b1	D207 b3	D209 b5	D211 b7
H _	DQB0	D197	D199	D201	D203	D197	D199	D201	D203
Α		a1 D245	D248	a5 D251	a7 D254	a1 D245	D248	a5 D251	D254
N	— DQA8 —	h1 D244	h4 D247	h7 D250	h10 D253	h1 D244	h4 D247	h7 D250	h10 D253
$ \mathbf{N} $	—— DQA7 —	h0	h3	h6	h9	h0 C20	h3 C23	h6	h9 C29
	—— DQA6 —	C20 g0	C23 g3	C26 g6	C29 g9	g0	C23 g3	C26 g6	g9
E _	—— DQA5 —	D236 f0	D238 f2	D240 f4	D242 f6	D236 f0	D238 f2	D240 f4	D242 f6
$L \mid _$	— DQA4 —	D228 e0	D230 e2	D232 e4	D234 e6	D228 e0	D230 e2	D232 e4	D234 e6
	— DQA3 —	D220	D222	D224	D226	D220	D222	D224	D226
3 -		d0 D212	d2 D214	D216	d6 D218	d0 D212	D214	D216	D218
ا ا	—— DQA2 —	cO	c2	C4	<u></u>	co	c2	c4	<u></u>
-	— DQA1 —	D204 b0	D206 b2	D208 b4	D210 b6	D204 b0	D206 b2	D208 b4	D210 b6
	— DQA0 —	D196 a0	D198 a2	D200 a4	D202 a6	D196 a0	D198 a2	D200 a4	D202 a6



The 18 main channel data bits cannot be evenly divided among the eight devices providing the packet (this is why there are some 12-bit symbols and some 8-bit). Therefore, IDM defines a rotating series of eight addresses over which each device drives each symbol.

Since the main channel request lines are duplicated for each of the four main channels, an address error outside the SNC is highly likely to be detected prior to use. If an address error occurs on one channel during a read, that channel will provide data from some other location. This will be detected unless that data happens to form a valid codeword with the data in other channels. If a fault occurs during a write, the error will be detected when that address is read.

The checkbits must be stored in memory so that a device that does not respond to a request produces an illegal code. Since the main channels use open drain technology, the high termination returns all 0's. Therefore the SNC will invert all write data checkbits when they are submitted to the RAC. Read data checkbits will be "un-inverted" when sampled.

When an uncorrectable error is detected in memory write data, the memory ECC is poisoned. This is achieved by inverting symbol g on RAC1 and RAC3.

5.2.5 Memory Device Failure Correction and Failure Isolation

In order to isolate all detectable errors to a Field Replacable Unit (FRU), the data must be partitioned into codewords so that each codeword comes from a single FRU. However, Memory Device Failure Correction (MDFC) can only be achieved when the errors produced by a single device are correctable.

In some cases there are as few as eight devices on an FRU (single-sided DIMM with X8 DRAMs). If a codeword came from the same FRU, and one of those DRAMs failed, one eighth of all the bits in a codeword would be corrupted. This number of errors cannot be corrected with the number of checkbits provided in standard 72-bit DIMMs. Therefore, both MDFC and isolation to the DIMM have not been provided by E8870 chipsets for X8 devices.

5.2.5.1 FRU Isolation

The main channel data packet is provided by a DIMM Row, which is comprised of one DIMM side on each of the four main channels. Isolation information is captured in the REDMEM register. The *channel* field identifies one of the two DDR branches and the *device* field identifies the Chip Select associated with the failed DIMM side on that DDR channel. For uncorrectable errors, only the failed DIMM Row can be reliably isolated. However, if the error was correctable, the locator field will identify the symbol in error.

By consulting Figure 5-1, the main channel on which the error occurred can be identified. This is sufficient to identify the failed DIMM side.

5.2.6 Memory Test

The SNC can autonomously test memory while code is running to support fast boots. The test will initialize memory to legal ECC values. Section 3.7.7, "MTS: Memory Test and Scrub Register" describes the register that controls memory testing. The MIRNUM field in the MTS register defines a Memory Interleave Range to be tested, and MTS.GO bit for run control.

The engine tests memory prior to normal operation. 32 data buffers are not available for normal operation during memory test. The Local, Remote, and Total data buffer quotas must be reduced by this amount. The test engine is local to the memory controller and cannot generate remote memory accesses.



All addresses mapped by the MIR will be tested whether they fall in ranges mapped to main memory or not. For example, addresses will still be tested where the MIR overlaps MMIOL.

Prior to test, the first 32 lines in the MIR must be written with a test pattern. Setting the MTS MTS.GO bit causes the test pattern to be duplicated throughout the range.

The memory controller must be able to service processor requests to addresses outside the test range while memory test is running. When the operation is complete, the go bit is reset. After the go bit is reset, the data at the end of the range can be inspected. If the data values at the end of the range match the values at the beginning of the range before the test, then all locations in the range have been written to the correct values and read out (only the data values for enabled ways should be examined). If the data values do not match, all cache lines above the fault should be corrupted. Binary search of the range will quickly isolate the faulty address. Multiple patterns must be run to stress memory fault mechanisms.

5.3 DDR Organization

DDR organization is shown in Figure 5-3. Up to four DIMMs can be placed on each of the two DDR channels supported by the DMH. Exactly one DMH is placed on each main channel.

5.3.1 DDR Configuration Rules

5.3.1.1 Permissible Configurations

- Exactly one DMH on each main channel.
- The DIMMs off each DMH must be symmetrical with the DIMMs off all the other DMHs. Therefore, each slot must hold the same type of DIMM on DMH 0, 1, 2, and 3. The memory upgrade granularity is the row of four DIMMs, one on each DMH, which collectively provide a cache line.
- 1, 2, 3, or 4 DIMMs of different types can be placed on each DMH DDR channel.
- The two DDR channels on a DMH need not have the same number or type of DIMMs.
- Electrical considerations restrict DIMM placement to be contiguous starting with the furthest slot. Only these configurations will be validated.
- Up to eight different DIMM technologies (banks, rows, columns) are supported. Thus each of the eight possible DIMM rows can be different technologies.



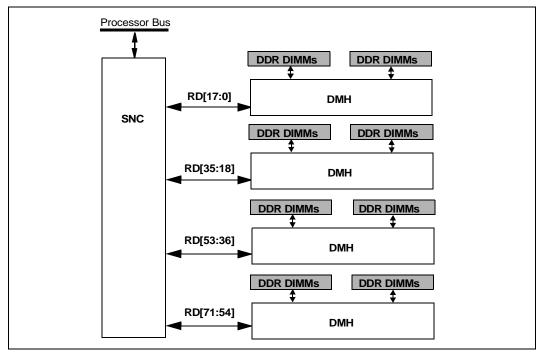


Figure 5-3. Typical DDR-SDRAM Memory System

5.3.1.2 Configuration for Performance

For best performance, the amount of memory on each DMH DDR channel should be the same.

Table 5-3. DDR-SDRAM Total Memory Per SNC

DIMM size	Tota	Total Number of DIMMs in the Memory System						
	4	8	16	32				
16M x 72	512 MB	1 GB	2 GB	4 GB				
32M x 72	1 GB	2 GB	4 GB	8 GB				
64M x 72	2 GB	4 GB	8 GB	16 GB				
128M x 72	4 GB	8 GB	16 GB	32 GB				
256M x 72	8 GB	16 GB	32 GB	64 GB				
512M x 72	16 GB	32 GB	64 GB	128 GB				

5.3.2 DDR Features Supported

5.3.2.1 Write Posting in the DMH

Writes will be posted in the DMH to eliminate the bubble produced when writes must be delayed until read data returns from the DIMMs. When the SNC issues a write, the data from the previous write is sent. This allows write data to be issued on the main channel with the same delay between column command and data as reads.

The DMH can post 512 bytes of data, so it posts four 128-byte writes when connected to the SNC. Writes are posted in an four-deep FIFO queue in the DMH.



The DMH will compare read addresses to the posted writes and substitute queued data for DIMM data with the same timing as a DIMM read. The SNC delays read and write issue on the main channels to avoid timing conflicts on the DDR data bus and in the DRAMs. Since the write issued on main channel causes a write to a different address on the DDR bus, the SNC must use the DDR address for timing conflict checks.

5.3.2.2 DDR Reordering Policies

See Section 5.1.2.6, "Read Re-Ordering" and Section 5.1.3.3, "Write Re-Ordering" for a discussion of SNC re-ordering in general. DDR timing conflict detection for purposes of re-ordering are handled as follows:

The SNC will store the channel, device (DIMM side) and bank of the four most recent reads, writes, or refreshes in four Busy Bank registers. It will issue no requests to the same channel, device and bank as a valid Busy Bank registers. A request in a Busy Bank registers is invalidated:

- Eight cycles after the decision to issue the request.
- When changing from read issue to write issue. The timing must be such that reads in the Busy Bank registers never delay write issue and vice-versa.

As the DMH invariably issues column commands with auto-precharge, the bank is always closed after access. Therefore, the SNC will not issue page hits back to back or give page hits any priority above requests in the other three queues as it does in RDRAM mode. A page hit will conflict with any requests still in the Busy Bank registers and will not be issued until they are invalidated.

Requests to the same channel, but different DIMM side (device) will not be issued until the DIMM data turnaround timing conflict is cleared. For 64-byte accesses, the last request comparison only prevents issue in the slot (RAMBUS packet) after the last request. For 128-byte accesses, the last request comparison prevents issue in the two slots following the last request.

5.3.2.3 Refresh

Regardless of the number of DIMMs installed, the SNC will issue 16 refreshes every 15.6 us. The 16 refresh cycle through all eight DIMM sides and both channels. This will not be synchronized to the RAMBUS maintenance operations.

5.3.2.4 Access Size

The SNC memory read and write commands (MCPs) on main channel perform 128-byte transfers. The four DMHs that provide each transfer must be configured to transfer 32-bytes when connected. When in 32-byte mode, the DMH transfers two main channel data packets for each request. The SNC sets MCP address so that the critical 64-bytes is transferred first.

5.3.2.5 DDR Address Bit Mapping

Each DIMM on an SNC will be assigned a Memory Interleave register. The address bit mapping can be different for each DIMM. DIMMs of the same or different technology may be interleaved. When eight DIMMs are populated, all MIRs will be used. This means that each DIMM can only be interleaved one way.

Within each interleave, address bits are mapped to the channel, device, row, column, and bank bits in different ways depending on the number of DIMM sides in the interleave. For details, see the description of the MIR and MIT registers. The mapping scheme is arranged to minimize the delay associated with address bit mapping.



The minimum configuration is 512 MB: 1 DIMM (total of 128MB) device on each DMH. The maximum configuration is 128 GB: 8 DIMMs (total of 32GB) devices on each DMH.

Table 5-4. Bits Used in MCP Packet for Different DDR Technologies

Technology	Organization	Row Bits	Column Lines	Bank Lines
128 Mb	16M x 8	RA11-RA0	CA9-CA0	B1-B0
120 1010	32M x 4	RA11-RA0	CA11, CA9-CA0	B1-B0
256 Mb	32M x 8	RA12-RA0	CA9-CA0	B1-B0
230 1010	64M x 4	RA12-RA0	CA11, CA9-CA0	B1-B0
512 Mb	64M x 8	RA12-RA0	CA11, CA9-CA0	B1-B0
312 1010	128M x 4	RA12-RA0	CA12,CA11, CA9-CA0	B1-B0
1 Gb ^a	128M x 8	RA13-RA0	CA11, CA9-CA0	B1-B0
1 00	256M x 4	RA13-RA0	CA12, CA11, CA9-CA0	B1-B0

a. 1Gb devices are not validated at the time of writing.

Fixed Field

Table 5-5 shows address bit mapping for various DDR technologies. In order to minimize address mapping hardware, as many address bits as possible are directly mapped to row and column bits in the Fixed field. Note that CA[7,8] and RA[9] do not appear in the Fixed field as they must appear in the interleave field for some cases.

Table 5-5. DDR Address Bit Mapping

Field	Address Line	Row Column or Bank Bits
High-Order Field	43:26	Any bits required by technology, but not in interleave field are assigned to address bits in this order (lsb first): CA[7],CA[8],CA[9],CA[11],CA[12], RA[9],RA[10],RA[11],RA[12],RA[13]
	25	RA[8]
	24	RA[7]
	23	RA[6]
	22	RA[5]
	21	RA[4]
	20	RA[3]
Fixed Field	19	RA[2]
T IXCU T ICIU	18	RA[1]
	17	RA[0]
	16	CA[2]
	15	CA[3]
	14	CA[4]
	13	CA[5]
	12	CA[6]
Interleave Field	11:6	See Table 5-6.

Since the size of the minimum SNC memory access is 64-bytes (one packet on each main channel), address bits below A[6] are not mapped to the main channel packet. SNC always sets CA[0] = 0. Conceivably, the main channel packet could be split into a early and late half, and the DMH could



provide the critical word in the early half of the main channel data packet. However, the SNC does not perform this optimization. All main channel data packets have the same data bit mapping. The SNC always sets CA[10] to indicate auto-precharge, and it is never mapped to any address bit.

Interleave Field

Table 5-6 shows how low-order address bits are mapped to any DDR Channels, DIMM sides and DRAM Banks that are included in an interleave. In some cases, there are not enough of these resources to fill the interleave range, in which case Column [7:8] or Row [9] are used to fill in.

Column[1] is mapped to A[6] for 128-byte lines so that the second 64-byte access hits the same page as the first.

The maximum DDR configuration has eight DIMMs. Therefore, each DIMM can be assigned one of the eight MIR/MIT register pairs. The ways field of the MIR registers can be used to include multiple DIMMs in an interleave. This is indicated by the "MIR" entries in the tables below. Entries marked MIR indicate that these bits are used to match the ways field of a MIR register.

One MIR entry in a column imply a two-way interleave across a pair of MIRs. Optimally, the DIMMs described by the two MIR/MITs should be on different channels.

Two MIR entries in a column imply an interleave across four MIRs. Optimally, the MIRs selected by the least significant address bit should describe different channels. The four-way interleave increases the probability of data turnarounds, but reduces the probability of page replacements. The net result is improved performance. The other MIRs in an interleave may or may not describe a different technology.

Accesses to different DDR channels and banks within the same device will not have timing dependencies. Accesses to different DIMM sides on the same channel will have to wait for a bus turnaround. Accesses to different column bits in the same bank will have to wait for a precharge.

Notice the pattern irregularity in the Single-Sided 4/4 column. B0 and CA7 are swapped to avoid a page replace bubble in a linear access sequence for 64B lines.

_	_							
IJК	or D	ına 1	Manni	I DIAI	Pave	Interi	5-6	Table
_	טוט	IIIU I	IVIADDI	iciu ii	cave	111161	J-U.	Iable

Address		Bank (B), Device (D), Channel (Ch), Column (C)					
Line L	ength.	Single-Sided		Single-Sided Double-Sided		I	
128B	64B		# Ways		# Ways		
1200	04B	1/4	2/4	4/4	1/4	2/4	4/4
A[11]	A[10]	CA[7]	CA[8]	CA[9]	D[0]	CA[7]	CA[8]
A[10]	A[9]	B[0]	CA[7]	CA[8]	B[0]	D[0]	CA[7]
A[9]	A[6]	B[1]	B[0]	B[0]	B[1]	B[0]	D[0]
A[8]	A[8]	MIR	B[1]	CA[7]	MIR	B[1]	B[0]
A[7]	A[7]	MIR	MIR	B[1	MIR	MIR	B[1]
A[6]	A[11]	CA[1]	CA[1]	CA[1]	CA[1]	CA[1]	CA[1]

A [7:8] is used to define the ways of the Memory Interleave Ranges. Read-Reorder Queue index [1] is set to Bank[0]. Index[0] is set to Bank[1] for 4/4 ways or Channel[0] for 1/4 and 2/4 ways. Optimal configurations will map A[7] to Channel[0] by having the MIRs selected by A[7] = 0 control one channel, and MIRs selected by A[7] = 1 controlling the other channel.



High-order Field

Bits that are required to address a given technology (the number of rows, columns or channels specified by the MIT register), but do not appear in the fixed or interleave fields, appear in the high-order range. These bits are assigned to address bits as defined in Table 5-5.

Note: CA[10] does not appear in this field, since DDR uses this for an auto-precharge indication.

No bit in the high-order field is mapped to an address bit under all conditions. RA[10] and RA[11] are used for all technologies, but may be forced to 1 or 0 for DIMM splitting described rather than being assigned to an address bit (see "DIMM Splitting").

RA[12] and RA[13] only exist for larger technologies. They may also be forced for DIMM splitting. CA[7] and CA[8] exist for all technologies, but may be used in the interleave field. CA[10], CA[11], and CA[12] only exist for larger technologies.

DIMM Splitting

In order to interleave larger DIMMs with smaller, it is necessary to "split" the larger DIMM into smaller portions. For each memory location to have a unique address, the most significant row bits of each portion must be assigned mutually exclusive values. This can be done by restricting the address ranges (using MIR.BASE) to which the portions are assigned, but this complicates memory mapping software. The MIT.DIV and MIT.RAFIX fields have been introduced to allow each portion to be assigned arbitrary address ranges.

MIT.DIV defines whether a DIMM is whole or split into halves or quarters. MIT.RAFIX assigns 1 or 0 values to the necessary number of most significant row bits. Then the different portions can be assigned arbitrary address ranges (MIR.BASE) (see Table 5-7).

Table 5-7. MCP Bits Forced by RAFIX and DIV Fields for DIMM Splitting

	NUMROW		
	0	1	2
If DIMM is split (MIT.DIV[1]=1) then RAFIX[1] is assigned to:	RA[11]	RA[12]	RA[13]
If DIMM is split in four (MIT.DIV[0]=1) then RAFIX[0] is assigned to:	RA[10]	RA[11]	RA[12]

5.3.3 Power Management

DIMMs can be powered down by programming DMH registers using the DMH register write command in the SCC register.

Clock control will not be provided by the DMH to the DDR DIMMs. The major factor contributing to DDR power dissipation is the access rate and the data patterns associated with the requests. The SNC will not determine if the access rate and associated data patterns are high enough to pose a danger to DDR devices. The SNC will not monitor the temperature of DDR devices. The SNC will not provide a mechanism to throttle traffic if another agent detects an over temperature among the SDRAMs. It will be the responsibility of the system designers to ensure enough air flow and ambient temperature to guarantee that maximum device temperatures are not exceeded.



5.3.4 DDR Maintenance Operations

The maintenance operations that may occur are DIMM Refresh, DMH Current Calibration, DMH Temperature Calibration, SNC RAC Temperature Calibration, and SNC RAC Current Calibration. The current and temperature calibration period (100 ms) is long enough that there is not a significant performance impact.

DDR refreshes are issued for all 16 possible Device Rows every 15.6 us. Refreshes are issued whether the DIMMs are populated or not. They are equally spaced in time. The SNC issues REFA commands on the main channels. The DIMM to be refreshed is specified by the device field of the REFA command. The SNC will hold off reads and writes to DIMMs that are executing a refresh. Accesses to other DIMMs can be issued.

5.3.4.1 Serial Control Register Bus

The SCC and DRC registers provide a configuration mechanism to access DMH registers via the Main Channel Serial I/O (MSIO) bus. The DMH translates this bus to an SPD bus to the DIMMs so that the DIMMs can be interrogated for size and type.

5.3.4.2 Memory Device Failure Correction

The SNC error correction code described in Section 5.2.5, "Memory Device Failure Correction and Failure Isolation." It can correct any data errors from a X4 DDR device. An error in eight out of every nine X8 devices will be corrected. If more than four errors occur in one out of nine X8 devices, it cannot always be corrected.

Memory Subsystem





Reliability, Availability, and Serviceability

6

This section describes the features provided by the E8870 chipset that play a role in the design and development of high Reliability, Availability and Serviceability (RAS) systems. This chapter describes the E8870 chipset support for system integrity. The E8870 chipset provides error logging and employs a method called *end-to-end* error detection for data errors. These features support identification of the first system error and its source. A summary of all errors, their classification, and the chipset response and logging registers is provided.

This chapter also describes the features and their use to support availability and serviceability of systems built using E8870 chipset components. An overview of the roles and responsibilities of firmware and system software to support high RAS systems is provided. There is also description on how high availability is supported by the chipset through a fast re-boot in a degraded mode upon the occurrence of a fatal hardware error. Finally, support on hot-plug for PCI and SP is described.

6.1 Data Integrity

Errors are classified into two basic types: fatal (or non-recoverable) and non-fatal (or recoverable). Fatal errors include protocol errors, parity errors on header fields, time-outs, failed link-level retry, etc. For fatal errors, continued operation of the chipset may be compromised.

For non-fatal errors chipset operations can continue (transactions are completed, resources deallocated, etc.). Non-fatal errors are further classified into correctable and non-correctable errors. Non-correctable errors are those that are not "corrected" by the chipset. Non-correctable errors may or may not be correctable by software. Correctable errors include single bit ECC errors, successful link level retry, and those transactions where the chipset performs a *master abort* of the transaction.

Each component in the chipset indicates an error condition on external pins. A pin (open drain) is provided for each error type (fatal, uncorrectable, and correctable). It is up to the system to decide what is the best course of action upon the detection of an error.

Each E8870 chipset component provides error logging and error status for the first error detected by the component and error status for subsequent errors. Errors are detected and logged at intermediate entry points (on the inbound SP interface, for example). Errors are detected but not logged at the end points (where the packet is consumed or translated to another interface with different error coverage/detection). This method of error correction and error logging is called *end-to-end error correction*.

Table 6-1 provides a summary of all errors detected by the E8870 chipset components. In this table the error type and the chipset response is listed. If an error is the first error on the component (see Section 6.1.3, "Error Reporting") then information may be logged for the error. If a log exists for the error, the information that is logged, and the name of the error log is provided. Some errors may be detected in more than one component

^{1.} These are hardware definitions used by the E8870 chipset, and are not the same error types that are used by software (MCA).



Table 6-1. Intel® E8870 Chipset Errors

ERR#	Туре	Error Name	Response	Log	Log Registers			
Processor Bus								
F1	Fatal	Illegal or Unsupported Transaction ^{a,b}	Hardfail, drop transaction. ^c	Control	NRECFSB			
F2	Fatal	Bus Protocol Error ^d	Hardfail.	Control	NRECFSB			
F3	Fatal	BINIT# Observed	SNC reset, memory maintained.	N/A	N/A			
F4	Fatal	Processor Bus Address Parity Error ^b	Hardfail, drop transaction. ^c	Control	NRECFSB			
F5	Fatal	Bus Request Parity Error ^b	Hardfail, drop transaction. ^c	Control	NRECFSB			
		Outbound Multi-Bit ECC Error	Propagate ECC					
F6	Unc	Outbound Single-Bit or Multi-Bit ECC Error (Target FWH) Outbound Data Parity Error (Target FWH)	Complete as normal on processor bus, drop transaction.	Control, ECC, 64-bit data.	RECFSB RED			
F8	Unc	BERR# Observed	N/A	N/A	N/A			
F9 ^e	Unc	Partial Merge Multi-Bit Data ECC	Poison ECC.	N/A	N/A			
F10	Corr	Outbound Single-Bit ECC Error (except for FWH writes, see F6)	Propagate ECC.	Control, ECC, 64-bit data.	RECFSB RED			
F12	Corr	Illegal Outbound Address (single node only)	Master abort.	Control	RECFSB			
F13 ^e	Corr	Partial Merge Single-Bit DATA ECC Error on Implicit Writeback ^e	Correct.	N/A	N/A			
FWH								
L1	Fatal	LPC SYNC ^f	Hardfail drop transaction.	Control ^g	NRECFSB			
L2	Corr	FWH Time-out ^h	Master abort to bus terminate on FWH	Control	RECFSB			
Memory	1							
M1 ^e	Unc	Multi-Bit Memory ECC Error on Write	Poison 32-byte ECC codeword in memory.	Control	RECMEM			
M2	Unc	Uncorrectable Memory ECC Error on Read	Reads: Poison 32 bytes of returned data. Partial Writes: poison 32-byte ECC codeword in memory.	Control, syndrome.	RECMEM REDMEM			
МЗ	Unc	Uncorrectable Memory ECC Error on Memory Scrub	Poison 32-byte ECC codeword in memory.	Control, syndrome.	RECMEM REDMEM			
M4 ^e	Unc	Partial Merge Multi-Bit Data ECC Error ^e	Poison 32-byte ECC codeword in memory.	N/A	N/A			
M6 ^e	Corr	Single-Bit Memory ECC Error on Write	Correct error and write to memory	N/A	N/A			



Table 6-1. Intel® E8870 Chipset Errors (Continued)

ERR#	Туре	Error Name	Response	Log	Log Registers
Memory	(cont)				
M7	Corr	Correctable Memory ECC Error on Read or Memory Scrub	Reads: Correct returned data. Scrub: Correct error and write to memory.	Control, syndrome.	RECMEM, REDMEM
M8 ^e	Corr	Partial Merge Single-Bit DATA ECC Error ^e	Correct error and write to memory.	N/A	N/A
SP Link	Layer				
S1	Fatal	Link Error; Failed SP LLR or LLR not enabled	Deassert idle flit acknowledge.	N/A	N/A
S2	Unc	SP Multi-Bit Data ECC Error	N/A	Control, ECC, syndrome.	RECSPL REDSPL
S3	Corr	Idle Flit Duplication Error	Enter LLR if enabled.	# of retries, parity, phit_no, phit.	RECSPL ⁱ
S4	Corr	Parity Error on the Link	Enter LLR if enabled.	# of retries, parity, phit_no, phit.	RECSPL ⁱ
S5	Corr	SP Single-Bit Data ECC Error	N/A	Control, ECC, syndrome.	RECSPL REDSPL
SP Prot	ocol La	yer			
P1	Fatal	SP Protocol Error	N/A	See component FERRST register.	NRECSPP NRESPPC(S PS) ^j
		LATT Time-out Error (SNC)			NRECSPP(S NC)
P2	Fatal	SPT Time-out Error (SPS)	N/A	Request header.	NRESPPC(S PS)
		LRB Time-out Error (SIOH)			NRECSPP(S IOH)
P3	Fatal	Received failed or unexpected unsupported SP request status response.	SNC: Hardfail SPS: Propagate status as part of normal transaction flows. SIOH HI: Target abort.	Response header.	NRECSPP NRESPPC(S PS) PCISTS(SIO H),
P4	Fatal	SPS Snoop Filter Uncorrectable ECC Error	Failed response.	SF entry.	NRESPPC
P5	Fatal	Strayed Transactions ^k	Drop response if no matching request.	Response header.	NRECSPP NRESPPC(S PS)
P6 ^e	Unc	Partial Merge Multi-Bit DATA ECC Error ^e	Poison ECC.	N/A	N/A
P7	Corr	SPS Snoop Filter Correctable ECC Error	Correct.	SF entry.	RECSPPC
P9 ^e	Corr	Partial Merge Single-Bit DATA ECC Error ^e	Correct.	N/A	N/A



Table 6-1. Intel[®] E8870 Chipset Errors (Continued)

ERR#	Туре	Error Name	Response	Log	Log Registers				
SP Prote	SP Protocol Layer (cont)								
P8	Corr	Illegal SP Address Error ^l	Master abort.	Request header.	RECSPP RECSPPD(S PS)				
P10	Corr	Received Master Abort Response ^m	Master abort.	Response header.	RECSPP RECSPPC(S PS)				
Config									
C1 ^e	Fatal	Configuration Multi-Bit DATA ECC Error (write only)	Register contents not updated; normal completion response.	N/A	N/A				
C2 ^e	Corr	Configuration Single-Bit DATA ECC Error (write only)	Correct.	N/A	N/A				
Hub Inte	erface (SIOH)							
H1	Fatal	Hub Interface Header Multi-Bit ECC Error (HI2.0) or Parity Error (HI1.5)	Transaction should be dropped without affecting SIOH state.	Header, parity or ECC.	NRECHUB PCISTS				
H2	Fatal	Hub Interface – Received DO_SERR# Message	N/A	N/A	N/A				
H3	Fatal	Illegal Inbound Hub Interface Request	Request should be dropped without affecting SIOH state.	Request header.	NRECHUB				
113	ratai	Unexpected or Invalid response	Response should be dropped without affecting SIOH state.	Response header.	INCLUIDS				
H4	Unc	Received Hub Interface Target Abort ⁿ	Poison data (reads), normal completion (delayed writes).	Response header. (HI only)	RECHUB PCISTS				
H5	Unc	Inbound Hub Interface Multi-Bit Data ECC Error (HI2.0) or Parity Error (HI1.5)°	Propagate ECC (HI2.0), poison data (HI1.5).	Header, data, parity. (HI1.5)/ECC (HI2.0)	RECHUB REDHUB PCISTS				
H6 ^e	Unc	Outbound Multi-Bit Data ECC Error at Hub Interface 1.5 Cluster ^p	Poison data.	N/A	N/A				
H7	Corr	Inbound Hub Interface Single Bit Data ECC Error (HI2.0 only) o	Propagate ECC.	Header, data, ECC.	RECHUB REDHUB				
H8	Corr	Received Hub Interface Header Single Bit ECC Error (HI2.0 only)	Correct.	Header	RECHUB				
H9 ^e	Corr	Outbound Single Bit Data ECC error at HI1.5	Correct.	N/A	N/A				
H10	Corr	Hub Interface Illegal Address Error ^l (Inbound)	Master abort.	Request header.	RECHUB				
H11	Corr	Received master abort on Hub Interface or Unimplemented Special Cycle	Master abort.	N/A	PCISTS,AP CISTS				

Decoding errors (unsupported DLEN, etc.).

Detected only on processor initiated requests.

Transactions are completed on the processor bus without causing SP issue or FWH writes or memory writes. Memory reads may be issued. Resources such as LATT entries or data buffers may be permanently allocated.

HITM# observed on explicit writeback.



- e. ECC checking, correction and/or poisoning is done within the 8B boundary of the partial write.
- f. FWH slave device indicates error or sync/response handshake in error.
- g. Address A[31:3] and transaction type only is logged.
- h. Set if no LPC/FWH device drives a valid SYNC after four consecutive clocks.
- i. Number of retries logged if LLR is successful.
- Contents of the error log will be all 0's if the error cannot be tied to a transaction.
- k. There are two instances of strayed transactions. The first is when a response with no matching request is detected. The second is when the DestNodeld field of the response packet does not match Nodeld of the component.
- This includes access to SP port that is disabled, inbound SP requests with illegal attributes.
- m. Provides the ability to detect master abort responses received from the CB or Hub Interface interfaces.
- n. Outbound reads only.
- o. This error applies to data flowing inbound (inbound write and outbound read completion).
- p. This error applies to data flowing outbound (outbound write and inbound read completion).

6.1.1 End-to-end Error Correction

ECC errors are passed along to the end point. If the data path does not have ECC all the way, single bit errors will be corrected just before the 1st ECC-less interface. Intermediate interfaces will not correct single bit ECC errors. The ECC checkbits and parity checkbits are always passed along with data internally. A typical error will leave a trail behind in each component it passes. The system can use this to pinpoint source of error and recover from error conditions.

The SNC has the following end points for data:

- Memory:
 - Correct single bit error before the data are converted to MDFC ECC on write.
 - Store data with poisoned MFDC ECC if multi-bit ECC errors are encountered.
 - Correct all correctable errors and convert to good SEC/DED ECC on read.
 - Generate poisoned SEC/DED ECC if uncorrectable errors are detected on read.
- SNC FWH (FWH Error Detection is Merged with Processor Bus):
 - On outbound cycles, convert to firmware hub (FWH) cycles if no error is detected by ECC.
 - On outbound cycles, drop the transaction if single-bit (1x ECC) or multi-bit ECC (2x ECC) errors are detected.
 - On FWH initiated cycles, generate good ECC.
- Configuration Registers:
 - On write, convert to internal configure cycles if no error is detected by ECC.
 - On write, convert to internal configure cycles after single bit ECC errors are corrected.
 - On write, the write is not performed if an uncorrectable ECC error is detected.
 - On read, generate good ECC.
- Partial (8-byte) Write Merge Buffers:
 - Merge the buffers and re-generate ECC if no error is detected by ECC.
 - Merge the buffers and re-generate ECC after single bit ECC errors are corrected.
 - Merge and poison the buffers if multi-bit ECC errors are detected.



6.1.1.1 Exceptions

- No checks will be done on FWH and configuration register read transactions.
- Write to FWH will be checked at processor bus. Processor bus errors will be logged. Failing FWH write data will not be logged.

6.1.2 Data Poisoning

Data covered by SEC/DED ECC is poisoned by flipping checkbits[7:1].

Memory write data, which is covered by chipset memory ECC, is poisoned by flipping symbol g on RAC1 and RAC3. This will be detected as a non-correctable Memory ECC error when the memory location is read. When this happens, all four SEC/DED code words that correspond to the Memory ECC code word will be poisoned and propagated to the requestor.

When data is covered by parity it is poisoned by flipping all parity bits associated with the data.

6.1.3 Error Reporting

6.1.3.1 Error Status and Log Registers

Error status registers are provided: FERRST (first error status register), and SERRST (second error status register). First fatal and/or first non-fatal errors are flagged in the FERRST register, subsequent errors are indicated in the SERRST. Associated with some of the errors flagged in the FERRST register are control and data logs. SP0 and SP1 share logging registers (RECSPL and REDSPL). The SPL Fatal Data Error Pointer bit in the FERRST register records which SP detected the error.

The contents of FERRST and SERRST are "sticky" across a reset (while PWRGOOD remains asserted). This provides the ability for firmware to perform diagnostics across reboots. Note that only the contents of FERRST affects the update of the any error log registers.

6.1.3.2 Error Logs

For some errors, control and/or data logs are provided. The "non-recoverable" error logs are used to log information associated with first fatal errors. The "recoverable" error logs are used for first non-fatal errors.

Once a first error for a type (fatal, non-fatal, recoverable) of error has been flagged (and logged), the log registers for that error type remain fixed until either (1) any errors in the FERRST register for which the log is valid are cleared or, (2) a power-on reset.

6.1.3.3 Error Signaling

Three open-drain error pins are associated with each of FERRST/SERRST register, one for each error type: fatal, uncorrectable and correctable (ERR[2:0]# respectively). If not masked (ERRMSK register), these pins will reflect the error status of each type in the two error status registers. The value of the error pins when an error is flagged is also stored in the FERRST to facilitate the identification of the first error in the system. For example, when a first fatal error is detected on the component, the value of the error status pin associated with fatal errors is also latched into the FERRST.



For reliable signaling of errors in the system, each component guarantees that the pin associated with the error is asserted within four system clock cycles (200 MHz) after the error is detected by the component. For example, if a multi-bit ECC error is detected at the SP interface in cycle x, the uncorrectable error pin (ERR[1]#) is asserted in cycle x+3.

6.1.4 Interface Details

Major interfaces in the chipset can be enabled/disabled via software to aid fault isolation. Any requests routed to a disabled interface will be master-aborted. Any responses will be absorbed. That is, no issue is required on the disabled interface, but the disabled interface must not assert internal flow control.

6.1.4.1 Processor Bus

- ECC or parity will be checked at the input pins only when the processor is an initiator of the processor bus transaction.
- Parity protection is provided on the Itanium 2 processor address bus and control bus. ECC protection is provided on the Itanium 2 processor data bus.
- BERR# is asserted on the processor bus by the SNC when BERRIN# is asserted. BINIT# is
 asserted on the processor bus by the SNC when BINITIN# is asserted. Both signals are
 asynchronous inputs, and are sampled over four consecutive system clocks (200 MHz) to filter
 glitches. When a assertion edge of these signals is observed, BERR# and BINIT# on the node
 are asserted according to the protocol requirements of the host bus. Multiple assertion edges of
 BERRIN# and BINITIN# are ignored until the host bus assertion of BERR# and/or BINIT#
 has been completed.
- The SNC may not detect errors in implicit write-back data for full-line writes. In this case the
 implicit write-back data is completely overwritten, so its value does not affect operation. This
 error is not reported to prevent unnecessary corrective action by software that might reduce
 reliability. Since software cannot tell that the uncorrected data was discarded, it might kill an
 application or reset the system.

6.1.4.2 Scalability Port (SP)

- Data is protected by ECC. ECC is checked only on entry of packets.
- Flit transfers are protected by parity.
- The information contained in the SP control and idle flits packet are protected by both parity and duplication (each field is duplicated on different wires to enhance error detection).
- Link level retry is supported on the SP. Link level retry is entered when parity errors are detected on flits, or when phits within an idle flit have a duplication error.

6.1.4.3 DRAM

• The addresses that are logged in the error registers are the decoded memory addresses (channel, devices, bank, row, column). Software can determine from the log which bit failed on correctable errors and which DIMM failed for uncorrectable errors.

Note: In the event of a multiple error, it may not be possible to isolate the failed device when the MDFC feature is enabled.

If MDFC is enabled, correctable ECC errors will be corrected as the data is read from memory.



- If MDFC is enabled, uncorrectable ECC errors on a memory read will poison the SEC/DED ECC. For uncorrectable ECC errors detected on memory writes, the MFDC code is poisoned.
- To correct single-bit errors in memory, the memory controller will "walk" the memory, reading, then writing each location. The interval between each "scrub" is 65536 cycles of 200 MHz clocks. Errors remain in memory until they are scrubbed.

6.1.4.4 Firmware Hub (FWH)

- ECC in outbound packets is checked at the processor bus.
- FWH has no hardware error protection. Error protection for FWH devices is done through software CRC or checksum.

6.1.4.5 Configuration Register

• ECC is checked on configuration writes.

6.1.4.6 Partial Write Merge Buffer

• ECC is checked before the merge.

6.1.4.7 SMBus

• The SMBus port supports the optional Packet Error Correction feature. This feature allows the slave to append an 8-bit CRC to read completions.

6.1.5 Time-Out

6.1.5.1 SIOH

Transactions in the LRB of the SIOH SPP cluster are tracked by timer(s). A time-out transaction is logged in the error registers as a fatal error. Transactions that time-out are not removed from internal data structures.

6.1.5.2 SPS

Transactions in SPT of the SPS SPPC cluster are tracked by timer(s). A time-out transaction is logged in the error registers as a fatal error. Transactions that time-out are not removed from internal data structures.

6.1.5.3 Timer Implementation

When an entry in the queue is allocated, it becomes valid and is tracked by the master timer logic. The timer is a 24-bit wrap-around counter, incrementing at 25 MHz (200 MHz core clock divided by 8). This provides approximately a maximum time-out period of 640 ms. The actual time-out period is programmable (a value in the ERRCOM register that determines the size of the counter). The timer interval must be greater than the worst-case latency required in the system to de-allocate the queue entry. For example, the LATT interval must be set to greater than the worst-case latency from the SP issue to the response, including contention scenarios for all resources the request must acquire.



An entry times-out if the counter wraps around (toggles the high-order) bit twice. As a result, the time-out period can be from 1×10^{-2} x the timer value.

Using such a mechanism, it is possible for multiple entries in a queue to time-out simultaneously. When a time-out occurs, the hardware selects one entry as the "first error" for logging in the FERRST. The presence of more than one error is indicated in the SERRST register.

6.2 RAS: System Components Roles and Responsibilities

The fault isolation process is greatly enhanced with active monitoring and logging of error conditions by the server management and the MCA handler. High RAS systems based on this chipset are not possible without well-designed server management and machine check architecture (MCA) handler.

Upon booting/re-booting, the error logs and SP interfaces can be checked by firmware (SAL/PAL/System Management) to identify faulty nodes. Faulty nodes can be isolated/disabled by the firmware, and the system can be rebooted with the revised hardware configuration. Faulty modules can be hot-replaced, and a new boot can be scheduled at a convenient time to integrate the modules into the system.

6.2.1 Machine Check Architecture (MCA)

MCA provides "in-band" error handling features for high RAS systems on the Itanium processor family. Some of the highlights of MCA are listed below. For details on MCA, refer to *Itanium*TM *Processor Family Error Handling Guide*.

- Error containment.
- · Error correction.
- Error logging (this log may be combined with SMs error log).
- Error classification. This classification scheme assists firmware and O/S handler development.
 Note that the error classification scheme used by MCA may be different than the error types and classification used by the chipset.
- Platform error signaling and escalation:
 - BERR#: It is recommended that hardware errors that are uncorrectable or fatal be reported as BERR#. The system hardware may choose to assert BERR# locally to a particular SNC node or globally to all SNC nodes (using BERRIN#). A processor assertion of BERR# is observable on SNC BERROUT#.
 - BINIT#: It is strongly recommended that the system hardware let software promote an
 error from BERR# to BINIT#.A processor assertion of BINIT# is observable on the SNC
 BINITOUT#. System hardware may choose to assert BINIT# globally to all SNC nodes
 (via BINITIN#).
 - PMI: Although platform events including errors can reported and logged through PMI
 (Itanium processor family), this is not recommended because it violates the *Developer's Interface Guide for IA-64 Servers* requirements of not reporting errors via PMI.2x ECC or Hardfail response.



6.2.2 Server Management (SM)

SM provides "out-of-band" error handling features for high RAS systems on the Itanium processor family:

- Error logging.
- · Remote diagnostics.
- Re-configuration (graceful degradation). In case of a catastrophic event, SM can analyze and isolate troublesome components and assist the system boot after a reset.

6.2.3 OS/System Software

- Resume from correctable errors.
- Recover:
 - Re-configuration: Disable malfunctioning hardware components without crashing the system.
 - Hot plug: online repair and upgrade.
 - Shoot down crashed processes/threads/applications.
 - Communicate I/O errors to device drivers.
- Reboot from fatal hardware and uncorrectable hardware errors that are not recoverable by system software.

6.2.4 Device Driver

- Retry failed I/O transactions.
- Support for fail-over.



6.2.5 Summary

Table 6-2 summarizes the different roles played by different RAS components. RAS components must be designed to work closely with each other to provide good system RAS.

Table 6-2. RAS Roles of Different System Components

RAS Tasks	Hardware	MCA	SM	Device Driver	OS/BIOS
Error Logging	1 instance	NVRAM	NVRAM	Report to OS	Report to MCA.
Error Containment	Data poisoning, hardfail response, machine check via BERR#/MCERR#.	Rendezvous	N/A	Discard uncorrectable error.	Kill processes/ threads/application.
Error Recovery or correction	Correct SBECC Detect DBECC Link Level Retry	Rendezvous Retry	Re-configuration during reset/boot.	Retry Fail-over Hot plug	Retry Re-configuration Kill processes/ threads/application.
Error Signaling From:	ERR[2:0]#; BERR#; BINIT#; PMI; hard fail response; regular interrupts.	BERR#; BINIT#; RESET#	PMI; BERR#; BINIT#; Regular Interrupts	Regular Interrupts; NMI; report to OS.	Transfer to MCA or Device driver. Issue reset.
Error Signaling To:	Error detection circuit; BINITIN#; BERRIN#.	BERR#; BINIT#; hard fail response; CPU internal errors.	ERR[2:0]#; Chipset registers; system sensors.	Regular Interrupts; bad software CRC.	Regular interrupts; PMI; MCA; Device driver.
Remote Management	SMBus ports on all chipset components.	Detailed error logs.	Out-of-band access for the remote node.	NA	In-band access for the remote node.
Re- configuration	Interface enabling/disabling. Hot plug on SP, PCI and Infiniband.	Diagnose the problem and then transfer to OS.	During reset/boot.	Fail-over Online repair and upgrade (PCI hot-plug).	On-line repair and upgrade (hot-plug).

6.3 Availability

This chipset supports a system in which modules and interfaces can be duplicated to increase availability. In the event that there is a fatal error, many of the features in the chipset are designed so that a fast reboot in a degraded configuration is possible. The availability of the system is increased in that there is "no-single-point-of-failure" that prohibits a fast reboot. Firmware can interrogate the error status and log registers of the chipset and system error logs to determine if a reboot in degraded mode is needed. There are many possible degraded system configurations. Some are listed below.

- Single SPS. One of two SPSs failed. Every component that is connected to the failed SPS disables the corresponding SP.
- Failed SNC nodes. The whole node is bad and cannot be salvaged. Each SPS connecting to the failed node disables the corresponding SP.
- Some of the CPUs on a node failed. The failed CPU is "killed" by tri-stating (not hanging).
- All of the CPUs on a node have failed (memory only node).
- Failed DIMM modules. Part of the memory system may still be salvaged.
- Memory subsystem failed (CPU-only node).
- Failed SIOH nodes. The whole node has failed and cannot be salvaged. Each connecting component disables the corresponding SP.



- Failed PCI slots. Failed PCI slots is isolated by PCI hot-plug hardware.
- Failed P64H2. Failed P64H2 is isolated by disabling the Hub Interface 2.0 interface.
- Failed ICH4. Failed ICH4 is isolated by disabling the Hub Interface 1.5 interface.

6.4 Hot-Plug

Care must be taken on module partitioning to enable maximum RAS. For example, if the two SPS switches are put on the same module, it is not possible to replace one of them without bringing the system down. The system vendor is responsible for RAS features on other critical components in the system, like dual oscillators, fail-over I/O cards, redundant hot-plug power and cooling, etc. The PCI slots interfaces are all hot-pluggable to provide finer-granularity RAS.

Chipset components reside on Field Replaceable Units (FRU) that are defined by each system vendor. In this document, these FRUs are referred to as modules to distinguish them from lower-granularity FRUs such as DIMMs. The E8870 chipset supports the design of a "no-single-point-failure" system. This is made possible by the chipset modularity and redundancy. In high RAS configurations, the modules are connected by the SPS switches through the high speed scalability ports (SPs) that are hot-pluggable. The SPS switches play a central role in the RAS.

This chipset supports hot-plug on SP and PCI. The PCI bus Hot-Plug is done through P64H2. All hot-plugs are done under the strict control of system software.

6.4.1 Hot-Plug Support on SP

Each SP has the following built-in hot-plug support functions:

- Idle/control packets. Idle and control packets are used in the link level retry, hot-plug and reset. Idle packets are sent over the SPs whenever the SPs are not in use. Control flits are used during initialization and framing. The following information is carried in idle and control packet:
 - Bus # and device # of the attached device.
 - The maximum credit per VC.
 - Acknowledgment of receipt of the idle pattern of another device.
 - The current FLIT sequence # (used mainly for link-level retry).
 - Error indicators.
 - No link level retry for next FLIT.
 - FLIT sequence # for the 1st bad FLIT.
- A bit to enable/disable SP. When an SP is disabled, its outputs (with the exception of SPSYNC) are tri-stated and all transactions targeting the SP are master aborted. Note that disabling/enabling one side of a link causes both sides the SP link to re-initialize and reframe.
- Idle pattern detection. An interrupt can be generated upon change of idle pattern state at initialization.
- SP{0/1}PRES is used to indicate a present component on the port, and all SP outputs (including SPSYNC) are tri-stated when SP{0/1}PRES is deasserted. An interrupt can also be generated upon change of the pin state. The assertion (rising edge) of SP{0/1}PRES also triggers the SP initialization and framing.
- Two GPIO pins for each SP. Those GPIOs can be used to control additional MUXs or power circuits.



- The ability for system software to generate an interrupt through the SP, and software scratch bits provided per SP port. This allows system software to use one interrupt for hot-plug addition and removal sequencing.
- Control and status is provided in a register provided per SP interface. On the SPS, this register
 is called the SPINCO register.
- The REMCDEF register on the SPS is used to indicate to the centralized protocol layer the
 presence of a component on the port. The SPS uses the contents of this register to determine if
 a node should receive a broadcast transaction or a back-invalidate.
- The SIOH provides a mechanism to flush the SIOH write cache. These lines must be flushed
 to memory before an SIOH can be hot-removed. Control for flushing the SIOH write cache is
 in the IOCTL register.

6.5 Chipset Error Record

This section provides an example of the contents of a chipset error record. The platform error record consists of a generic header, followed by a number of sections. Each section consists of a section header followed by a section body. An example section header and body for the E8870 chipset is described here, the chipset using one section. Guidelines for creating the error record are also provided.

6.5.1 Generating the Error Record

The simplest approach to creating an error record is to read the contents of the FERRST and SERRST registers in each of the E8870 components in the system. Based on the contents of FERRST, an error log register is also captured (see Table 6-1 to identify log registers associated with errors). The FERRST is designed to support status and logging of the first fatal and/or first non-fatal errors. Once the error status and any associated log registers are captured, errors are cleared by writing (1's) to the error bits in SERRST, and FERRST of each component.

It is recommended that the SERRST be cleared before the FERRST so that any subsequent errors that may occur during the error handling are recorded and logged in the proper order. Also note that the FERRST/SERRST registers must be cleared for each error for reliable error logging and parsing.

6.5.2 Chipset Record Section

The chipset section consists of a section header followed by a section body. A section header may consist of the following fields:

```
GUID //Globally Unique ID //128 bits, this value will uniquely identify the E8870 chipset revision \# section length //bytes, length of header and section body
```

The chipset section body is organized by function where each function includes a component header followed by a set of reg_id, reg_value pairs ¹. A single component in the chipset may report more than one function.

The following is an example of the fields that may be part of the component header:

^{1.} See Table 6-3.



BusNum // Bus number on which component resides

DevNum // Device number of the component, also known as E8870 NodeId

FuncNum // Function ID

DevID // PCI device ID (identifies the component)

RevID // Device revision

ConfigSpaceNumReg// Number of registers listed for this function

Length // length of this function log in byte

Table 6-3. Intel[®] E8870 Chipset Error Status and Log Registers

Component	Function	Reg_ID	Register Name	Size (Bytes)	Description
SNC	0	CC	RECFSB	12	Processor Bus non-fatal error log.
SNC	0	DC	NRECFSB	12	Processor Bus fatal error log.
SNC	1	D4	REDMEM	12	Memory data log.
SNC	1	E0	RECMEM	8	Memory control log for non-fatal errors.
SNC	2	40	RECSPP	8	SP Protocol log for non-fatal errors.
SNC	2	48	NRECSPP	8	SP Protocol log for fatal errors.
SNC	2	58	RED	9	Data log for non-fatal errors.
SNC	2	80	FERRST ^a	12	First error status register.
SNC	2	8C	SERRST ^a	12	Second error status register.
SNC	2	C4	RECSPL0	8	SP0 Link layer control log for non-fatal errors.
SNC	2	СС	REDSPL0	2	SP0 Link layer data log for non-fatal errors.
SNC	3	C4	RECSPL1	8	SP1 Link layer control log for non-fatal errors.
SNC	3	СС	REDSPL1	8	SP1 Link layer data log for non-fatal errors.
SPS	0-5	44	RECSPL	8	SP0-SP5 Link layer control log for non-fatal errors.
SPS	0-5	4C	REDSPL	2	SP0-SP5 Link layer data log for non-fatal errors.
SPS	0-5	64	RECSPPD	8	SP0-SP5 Distributed protocol layer control log for non-fatal errors.
SPS	6,7	40	NRESPPC0	8	SP Bi-interleave 0,2 central protocol layer control log for fatal errors.
SPS	6,7	48	RECSPPC0	8	SP Bi-interleave 0,2 central protocol layer control log for non-fatal errors.
SPS	6,7	C0	NRESPPC1	8	SP Bi-interleave 1,3 central protocol layer control log for fatal errors.
SPS	6,7	C8	RECSPPC1	8	SP Bi-interleave 1,3 central protocol layer control log for non-fatal errors.
SPS	6	9C, A8	FERRST0 ^a , FERRST1 ^a	4	First error status register, domain0 and domain1.
SPS	6	A0,AC	SERRST0 ^a , SERRST1 ^a	4	Subsequent error status register, domain0 and domain1.
SIOH	0-4	4C	RECHUB	16	Hub Interface control log for non- fatal errors.



Table 6-3. Intel® E8870 Chipset Error Status and Log Registers (Continued)

Component	Function	Reg_ID	Register Name	Size (Bytes)	Description
SIOH	0-4	5C	REDHUB	12	Hub Interface data log for non-fatal errors.
SIOH	0-4	68	NRECHUB	16	Hub Interface control log for fatal errors.
SIOH	6	84	RECSPL0	8	SP0 Link layer control log for non-fatal errors.
SIOH	6	8C	REDSPL0	2	SP0 Link layer data log for non-fatal errors.
SIOH	6	A0	RECSPL1	8	SP1 Link layer control log for non-fatal errors.
SIOH	6	AC	REDSPL1	8	SP1 Link layer data log for non-fatal errors.
SIOH	6	44	FERRST ^a	12	First error status register.
SIOH	6	4C	SERRST ^a	12	Second error status register.
SIOH	6	64	RECSPP	8	SP Protocol log for non-fatal errors.
SIOH	6	78	NRECSPP	8	SP Protocol log for fatal errors.

a. must be part of the error record.

For E8870 chipset components, the DevNum shown in the example above is the same as the NodeId that is used to identify nodes. There may be more than one component reporting SNC functions and registers, with a different value for DevNum. This would occur if there is more than one SNC in the platform.

It is not necessary for all error log registers provided by the component to be part of the error record. Only the error log associated with the fatal/non-fatal errors identified by FERRST need be included.

6.5.3 Error Interpretation Guidelines

This section provides general guidelines regarding interpretation of the information contained in the chipset error record. To assist in the interpretation of the error record, errors can be classified into four different classes (these classes are separate from the error type used in signaling the error to the system).

- Non-continuable (NC)
 - General system processing may be compromised. These are errors associated with coherency protocols, the operation of the processor bus or scalability port, etc. These errors may cause other errors to occur in the system.
- Non-continuable-Subsystem (NCS)
 - These errors may not compromise general system processing, but further operations of the subsystem (bus, interface) may be compromised. On the E8870 chipset, these errors generally impact the I/O buses or devices.
- Continuable Single (CS)
 - These errors do not compromise further system operation. These errors do not propagate across components.
- Continuable Trailing (CT)



These errors do not compromise further chipset operation. These errors leave an error status and log trail as the error propagates from one component to its destination. There are three types of trailing errors detected by the chipset: 2x ECC, 1x ECC, and master abort. Each CT error can be an error source, midpoint, and/or endpoint.

Table 6-4 provides general information for all of the errors detected by the E8870 chipset. An error may or may not be associated with a transaction. For example, an inbound 2x ECC error detected by the SNC can only be the result of a processor read from memory or I/O. On the other hand, an assertion of BINIT# on the node would not occur as a result of any specific transaction.

Table 6-4 provides information as to the type of transaction that is associated with an error. Also provided is the error class. For CT errors, the trailing error type is provided, along with the detection point (source, mid or end). The type of trailing error along with an understanding of whether an error can be a source, midpoint, or endpoint can be used in determining the error trail.

6.5.3.1 Error Parsing

The error record can be viewed as the raw data. Identifying the error source is useful for scheduling system maintenance, recovery, reconfiguration on boot after error, etc. For example, a frequently occurring parity on a scalability port (corrected using link-level retry) may be an indication of problems with the connector on that port.

The FERRST register of each component has a Last_Err_Value field for each error type (fatal, unc, cor). As each component detects a fatal and/or non-fatal error, it latches the value of its error pin associated with the error type. As a result, the value of the Last_Err_Value can be used to help identify the error source for fatal and non-fatal errors. This relies on platform specific support for this feature. ¹

There are cases where parsing of the error record cannot be accomplished in a reliable way. For the purposes of these guidelines, parsing an error means to analyze the contents of the error record (using an algorithm) to determine the source of the error in the platform. Some error parsing guidelines are:

- When the first fatal error in the platform is NC, parsing of any other errors is unreliable.
- If there is an NC error reported in any of the components, parsing of any error in the platform may be unreliable.
- If the first non-fatal error is CT, parsing the CT error may be unreliable if there are NCS errors in the system.
- When the first non-fatal error is CT, multiple errors have been detected if there are other CT errors detected by the chipset that have different trailing types.
- Since CS errors do not propagate, determining the error source of CS errors is implied (source is the component that detected the error). Allowing CS errors to populate the FERRST may compromise the parsing of an error trail for subsequent CT errors.
- For CT errors, the trail can be recreated using the src, mid, and endpoint attributes of each error. For example, a 2xECC error on the processor bus for a write to local memory will have F6 reported in the FERRST, and M1 reported in the SERRST. F6 is a source of a CT error, and M1 is shown as an endpoint. In addition, the value for LastERR2 in the FERRST will show the SNC detected the first uncorrectable error in the system. Note that the error trail in a multinode E8870 platform can have up to two branches (this situation can occur on a implicit write back that has a 2xECC error where the requesting node that receives the poisoned data is different than the home node that gets the memory update

^{1.} A larger system may provide this information in external logic to support this feature.



 Table 6-4.
 E8870 Chipset Errors, Transaction, and Class Information

							Trans	saction					
ERR #	Туре	Error Name	Proc read, coh	Proc read, non- coh ^a	Proc write, coh	Proc write, non- coha	Read from I/O, coh	Write from I/O, coh	Write from I/O ^b	SPS Back Invali- date	SPS Broad- cast ^c	No Trans- action	Error Class
		1		l .	Proc	cessor E	Bus		•	•	•	•	
F1	Fatal	Illegal or Unsupported Transaction	х	х	х	х							NC
F2	Fatal	Bus Protocol Error										х	NC
F3	Fatal	BINIT# Observed										х	NC
F4	Fatal	Processor Bus Address Parity Error	х	х	х	х							NC
F5	Fatal	Bus Request Parity Error	х	х	х	х							NC
		Outbound Multi-Bit ECC Error	src ^d		src	src	srcd	srcd		src			CT:2xECC
F6	Unc	Outbound ECC Error (Target LPC) Outbound data parity error (Target LPC)				end							CT:2xECC
F8	Unc	BERR#/MCERR# Observed										х	CS
F9	Unc	Partial Merge Multi-Bit Data ECC			mid								CT:2xECC
F10	Corr	Outbound Single-Bit ECC Error	src		src	src	src	src		src			CT:1xECC
F12	Corr	Illegal Outbound Address (single node only)	х	х	х	х							CS
F13	Corr	Partial Merge Single-Bit DATA ECC Error on Implicit Writeback			end								CT:1xECC
						LPC							
L1	Fatal	LPC SYNC		х		х							NC
L2	Corr	LPC Time-out		х									CS
					ı	Memory							
M1	Unc	Multi-Bit Memory ECC Error on Write	end ^e		end		ende	ende		ende			CT:2xECC
M2	Unc	Uncorrectable Memory ECC Error on Read	src,end		src ^f		src	srcf					CT:2xECC
МЗ	Unc	Uncorrectable Memory ECC Error on Memory Scrub										х	CS
M4	Unc	Partial Merge Multi-Bit Data ECC Error			mid								CT:2xECC
M5	Corr	RDRAM Overheating Error										х	CS
M6	Corr	Single-Bit Memory ECC Error on Write	end		end		ende	end		end			CT:1xECC
M7	Corr	Correctable Memory ECC Error on Read or Memory Scrub	х				х	х					CS
M8	Corr	Partial Merge Single-Bit DATA ECC Error			end								CT:1xECC



Table 6-4. E8870 Chipset Errors, Transaction, and Class Information (Continued)

							Tran	saction					
ERR #	Туре	Error Name	Proc read, coh	Proc read, non- coh ^a	Proc write, coh	Proc write, non- coha	Read from I/O, coh	Write from I/O, coh	Write from I/O ^b	SPS Back Invali- date	SPS Broad- cast ^c	No Trans- action	Error Class
		1			SP	Link La	yer			l.		l.	
S1	Fatal	Link Error; Failed SP LLR or LLR not Enabled										х	NC
S2	Unc	SP Multi-Bit Data ECC Error	src,mid (NSI) ^g end(N)	src,mid (NSI) end(N)	src,m id (NSI)	src,m id (NSI) end(I)	src,mid (NSI) end(I) ^h	src,mid (NSI)	src,mid (NSI) end(I) ^h	src,mid (NSI)	src,mid (NSI)		CT:2xECC
S3	Corr	Idle Flit Duplication Error										х	CS
S4	Corr	Parity Error on the Link										х	CS
S5	Corr	SP Single-Bit Data ECC Error	src,mid (NSI) end(N)	src,mid (NSI) end(N)	src,m id (NSI)	src,m id (NSI)	src,mid (NSI)	src,mid (NSI)	src,mid (NSI)	src,mid (NSI)	src,mid (NSI)		CT:1xECC
		1		ı	SP Pr	otocol l	_ayer		ı	I.	l .	I.	
P1	Fatal	SP Protocol Error										х	NC
		LATT Time-out Error (SNC)	х	х	х	х							NC
P2	Fatal	SPT Time-out Error (SPS)	х		х		х	х		х	х		NC
		LRB Time-out Error (SIOH)					x	x	x				NC
P3	Fatal	Received failed or unexpected unsupported SP request status response	х	х	х	х	х	х	х	х	х		NC
P4	Fatal	SPS Snoop Filter Uncorrectable ECC Error	src		src		src	src					NC
P5	Fatal	Strayed Transactions										х	NC
P6	Unc	Partial Merge Multi-Bit DATA ECC Error			mid			mid					CT:2xECC
P7	Corr	SPS Snoop Filter Correctable ECC Error	х		х		х	x					CS
P8	Corr	Partial Merge Single-Bit DATA ECC Error			end			end					CT:1xECC
P9	Corr	Illegal SP Address Error	src	src	src	src	src	src	src	src	src		CT:MA
P10	Corr	Received Master Abort Response	end	end	end	end	end	end	end	end	end		CT:MA
						Config							
C1	Fatal	Configuration Multi-Bit DATA ECC Error (write only)				end							CT:2xECC
C2	Corr	Configuration Single-Bit DATA ECC Error (write only)				end							CT:1xECC
	•		•	•	Hub In	terface ((SIOH)	•	•	•	•	•	
H1	Fatal	Hub Interface Header Multi-Bit ECC Error (HI2.0) or Parity Error (HI1.5) ⁱ		х		х	х	х	х		х		NCS
H2	Fatal	Hub Interface – Received DO_SERR# Message		end ^j		end ^j	end ^j				endj		NCS/ CT:2xECC



Table 6-4. E8870 Chipset Errors, Transaction, and Class Information (Continued)

							Trans	saction					
ERR #	Туре	Error Name	Proc read, coh	Proc read, non- coh ^a	Proc write, coh	Proc write, non- coha	Read from I/O, coh	Write from I/O, coh	Write from I/O ^b	SPS Back Invali- date	SPS Broad- cast ^c	No Trans- action	Error Class
	Hub Interface (SIOH)												
НЗ	Fatal	Illegal Inbound Hub Interface Request, Unexpected or Invalid Response		x			х	х	х		x		NCS
H4	Unc	Received Hub Interface Target Abort		src		src					src		CT:2xECC
H5	Unc	Inbound Hub Interface Multi-Bit Data ECC Error (HI2.0) or Parity Error (HI1.5)		src				src	src		src		CT:2xECC
H6	Unc	Outbound Multi-Bit Data ECC Error at HI 1.5 Cluster				end	end				end		CT:2xECC
H7	Corr	Inbound Hub Interface Single Bit Data ECC Error (HI2.0 only)		src				src	src		src		CT:1xECC
H8	Corr	Received Hub Interface Header Single Bit ECC Error (HI2.0 only)		х		х	х	х	х		х		CS
Н9	Corr	Outbound Single Bit Data ECC Error at HI 1.5				end	end				end		CT:1xECC
H10	Corr	Hub Interface Illegal Address Error					х	х	х				CS
H11	Corr	Received Master Abort on Hub Interface or Unimplemented Special Cycle		src		src			src				CT:MA

- a. A memory mapped I/O or I/O transaction.
- b. Peer-to-peer write.
- c. PLCK, PWNC (attr=INT), PPTC, PEOI, PULCK.
- d. Implicit write-back on a snoop.
- e. Memory update on implicit write-back.
- f. Partial write.
- g. N=SNC, S=SPS, I=SIOH.
- h. In smart PCI card error model where P64H2 is not programmed to send a DO_SERR special cycle.
- . Headers included on both request and completion packets.
- j. Assumes that P64H2 programmed to send a DO_SERR special cycle for ECC errors on outbound data or if PERR#/SERR# observed on PCI bus. Used in dumb PCI card error model.



6.5.4 ESP Error Logs

This section provides the format of the contents of the log registers for SP link layer and SP protocol layer errors. The contents of the error logs vary with the type of the error that is detected. Table 6-5 and Table 6-6 show the contents of the error log when the type of information that is logged for the error is "control" information.

Table 6-5. Control: SP Request Header Error Log

SP Request He	eader Fields		
Field Name	Number of Bits in Header	Description	Error Log Field
PktType	2	Packet Type: Req/Resp, Data/NoData	63 (Req/Resp)
DestNodeID	6	Destination Node ID	
Coh	1	(hardware) Coherent or Not	62
SrcTxnID	6	Transaction ID assigned by Source Node	61:56
SrcNodelD	5	Source Node ID	55:51
StreamID	6	ID of Stream within the Source Node	50:47 (low order bits)
Attr	4	Transaction Attributes	
Ord	2	Transaction ordering semantics	
ReqType	6	Request Type	46:41
DLen	3	Requested Data Length	
ByteEn	8	Byte Enables	
Addr	47	To support 50 bits physical address	40:0 (A43-A3)
Reserved	31	For future use	
ErrProt	16	Eight Error Protection bits for 64b information	
Total Bits	144		64

Table 6-6. Control: SP Response Header Error Log

SP Response H	eader Fields			
Field Name	Number of Bits in Header	Description	Error Log Field	
PktType	2	Packet Type: Req/Resp, Data/NoData	63:62	
DestNodeID	6	Destination Node ID	61:59 (low order bits)	
Coh	1	(hardware) Coherent or Not	58	
SrcTxnID	6	Transaction ID assigned by Source Node	57:52	
SrcNodelD	5	Source Node ID	51:47	
Attr	4	Transaction Attributes	46:43	
CMP	1	Transaction Completion bit	42	
RespType	4	Response Type	41:38	
DLen	3	Length of Data Associated with the Packet	37:35	
Route	2	Bits for efficient routing of response packets	34:33	



Table 6-6. Control: SP Response Header Error Log (Continued)

SP Response He	eader Fields			
Field Name	Number of Bits in Header	Description	Error Log Field	
XAddr	6	X Address bits from request packet are returned in this field for routing of response	32:27	
Reserved	87	For future use		
Prot	16	Error protection		
Total Bits	144		37	

For SP link layer ECC errors, information is logged in a data log register (REDSPL). Table 6-7 shows the contents of this log. For SP link layer errors related to flit transfer, phit specific information is logged in the RECSPL register. Table 6-8 shows the contents of the RECSPL for those errors.

Table 6-7. Link Layer Errors: Data Log Fields

Field Name	Description	Log Field	
Syn	Syndrome	15:8	
ECC	ECC Checkbits	7:0	

Table 6-8. Link Layer Errors: LLR and Phit Fields

Field Name	Description	Log field
LLRnum	Number of retries	63:61
Reserved	N/A	60:46
Phit_no	Phit number	45:42
SSO	SSO 41	
Par	Phit parity	39:38
LLC	Phit LLC	37:36
ECC	Phit ECC	35:32
Data	Phit data	31:0

Reliability, Availability, and Serviceability





intel_®
Clocking

7.1 System Clocking

In systems employing the E8870 chipset, the phase of the clock routed to each component can be arbitrary, although the variation in phase (drift) must be controlled. All of the signals between the SNC, SPS, and SIOH are source synchronous, or function asynchronously, allowing greater flexibility in the distribution of the system level clocks.

Agents that have common clock interfaces need clocks delivered in-phase. This condition exists at the processor bus and the Hub Interface interfaces. The SIOH provides clocks which can be used by the downstream I/O components (P64H2 and ICH4), and are in phase with SIOH component core clocks.

Clock Gearing and Fractional Ratios 7.2

There is no support for fractional ratios in the E8870 chipset components. A single clock is used at each external interface. It is not possible to run the processor bus or HI buses at a frequency independent of the core or other interfaces. All of these frequencies have fixed ratios to the other frequencies of the other interfaces. For example, on the SNC the processor bus control signals work at the same frequency as the core. The SP I/Os always work at 4x that frequency.

Figure 7-1 illustrates the clock distribution scheme the chip set is designed to support.

7.3 **Master Clock**

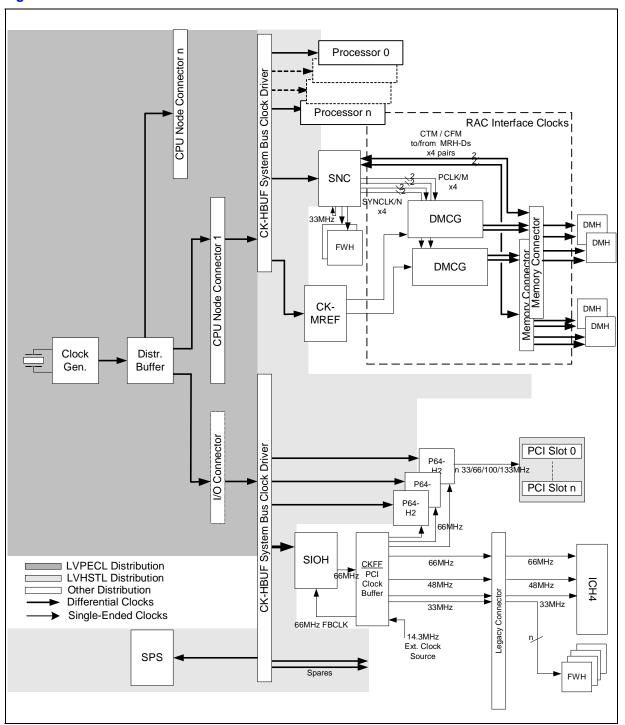
The Master System Clock is driven from a central oscillator or frequency synthesizer. A crystal oscillator is preferred to avoid cascading PLLs. Cascaded PLLs can amplify jitter. The frequency synthesizer defined for the E8870 chipset supports spread spectrum clocking to minimize EMI. The clock synthesizer is also capable of operating in non-SSC mode. Nominally this oscillator runs at 200MHz.

For highly available systems, two Master Oscillators can drive the Master Clock. If the primary fails, the backup oscillator can be selected by SMBus control.

The Master Clock is distributed to the processor node (processor and SNC), SPSs, and SIOHs without phase matching. This creates the following timing domains: each node, each SPS, each SIOH. These domains all run at multiples of the same frequency, but the phase between domains may vary. The SPs compensate for phase differences between these domains.



Figure 7-1. Clock Distribution Scheme





Processor and chipset reference clock inputs are differential. Each chipset component has a pair of differential clock input pins, BUSCLK+ and BUSCLK- on the SNC components, and SYSCLK+ and SYSCLK- on the SIOHs and SPS. These pins are the reference clock inputs for the PLL that supplies clocks to the core and I/Os. LVHSTL signaling is used. Lengths of processor bus clock traces must be matched to ensure the processors node bus I/Os are in-phase. Lengths of HI clock traces must be matched to ensure the SIOH and P64H2/ICH4 I/Os in-phase.

The SNC uses a divided BUSCLK to provide a 25 MHz clock for the common-clocked FWH components. This clock feeds both sides of the interface. Internal phase synchronizers are used to synchronize the external interface with the SNC core.

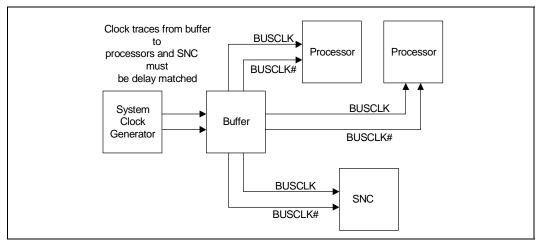
The SIOH uses a regenerated and divided SYSCLK to provide a 66 MHz clock for the common-clocked Hub Interface buses.

7.4 Itanium® 2 Processor Bus Clock

7.4.1 Differential Reference Clock (BUSCLK & BUSCLK#)

A 200 MHz common clock, originating from a vendor-supplied system clock generator, is provided to all processors and the SNC. This is the SNC system bus and Scalability Port reference clock. This 200 MHz clock is provided in-phase so that the processor bus can achieve maximum performance. The SNC and processors use this clock to drive and sample system bus common clock signals. All clocks generated by the SNC such as main memory channels, FWH, processor bus strobe, and SP transmission clocks are all derived from this clock.

Figure 7-2. Differential Bus Clock to Processors and SNC



Clock gearing is not be available in the SNC. This means that as the input frequency is increased, all subsystems must scale in frequency. That includes the SNC core, processor system bus, FWH, SP, RAC and DRCG/DMCG.

7.5 RAC Clocking Support

Clocking for the RAMBUS ASIC Cell (RAC) in the SNC is provided by the external Direct RAMBUS Clock Generator (DRCG/DMCG) components. These components require either a 50MHz or 100 MHz single-ended clock source. This clock is provided by the system designer.



Each Clock Generator requires two phase difference signals from each RAC within the SNC. The SNC provides a SYNCLK/PCLKN pair for each main channel. The PCLK and SYNCCLK divider must be cleared by reset to guarantee determinism.

For each main channel, the SNC provides a clock (RxSCK) for serial operations. This clock is normally 1 MHz, but will change to the SYNCLK frequency (100 MHz) for specific operations. This clock will be held low from the time PWRGOOD is asserted until after RESETI# rises so that it does not exceed the specified frequency before PLLs are stabilized.

7.6 DDR SDRAM Clocking Support

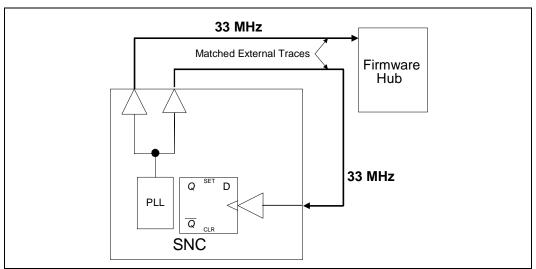
All DDR SDRAM clocking support is provided by the DMH component. The DMH converts the RAC signals of the SNC to interface to DDR SDRAMs. The DRCG/DMCG CTM clocks are used by the DMH to generate the clocks to the SDRAMs. Refer to the *Intel*[®] *E8870DH DDR Memory Hub (DMH) Datasheet* for details.

7.7 Firmware Hub Clocking

The FWH device connecting to the SNC requires a 33 MHz common clock signals. This clock is divided off of the core clock and output from the SNC to an external clock distribution amplifier with matched output traces to both the SNC and the FWH device.

The 33 MHz clock is provided to both sides of the interface in-phase. This clock is not in-phase with the core clock. Instead, synchronizers are used for these few signals. Data sampled with the incoming LCLK is transferred three core clock cycles (nominally 15 ns) after LCLKOUT is driven. This addresses metastability issues and ensures that FWH reads are deterministic while allowing a wide range in the length of external clock traces.

Figure 7-3. Firmware Hub Clocks





7.8 JTAG

The external TCK is synchronized to the internal core clock for interfacing to the TAP controller private chains. A metastability-hardened synchronizer is provided for this purpose. TCK interface to boundary scan uses TCK directly. TCK can be active 10 ms after RESET deassertion. When inactive, TCK should be deasserted (low). TCK can be clocked from 1 to 20 MHz.

The TCK high time is a minimum of five BUSCLK cycles in duration. The TCK low time is a minimum of five BUSCLK cycles in duration. This need not be in phase with the BUSCLK for public chain access.

7.9 SMBus Clocking

The external SMBus clock on the SNC is always a master. It is synchronized to the SNC core clock. Data driven to the SNC is handled with respect to the serial clock pin SCL. Data received on the SDA pin with respect to the slave agent's SCL is synchronized to the core using a metastability-hardened synchronizer. SCL can be active 10 ms after RESET deassertion. When active, SCL should be deasserted (high). SCL can be clocked at 100 kHz and 400 kHz.

7.10 Other Functional and Electrical Requirements

7.10.1 Spread Spectrum Support

The E8870 chipset will support Spread Spectrum Clocking (SSC). SSC is a frequency modulation technique for EMI reduction. Instead of maintaining a constant frequency, SSC modulates the clock frequency/period along a predetermined path (i.e., the modulation profile). The SNC is designed to support a nominal modulation frequency of 30 kHz with a downspread percentage of 0.5%.

7.10.2 PLL Lock Time

All chipset PLLs will lock within 1 ms of PWRGOOD assertion. This requires that the differential BUSCLKs be stable at least 1 ms prior to the assertion of PWRGOOD. The assertion of PWRGOOD initiates the PLL lock process. External clocks dependent on the PLL are LPC, memory main channels, SP strobes, and processor bus strobes.

7.11 Analog Power Supply Pins

The SNC uses three PLLs. Each PLL requires an Analog Vcc and Analog Vss pin and external LC filter.

Note: The filter is NOT to be connected to board Vss. The ground connection of the filter will be routed through the package and grounded to on-die Vss.

Clocking





int_{el}_® System Reset

Reset Types 8.1

The Intel E8870 chipset supports several reset types. Table 8-1 describes their causes, characteristics and the sequences they trigger. describes these sequences in detail.

Table 8-1. Intel[®] E8870 chipset Reset Types

Reset Type	Triggered by	Description	Sequence	
Power-up Reset Section 8.2.1	System power logic or reset button results in PWRGOOD assertion. This must be followed by a RESETI# deassertion.	Resets all E8870 chipset components to a known reset state. Produces a sync point for deterministic resets to follow.	PWRGOOD Deassertion, PWRGOOD Assertion, Hard Reset Deassertion	
Hot-Plug Power-up Section 8.2.1	One component powers up while the rest of the system is in normal operation.	Resets the hot-plugged module to a known reset state. Determinism is no longer possible after the module is brought on-line.	PWRGOOD Deassertion, PWRGOOD Assertion, Hard Reset Deassertion	
Hard Resets	Second and successive RESETI# assertions. Ultimate cause depends on system RESETI# distribution.	Resets all E8870 chipset components to a known reset state.	Hard Reset Assertion, Hard Reset Deassertion	
Deterministic Hard Reset Section 8.2.2.6	SNC SYRE.SysHardReset configuration bit. This asserts RESETO# which may be routed to RESETI#.	A type of Warm Reset that produces determinism.		
Processor-Only Hard Reset Section 8.2.2.7	Second and successive RESETI# assertions, steered by system logic to appropriate components.	A type of Warm Reset that only affects SNCs and processors. E8870 chipset configuration is preserved.		
SNC Local Hard Reset Section 8.2.2.7	SNC SYRE.SNCReset configuration bit.	Warm Reset to SNC, processors, DMH and LPC components.	Hard Reset Assertion, Hard Reset Deassertion	
SIOH Local Hard Reset Section 8.2.2.7	SIOH SYRE.SIOHReset configuration bit.	A hard reset that only affects components controlled by the SIOH.		
BINIT# Reset	Processor bus BINIT#	SNC is reset. Local memory access is provided after reset.	Hard Reset Assertion, Hard Reset Deassertion	
Soft Reset Section 8.2.3	If SNC drives INIT#, SNC.SoftReset configuration bit. If ICH4 drives INIT#, I/O events.	Forces the processor to start execution at the boot vector.	INIT# Assertion	



8.2 Reset Sequences

All E8870 chipset reset sequences with the sub-sequences are summarized in Table 8-2.

Table 8-2. Reset Response Sequences Summary

Sequence	Begins	Ends	SNC	SPS	SIOH		
PWRGOOD When PWRGOOD falls or as the		System Logic asserts PWRGOOD	Assert RESET# and LRESET#	N/A Assert RESET66			
	power rails rise. (not possible to define behavior prior to power supplies in spec)	PWRGOOD		ogic that can be reset in a single cycle (as require a sequential initialization). Outputs			
PWRGOOD Assertion	PWRGOOD rises. Internal clocks not stable yet.	RESETI# deassertion. Internal clocks		that can be reset in a single cycle except as d outputs. Configuration bits are set to default			
		stable.	SPS are disabled if booted from local FWH.	SPs enabled.			
			Reset any lower frequency clocks on exit.	N/A	Reset any lower frequency clocks on exit (if DET).		
First RESETI# Deassertion	First time RESETI# rises after PWRGOOD is	A few cycles after it begins.	Sticky Configuration bits Starts divide-by-8 for sub Hard reset deassertion s	sequent RESETI# sampling.			
	high.		Reset references for lower frequency clocks.	Snoop Filter initialization.	Reset references for lower frequency clocks (if DET).		
Hard Reset Assertion	Assertion of: RESETI# (warm),	Cycle after sequence	Configuration bits that are not protected by SYRE.SAVMEM or SYRE.SAVCFG are set to default values.				
Section 8.2.2.1	SYRE.HardReset, SYRE.SNCreset, SYRE.SIOHreset,	begins.	SPS are disabled if booted from local FWH.	SPs enabled.			
	BINIT#		Clear all logic that can be reset in a single cycle except that covered by SYRE.SAVCFG or SYRE.SAVMEM and sticky configuration bits, memory maintenance logic. Any outstanding RAMBUS operations must not be interrupted.	Logic that can be cleared reset.	d in a single cycle is		
Hard Reset Deassertion Section 8.2.2	Deassertion of: Warm Reset, SYRE.HardReset, SYRE.SNCreset, SYRE.SIOHreset, BINIT#	When sequence completes: 101ms max.	Clear all logic except that covered by SYRE.SAVCFG or SYRE.SAVMEM and sticky configuration bits. BNR stall. Optional MEMRST and CPURST. Multi-cycle initialization.	Multi-cycle initialization.	Clear all logic except sticky configuration bits. Multi-cycle initialization.		
Soft Reset Section 8.2.3	SNC SYRE. Soft Reset.	When sequence completes.	Assert INIT#	None			



8.2.1 Power-up Reset Sequence

The following sections define the timing required of external E8870 chipset signals at power-up. The power-up sequence is described in 3 phases: PWRGOOD deassertion, PWRGOOD assertion, and hard reset deassertion. Each component must see this timing at power-up, although they may not see the sequence at the same time. For example, if an SNC is hot-plugged, system logic on the hot-plug module must drive the SNC RESETI# pin as specified, but the connected SPS will be out of reset and operating normally.

Figure 8-1 shows the E8870 chipset power-up timing.

Figure 8-1. Power-up Reset Timing

Figure 8-2 shows the timing for a hard reset deassertion.

Figure 8-2. Hard Reset Deassertion Timing

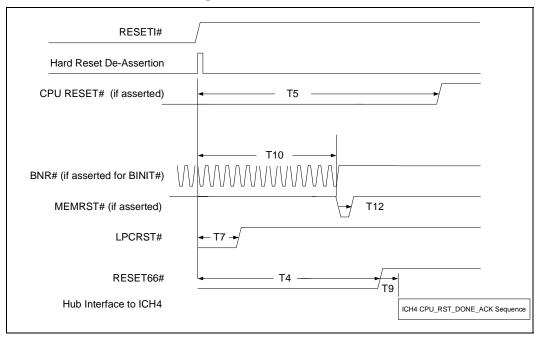


Table 8-3 specifies the timings drawn in Figure 8-1 and Figure 8-2. Nominal clock frequencies are described. Specifications still hold for de-rated clock frequencies.



Table 8-3. Power-up and Hard Reset Deassertion Timings

	Description	Min	Max	Comments
T1	Power stable to PwrGood active	10ms	As close to 10ms as possible.	
Т3	PWRGOOD assertion to RESETI# deassertion	1ms	2ms	This delay can be provided by system logic, or in non- deterministic systems by the ICH4.
T4	RESETI# deassertion to RESET66# deassertion	4002 SYSCLKs	4007 SYSCLKs	Variation is due to alignment of 66 MHz clocks and SYSCLK.
T5	RESETI# deassertion to processor RESET# deassertion.	200,000 SYSCLKs	200,000 SYSCLKs	Meets 1ms minimum Pulse width.
T7	RESETI# deassertion to LRESET# deassertion.	2 LPCCLKOUTs	10 LPCCLKOUTs	LPCCLKOUT is 25-33 MHz clocks.
Т9	RESET66# deassertion reset sequence (SIOH to ICH4).	16 CLK66s	20 CLK66s	66 MHz.
T10	Hard reset deassertion to BNR Throttle stops	3000/1500 BUSCLKs	3000/1500 BUSCLKs	BUSCLK is 200 MHz

Table 8-4. Critical Initialization Timings

Sequence	Started By	Maximum Length (200 MHz Clocks)	Covered by Timing Parameter	
SP Initialization in Half Speed Mode Including Framing	Hard reset deassertion	2864	T5	
SPS Snoop Filter initialization	Redundancy download complete	8000	T5	
SNC Memory Array initialization	Hard reset deassertion	128	T10	
DRCG Lock	Stable PCLKN and SYNCLKN from SNC	800,000	Software Initialization	
LPC	Stable LPCCLKOUT and LRESET deassertion	4000	T5	
SNC, SIOH Core clock PLL capture time	PWRGOOD Assertion	1000	Т3	
SPS DLL Capture	PWRGOOD Assertion	2000	Т3	
CLK66 PLL Capture	First Hard reset dassertion	1000	T4	
P64H2 PLL Capture	CLK66 stable	6000	T4	
Hub Interface Impedance Compensation	CLK66 stable	1000	T5- T4	
ICH4 CPURST Handshake	RESET66# deassertion	300	1	
SIOH Array initialization	Hard reset deassertion	512	T5	



8.2.1.1 PWRGOOD Deassertion

While PWRGOOD is deasserted, the SNC asserts RESET# to processors and LRESET# to the LPC interface asynchronously.

The SIOH asserts RESET66# asynchronously.

Since internal clocks will not be within specifications while PWRGOOD is deasserted, PWRGOOD must act asynchronously. All E8870 chipset components will reset any core logic that can be asynchronously reset, and all logic must be forced into a non-destructive state. For example, multiple drivers must not attempt to drive the same signal to different logic values. JTAG chains and any logic clocked by TCK should be cleared. The TAP will not be operational until PWRGOOD is asserted. TCK may or may not be active at this time. All outputs (except for any reset outputs) are placed in a high impedance state.

RESETI# must be asserted when PWRGOOD rises.

If the E8870 chipset is operating, PWRGOOD can be deasserted to produce a total reset. In this case power supplies and external clocks have been stable for more than 10ms, so PWRGOOD need not be held inactive for more than 80ns.

8.2.1.2 PWRGOOD Assertion Sequence

RESETI# must be asserted by the system for 1ms after PWRGOOD rises to allow E8870 chipset PLLs to lock. All logic in E8870 chipset components may be reset while RESETI# is asserted the first time after PWRGOOD. Public JTAG chains and any logic clocked by TCK must be operational (even though RESETI# is still asserted). Private JTAG chains need not be operational while RESETI# is asserted.

SIOH should drive RESET66# to reset Hub Interface devices asynchronously.

The SNC continues to assert RESET# to processors until the first RESETI# deassertion.

8.2.1.3 First RESETI# Deassertion Sequence

SIOH should continue to drive RESET66# until T4 expires. Snoop Filter initialization is done next.

The first RESETI# deassertion after PWRGOOD is the synchronizing event for determinism.

RESETI# may or may not be distributed synchronously to 200 MHz core clock, but deassertion must be detected by sampling with the 200 MHz internal core clock in each E8870 chipset component.

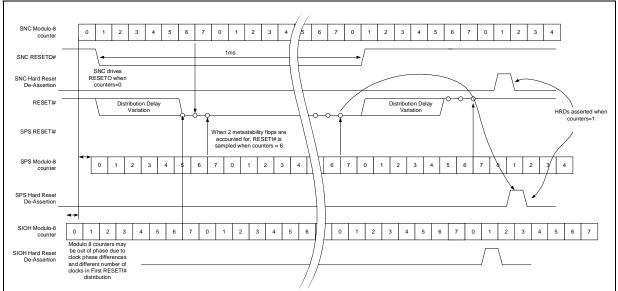
References to clocks slower than 200 MHz generated by the E8870 chipset are reset by the first RESETI# deassertion. The references must achieve their new phase ten clocks after the clock that sampled the first RESETI# inactive. Any PLLs associated with those references may have to recapture. This does not imply that external clocks rise on the same picosecond. The important thing is that when the slower clocks transfer data to the 200 MHz domain, the transfer occurs on the same 200 MHz edge on each reset and across different systems. Examples of slow clocks are LPCCLKOUT, SPDCLK, SYNCLKN and PCLKN, and CLK66.

In the SNC, SPS, and SIOH, a modulo-8 counter is started on the first RESETI# deassertion. This counter qualifies RESETI# sampling so that it is effectively sampled at 25 MHz. System logic is allowed ~20ns (allowing for maximum 200 MHz clock skew between components and 5ns of output delay + input setup) to distribute RESETI# to all components. Due to variation in clocks this reset distribution, the counters in all components may not be in phase, but if the first RESETI#



rising edge makes setup and hold at each component, the counters will all have the same phase relationship on each power-up. Figure 8-3 shows how this sampling guarantees that RESETO# from any SNC will produce the same hard reset deassertion phasings in each component.

Figure 8-3. Warm RESETI# Sampling



The SNC starts a 240 cycle counter that is a multiple of the periods of all E8870 chipset clock dividers that are not cleared on subsequent resets. The 240 cycle counter is not reset with subsequent resets, staying in synch until PWRGOOD is asserted. When memory operations are enabled in the SNC, the memory maintenance cycle is started when this counter=0. The memory maintenance timer is also a multiple of 240 cycles, so it is also in phase with the clock dividers. Subsequent RESETI# assertions can be deterministic if they are driven with fixed timing relative to the memory maintenance cycle.

Hard Reset Deassertion Sequence Triggered

When RESETI# first rises, it triggers a hard reset deassertion sequence in all E8870 chipset components. This sequence is described in Section 8.2.2.4. The first hard reset deassertion differs from subsequent deassertions as follows:

- All sticky configuration bits are cleared. They may have already been cleared by PWRGOOD, but clocks have been invalid since then. The inputs to sticky state must be masked to keep them from latching invalid inputs produced during the reset sequence.
- Since the default value of SNC SYRE.SAVMEM is 0, the hard reset deassertion sequence in the SNC is not delayed by the memory maintenance cycle.



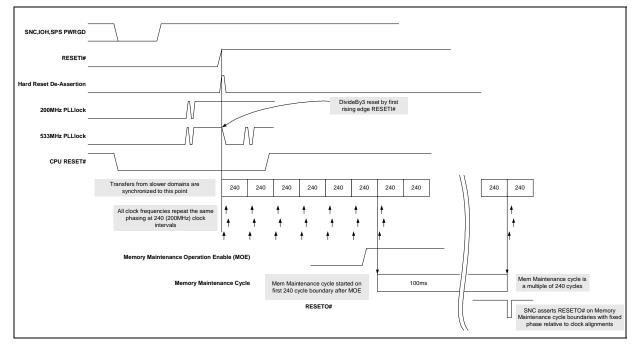


Figure 8-4. Synchronization Point for Determinism

8.2.2 Hard Reset

8.2.2.1 Hard Reset Assertion Sequence

- RESETI# assertions need only be 80ns in width. Since hard reset assertion is a synchronous
 response and core clocks are not valid during PWRGOOD, no hard reset assertion occurs in
 the power-up sequence.
- Setting SYRE.SNCReset in SNC and SYRE.SIOHReset in SIOH.
- BINIT# assertion on SNC.
- Setting SYRE.HardReset configuration bits in the SNC.

Only the first hard reset assertion restarts clocks and clock references.

All logic that can be cleared in a single cycle may be cleared (for example flops with individual resets, as opposed to arrays of non resetable storage that requires a sequencer to write 0's to each storage element in the array). Configuration bits are set to default values. Logic that remains functioning through hard reset such as sticky configuration bits, SNC configuration protected by SYRE.SAVCFG and Memory Maintenance Logic (when SYRE.SAVMEM is set) must not be affected during hard reset. This logic must be protected from invalid inputs during reset. This includes inputs from de-activated buses, initialization sequences, and spurious inputs on internal interfaces. All operations initiated on the interface to this logic must be completed legally before hard reset deassertion. The SNC will assert BNR# or RESET# on the processor bus until hard reset deassertion and SPs will be disabled (if there are processors on the bus and Local firmware) to support Itanium 2 processor BINIT#.

Logic that need not function through reset, (such as all logic in the SPS and SIOH, and all SNC logic when neither SYRE.SAVCFG or SYRE.SAVMEM are set) may be held reset as long as RESETI# is asserted.



8.2.2.2 Hard Reset Assertion that Does Not Preserve Memory nor Configuration

As the default value of SAVMEM is 0, power-up reset follows this path. Internal clocks are not stable when PWRGOOD rises, so these actions are not guaranteed to immediately take effect. However, the clocks will become stable long enough before RESETI# rises for these actions to succeed. The SNC will respond to hard reset deassertion that does not preserve memory nor configuration as follows:

- Assert RESET# and Power-on Configuration to the processor bus.
- Assert LRESET# and clear the FWH interface.
- The SNC holds all logic reset. Multi-cycle initialization does not start, so arrayed structures are not yet initialized.
- The SPs are disabled.
- The SNC is ready to proceed to hard reset deassertion as soon as the deassertion trigger arrives.
- No configuration bits are reset due to hard reset assertion.

8.2.2.3 Hard Reset Assertion that Preserves Memory or Configuration

The SNC will respond to hard reset deassertion that preserves memory or configuration as follows:

- New requests on the processor bus are blocked. The SNC asserts BNR# according to the
 processor bus protocol. The SPs are disabled. If the reset is local to the SNC, this will hang
 other chipset components. A hard reset that does not apply to all chipset components is not
 continuable.
- No configuration bits are reset. Sticky bits may need to be protected from spurious changes caused by initialization.
- The SNC may reset any logic not required to maintain memory or to complete memory operations already initiated. The logic that tracks the DMH write queues is cleared, but any operations already initiated must complete without violating DDR timing. Memory Scrubbing logic should be reset.
- Assert LRESET# and clear the FWH interface.
- Any operations already initiated on main channel, and main channel serial interface are
 completed correctly externally. A limited number of new operations stored in the SNC may be
 initiated if that simplifies the design of the logic running through reset. All operations initiated
 should be completed correctly.
- Memory maintenance operations such as current calibration, temperature calibration, and refresh must continue through reset. The sequence of refresh banks is not disturbed.
- Delay hard reset deassertion until the memory maintenance cycle completes. If memory maintenance operations are not enabled by SCC.MOE, the memory maintenance cycle is completed every 240 cycles.

8.2.2.4 Hard Reset Deassertion Sequence

Whenever a hard reset deassertion is detected, all components begin to initialize their internal structures. The timing of hard reset deassertion sequence is shown in Figure 8-2.



CLK66 and CLK33 references are reset only on the First Reset deassertion. After a delay to allow CLK33 and CLK66 to stabilize, the SIOH deasserts RESET66# and initiates the ICH4 CPURST handshake sequence. Subsequent resets have no effect on these clocks.

SP initialization and framing is started. SPs are enabled in all components except SNCs with local firmware and processors attached. SP framing will not complete until software enables those SPs.

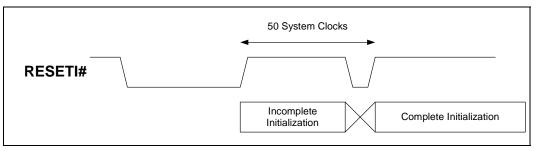
The SNC holds off processor requests. Unless BINIT# was the cause of the hard reset, the SNC holds CPU RESET# and power-on-configuration for 1ms. If BINIT# was the cause, The SNC toggles BNR# until the SNC completes multi-cycle initialization. MEMRST# is asserted to clear any posted writes in the DMH. All multi-cycle initialization processes are started at this point.

Strapping pins (such as NODEID and BUSID) that are defined to be sampled when RESETI# rises, are sampled.

When the hard reset deassertion sequence is complete, all logic should be initialized except for sticky configuration bits and SNC configuration covered by SYRE.SAVMEM and SYRE.SAVCFG. All logic associated with memory maintenance should be reset such that the memory maintenance counter is not disturbed. Inputs from buses tristated during reset must be masked until it is guaranteed that bus values are electrically and logically valid.

A hard reset deassertion will be re-triggerable within 50 clocks, as shown in Figure 8-5.

Figure 8-5. Reset Re-triggering Limitations



8.2.2.5 Hard Reset Deassertion

The SNC will respond to hard reset deassertion as follows:

- Release LRESET#.
- Release any resets on SNC logic held while RESETI# was asserted.
- Start SP initialization. The SPs are disabled if there is local firmware and processors present. In that case SP framing will not complete until the SPs are enabled by software.
- If BINIT# caused the reset,

Toggle BNR#.

else

Clear non-sticky configuration register bits that are not protected by SYRE.SAVCFG or SYRE.SAVMEM. This includes SYRE.SAVMEM and SYRE.SAVCFG. Software must set these bits again for them to take effect on the next reset.

Assert RESET# and capture address bits in the CVCR register.

Multi-cycle initialization processes are started. The LATT and RATT should be initialized
within 200 cycles. The data buffers need not be initialized. The SNC never reads a data buffer
before it is written.

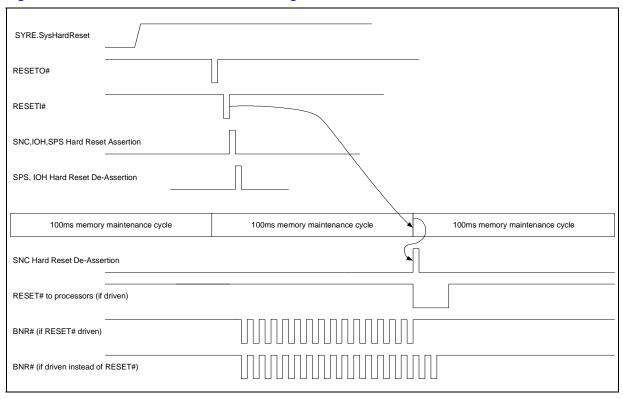


After Multi-cycle initialization is complete,
 If ((MC.MT indicated DDR before the reset) OR
 (this is the First Reset Deassertion after PWRGOOD)), Pulse MEMRST# to invalidate any
 writes buffered in the DMH.

8.2.2.6 Deterministic Hard Reset

The E8870 chipset behavior following the first RESETI# deassertion will not necessarily be repeatable. The E8870 chipset guarantees determinism only from resets triggered by a configuration write to the system hard reset bit in the SNC SYRE register. First, software must set the SYRE.SAVMEM configuration bit.

Figure 8-6. Deterministic Hard Reset Timing



Preserving Memory

If SYRE.SAVMEM is set (and memory maintenance operations are enabled SCC.MOE), the SNC will maintain memory through RESETI# assertions. Hard reset deassertion will clear this bit, so it must be set each time a deterministic reset is required. Software then sets the SNC system hard reset configuration bit. RESETO# is driven from a flop enabled by the modulo-8 counter that samples RESETI#. The system routes RESETO# to RESETI# in the SNC, and RESETI# to SIOH. SPS and SIOH perform their hard reset deassertion sequences when RESETI# is deasserted, but the SNC does not begin its hard reset deassertion sequence until the memory maintenance cycle is complete. Memory maintenance operations continue while RESETI# is asserted.

Up to 72 writes may be dropped in the SNC and DMH unless flushed by software.



DDR-SDRAM refresh is not synchronized to the memory maintenance cycle. The DDR refresh counter in the SNC will be cleared on hard reset deassertion to maintain determinism. In the worst case, this can double one refresh interval. Since refreshes rotate across the 16 possible DIMM sides, a given DIMM side may experience a refresh interval 17/16^{ths} longer than usual. To guarantee that each DIMM side receives one refresh every 15.6 us, the refresh rate must be set 17/16 higher than required by DDR specifications. Writes buffered in the DMH and the corresponding timing conflict trackers in the SNC will be cleared on hard reset deassertion.

If the SYRE.SAVMEM configuration bit is set, the SNC hard reset deassertion sequence starts at the end of the memory maintenance cycle, the determinism synchronization point. BNR# is toggled until the end of the next memory maintenance cycle. At that point, a hard reset deassertion response starts. Unless BINIT# was the cause of the reset, BNR# is deasserted and RESET# is asserted to the processors. If BINIT# was the cause of reset, BNR# is toggled instead. In either case, the first processor request, which initiates all system activity, occurs with fixed timing relative to all E8870 chipset clocks.

Non-deterministic Hard Resets

Since a hot-plugged component does not get the same synchronization point as the rest of the system, deterministic operation is not possible after it is brought on-line. The hot-plugged component never received the same synchronization point as the rest of the system. Only a Power-up Reset Sequence can provide this synchronization point.

If the SYRE.SAVMEM bit is not set in the SNC, memory maintenance operations are not enabled, the RESETI# is not delivered synchronously, or the reset is not triggered by SNC SYRE.SysHardReset configuration bit, the E8870 chipset operates as previously described, but determinism is not guaranteed. The Hard Reset Assertion and Hard Reset Deassertion sequences remain the same.

8.2.2.7 Local Resets

Local Resets clear some E8870 chipset components but not others. If there are any outstanding transactions, the portion of the E8870 chipset system that is not reset will hang. If system operation is expected to continue, software must guarantee that all transactions are complete.

The SNC Reset bit in the SYRE register initiates a hard reset sequence in the SNC, which will reset processors and the LPC interface. This bit will be reset when the hard reset deassertion sequence is complete. This reset is delayed long enough to allow an SP configuration write that sets the bit to complete in the idle case.

The SIOH Reset bit in the SYRE register initiates a hard reset sequence in the SIOH, which will reset all Hub Interfaces. This reset is delayed long enough to allow an SP configuration write that sets the bit to complete in the idle case.

Processor-only resets clear some E8870 chipset components but not others. If there are any outstanding transactions, the portion of the E8870 chipset system not reset will hang. If system operation is expected to continue, software must guarantee that all transactions are complete. A processor only reset preserves E8870 chipset configuration through reset. SYRE.SAVCFG is cleared by RESETI# assertions, so it must be set before each write to the system hard reset bit in the SNCs SYRE register.

Whenever an SP is reset, both sides of the bus re-initialize.



8.2.2.8 Itanium[®] 2 Processor BINIT# Reset

A BINIT# assertion on the Itanium 2 processor bus triggers a hard reset assertion sequence followed by a hard reset deassertion sequence in the SNC. The hard reset assertion sequences results in the processor and SP buses being blocked while outstanding memory accesses are completed. RESET# and associated processor power-up configuration values are not driven. BNR# is deasserted when the memory maintenance cycle is complete. Local memory and local flash will be accessible after the sequence completes. This enables the processor to dump state into local memory. Only local memory access is possible following a BINIT#. Continued machine check operation after BINIT# is not supported on systems with no local flash.

Resetting the SNC during normal operation will hang the remainder of the system. In order to store the memory image to disk, software must set the SYRE.SAVMEM bit which was cleared by the BINIT hard reset deassertion. Then it must initiate a reboot by setting the system hard reset bit in the SNC SYRE register. Providing that SYRE.SAVMEM was set in all SNCs of the system during reboot, the memory image may be saved to disk.

8.2.3 Soft Reset

If the SNC SYRE.SoftReset configuration bit is set, INIT# is asserted

8.2.4 Software initialization

8.2.4.1 SNC SPs

On an SNC that has working processors and local firmware present, the SPs will come up disabled. Once the node completes node boot, software will enable the SPs, and the framing process will complete.

8.2.5 Memory after Hard Reset

Software need not re-initialize memory after a reset when the SNC SYRE.SAVMEM bit is set. If SAVMEM is not set, the memory must be initialized as it was for power-up. Any software using this feature must remember that memory has been initialized through a reset; the SNC will provide no indication.

8.3 Reset Signals

The E8870 chipset signals that are involved in reset are summarized in the following sections. The timing of these signals is described in Section 8.2, "Reset Sequences."

PWRGOOD will be deasserted as the voltage supplies come up, or may be pulsed after power-on to clear the system. The assertion of the PWRGOOD signal indicates that external clocks and power at the particular E8870 chipset component is stable.

Figure 8-7 provides an example of the simplest power-good signal distribution. It is not necessary that the PWRGOOD signal is distributed in this fashion. For example, hot-plug considerations may require each SNC to have a separate PWRGOOD signal. Figure 8-1 shows the required timing.



SPSs SNCs PWRGOOD PWRGOOD

PWRGOOD SIOHs
DET

Power Good
Logic

Processors PWRGOOD

Figure 8-7. Simplest Power Good Distribution

8.3.1 ICH4: PWROK

This pin causes the ICH4 to assert PCIRST#. It may be connected to PWRGOOD pins of all E8870 chipset components (as illustrated in Figure 8-7), or the result of an OR of PWRGOOD, SNC RESETO# pins, or other sources of hard reset (as illustrated by Figure 8-8). PWROK must be delayed until SIOH clocks to the ICH4 are stable.

8.3.2 Basic Reset Distribution

Figure 8-8 shows an example on the reset distribution of an E8870 chipset system. The ICH4 will generate PCIRST# from either PWRGOOD or writes to certain registers. This PCIRST# will be buffered and distributed to each component's RESETI#. The SIOH generates RESET66# on each Hub Interface, and the SNC generates RESET# to processors, MEMRST#, and LRESET#.

8.3.3 SIOH: DET

The DET pin is strapped high to enable determinism in the E8870 chipset. If high, CLK33 and CLK66 references are reset on first hard reset deassertion as described in Section 8.2.2.4, "Hard Reset Deassertion Sequence". If this pin is low, the dividers that provide references for these clocks can come up at an arbitrary phase relative to the same clocks on other SIOHs and SNC memory maintenance operations.

8.3.4 ICH4: PCIRST#

ICH4 will drive PCIRST# for a minimum of 1ms after the deassertion of its PWROK pin or when the hard reset sequence is initiated through the CF9 I/O register. For non-deterministic systems, this may be connected to RESETI# of the SNC, SIOH, and SPS.



Figure 8-8. Basic System Reset Distribution

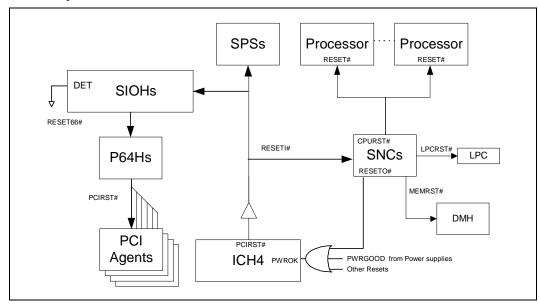
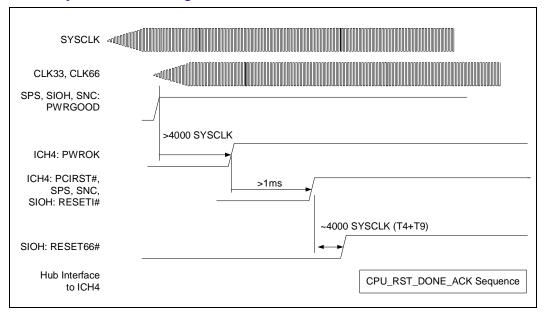


Figure 8-9. Basic System Reset Timing



8.3.5 SNC and SIOH and SPS: RESETI#

This pin is the hard reset input to the SNC, SPS and SIOH. It may be driven by the ICH4 PCIRST# signal (Figure 8-8) or, if determinism is required, by system reset control logic.



8.3.6 SIOH: RESET66#

This pin is asserted combinationally while RESETI# is asserted or asynchronously after PWRGOOD assertion, or if the hard reset bit is set in the SIOH SYRE register. RESET66# will rise synchronously to CLK66. This pin will be driven to the P64H2 RSTIN# pin.

8.3.7 P64H2: RSTIN#

The SIOH drives this with RESET66#. All P64H2 logic is cleared synchronously when RSTIN# is asserted.

8.3.8 SNC: RESETO#

The SNC drives its RESETO# pin after the system hard reset bit in the SYRE register is written. It does not reset the SNC or any other E8870 chipset logic. RESETO# assertion is delayed until the Memory Maintenance Cycle completes so that resets are synchronized with memory maintenance operations.

8.3.9 SNC: RESET# and Processor Power-on Configuration

The SNC drives the RESET# pin on the processor bus to hard reset the processors. The SNC drives power-on configuration from its CVDR register to certain processor bus address lines while this signal is asserted.

The SNC drives the RESET# signal asynchronously on this interface while PWRGOOD is deasserted.

After PWRGOOD is asserted, RESETI# will be asserted; RESET# is still driven asynchronously.

When RESETI# is deasserted, RESET# is deasserted synchronous to BUSCLK.

8.3.10 SNC and DMH: MEMRST#

The SNC asserts MEMRST# to the DMH. It is pulsed just as RESETI# is deasserted. MEMRST# clears posted writes inside the DMH, so when memory is present, it is pulsed on every SNC Hard Reset De-assertion.

8.3.11 SNC and DMH: R[3:0]SCK,R[3:0]SIO,R[3:0]CMD

The SNC holds SCK in reset until RESETI# is deasserted. After that it toggles at 1 MHz. Firmware initializes the DMH through this interfaces.

8.3.12 SNC: LRESET#

The SNC asserts LRESET# to the LPC/FWH port. It is driven active while RESETI# is asserted and deasserted synchronous to LPCCLKOUT after SNC hard reset deassertion. LRESET# must be driven active for at least 100ns and no LPC access must occur for 20us.



8.3.13 SNC: BNR#

The SNC toggles BNR# to prevent requests from being initiated on the processor bus until the E8870 chipset initialization is complete.

8.3.14 SNC: BINIT#

In the SNC, this pin initiates the reset described in Section 8.2.2.8, "Itanium® 2 Processor BINIT# Reset".

8.3.15 SNC: INIT#

Asserting the INIT# signal to the processors forces them to start execution at the boot vector. The SNC provides an INIT# output that is asserted when the Soft Reset bit in the SYRE register is set. System logic should combine the SNC INIT# signal with INIT# signals from other sources (such as the ICH4), and drive the result to the processors.

The SNC does not respond to INIT# assertion.

8.3.16 P64H2: CLK66,PXPCLKO,PXPCLKI

The P64H2 gets 66 MHz phasing information from the SIOH CLK66. The P64H2 uses these and the 200MHz to produce a 66 MHz internal clock that is in phase with CLK66. This is phase locked to the P64H2 core clock which is locked to the PxPCLKO. This is distributed to the PCI devices. PxPCLKI is delay matched by system logic so that it arrives at the P64H2 at the same time as it arrives at the other devices on the bus. The P64H2 supports a mode in which the skew between CLK66 and PxPCLKI is controlled. Synchronous transfers can be made between the Hub Interface domain and PCI domain.

8.3.17 SIOH: CLK33

This clock is CLK66 divided by two. The system must control CLK33 routing delays between SIOH and ICH4 in order to meet ICH4 clock phasing requirements.

8.3.18 SNC and SPS and SIOH: NODEID, BUSID

These straps are sampled as RESETI# deasserted.



Electrical Specifications

9.1 Non-operational Maximum Rating

The absolute maximum non-operational DC ratings are provided in Table 9-1. T. Functional operation at the absolute maximum and minimum ratings is neither implied nor guaranteed. The SNC should not receive a clock while subjected to these conditions. Functional operating conditions are given in the AC and operational DC tables. Furthermore, although the SNC contains protective circuitry to resist damage from static discharge, one should always take precautions to avoid high static voltages or electric fields.

Table 9-1. Absolute Maximum Non-operational DC Ratings at the Package Pin

Symbol	Parameter	Min	Max	Unit	Notes
Tstorage	SNC storage temperature	-10	45	°C	
Vcc (All)	SNC supply voltage with respect to Vss	-0.50	Operating voltage + 0.50	V	
Vin (AGTL+)	AGTL+ buffer DC input voltage with respect to Vss	-0.50	VTTMK + 0.50	V	
Vcc (CMOS)	CMOS buffer DC input voltage with respect to Vss	-0.50	VCC (CMOS)+ 0.50	V	

9.2 Operational Power Delivery Specification

SNC power requirements are outlined in this section. All parameters in Table 9-2 are specified at the pin of the component package.

Table 9-2. Voltage and Current Specifications

Symbol	Parameter	Min	Typical	Max	Unit	Notes
Core Voltage and I/O						
VCC	Core Voltage	1.425	1.5	1.575	V	a,b
ICC _{CORE}	SNC Core Current		3.0	6	Α	С
dICC/dt _(Core)	Transient Core Slew Rate		1	2	A/ns	
System Bus						
VTTMK	System Bus Termination Voltage	1.2-1.5%	1.2	1.2+1.5%	V	d
I _{VTTMK}	System Bus Termination Current		3.6	7.2	Α	е
dl _{VTTMK} /dt	System Bus Termination Transient Slew Rate	0.75	1.0	2	A/ns	
Termination Resistor	AGTL+ Termination Resistor	ODT-5%	ODT	ODT+5%	Ohm	f,g



Table 9-2. Voltage and Current Specifications (Continued)

Symbol	Parameter	Min	Typical	Max	Unit	Notes
Memory main channel Interface						
VCCRIO	Termination Voltage	1.71	1.8	1.89	V	
Irio	Termination Current			650	mA	h
dIrio/dt	Transient Slew Rate			0.025	A/ns	
Scalability Port Interf	acei					
VCCSP	Scalability Port Supply Voltage	1.209	1.30	1.391	V	j,k,l
Isp	Scalability Port Current			0.50	Α	m,n
dlsp/dt	Transient Slew Rate			1.0	A/ns	0
LPC and I ² C			•		•	
Vcc3.3lpc,Vccl2C	LPC and I ² C Voltage	3.135	3.3	3.465	V	р
lv	LPC and I ² C Current		140	230	mA	
dlv/dt	LPC and I ² C Transient Current		0.35	0.55	A/ns	q

- Core voltage for SNC.
- b. Specification comprehends all AC and DC components.
- c. The maximum ICC current is the worst case specification, (i.e. Vcc max, low temperature and application mix) intended for power supply design.
- d. Itt max can be calculated from Ron (min) at Vol (max).
- e. Only applies to the SNC terminating and not the entire processor's system bus termination current requirement.
- f. The on-die Rtt is measured at Vol of the AGTL+ output driver. Refer to component I/O buffer model for I/V curve.
- g. ODT (on-die termination) nominal value is driven from the externally installed resistor, 86.7 Ohm resistor at 1%, 0.1W, or better, across the FSBODTCRES0 and FSBODTCRES1 pins.
- h. Specification is per main channel.
- Estimated values provided for power budgeting considerations; these parameters are not tested. This is the same SP interface as specified in SIOH and SPS.
- j. Vccsp budget is ±3% DC, and (DC + AC) at ±7% noise delivered at the pin.
- k. The power pins are separated at the package from the Vcc core or other supplies on-die.
- The power supply must be local to each component. The SP power supply between two communicating ports needs to be separate.
- m. The current requirement per scalability port (SP) port.
- n. Under normal operating conditions. However, under certain test conditions, Isp might exceed the specification.
- o. The specification is per SP port at the package pin.
- p. Two pins can be tied together on the motherboard.
- q. I²C circuitry does not contribute significantly to the 3.3V transient load.

9.3 SNC System Bus Signal Group

9.3.1 Overview

In this section, the system bus signals relevant to the SNC are outlined.

SNC system bus interface signals use the Itanium processor's AGTL+ (assisted gunning transceiver logic) signaling technology. The termination voltage, VTTMK, is generated on the baseboard and is the system bus high reference voltage. The buffers that drive most of the system bus signals on the SNC are actively driven to VTTMK during a low-to-high transition to improve rise times and reduce noise. These signals should still be considered open-drain and do require termination to VTTMK.

The system bus is terminated to VTTMK through active termination within the bus agents at each end of the bus. VTTMK specification is outlined in the Power section, see Table 9-2.



AGTL+ inputs use differential receivers which require a reference signal (Vref). The SNC generates Vref on-die so there is no need for external logic.

9.3.2 Signal Group

Table 9-3 contains the SNC system bus signals that are combined into groups by buffer type and whether they are inputs, outputs, or bidirectional with respect to the SNC.

Most of the system bus signals use assisted gunning transceiver logic (AGTL+) signaling technology. This signaling technology provides improved noise margins and reduced ringing.

AGTL+ output signals require termination to VTTMK. In this section, "AGTL+ Input Signals" refers to the AGTL+ input group, as well as the AGTL+ I/O group when receiving. Similarly, "AGTL+ Output Signals" refers to the AGTL+ output group as well as the AGTL+ I/O group when driving.

The SNC system bus interface signal pins are terminated via on-die termination to VTTMK supply voltage, so no external termination resistor is required.

The system bus clock signals are LVHSTL, which are compatible with the Itanium 2 processor differential clock inputs. All miscellaneous and clock signals are documented in Section 9.8 and Section 9.9.

Table 9-3. SNC System Bus Signal Groups

Signal Group		Signal			
AGTL+ Output Signals	BPRI#, DEFER#, GSEQ#, ID[9:0]#, IDS#, RESET#, RS[2:0]#, RSP#, TRDY#				
	D[12		INIT#, BNR#, BPM[5:0]#, BREQ0#, 0]#, DRDY#, HIT#, HITM#, REQ[5:0]#, #, TND# Associated Strobe		
		REQ[5:0]#,A[49:3]#	ADS#		
		D[15:0]#, DEP[1:0]#	STBP[0]#, STBN[0]#		
A OTHER MODERNIA		D[31:16]#, DEP[3:2]#	STBP[1]#, STBN[1]#		
AGTL+ I/O Signals		D[47:32]#, DEP[5:4]#	STBP[2]#, STBN[2]#		
		D[63:48]#, DEP[7:6]#	STBP[3]#, STBN[3]#		
		D[79:64]#, DEP[9:8]#	STBP[4]#, STBN[4]#		
		D[95:80]#, DEP[11:10]#	STBP[5]#, STBN[5]#		
		D[111:96]#, DEP[13:12]#	STBP[6]#, STBN[6]#		
		D[127:112]#, DEP[15:14]#	STBP[7]#, STBN[7]#		
AGTL+ Input Signals	BREQ[3:1]#, LOCK#				
Special AGTL+ Asynchronous Output Signals	INIT#				
Power/Other ^a	VCC ^b , VTTMK ^c , VSS				
Analog Input ^d	VCC	VCCAFSB ^e , VSSAFSB, FSBSLWCRES[1:0] ^f , FSBODTCRES[1:0] ^g			

a. The SNC generates system bus Vref on-die.

b. SNC core voltage. See Table 9-2.



- c. VTTMK, the system bus termination voltage. See Table 9-2.
- d. PLL analog voltage input.
- e. Connect to 1.5V ±5% supply on the motherboard through a network filter.
- f. Connect 1K Ohm, 1%, 0.1W, resistor across the FSBSLWCRES0 and FSBSLWCRES1.
- g. Connect 86.7 Ohm 1%, 0.1 W, resistor across the FSBODTCRES0 and FSBODTCRES1.

9.3.3 DC Specifications

The DC specifications for all the system bus interface signals are contained in Table 9-4.

Table 9-4. SNC AGTL+ DC Parameters^{a,b}

Symbol	Parameter	Min	Max	Unit	Notes
Vil	Input Low Voltage		0.585	V	С
Vih	Input High Voltage	0.915		V	С
Vol	Output Low Voltage		0.40	V	С
Voh	Output High Voltage	1.05		V	С
lol	Output Low Current	17		mA	
Ili	Input Leakage Current		50	μA	
C _{AGTL+}	AGTL+ Pin Capacitance	2.8	4.0	pF	

- a. All specifications are at the pin of the package
- b. Parameters applies to input, output and I/O buffer.
- c. All specifications are measured into a 50-ohm test load connected to 1.2V.

9.4 Scalability Port (SP) Signal Group

The SP interface is a source-synchronous interface with coincident data and continuous strobe transmission. The data and strobe signals are launched simultaneously and are expected to arrive at the receiver with the same timing relationship to one another.

Each SP port consists of two strands that are further subdivided into two bundles. Each SP port consists of 32 data bits, 4 ECC bits, 2 parity bits, 2 SSO coding bits, 2 link layer control (LLC) bits, 4 strobe pairs (8 signal pins), reserved pins, and 8 reference voltage pairs (16 signal pins).

The simultaneous bi-directional (SBD) signaling can create conditions for three logic levels on the interconnect (0, 0.65, 1.3)V, depending on the data values driven from each end of the trace.

All SBD signals are terminated via on-die termination. The reference voltages are generated on die and are set to 1/4VCCSP and 3/4VCCSP, so no external logic is needed to generate these reference voltages.

Each SP voltage reference pin is required to be interlinked to the corresponding SP port.

Table 9-5 summarizes the signal grouping of the SP interface. The "x" in the signal names is replaced with the specific SP port on the SIOH (0 or 1).

Table 9-5. Scalability Port Interface Signal Group

Signal	Signal Description
SBD I/O	SPxAD[15;0],SPxBD[15;0], SPxASTBP[1:0], SPxASTBPN[1:0], SPxBSTBP[1:0], SPxBSTBPN[1:0], SPxAEP[2:0], SPxBEP[2:0], SPxALLC, SPxBLLC, SPxASSO, SPxBSSO
CMOS1.5 I/O OD ^a	SPxGPIO[1:0]



Table 9-5. Scalability Port Interface Signal Group (Continued)

Signal	Signal Description
CMOS1.3 INPUT ^a	SPxPRES
CMOS1.3 I/O ^a	SPxSYNC
Power/Other	VCCSP ^b , VSS
Analog I/O ^c	SPxZUPD[1:0] ^d , SPxAVREFH[3:0], SPxBVREFH[3:0], SPxAVREFL[3:0], SPxBVREFL[3:0] ^e
SP Analog Input	VCCASP ^e , VSSASP

- See Section 9.8 for "CMOS1.3" specifications.
- VCCSP is to be supplied to the SP port externally. See Table 9-2.
- Reference voltages are generated on-die.
- SPxZUPD0 impedance update pins are connected through a 45-ohm, 1% resistor to Vccsp; SPxZUPD1 impedance update pins are connected through 45-ohm, 1% resistor to Vss. PLL analog voltage for SP, connected on the motherboard to Vcc15 supply (1.5V nominal ±5%) through a filter network.

9.5 **Main Channel Interface**

Table 9-6. DMH Main Channel Signal Groups

Signal Group	Signal
RSL I/O Pins	R{0/1/2/3}DQA[8:0], R{0/1/2/3}DQB[8:0]
RSL Input Pins	R{0/1/2/3}RQ[7:0], R{0/1/2/3}CFM, R{0/1/2/3}CFMN (differential clock)
RSL Input Pins	R{0/1/2/3}CTM, R{0/1/2/3}CTMN (differential clock)
CMOS 1.8 Output Pins ^a	R(0/1/2/3}SCK, R{0/1/2/3}CMD, R{0/1/2/3}SYNCLKN, R{0/1/2/3}PCLKM
CMOS 1.8 I/O Pins ^b	R{0/1/2/3}SIO
Power/Other	VCCRA, R{0/1}VREF[1:0] ^c , VSS

a. See Table 9-23 and Table 9-29 for "CMOS 1.8" specification.

9.5.1 **Main Channel Interface Reference Voltage Specification**

Table 9-7. Main Channel Vref Specification

Symbol	Parameter	Min	Typical	Max	Units	Notes
Vref,r	Main Channel Reference Voltage	1.25	1.40	1.53	٧	а

a. Vref is generated from 1.8V voltage (VCCRIO on the SNC).

b. See Table 9-10 for "CMOS 1.8 I/O" specification.

c. See Table 9-7 for Vref specification.



DC Specifications 9.5.2

Table 9-8. RSL Data Group, DC Parameters (a, b)

Symbol	Parameter	Min	Max	Unit	Notes
Vil	Input Low Voltage	Vref,r – 0.5	Vref,r – 0.175	V	С
Vih	Input High Voltage	Vref,r + 0.175	Vref,r + 0.5	V	С
V _{DIS}	Data Voltage Swing	0.54	1.10	V	
A _{DI}	Data Input Asymmetry about V _{REF}	-15%	15%	V _{DIS}	
lol	Output Low Current		30	mA	d
Ili	Input Leakage Current		5	μΑ	
llo	Output Leakage Current		5	μΑ	

- a. All specifications are at the pin of the package.
- b. Applies to RSL input, output and I/O buffers.
- c. Vref here refers to "Typical" value of the RAMBUS reference voltage. See Table 9-7 for Vref specification.
- d. Current per I/O.

Table 9-9. RSL Clocks, DC Parameters (a, b)

Symbol	Parameter	Min.	Max	Unit	Notes
V _{CIS,CTM}	Clock Input Voltage Swing on CTM Pin	0.25	_	V/ns	
V _{CIS,CFM}	Clock Input Voltage Swing on CFM Pin	0.25	_	V/ns	
V _X	Clock Differential Crossing-point Voltage	1.30	1.80	V	
V _{CM}	Clock Input Common-mode Voltage	1.40	1.70	V	

a. VCIS applies to both Clock and Clock#.

Table 9-10. RAMBUS "CMOS 1.8 I/O" DC Parameters (a, b)

Symbol	Parameter	Min	Max	Unit	Notes
Vil	Input Low Voltage	-0.3	1/ 2(VCCRIO) -0.25	V	
Vih	Input High Voltage	1/2 (VCCRIO) + 0.25	VCCRAC ^c + 0.30	V	
Ili	Input Leakage Current		20	μA	
llo	Output Leakage Current		20	μΑ	

AC Specifications 9.5.3

For complete RAMBUS data sheet, including the AC specifications, timing relationships, etc., please refer to the RAMBUS website.

b. Parameters apply to RSL input, output, and I/O buffers.

<sup>a. All specifications are at the pin of the package.
b. Parameters apply to "CMOS 1.8" input, output, and I/O buffers.
c. Refer to Intel® E8870DH DDR Memory Hub (DMH) Datasheet.</sup>



9.6 LPC Signal Group

The seven required and five supporting signals used for the low pin count (LPC) interface are listed in the following table. Many of the signals are the same as signals found on the PCI interface.

Table 9-11. LPC Interface Signal Group

Signal Group	Signal	
LPC I/O	LAD[3:0]	
LPC Output	LFRAME#, LRESET#, LPCCLKOUT[2:0]	
LPC Input	LCLK	
CMOS 1.5 Input ^a	LPCSEL, LPCEN	

a. See Section 9.8 for CMOS 1.5V specifications.

9.6.1 DC Specifications

Table 9-12, LPC DC Parameters^{a,b}

Symbol	Parameter	Min	Max	Unit	Notes
Vil	Input Low Voltage		0.99	V	
Vih	Input High Voltage	1.65		V	
Vol	Output Low Voltage		0.33	V	С
Voh	Output High Voltage	2.97		V	d
CkVol	Clock Output Low Voltage		0.66	V	С
CkVoh	Clock Output High Voltage	1.98		V	d
I _{li}	Input Leakage Current		150	μΑ	е
CClk	Clock Input Capacitance	0.5	10	pF	

- a. All specifications are at the pin of the package.
- b. Parameters apply to LPC inputs, outputs, I/O buffers and clock output.
- c. At 1.5 mA minimum.
- d. At -0.5 mA minimum.
- e. Requires external 10k ohm pull-up resistor.

9.6.2 AC Specifications

For a complete LPC data sheet including AC specifications and timing relationships, refer to the *Low Pin Count (LPC) Interface Specification*.

9.7 SMBus and TAP Electrical Specifications

The SNC uses open-drain outputs and has its own defined logic levels, which are different than CMOS logic levels.

The TAP connection input signals require external termination. No reference voltage is required for these signals.

The SMBus and TAP signals require termination to 3.3V and 1.5V on the motherboard, respectively.



For specifications related to components or external tools that will interface with the SNC components, refer to that component or tool's associated specification.

Table 9-13. SMBus and TAP Interface Signal Group

Signal Group	Signal
SMBus (I/O)	SPDCLK, SPDDA, SCL, SDA
TAP (Input)	TCK, TDI, TMS, TRST#
TAP (Output)	TDO

Table 9-14. TAP Signal Terminations^{a,b}

TCK	27-ohm to GND
TMS	39-ohm to VCC
TDI ^c	150-ohm to VCC
TDO, TDI	75-ohm to VCC
TRST#	500 to 680-Ohm to GND

Termination values for input pins are based on requirements of Intel's in-target probe. Requirements for other applications may differ. All resistances are nominal with a tolerance allowance of $\pm 5\%$. This TDI pull-up value applies only to TDI inputs driven by Intel's in-target probe TAP centraller.

DC Specifications 9.7.1

Table 9-15. TAP DC Parameters^a

Symbol	Parameter	Min	Max	Unit	Notes
Vil	Input Low Voltage	-0.4	0.76	V	
Vih	Input High Voltage	1.16	1.8	V	
V _T -	Negative-going Threshold Voltage	0.76	1.03	V	b
V _T +	Positive-going Threshold Voltage	0.91	1.16	V	b
V _H	Hysteresis Voltage	130		mV	b
Vol	Output Low Voltage	0.34	0.49	V	С
I _{li}	Input Leakage Current		50	μΑ	С
I _{ol}	Output Low Current	12.7		mA	С

All specifications are at the pin of the package.

TAP controller.

See Figure 9-1 b.

Measured with a 75-ohm ±10% test load to Vcc.



Figure 9-1. TAP DC Thresholds

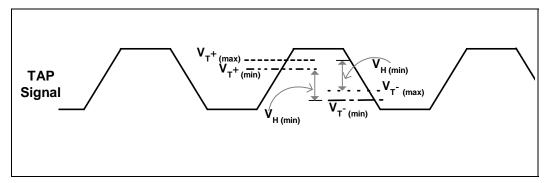


Table 9-16. SMBus DC Parameters^{a,b}

Symbol	Parameter	Mi	Max	Unit	Notes
Vil	Input Low Voltage	-0.5	0.8	V	
Vih	Input High Voltage	2.1	3.47	V	
Vol	Output Low Voltage		0.4	V	С
Ili	Input Leakage Current		50	μA	
Ipullup	Current through Pull-up Resistor	4.0		mA	
Cin	Input Capacitance		10	pF	
Vnoise	Signal Noise Immunity	300		mV	d,e

- All specifications are at the pin of the package. Parameters apply to SMBus inputs, outputs and I/O buffers.
- At Vol max, Iol = 4 mA. At 1 MHz to 5 MHz range. Peak-to-peak.

9.7.2 **AC Specifications**

Table 9-17. SMBus Signal Group AC Specifications^a

Symbol	Parameter	Minimum	Maximum	Unit	Figure	Notes
f _{smb}	Operating Frequency	10	100	kHz		
T60	SMBus Output Valid Delay		1.0	us	9-2	
T61	SMBus Input Setup Time	250		ns	9-2	
T62	SMBus Input Hold Time	300		ns	9-2	
T _r	Clock/Data Rise Time		1000	ns		b
T _f	Clock/Data Fall Time		300	ns		С
	Bus Free Time	4.70		μs		d

All AC timings for the SMBus signals are referenced to the SM_CLK signal at 0.5 • SM_VCC at the package pins. All SMBus signal timings (SM_DAT, SM_ALERT#, etc.) are referenced at 0.5 • SM_VCC at the package pins.

 $T_{\rm f} = (V_{\rm il,max}\text{-}0.15) \text{ to } (V_{\rm ih,min}\text{+}0.15) \\ T_{\rm f} = (V_{\rm il,min}\text{+}0.15) \text{ to } (V_{\rm il,max}\text{-}0.15) \\ \text{Minimum time allowed between request cycles.}$



Table 9-18. TAP Signal Group AC Specifications^a

Symbol	Parameter	Minimum	Maximum	Unit	Figure	Notes
	TCK Frequency	1.0	20	MHz	9-3	
T58	TCK, TMS, TDI Rise Time	0.5	16	ns	9-3	b
T59	TCK, TMS, TDI Fall Time	0.5	16	ns		b
	TDO Rise Time	2.3	4.6	ns		b
	TDO Fall Time	1.2	5.3	ns		b
T60	TDO Clock to Output Delay	2.5	10	ns	9-2	С
T61	TDI, TMS Setup Time	5		ns	9-2	d,e
T62	TDI, TMS Hold Time	18		ns	9-2	d,e
TRST#	Assert Time	300		ns		

- a. All AC timings for the TAP signals are referenced to TCK at 50% voltage level.
- b. Rise and fall times are measured from the 20% to 80% points of the signal swing.
- c. Referenced to the falling edge of TCK.
- Specification for a minimum swing defined between TAP V IL_MAX to V IH_MIN. This assumes a minimum edge rate of 0.5V per ns.
- e. Referenced to the rising edge of TCK at the component pin.

9.7.3 AC Timing Waveforms

The following figures are used in conjunction with the AC timing Table 9-13 and Table 9-14.

Note: The following apply:

- 1. All AC timings for the TAP signals are referenced to the TCK signal at 0.5 Vcc_tap at the component pin. All TAP signal timings (TMS, TDI, etc.) are referenced at the package pin.
- 2. All AC timings for the SMBus signals are referenced to the SM_CLK signal at 0.5 SM_Vcc at the component pin. All SMBus signal timings (SM_DAT, SM_ALERT#, etc.) are referenced at 0.5 SM_Vcc at the package pin.

Figure 9-2. TAP and SMBus Valid Delay Timing Waveform

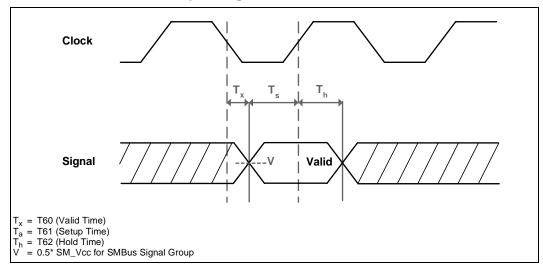
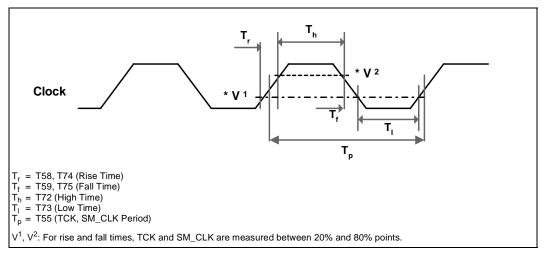




Figure 9-3. TCK and SM_CLK Clock Waveform



9.8 **Miscellaneous Signal Pins**

All buffer types that do not belong to one of the major buses in the system are listed as miscellaneous signals.

Signal Groups 9.8.1

Table 9-19. Signal Groups

Signal Group	Signal
CMOS1.3 Input	SP{0/1}PRES
CMOS1.3 I/O	SP{0/1}SYNC
CMOS1.5 I/O OD	ERR[2:0]#, EV[3:0]#,SP{0/1}GPIO[1:0]
CMOS1.5 O OD	INT_OUT#
CMOS1.5 Input	BPIN, CPUPRES#, COMPCNTRL[1:0]# ^a , BUSID[2:0], BINITIN#, BERRIN#, LVHSTLODTEN, NODEID[4:0], PWRGOOD, RESETI# ^b , RACODTEN[1:0] ^c
CMOS1.5 Output	RESETO#
CMOS1.8 Output	MEMRST[1:0]#
CMOS3.3 Output	BERROUT#, BINITOUT#
Analog Input VCC	VCCACORE ^d , VSSACORE

COMPCNTRL[0]: A pull-down (330 ohm) disables the on-die termination on the RESET# and BPM# (debug pins for use by the in-target probe [ITP]) signals. A pull-up (330 ohm) enables the on-die termination on the RESET# and BPM# (debug pin for use by the ITP).

On Die Termination Select:

RACODTEN[1] RACODTEN[0] ODT OFF 330-ohm to VSS 330-ohm to VSS 330-ohm to VCC 330-ohm to VSS 100-ohm

330-ohm to VCC(1.5V)300-ohm to VCC(1.5V) --> Recommended Value

PLL analog voltage input for core PLL, connect to 1.5V ±5% through a network filter.

COMPCNTRL[1]: A pull-down (330 ohm) enables glitch filter on the system bus STB{P/N}[7:0]#. A pull-up (330 Ohm) disables the glitch filter on the system bus STB {P/N}[7:0]# signals. Requires external 330 Ohm pull-up resistor.



DC Characteristics 9.8.2

Table 9-20. CMOS 1.3V DC Parameters^{a,b}

Symbol	Parameter	Min	Max	Unit	Notes
Vil	Input Low Voltage	-0.3	0.35	V	
Vih	Input High Voltage	1.11	VCCSP + 0.3	V	
Vol	Output Low Voltage	-0.15	0.26	V	С
Voh	Output High Voltage	1.21	1.39	V	С
I _{li}	Input Leakage Current		10	μΑ	
Ron_p	On-resistance p-device	300	700	Ohm	
Ron_n	On-resistance n-device	27	72	Ohm	

Table 9-21. CMOS 1.5V OD DC Parameters^a

Symbol	Parameter	Min	Max	Unit	Notes
V _{IH}	Input High Voltage	1.15	VCC + 0.3	V	
V _{IL}	Input Low Voltage	-0.3	0.70	V	
V _{oH}	Output High Voltage	1.3	VCC + 0.3	V	b
V _{oL}	Output Low Voltage		0.54	V	С
I _{ol}	Output Low Current		52.0	mA	С
I _{li}	Input Leakage Current		50	μΑ	

Supply voltage at 1.5V \pm 5% tolerance. RI = 50 or 25 ohms.

Table 9-22. CMOS 1.5V DC Parameters^a

Symbol	Parameter	Min	Max	Unit	Notes
V _{IH}	Input High Voltage	0.90	Vcc+0.3	V	
V _{IL}	Input Low Voltage	-0.30	0.70	V	
V _{oH}	Output High Voltage	0.8 • Vcc	VCC+0.3	V	
V _{oL}	Output Low Voltage		0.20 • VCC	V	
V _{hysteresis}	Hysteresis Voltage	0.10		V	
Ron	Output Impedance	30	80	ohm	
I _{li}	Input Leakage Current		70	μΑ	

Supply voltage at 1.5V ±5% tolerance.

All specifications are at the pin of the package.
Parameters apply to all CMOS 1.3V buffer types unless otherwise noted.
Not applicable for CMOS 1.3V Input buffer types. b.

RI = 25 ohms.



Table 9-23. CMOS 1.8V Output DC Parameters^a

Symbol	Parameter	Min	Max	Unit	Notes
V _{oH}	Output High Voltage	1.50		V	
V _{oL}	Output Low Voltage		0.20	V	
Ron	Output Impedance, Pull-down	20	40	ohm	
Ron	Output Impedance, Pull-up	24	40	ohm	
I _{li}	Input Leakage current	-500	500	μA	

Supply voltage at 1.5V ±5% tolerance.

Table 9-24. CMOS 3.3V DC Parameters

Symbol	Parameter	Min	Max	Unit	Notes
V _{IH}	Input High Voltage	2.0	VCC + 0.3	V	
V _{IL}	Input Low Voltage	-0.3	0.50	V	
V _{oH}	Output High Voltage	2.80		V	
V _{oL}	Output Low Voltage		0.40	V	
V _{hysteresis}	Hysteresis Voltage	120		mV	
I _{II}	Input Leakage Current		25	μΑ	
Cl _{li}	Input Pin Capacitance	0.50	10	pF	
Ron	Pull-down	8	28	ohm	
Ron	Pull-up	16	40	ohm	

AC Specification 9.8.3

Table 9-25. CMOS 1.3V Open-Drain AC Parameters^a

Symbol	Parameter	Min	Max	Unit	Notes
Tco	Clock to Output Valid Delay	0.15	15.0	ns	
SRf	Output Slew Rate Fall	0.25	0.7	V/ns	
SRr	Output Slew Rate Rise	0.5	15.0	V/ns	

a. Clock delay is in reference to the 200 MHz clock.

Table 9-26. CMOS 1.5V Open-Drain AC Parameters^{a,b,c}

Symbol	Parameter	Min	Max	Unit	Notes
Tco	Clock to Output Valid Delay	0.15	2.69	ns	d,e
Tsu	Input Setup Time	0.98		ns	
Thold	Input Hold Time	0.38		ns	
SRf	Output Slew Rate Fall	0.25	0.91	V/ns	е
SRr	Output Slew Rate Rise	0.37	1.18	V/ns	е
Signal: INT	Signal: INT_OUT#				
Tco	Clock to Output Valid Delay		4.71	ns	

Supply voltage at 1.5V ±5% tolerance.

Supply voltage at 1.5v ±5% tolerance.

Clock delay is in reference to the 200 MHz clock.

Specification doesn't apply to signals EV[3:0]#, ERR[2:0]#,SP{0/1}GPI0[1:0]. See Table 9-28.

Specification doesn't apply to INT_OUT#.

RI = 25 ohms.



Table 9-27. CMOS 1.5V AC Parameters^{a,b}

Symbol	Parameter	Min	Max	Unit	Notes
Tco	Clock to Output Valid Delay	-0.28	1.44	ns	С
Tsu	Input Setup Time	0.84		ns	
Thold	Input Hold Time	0.35		ns	
SRf	Output Slew Rate Fall	2.00	5.00	V/ns	
SRr	Output Slew Rate Rise	1.90	4.9	V/ns	
Signal: RESETO#					
Tco	Clock to Output Valid Delay		1.35	ns	

Table 9-28. CMOS1.5 I/O OD AC Parameters

Symbol	Parameter	Min	Max	Unit	Notes	
Signals: EV	Signals: EV[3:0]#, ERR[2:0]#					
Tco	Clock to Output Valid Delay		6.45	ns		
Tsu	Input Setup Time	0.85		ns		
Thold	Input Hold Time	-0.73		ns		
SRf	Output Slew Rate Fall	0.25	0.91	V/ns		
SRr	Output Slew Rate Rise	0.37	1.18	V/ns		
Signal: SP{	0/1}GPIO[1:0]					
Тсо	Clock to Output Valid Delay		4.8	ns		
Tsu	Input Setup Time	0.84		ns		
Thold	Input Hold Time	-0.78		ns		
SRf	Output Slew Rate Fall	0.25	0.91	V/ns		
SRr	Output Slew Rate Rise	0.37	1.18	V/ns		

Table 9-29. CMOS 1.8V AC Parameters

Symbol	Parameter	Min	Max	Unit	Notes
Tco	Clock to Output Valid Delay	0.5	2.5	ns	
SRf	Output Slew Rate Fall	1	3	V/ns	
SRr	Output Slew Rate Rise	1	3	V/ns	

Table 9-30. CMOS 3.3 V AC Parameters^{a,b}

Symbol	Parameter	Min	Max	Unit	Notes
Tco	Clock to Output Valid Delay	0.9	3.9	ns	
Tsu	Input Setup Time	1		ns	
Thold	Input Hold Time	0		ns	

Supply voltage at 1.5V ±5% tolerance. Clock delay is in reference to the 200 MHz clock. Specification doesn't apply to RESETO#. b.



Table 9-30. CMOS 3.3 V AC Parameters^{a,b} (Continued)

Symbol	Parameter	Min	Max	Unit	Notes
SRf	Output Slew Rate Fall	1	4	V/ns	
SRr	Output Slew Rate Rise	1	4	V/ns	

a. Supply voltage at 1.5V ±5% tolerance.

9.9 Clock Signal Groups

Table 9-31. Clock Signal Groups

Signal Group	Signals
LVHSTL Differential Inputs	BUSCLK, BUSCLK#

Table 9-32. LVHSTL Clock DC Parameters

Symbol	Parameter	Min	Тур	Max	Unit
V _{IH}	Input High Voltage	0.78		1.3	V
V _{IL}	Input Low Voltage	-0.3		0.5	V
V _X	Input Crossover Voltage	0.55		0.85	V
C _{CLK}	Input Capacitance	1.0		11.5	pF

9.9.1 AC Specification

Table 9-33. LVHSTL Differential Clock AC Specification

Symbol	Parameter	Min	Тур	Max	Unit	Notes
T _{period}	BUSCLK Period		5.0		ns	а
f _{BCLK}	BUSCLK Frequency	200		200	MHz	a,b
T _{jitter}	BUSCLK Input Jitter			100	ps	a,c
T _{high}	BUSCLK High Time	2.25	2.5	2.75	ns	a,d
T _{low}	BUSCLK Low Time	2.25	2.5	2.75	ns	a,d
T _{rise}	BUSCLK Rise Time	333	500	667	ps	а
T _{fall}	BUSCLK Fall Time	333	500	667	ps	а
V _{PP}	Minimum Input Swing		600		mV	a,e

a. See Figure 9-4.

b. Clock delay is in reference to the 200 MHz clock.

Measured on cross point of rising edge of BUSCLK and falling edge of BUSCLK#. Long term jitter is defined as peak-to-peak variation measured by accumulating a large number of clock cycles and recording peak-to-peak jitter.

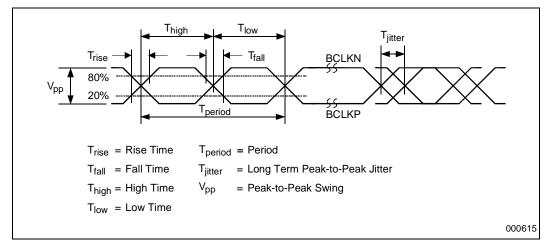
Long term jitter is defined as peak-to-peak variation measured by accumulating a large number of clock cycles and recording peak-to-peak jitter.

d. Measured on cross point of rising edge of BUSCLK and falling edge of BUSCLK#.

e. V_{PPmin} is defined as the minimum input differential voltage which will cause no increase in the clock receiver timing.



Figure 9-4. Generic Differential Clock Waveform



Ballout and Package Information

10

10.1 1357-ball OLGA2b Package Information

The 1357-ball OLGA2b package has an exposed die mounted on a package substrate. The package's coplanarity has a mean of approximately 8 mils and a tolerance at 4-sigma of approximately 4 mils. A heatsink, with appropriate interface material and retention capabilities, is required for proper operation.

Figure 10-1. 1357-ball OLGA2b Package Dimensions - Top View

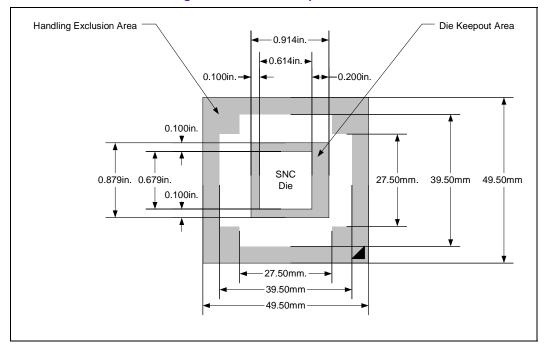
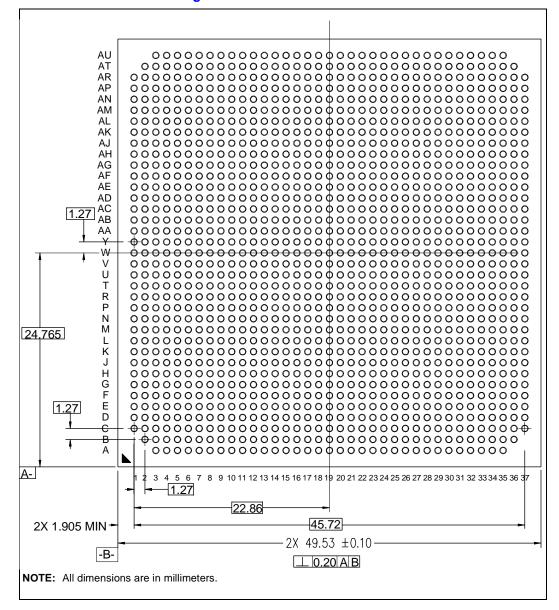




Figure 10-2. 1357-ball OLGA2b Package Dimensions - Bottom View





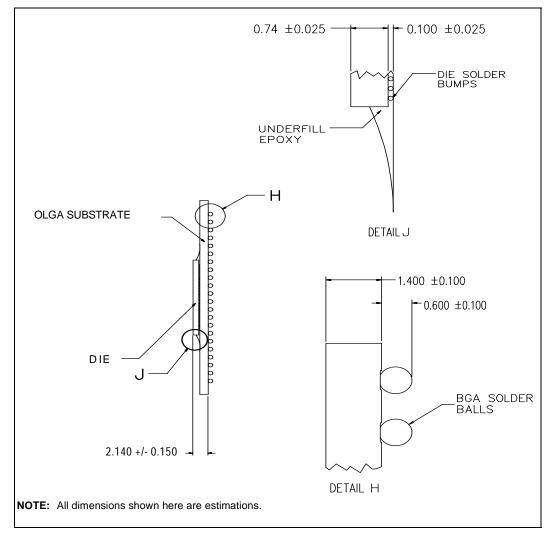


Figure 10-3. 1357-ball OLGA2b Solder Balls Detail

10.2 Ball-out Specifications

10.2.1 Ball-out Lists

Table 10-1 list the respective ball-outs and Table 10-2 the respective signal lists for SNC.

All ball locations marked "N/C" are no-connects. All ball locations marked "RSVD" are reserved. Both of these ball location types must remain unconnected. This restriction forbids any connection, including floating conductors, to be attached.

All ball locations marked "P/U" or "P/D" should be pulled up to the core VCC or pulled down to VSS through the specified resistor value, unless otherwise noted.



Table 10-1. SNC Ball List

Ball Number	Signal
A3	VTTMK
A4	ID[6]#
A5	ID[0]#
A6	VSS
A7	ID[1]#
A8	ID[3]#
A9	VSS
A10	A[6]#
A11	A[4]#
A12	VSS
A13	VTTMK
A14	D[30]#
A15	VSS
A16	D[27]#
A17	D[23]#
A18	VSS
A19	D[17]#
A20	N/C
A21	VTTMK
A22	D[11]#
A23	D[14]#
A24	VSS
A25	D[1]#
A26	D[4]#
A27	VSS
A28	VSS
A29	SP0AD[14]
A30	VSS
A31	VSS
A32	VSS
A33	VSS
A34	VSS
A35	VSS
B2	VSS
B3	RSP#
B4	RS[0]#
B5	VSS
B6	ID[2]#

Ball Number	Signal
B7	ID[5]#
B8	VTTMK
B9	A[7]#
B10	A[12]#
B11	VSS
B12	A[5]#
B13	VSS
B14	VSS
B15	D[25]#
B16	D[24]#
B17	VTTMK
B18	D[20]#
B19	D[19]#
B20	VSS
B21	D[13]#
B22	D[12]#
B23	VSS
B24	D[7]#
B25	STBP[0]#
B26	VTTMK
B27	N/C
B28	VTTMK
B29	VSS
B30	SP0AD[13]
B31	VSS
B32	VSS
B33	VCCSP
B34	VSS
B35	VSS
B36	VSS
C1	VSS
C2	VSS
C3	REQ[1]#
C4	VTTMK
C5	ID[4]#
C6	ID[7]#
C7	VSS
C8	A[11]#



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
C9	A[13]#
C10	VSS
C11	A[10]#
C12	VTTMK
C13	VTTMK
C14	DEP[3]#
C15	D[29]#
C16	VSS
C17	STBN[1]#
C18	STBP[1]#
C19	VSS
C20	D[16]#
C21	DEP[1]#
C22	VTTMK
C23	D[8]#
C24	STBN[0]#
C25	VSS
C26	D[3]#
C27	D[2]#
C28	VSS
C29	SP0AD[12]
C30	VSS
C31	SP0AD[15]
C32	VSS
C33	VSS
C34	VSS
C35	SP0AD[5]
C36	VSS
C37	VSS
D1	VSS
D2	VTTMK
D3	VSS
D4	REQ[0]#
D5	ID[8]#
D6	VSS
D7	ID[9]#
D8	A[23]#
D9	VTTMK
D10	A[14]#

Ball Number	Signal
D11	A[3]#
D12	VSS
D13	VSS
D14	DEP[2]#
D15	VSS
D16	D[26]#
D17	D[22]#
D18	VTTMK
D19	D[21]#
D20	D[18]#
D21	VSS
D22	D[9]#
D23	D[15]#
D24	VSS
D25	D[10]#
D26	D[5]#
D27	VTTMK
D28	VTTMK
D29	VSS
D30	SP0AVREFH[3]
D31	VCCSP
D32	SP0AVREFL[3]
D33	VSS
D34	SP0AD[7]
D35	VCCSP
D36	SP0AD[6]
D37	VSS
E1	VSS
E2	VSS
E3	REQ[4]#
E4	REQ[3]#
E5	VTTMK
E6	IDS#
E7	RS[2]#
E8	VSS
E9	A[8]#
E10	A[21]#
E11	VSS
E12	A[9]#



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
E13	VTTMK
E14	VTTMK
E15	D[31]#
E16	D[54]#
E17	VSS
E18	D[28]#
E19	D[53]#
E20	VSS
E21	DEP[0]#
E22	D[42]#
E23	VTTMK
E24	D[6]#
E25	D[40]#
E26	VSS
E27	D[0]#
E28	VSS
E29	SP0AD[11]
E30	VSS
E31	SP0ASSO
E32	VSS
E33	SP0AVREFH[1]
E34	VSS
E35	SP0AVREFL[1]
E36	VSS
E37	SP0AD[4]
F1	VSS
F2	VTTMK
F3	TRDY#
F4	VSS
F5	RS[1]#
F6	DBSY#
F7	VSS
F8	BINIT#
F9	A[17]#
F10	VTTMK
F11	A[15]#
F12	A[18]#
F13	VSS
F14	DEP[6]#

Ball Number	Signal
F15	D[63]#
F16	VSS
F17	D[58]#
F18	D[48]#
F19	VTTMK
F20	D[49]#
F21	DEP[4]#
F22	VSS
F23	D[38]#
F24	D[45]#
F25	VSS
F26	D[37]#
F27	D[35]#
F28	VTTMK
F29	VCCSP
F30	SP0ARSVD
F31	VSS
F32	SP0AD[10]
F33	VCCSP
F34	SP0AD[3]
F35	VSS
F36	SP0AEP[0]
F37	VSS
G1	VSS
G2	VSS
G3	VSS
G4	SBSY#
G5	REQ[2]#
G6	VTTMK
G7	HIT#
G8	A[33]#
G9	VSS
G10	A[26]#
G11	A[20]#
G12	VSS
G13	VSS
G14	DEP[7]#
G15	VTTMK
G16	D[61]#



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
G17	STBN[3]#
G18	VSS
G19	D[56]#
G20	D[50]#
G21	VSS
G22	D[32]#
G23	D[41]#
G24	VTTMK
G25	STBP[2]#
G26	D[34]#
G27	VSS
G28	VSS
G29	SP0ASTBP[1]
G30	VSS
G31	SP0ASTBN[1]
G32	VSS
G33	SP0ASTBP[0]
G34	VSS
G35	SP0ASTBN[0]
G36	VSS
G37	SP0AD[2]
H1	VSS
H2	VTTMK
H3	BREQ0#
H4	LOCK#
H5	VSS
H6	DRDY#
H7	HITM#
H8	VSS
H9	A[24]#
H10	A[22]#
H11	VTTMK
H12	A[16]#
H13	VTTMK
H14	VSS
H15	D[60]#
H16	D[57]#
H17	VSS
H18	STBP[3]#

Ball Number	Signal
H19	D[52]#
H20	VTTMK
H21	DEP[5]#
H22	D[46]#
H23	VSS
H24	STBN[2]#
H25	D[39]#
H26	VSS
H27	D[33]#
H28	VTTMK
H29	VSS
H30	SP0ALLC
H31	VCCSP
H32	SP0AD[9]
H33	VSS
H34	SP0AD[1]
H35	VCCSP
H36	SP0AEP[1]
H37	VSS
J1	VSS
J2	VSS
J3	BREQ[3]#
J4	VSS
J5	REQ[5]#
J6	RP#
J7	VTTMK
J8	AP[1]#
J9	A[25]#
J10	VSS
J11	A[19]#
J12	A[28]#
J13	VSS
J14	D[62]#
J15	D[59]#
J16	VTTMK
J17	D[55]#
J18	D[51]#
J19	VSS
J20	N/C



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
J21	D[47]#
J22	VSS
J23	D[43]#
J24	D[44]#
J25	VTTMK
J26	D[36]#
J27	N/C
J28	VSS
J29	SP0AVREFL[2]
J30	VSS
J31	SP0AVREFH[2]
J32	VSS
J33	SP0AVREFL[0]
J34	VSS
J35	SP0AVREFH[0]
J36	VSS
J37	SP0AEP[2]
K1	VSS
K2	VTTMK
K3	VTTMK
K4	BPRI#
K5	GSEQ#
K6	VSS
K7	DEFER#
K8	AP[0]#
K9	VSS
K10	A[37]#
K11	A[31]#
K12	VTTMK
K13	VTTMK
K14	D[94]#
K15	VSS
K16	D[87]#
K17	D[91]#
K18	VSS
K19	D[81]#
K20	N/C
K21	VTTMK
K22	D[75]#
1144	D[10]#

Ball Number	Signal
K23	D[71]#
K24	VSS
K25	D[67]#
K26	D[65]#
K27	VSS
K28	VTTMK
K29	VCCSP
K30	SP0AD[8]
K31	VSS
K32	N/C
K33	VCCSP
K34	SP0AD[0]
K35	VSS
K36	N/C
K37	VSS
L1	VSS
L2	VSS
L3	VSS
L4	N/C
L5	VSS
L6	TND#
L7	BREQ[2]#
L8	VTTMK
L9	A[34]#
L10	A[32]#
L11	VSS
L12	BNR#
L13	VSS
L14	VSS
L15	D[92]#
L16	D[93]#
L17	VTTMK
L18	D[84]#
L19	D[88]#
L20	VSS
L21	D[78]#
L22	D[76]#
L23	VSS
L24	D[68]#



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
L25	STBP[4]#
L26	VTTMK
L27	N/C
L28	VSS
L29	N/C
L30	VSS
L31	SP0BD[8]
L32	VSS
L33	N/C
L34	VSS
L35	N/C
L36	VSS
L37	SP0BD[0]
M1	VSS
M2	VTTMK
M3	N/C
M4	VTTMK
M5	BREQ[1]#
M6	N/C
M7	VSS
M8	N/C
M9	A[36]#
M10	VSS
M11	A[38]#
M12	VTTMK
M13	VTTMK
M14	DEP[11]#
M15	D[89]#
M16	VSS
M17	STBN[5]#
M18	STBP[5]#
M19	VSS
M20	D[83]#
M21	DEP[9]#
M22	VTTMK
M23	D[72]#
M24	STBN[4]#
M25	VSS
M26	D[66]#

Ball Number	Signal
M27	D[73]#
M28	VTTMK
M29	VSS
M30	SP0BVREFH[2]
M31	VCCSP
M32	SP0BVREFL[2]
M33	VSS
M34	SP0BVREFH[0]
M35	VCCSP
M36	SP0BVREFL[0]
M37	VSS
N1	VSS
N2	VSS
N3	VSS
N4	BPM[2]#
N5	RESET#
N6	VSS
N7	ADS#
N8	N/C
N9	VTTMK
N10	A[30]#
N11	A[29]#
N12	VSS
N13	VSS
N14	DEP[10]#
N15	VSS
N16	D[95]#
N17	D[85]#
N18	VTTMK
N19	D[82]#
N20	D[80]#
N21	VSS
N22	D[77]#
N23	D[79]#
N24	VSS
N25	D[74]#
N26	D[64]#
N27	VTTMK
N28	VSS



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
N29	SP0BD[9]
N30	VSS
N31	SP0BLLC
N32	VSS
N33	SP0PRES
N34	VSS
N35	SP0BD[1]
N36	VSS
N37	SP0BEP[2]
P1	VSS
P2	VSS
P3	VSS
P4	BPM[0]#
P5	VTTMK
P6	BPM[3]#
P7	BERR#
P8	VSS
P9	A[35]#
P10	A[41]#
P11	VSS
P12	A[27]#
P13	VSS
P14	VTTMK
P15	D[90]#
P16	D[122]#
P17	VSS
P18	D[86]#
P19	D[112]#
P20	VSS
P21	DEP[8]#
P22	D[111]#
P23	VTTMK
P24	D[69]#
P25	D[96]#
P26	VSS
P27	D[70]#
P28	VTTMK
P29	VCCSP
P30	SP0BSTBN[1]

Ball Number	Signal
P31	VSS
P32	SP0BSTBP[1]
P33	VCCSP
P34	SP0BSTBN[0]
P35	VSS
P36	SP0BSTBP[0]
P37	VSS
R1	VSS
R2	VSS
R3	N/C
R4	BPM[4]#
R5	VSS
R6	BPM[1]#
R7	VSS
R8	BPM[5]#
R9	A[39]#
R10	VTTMK
R11	A[40]#
R12	A[42]#
R13	VTTMK
R14	DEP[14]#
R15	D[124]#
R16	VSS
R17	D[127]#
R18	D[118]#
R19	VTTMK
R20	D[117]#
R21	DEP[12]#
R22	VSS
R23	D[101]#
R24	D[106]#
R25	VSS
R26	D[102]#
R27	D[99]#
R28	VSS
R29	SP0BD[10]
R30	VSS
R31	SP0BRSVD
R32	VSS



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
R33	SP0SYNC
R34	VSS
R35	SP0BD[2]
R36	VSS
R37	SP0BEP[1]
T1	VSS
T2	VSS
Т3	VSS
T4	N/C
T5	N/C
T6	N/C
T7	N/C
Т8	FSBODTCRES[0]
Т9	VSS
T10	A[43]#
T11	FSBODTCRES[1]
T12	FSBSLWCRES[1]
T13	VSS
T14	DEP[15]#
T15	VTTMK
T16	D[125]#
T17	STBN[7]#
T18	VSS
T19	D[116]#
T20	D[114]#
T21	VSS
T22	D[105]#
T23	D[108]#
T24	VTTMK
T25	STBP[6]#
T26	D[98]#
T27	VSS
T28	VSS
T29	VSS
T30	SP0BSSO
T31	VCCSP
T32	SP0BD[11]
T33	VSS
T34	SP0BEP[0]
L	l .

Ball Number	Signal
T35	VCCSP
T36	SP0BD[3]
T37	VSS
U1	VSS
U2	R0DQA[7]
U3	VSS
U4	R0DQA[8]
U5	VSS
U6	R1DQA[7]
U7	VSS
U8	R1DQA[8]
U9	VCC
U10	BUSID[2]
U11	COMPCNTRL[1]#
U12	FSBSLWCRES[0]
U13	VTTMK
U14	VSS
U15	D[126]#
U16	D[120]#
U17	VSS
U18	STBP[7]#
U19	D[113]#
U20	VTTMK
U21	DEP[13]#
U22	D[109]#
U23	VSS
U24	STBN[6]#
U25	D[100]#
U26	VSS
U27	D[97]#
U28	VSS
U29	SP0BVREFL[3]
U30	VSS
U31	SP0BVREFH[3]
U32	VSS
U33	SP0ZUPD[0]
U34	VSS
U35	SP0BVREFL[1]
U36	VSS



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
U37	SP0BVREFH[1]
V1	R0DQA[5]
V2	VCCRIO
V3	R0DQA[6]
V4	VSS
V5	R1DQA[5]
V6	VCCRIO
V7	R1DQA[6]
V8	VSS
V9	BUSID[1]
V10	VSS
V11	ERR[1]#
V12	COMPCNTRL[0]#
V13	VSS
V14	D[123]#
V15	D[121]#
V16	VTTMK
V17	D[119]#
V18	D[115]#
V19	VSS
V20	N/C
V21	D[110]#
V22	VSS
V23	D[107]#
V24	D[103]#
V25	VTTMK
V26	D[104]#
V27	N/C
V28	VTTMK
V29	VCCSP
V30	SP0BD[15]
V31	VSS
V32	SP0BD[12]
V33	VCCSP
V34	SP0BD[7]
V35	VSS
V36	SP0BD[4]
V37	VSS
W1	VSS

Ball Number	Signal
W2	R0DQA[2]
W3	VSS
W4	R0DQA[4]
W5	VSS
W6	R1DQA[2]
W7	VSS
W8	R1DQA[4]
W9	TMS
W10	BUSID[0]
W11	VCC
W12	ERR[2]#
W13	N/C
W14	VCC
W15	VSS
W16	VCC
W17	VSS
W18	VCC
W19	VSS
W20	VCC
W21	VSS
W22	VCC
W23	VSS
W24	VCC
W25	330-ohm P/D
W26	330-ohm P/D
W27	VCC
W28	VSS
W29	SP0BD[14]
W30	VSS
W31	SP0BD[13]
W32	VSS
W33	SP0ZUPD[1]
W34	VSS
W35	SP0BD[5]
W36	VSS
W37	SP0BD[6]
Y1	R0DQA[1]
Y2	VSS
Y3	R0DQA[3]



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
Y4	VSS
Y5	R1DQA[1]
Y6	VSS
Y7	R1DQA[3]
Y8	VSS
Y9	VCC
Y10	NODEID[4]
Y11	ERR[0]#
Y12	VSS
Y13	INIT#
Y14	VSS
Y15	VCC
Y16	VSS
Y17	VCC
Y18	VSS
Y19	VCC
Y20	VSS
Y21	VCC
Y22	VSS
Y23	VCC
Y24	VSS
Y25	BUSCLK
Y26	VSS
Y27	330-ohm P/D
Y28	330-ohm P/D
Y29	VSS
Y30	SP1AD[13]
Y31	VCCSP
Y32	SP1AD[14]
Y33	VSS
Y34	SP1AD[6]
Y35	VCCSP
Y36	SP1AD[5]
Y37	VSS
AA1	VSS
AA2	R0DQA[0]
AA3	VSS
AA4	VCCRIO
AA5	VSS

Ball Number	Signal
AA6	R1DQA[0]
AA7	VSS
AA8	VCCRIO
AA9	TDI
AA10	VSS
AA11	BINITIN#
AA12	EV[3]#
AA13	TDIOANODE
AA14	VCC
AA15	VSS
AA16	VCC
AA17	VSS
AA18	VCC
AA19	VSS
AA20	VCC
AA21	VSS
AA22	VCC
AA23	VSS
AA24	VCC
AA25	BUSCLK#
AA26	330-ohm P/D
AA27	330-ohm P/D
AA28	VSS
AA29	SP1AD[12]
AA30	VSS
AA31	SP1AD[15]
AA32	VSS
AA33	SP1ZUPD[1]
AA34	VSS
AA35	SP1AD[4]
AA36	VSS
AA37	SP1AD[7]
AB1	R0CFMN
AB2	VSS
AB3	ROCFM
AB4	VSS
AB5	R1CFMN
AB6	VSS
AB7	R1CFM



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
AB8	VSS
AB9	TDO
AB10	NODEID[1]
AB11	VCC
AB12	EV[2]#
AB13	TDIOCATHODE
AB14	VSS
AB15	VCC
AB16	VSS
AB17	VCC
AB18	VSS
AB19	VCC
AB20	VSS
AB21	VCC
AB22	VSS
AB23	VCC
AB24	VSS
AB25	330-ohm P/D
AB26	330-ohm P/D
AB27	VCC
AB28	330-ohm P/D
AB29	VCCSP
AB30	SP1AVREFH[3]
AB31	VSS
AB32	SP1AVREFL[3]
AB33	VCCSP
AB34	SP1AVREFH[1]
AB35	VSS
AB36	SP1AVREFL[1]
AB37	VSS
AC1	VSS
AC2	ROCTM
AC3	VCCRA ^a
AC4	ROCTMN
AC5	VSS
AC6	R1CTM
AC7	VCCRA ^a
AC8	R1CTMN
AC9	VCC

Ball Number	Signal
AC10	NODEID[0]
AC11	INT_OUT#
AC12	VSS
AC13	EV[0]#
AC14	VCC
AC15	VSS
AC16	VCC
AC17	VSS
AC18	VCC
AC19	VSS
AC20	VCC
AC21	VSS
AC22	VCC
AC23	VSS
AC24	VCC
AC25	330-ohm P/D
AC26	VSS
AC27	330-ohm P/D
AC28	VSS
AC29	SP1AD[11]
AC30	VSS
AC31	SP1ASSO
AC32	VSS
AC33	SP1ZUPD[0]
AC34	VSS
AC35	SP1AD[3]
AC36	VSS
AC37	SP1AEP[0]
AD1	R0RQ[6]
AD2	VCCRA ^a
AD3	R0RQ[7]
AD4	VSS
AD5	R1RQ[6]
AD6	VCCRA ^a
AD7	R1RQ[7]
AD8	VSS
AD9	TRST#
AD10	VSS
AD11	BERRIN#



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
AD12	EV[1]#
AD13	RACODTEN[0]
AD14	VSS
AD15	VCC
AD16	VSS
AD17	VCC
AD18	VSS
AD19	VCC
AD20	VSS
AD21	VCC
AD22	VSS
AD23	VCC
AD24	VSS
AD25	VSS
AD26	PWRGOOD
AD27	330-ohm P/D
AD28	330-ohm P/D
AD29	VSS
AD30	SP1ARSVD
AD31	VCCSP
AD32	SP1AD[10]
AD33	VSS
AD34	SP1AEP[1]
AD35	VCCSP
AD36	SP1AD[2]
AD37	VSS
AE1	VSS
AE2	R0RQ[5]
AE3	VCCRIO
AE4	R0EXRC
AE5	VSS
AE6	R1RQ[5]
AE7	VCCRIO
AE8	R1EXRC
AE9	TCK
AE10	NODEID[2]
AE11	VCC
AE12	RACODTEN[1]
AE13	MEMRST1#

Ball Number	Signal
AE14	VCC
AE15	VSS
AE16	VCC
AE17	VSS
AE18	VCC
AE19	VSS
AE20	VCC
AE21	VSS
AE22	VCC
AE23	VSS
AE24	VCC
AE25	SP1GPIO[1]
AE26	SP0GPIO[0]
AE27	VCC
AE28	VSS
AE29	SP1ASTBP[1]
AE30	VSS
AE31	SP1ASTBN[1]
AE32	VSS
AE33	SP1SYNC
AE34	VSS
AE35	SP1ASTBP[0]
AE36	VSS
AE37	SP1ASTBN[0]
AF1	R0EXCC
AF2	VSS
AF3	R0RQ[4]
AF4	VSS
AF5	R1EXCC
AF6	VSS
AF7	R1RQ[4]
AF8	VSS
AF9	VCC
AF10	NODEID[3]
AF11	RACODTCRES[1]
AF12	VSS
AF13	SDA
AF14	SCL
AF15	VSS



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
AF16	N/C
AF17	VSS
AF18	N/C
AF19	VSS
AF20	LAD[1]
AF21	LAD[0]
AF22	LPCCLKOUT0
AF23	VCC
AF24	SP0GPIO[1]
AF25	VSS
AF26	VSSASP
AF27	SP1GPIO[0]
AF28	330-ohm P/D
AF29	VCCSP
AF30	SP1ALLC
AF31	VSS
AF32	SP1AD[9]
AF33	VCCSP
AF34	SP1AEP[2]
AF35	VSS
AF36	SP1AD[1]
AF37	VSS
AG1	VSS
AG2	R0RQ[2]
AG3	VSS
AG4	R0RQ[3]
AG5	VSS
AG6	R1RQ[2]
AG7	VSS
AG8	R1RQ[3]
AG9	ITEST
AG10	VSS
AG11	RACODTCRES[0]
AG12	VCC3.3I2C
AG13	VCC
AG14	SPDDA
AG15	R2PCLKM
AG16	VCCRIO
AG17	R3PCLKM

Ball Number	Signal
AG18	VSS
AG19	LAD[3]
AG20	VCC3.3LPC
AG21	LAD[2]
AG22	LPCSEL
AG23	VSS
AG24	LVHSTLODTEN
AG25	VSS
AG26	VSSACORE
AG27	VCCASP
AG28	VSS
AG29	SP1AVREFL[2]
AG30	VSS
AG31	SP1AVREFH[2]
AG32	VSS
AG33	SP1PRES
AG34	VSS
AG35	SP1AVREFL[0]
AG36	VSS
AG37	SP1AVREFH[0]
AH1	R0DQB[0]
AH2	VSS
AH3	R0RQ[1]
AH4	VSS
AH5	R1DQB[0]
AH6	VSS
AH7	R1RQ[1]
AH8	VSS
AH9	BERROUT#
AH10	BINITOUT#
AH11	VCC
AH12	330-ohm P/U
AH13	SPDCLK
AH14	N/C
AH15	VSS
AH16	N/C
AH17	VSS
AH18	LRESET#
AH19	VCC



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
AH20	LFRAME#
AH21	LPCCLKOUT1
AH22	VSS
AH23	CPUPRES#
AH24	RESETO#
AH25	VSS
AH26	VCCACORE
AH27	VSS
AH28	N/C
AH29	VSS
AH30	SP1AD[8]
AH31	VCCSP
AH32	N/C
AH33	VSS
AH34	SP1AD[0]
AH35	VCCSP
AH36	N/C
AH37	VSS
AJ1	VSS
AJ2	R0DQB[1]
AJ3	VCCRIO
AJ4	R0RQ[0]
AJ5	VSS
AJ6	R1DQB[1]
AJ7	VCCRIO
AJ8	R1RQ[0]
AJ9	VCC
AJ10	MEMRST0#
AJ11	330-ohm P/U
AJ12	VSS
AJ13	N/C
AJ14	VCC
AJ15	R2SYNCLKN
AJ16	VCCRIO
AJ17	R3SYNCLKN
AJ18	VSS
AJ19	LPCCLKOUT2
AJ20	LPCEN
AJ21	VCC3.3LPC

Ball Number	Signal
AJ22	LCLK
AJ23	N/C
AJ24	VCC
AJ25	RESETI#
AJ26	VCCAFSB
AJ27	VSSAFSB
AJ28	N/C
AJ29	N/C
AJ30	VSS
AJ31	SP1BD[8]
AJ32	VSS
AJ33	N/C
AJ34	VSS
AJ35	N/C
AJ36	VSS
AJ37	SP1BD[0]
AK1	R0DQB[3]
AK2	VSS
AK3	R0DQB[2]
AK4	VSS
AK5	R1DQB[3]
AK6	VSS
AK7	R1DQB[2]
AK8	VSS
AK9	VSS
AK10	R3DQA[8]
AK11	VSS
AK12	R3DQA[4]
AK13	VSS
AK14	VCCRIO
AK15	VSS
AK16	R3CTMN
AK17	VSS
AK18	R3EXRC
AK19	VSS
AK20	R3RQ[3]
AK21	VSS
AK22	R3RQ[0]
AK23	VSS



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
AK24	R3DQB[4]
AK25	VSS
AK26	R3DQB[8]
AK27	VSS
AK28	R3SIO
AK29	VCCSP
AK30	SP1BVREFH[2]
AK31	VSS
AK32	SP1BVREFL[2]
AK33	VCCSP
AK34	SP1BVREFH[0]
AK35	VSS
AK36	SP1BVREFL[0]
AK37	VSS
AL1	VSS
AL2	R0DQB[5]
AL3	VSS
AL4	R0DQB[4]
AL5	VSS
AL6	R1DQB[5]
AL7	VSS
AL8	R1DQB[4]
AL9	VSS
AL10	VSS
AL11	R3DQA[6]
AL12	VSS
AL13	R3DQA[3]
AL14	VSS
AL15	R3CFM
AL16	VCCRA ^a
AL17	R3RQ[7]
AL18	VCCRIO
AL19	R3RQ[4]
AL20	VSS
AL21	R3RQ[1]
AL22	VCCRIO
AL23	R3DQB[2]
AL24	VSS
AL25	R3DQB[6]

Ball Number	Signal
AL26	VSS
AL27	R3CMD
AL28	VSS
AL29	SP1BD[9]
AL30	VSS
AL31	SP1BLLC
AL32	VSS
AL33	SP1BEP[2]
AL34	VSS
AL35	SP1BD[1]
AL36	VSS
AL37	SP1BEP[1]
AM1	R0DQB[7]
AM2	VCCRIO
AM3	R0DQB[6]
AM4	VSS
AM5	R1DQB[7]
AM6	VCCRIO
AM7	R1DQB[6]
AM8	VSS
AM9	VSS
AM10	R3DQA[7]
AM11	VCCRIO
AM12	R3DQA[2]
AM13	VSS
AM14	R3DQA[0]
AM15	VSS
AM16	R3CTM
AM17	VCCRA ^a
AM18	R3RQ[5]
AM19	VSS
AM20	R3RQ[2]
AM21	VSS
AM22	R3DQB[1]
AM23	VSS
AM24	R3DQB[5]
AM25	VCCRIO
AM26	R3VREF[1]
AM27	VSS



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
AM28	R3SCK
AM29	VSS
AM30	SP1BSTBN[1]
AM31	VCCSP
AM32	SP1BSTBP[1]
AM33	VSS
AM34	SP1BSTBN[0]
AM35	VCCSP
AM36	SP1BSTBP[0]
AM37	VSS
AN1	VSS
AN2	R0VREF[1]
AN3	VSS
AN4	R0DQB[8]
AN5	VSS
AN6	R1VREF[1]
AN7	VSS
AN8	R1DQB[8]
AN9	VSS
AN10	VSS
AN11	R3DQA[5]
AN12	VSS
AN13	R3DQA[1]
AN14	VSS
AN15	R3CFMN
AN16	VSS
AN17	R3RQ[6]
AN18	VSS
AN19	R3EXCC
AN20	VSS
AN21	R3DQB[0]
AN22	VSS
AN23	R3DQB[3]
AN24	VSS
AN25	R3DQB[7]
AN26	VSS
AN27	R3VREF[0]
AN28	VSS
AN29	SP1BD[10]

Ball Number	Signal
AN30	VSS
AN31	SP1BRSVD
AN32	VSS
AN33	SP1BEP[0]
AN34	VSS
AN35	SP1BD[3]
AN36	VSS
AN37	SP1BD[2]
AP1	R0VREF[0]
AP2	VSS
AP3	R0CMD
AP4	VSS
AP5	R1VREF[0]
AP6	VSS
AP7	R1CMD
AP8	VSS
AP9	VSS
AP10	R2DQA[8]
AP11	VSS
AP12	R2DQA[4]
AP13	VSS
AP14	VCCRIO
AP15	VSS
AP16	R2CTMN
AP17	VSS
AP18	R2EXRC
AP19	VSS
AP20	R2RQ[3]
AP21	VSS
AP22	R2RQ[0]
AP23	VSS
AP24	R2DQB[4]
AP25	VSS
AP26	R2DQB[8]
AP27	VSS
AP28	R2SIO
AP29	VCCSP
AP30	SP1BSSO
AP31	VSS



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
AP32	SP1BD[11]
AP33	VCCSP
AP34	SP1BVREFL[1]
AP35	VSS
AP36	SP1BVREFH[1]
AP37	VSS
AR1	VSS
AR2	VCCRIO
AR3	ROSCK
AR4	VSS
AR5	ROSIO
AR6	VCCRIO
AR7	R1SCK
AR8	VSS
AR9	VSS
AR10	VSS
AR11	R2DQA[6]
AR12	VSS
AR13	R2DQA[3]
AR14	VSS
AR15	R2CFM
AR16	VCCRA ^a
AR17	R2RQ[7]
AR18	VCCRIO
AR19	R2RQ[4]
AR20	VSS
AR21	R2RQ[1]
AR22	VCCRIO
AR23	R2DQB[2]
AR24	VSS
AR25	R2DQB[6]
AR26	VSS
AR27	R2CMD
AR28	VSS
AR29	SP1BVREFL[3]
AR30	VSS
AR31	SP1BVREFH[3]
AR32	VSS
AR33	SP1BD[7]

Ball Number	Signal
AR34	VSS
AR35	SP1BD[4]
AR36	VSS
AR37	VSS
AT2	VSS
AT3	VSS
AT4	ROPCLKM
AT5	VSS
AT6	R1PCLKM
AT7	VSS
AT8	R1SIO
AT9	VSS
AT10	R2DQA[7]
AT11	VCCRIO
AT12	R2DQA[2]
AT13	VSS
AT14	R2DQA[0]
AT15	VSS
AT16	R2CTM
AT17	VCCRA ^a
AT18	R2RQ[5]
AT19	VSS
AT20	R2RQ[2]
AT21	VSS
AT22	R2DQB[1]
AT23	VSS
AT24	R2DQB[5]
AT25	VCCRIO
AT26	R2VREF[1]
AT27	VSS
AT28	R2SCK
AT29	VSS
AT30	SP1BD[15]
AT31	VSS
AT32	SP1BD[12]
AT33	VSS
AT34	SP1BD[6]
AT35	VCCSP
AT36	VSS



Table 10-1. SNC Ball List (Continued)

Ball Number	Signal
AU3	VSS
AU4	VSS
AU5	ROSYNCLKN
AU6	VSS
AU7	R1SYNCLKN
AU8	VSS
AU9	VSS
AU10	VSS
AU11	R2DQA[5]
AU12	VSS
AU13	R2DQA[1]
AU14	VSS
AU15	R2CFMN
AU16	VSS
AU17	R2RQ[6]
AU18	VSS
AU19	R2EXCC
AU20	VSS
AU21	R2DQB[0]
AU22	VSS
AU23	R2DQB[3]
AU24	VSS
AU25	R2DQB[7]
AU26	VSS
AU27	R2VREF[0]
AU28	VSS
AU29	SP1BD[14]
AU30	VSS
AU31	SP1BD[13]
AU32	VSS
AU33	SP1BD[5]
AU34	VSS
AU35	VSS

Ball Number	Signal

a. Tied to VCC.



Table 10-2. SNC Signal-Ball Number

Signal	Ball Number
ADS#	N7
A[10]#	C11
A[11]#	C8
A[12]#	B10
A[13]#	C9
A[14]#	D10
A[15]#	F11
A[16]#	H12
A[17]#	F9
A[18]#	F12
A[19]#	J11
A[20]#	G11
A[21]#	E10
A[22]#	H10
A[23]#	D8
A[24]#	H9
A[25]#	J9
A[26]#	G10
A[27]#	P12
A[28]#	J12
A[29]#	N11
A[3]#	D11
A[30]#	N10
A[31]#	K11
A[32]#	L10
A[33]#	G8
A[34]#	L9
A[35]#	P9
A[36]#	M9
A[37]#	K10
A[38]#	M11
A[39]#	R9
A[4]#	A11
A[40]#	R11
A[41]#	P10
A[42]#	R12
A[43]#	T10
A[5]#	B12

A[6]# A10 A[7]# B9 A[8]# E9 A[9]# E12 AP[0]# K8 AP[1]# J8 BERRIN# AD11 BERR# P7 BERROUT# AH9 BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4 BPM[1]# R6	
A[8]# E9 A[9]# E12 AP[0]# K8 AP[1]# J8 BERRIN# AD11 BERR# P7 BERROUT# AH9 BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
A[9]# E12 AP[0]# K8 AP[1]# J8 BERRIN# AD11 BERR# P7 BERROUT# AH9 BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
AP[0]# K8 AP[1]# J8 BERRIN# AD11 BERR# P7 BERROUT# AH9 BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
AP[1]# J8 BERRIN# AD11 BERR# P7 BERROUT# AH9 BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
BERRIN# AD11 BERR# P7 BERROUT# AH9 BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
BERR# P7 BERROUT# AH9 BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
BERROUT# AH9 BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
BINITIN# AA11 BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
BINIT# F8 BINITOUT# AH10 BNR# L12 BPM[0]# P4	
BINITOUT# AH10 BNR# L12 BPM[0]# P4	
BNR# L12 BPM[0]# P4	
BPM[0]# P4	
BPM[1]# R6	
-	
BPM[2]# N4	
BPM[3]# P6	
BPM[4]# R4	
BPM[5]# R8	
BPRI# K4	
BREQ0# H3	
BREQ[1]# M5	
BREQ[2]# L7	
BREQ[3]# J3	
BUSCLK Y25	
BUSCLK# AA25	
BUSID[0] W10	
BUSID[1] V9	
BUSID[2] U10	
COMPCNTRL[0]# V12	
COMPCNTRL[1]# U11	
330-ohm P/D AA27	
CPUPRES# AH23	
N/C AJ23	
DBSY# F6	
DEFER# K7	
DEP[0]# E21	
DEP[1]# C21	



Table 10-2. SNC Signal-Ball Number (Continued)

DEP[10]# N14 DEP[11]# M14 DEP[12]# R21 DEP[13]# U21 DEP[14]# R14 DEP[15]# T14 DEP[2]# D14 DEP[3]# C14 DEP[3]# F21 DEP[6]# F14 DEP[6]# F14 DEP[8]# P21 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[10]# D25 D[10]# D25 D[10]# R23 D[10]# R23 D[10]# V24 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# P22 D[11]# P22 D[112]# P19 D[113]# U19 D[115]# <th>Signal</th> <th>Ball Number</th>	Signal	Ball Number
DEP[12]# R21 DEP[13]# U21 DEP[14]# R14 DEP[15]# T14 DEP[2]# D14 DEP[3]# C14 DEP[3]# F21 DEP[6]# F21 DEP[6]# F14 DEP[7]# G14 DEP[8]# P21 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[100]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U25 D[109]# U25 D[101]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[11]# A22 D[11]# P22 D[11]# P22 D[11]# P19 D[113]# U19 D[114]# T20	DEP[10]#	N14
DEP[13]# U21 DEP[14]# R14 DEP[15]# T14 DEP[2]# D14 DEP[3]# C14 DEP[3]# F21 DEP[5]# H21 DEP[6]# F14 DEP[8]# P21 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[10]# D25 D[10]# D25 D[10]# R23 D[10]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[11]# A22 D[11]# P19 D[113]# U19 D[114]# T20	DEP[11]#	M14
DEP[14]# R14 DEP[2]# D14 DEP[3]# C14 DEP[4]# F21 DEP[5]# H21 DEP[6]# F14 DEP[7]# G14 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[10]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[11]# A22 D[110]# V21 D[112]# P19 D[113]# U19 D[114]# T20	DEP[12]#	R21
DEP[15]# T14 DEP[2]# D14 DEP[3]# C14 DEP[4]# F21 DEP[6]# H21 DEP[6]# F14 DEP[7]# G14 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[109]# U22 D[11]# A22 D[11]# A22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P19 D[113]# U19 D[114]# T20	DEP[13]#	U21
DEP[2]# D14 DEP[3]# C14 DEP[4]# F21 DEP[5]# H21 DEP[6]# F14 DEP[7]# G14 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U25 D[109]# U22 D[11]# A22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P19 D[113]# U19 D[114]# T20	DEP[14]#	R14
DEP[3]# C14 DEP[4]# F21 DEP[5]# H21 DEP[6]# F14 DEP[7]# G14 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[10]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[11]# P22 D[112]# P19 D[113]# U19 D[114]# T20	DEP[15]#	T14
DEP[4]# F21 DEP[5]# H21 DEP[6]# F14 DEP[7]# G14 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[11]# A22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P22 D[11]# P19 D[113]# U19 D[114]# T20	DEP[2]#	D14
DEP[5]# H21 DEP[6]# F14 DEP[7]# G14 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	DEP[3]#	C14
DEP[6]# F14 DEP[7]# G14 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	DEP[4]#	F21
DEP[7]# G14 DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[100]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[11]# A22 D[11]# A22 D[11]# P22 D[11]# P22 D[11]# P19 D[113]# U19 D[114]# T20	DEP[5]#	H21
DEP[8]# P21 DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	DEP[6]#	F14
DEP[9]# M21 D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[11]# A22 D[11]# P22 D[11]# P22 D[112]# P19 D[113]# U19 D[114]# T20	DEP[7]#	G14
D[0]# E27 D[1]# A25 D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	DEP[8]#	P21
D[1]# A25 D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	DEP[9]#	M21
D[10]# D25 D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[0]#	E27
D[100]# U25 D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[108]# T23 D[109]# U22 D[11]# A22 D[11]# A22 D[110]# P19 D[111]# P19 D[113]# U19 D[114]# T20	D[1]#	A25
D[101]# R23 D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[10]#	D25
D[102]# R26 D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[100]#	U25
D[103]# V24 D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[101]#	R23
D[104]# V26 D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[102]#	R26
D[105]# T22 D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[103]#	V24
D[106]# R24 D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[104]#	V26
D[107]# V23 D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[105]#	T22
D[108]# T23 D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[106]#	R24
D[109]# U22 D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[107]#	V23
D[11]# A22 D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[108]#	T23
D[110]# V21 D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[109]#	U22
D[111]# P22 D[112]# P19 D[113]# U19 D[114]# T20	D[11]#	A22
D[112]# P19 D[113]# U19 D[114]# T20	D[110]#	V21
D[113]# U19 D[114]# T20	D[111]#	P22
D[114]# T20	D[112]#	P19
		U19
D[115]# V18	D[114]#	T20
	D[115]#	V18
D[116]# T19	D[116]#	T19
D[117]# R20	D[117]#	R20
D[118]# R18	D[118]#	R18
D[119]# V17	D[119]#	V17
D[12]# B22	D[12]#	B22

D[400]#	
D[120]#	U16
D[121]#	V15
D[122]#	P16
D[123]#	V14
D[124]#	R15
D[125]#	T16
D[126]#	U15
D[127]#	R17
D[13]#	B21
D[14]#	A23
D[15]#	D23
D[16]#	C20
D[17]#	A19
D[18]#	D20
D[19]#	B19
D[2]#	C27
D[20]#	B18
D[21]#	D19
D[22]#	D17
D[23]#	A17
D[24]#	B16
D[25]#	B15
D[26]#	D16
D[27]#	A16
D[28]#	E18
D[29]#	C15
D[3]#	C26
D[30]#	A14
D[31]#	E15
D[32]#	G22
D[33]#	H27
D[34]#	G26
D[35]#	F27
D[36]#	J26
D[37]#	F26
D[38]#	F23
D[39]#	H25
D[4]#	A26
D[40]#	E25



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
D[41]#	G23
D[42]#	E22
D[43]#	J23
D[44]#	J24
D[45]#	F24
D[46]#	H22
D[47]#	J21
D[48]#	F18
D[49]#	F20
D[5]#	D26
D[50]#	G20
D[51]#	J18
D[52]#	H19
D[53]#	E19
D[54]#	E16
D[55]#	J17
D[56]#	G19
D[57]#	H16
D[58]#	F17
D[59]#	J15
D[6]#	E24
D[60]#	H15
D[61]#	G16
D[62]#	J14
D[63]#	F15
D[64]#	N26
D[65]#	K26
D[66]#	M26
D[67]#	K25
D[68]#	L24
D[69]#	P24
D[7]#	B24
D[70]#	P27
D[71]#	K23
D[72]#	M23
D[73]#	M27
D[74]#	N25
D[75]#	K22
D[76]#	L22

D[77]# N22 D[78]# L21 D[79]# N23 D[8]# C23 D[80]# N20 D[81]# K19 D[82]# N19 D[83]# M20 D[84]# L18 D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12 EV[2]# AB12	Signal	Ball Number
D[79]# N23 D[8]# C23 D[80]# N20 D[81]# K19 D[82]# N19 D[83]# M20 D[84]# L18 D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[77]#	N22
D[8]# C23 D[80]# N20 D[81]# K19 D[82]# N19 D[83]# M20 D[84]# L18 D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# K14 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[78]#	L21
D[80]# N20 D[81]# K19 D[82]# N19 D[83]# M20 D[84]# L18 D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# K14 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[79]#	N23
D[81]# K19 D[82]# N19 D[83]# M20 D[84]# L18 D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[8]#	C23
D[82]# N19 D[83]# M20 D[84]# L18 D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# K14 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[80]#	N20
D[83]# M20 D[84]# L18 D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[81]#	K19
D[84]# L18 D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[82]#	N19
D[85]# N17 D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# K14 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[83]#	M20
D[86]# P18 D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[84]#	L18
D[87]# K16 D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[85]#	N17
D[88]# L19 D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[86]#	P18
D[89]# M15 D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[87]#	K16
D[9]# D22 D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[88]#	L19
D[90]# P15 D[91]# K17 D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[89]#	M15
D[91]# K17 D[92]# L15 D[93]# L16 D[93]# K14 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[9]#	D22
D[92]# L15 D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[90]#	P15
D[93]# L16 D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[91]#	K17
D[94]# K14 D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[92]#	L15
D[95]# N16 D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[93]#	L16
D[96]# P25 D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[94]#	K14
D[97]# U27 D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[95]#	N16
D[98]# T26 D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[96]#	P25
D[99]# R27 DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[97]#	U27
DRDY# H6 ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[98]#	T26
ERR[0]# Y11 ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	D[99]#	R27
ERR[1]# V11 ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	DRDY#	H6
ERR[2]# W12 EV[0]# AC13 EV[1]# AD12	ERR[0]#	Y11
EV[0]# AC13 EV[1]# AD12	ERR[1]#	V11
EV[1]# AD12	ERR[2]#	W12
	EV[0]#	AC13
FV[2]# AR12	EV[1]#	AD12
- · [-]"	EV[2]#	AB12
EV[3]# AA12	EV[3]#	AA12
330-ohm P/D AB26	330-ohm P/D	AB26
FSBODTCRES[0] T8	FSBODTCRES[0]	Т8
FSBODTCRES[1] T11	FSBODTCRES[1]	T11
FSBSLWCRES[0] U12	FSBSLWCRES[0]	U12
FSBSLWCRES[1] T12	FSBSLWCRES[1]	T12
GSEQ# K5	GSEQ#	K5



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
N/C	AJ28
N/C	AH28
HITM#	H7
HIT#	G7
ID[0]#	A5
ID[1]#	A7
ID[2]#	B6
ID[3]#	A8
ID[4]#	C5
ID[5]#	B7
ID[6]#	A4
ID[7]#	C6
ID[8]#	D5
ID[9]#	D7
IDS#	E6
INIT#	Y13
INT_OUT#	AC11
ITEST	AG9
LAD[0]	AF21
LAD[1]	AF20
LAD[2]	AG21
LAD[3]	AG19
LCLK	AJ22
LFRAME#	AH20
LOCK#	H4
LPCCLKOUT0	AF22
LPCCLKOUT1	AH21
LPCCLKOUT2	AJ19
LPCEN	AJ20
LPCSEL	AG22
LRESET#	AH18
LVHSTLODTEN	AG24
MEMRST0#	AJ10
MEMRST1#	AE13
N/C	L4
N/C	T7
N/C	AF16
N/C	AF18
N/C	AH16

Signal	Ball Number
N/C	L33
N/C	AJ33
N/C	K32
N/C	M3
N/C	L29
N/C	AH32
N/C	AJ29
N/C	M6
N/C	M8
N/C	N8
N/C	R3
N/C	T4
N/C	T5
N/C	T6
NODEID[0]	AC10
NODEID[1]	AB10
NODEID[2]	AE10
NODEID[3]	AF10
NODEID[4]	Y10
330-ohm P/D	AC25
330-ohm P/D	AB25
330-ohm P/D	W25
330-ohm P/D	AA26
330-ohm P/D	W26
330-ohm P/D	AD27
330-ohm P/D	AC27
330-ohm P/D	AF28
330-ohm P/D	AB28
PWRGOOD	AD26
R0CFM	AB3
ROCFMN	AB1
R0CMD	AP3
ROCTM	AC2
ROCTMN	AC4
R0DQA[0]	AA2
R0DQA[1]	Y1
R0DQA[2]	W2
R0DQA[3]	Y3
R0DQA[4]	W4



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
R0DQA[5]	V1
R0DQA[6]	V3
R0DQA[7]	U2
R0DQA[8]	U4
R0DQB[0]	AH1
R0DQB[1]	AJ2
R0DQB[2]	AK3
R0DQB[3]	AK1
R0DQB[4]	AL4
R0DQB[5]	AL2
R0DQB[6]	AM3
R0DQB[7]	AM1
R0DQB[8]	AN4
R0EXCC	AF1
R0EXRC	AE4
ROPCLKM	AT4
R0RQ[0]	AJ4
R0RQ[1]	AH3
R0RQ[2]	AG2
R0RQ[3]	AG4
R0RQ[4]	AF3
R0RQ[5]	AE2
R0RQ[6]	AD1
R0RQ[7]	AD3
ROSCK	AR3
ROSIO	AR5
ROSYNCLKN	AU5
R0VREF[0]	AP1
R0VREF[1]	AN2
R1CFM	AB7
R1CFMN	AB5
R1CMD	AP7
R1CTM	AC6
R1CTMN	AC8
R1DQA[0]	AA6
R1DQA[1]	Y5
R1DQA[2]	W6
R1DQA[3]	Y7
R1DQA[4]	W8

Signal	Ball Number
R1DQA[5]	V5
R1DQA[6]	V7
R1DQA[7]	U6
R1DQA[8]	U8
R1DQB[0]	AH5
R1DQB[1]	AJ6
R1DQB[2]	AK7
R1DQB[3]	AK5
R1DQB[4]	AL8
R1DQB[5]	AL6
R1DQB[6]	AM7
R1DQB[7]	AM5
R1DQB[8]	AN8
R1EXCC	AF5
R1EXRC	AE8
R1PCLKM	AT6
R1RQ[0]	AJ8
R1RQ[1]	AH7
R1RQ[2]	AG6
R1RQ[3]	AG8
R1RQ[4]	AF7
R1RQ[5]	AE6
R1RQ[6]	AD5
R1RQ[7]	AD7
R1SCK	AR7
R1SIO	AT8
R1SYNCLKN	AU7
R1VREF[0]	AP5
R1VREF[1]	AN6
R2CFM	AR15
R2CFMN	AU15
R2CMD	AR27
R2CTM	AT16
R2CTMN	AP16
R2DQA[0]	AT14
R2DQA[1]	AU13
R2DQA[2]	AT12
R2DQA[3]	AR13
R2DQA[4]	AP12



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
R2DQA[5]	AU11
R2DQA[6]	AR11
R2DQA[7]	AT10
R2DQA[8]	AP10
R2DQB[0]	AU21
R2DQB[1]	AT22
R2DQB[2]	AR23
R2DQB[3]	AU23
R2DQB[4]	AP24
R2DQB[5]	AT24
R2DQB[6]	AR25
R2DQB[7]	AU25
R2DQB[8]	AP26
R2EXCC	AU19
R2EXRC	AP18
R2PCLKM	AG15
R2RQ[0]	AP22
R2RQ[1]	AR21
R2RQ[2]	AT20
R2RQ[3]	AP20
R2RQ[4]	AR19
R2RQ[5]	AT18
R2RQ[6]	AU17
R2RQ[7]	AR17
R2SCK	AT28
R2SIO	AP28
R2SYNCLKN	AJ15
R2VREF[0]	AU27
R2VREF[1]	AT26
R3CFM	AL15
R3CFMN	AN15
R3CMD	AL27
R3CTM	AM16
R3CTMN	AK16
R3DQA[0]	AM14
R3DQA[1]	AN13
R3DQA[2]	AM12
R3DQA[3]	AL13
R3DQA[4]	AK12

Signal	Ball Number
R3DQA[5]	AN11
R3DQA[6]	AL11
R3DQA[7]	AM10
R3DQA[8]	AK10
R3DQB[0]	AN21
R3DQB[1]	AM22
R3DQB[2]	AL23
R3DQB[3]	AN23
R3DQB[4]	AK24
R3DQB[5]	AM24
R3DQB[6]	AL25
R3DQB[7]	AN25
R3DQB[8]	AK26
R3EXCC	AN19
R3EXRC	AK18
R3PCLKM	AG17
R3RQ[0]	AK22
R3RQ[1]	AL21
R3RQ[2]	AM20
R3RQ[3]	AK20
R3RQ[4]	AL19
R3RQ[5]	AM18
R3RQ[6]	AN17
R3RQ[7]	AL17
R3SCK	AM28
R3SIO	AK28
R3SYNCLKN	AJ17
R3VREF[0]	AN27
R3VREF[1]	AM26
RACODTCRES[0]	AG11
RACODTCRES[1]	AF11
RACODTEN[0]	AD13
RACODTEN[1]	AE12
330 ohm P/U	AH12
REQ[0]#	D4
REQ[1]#	C3
REQ[2]#	G5
REQ[3]#	E4
REQ[4]#	E3



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
REQ[5]#	J5
RESETI#	AJ25
RESET#	N5
RESETO#	AH24
RP#	J6
RS[0]#	B4
RS[1]#	F5
RS[2]#	E7
RSP#	B3
N/C	AJ13
N/C	AH14
SBSY#	G4
SCL	AF14
SDA	AF13
SP0AD[0]	K34
SP0AD[1]	H34
SP0AD[10]	F32
SP0AD[11]	E29
SP0AD[12]	C29
SP0AD[13]	B30
SP0AD[14]	A29
SP0AD[15]	C31
SP0AD[2]	G37
SP0AD[3]	F34
SP0AD[4]	E37
SP0AD[5]	C35
SP0AD[6]	D36
SP0AD[7]	D34
SP0AD[8]	K30
SP0AD[9]	H32
SP0ARSVD	F30
SP0AEP[0]	F36
SP0AEP[1]	H36
SP0AEP[2]	J37
SP0ALLC	H30
N/C	K36
SP0ASSO	E31
SP0ASTBN[0]	G35
SP0ASTBN[1]	G31

Signal	Ball Number
SP0ASTBP[0]	G33
SP0ASTBP[1]	G29
SP0AVREFH[0]	J35
SP0AVREFH[1]	E33
SP0AVREFH[2]	J31
SP0AVREFH[3]	D30
SP0AVREFL[0]	J33
SP0AVREFL[1]	E35
SP0AVREFL[2]	J29
SP0AVREFL[3]	D32
SP0BD[0]	L37
SP0BD[1]	N35
SP0BD[10]	R29
SP0BD[11]	T32
SP0BD[12]	V32
SP0BD[13]	W31
SP0BD[14]	W29
SP0BD[15]	V30
SP0BD[2]	R35
SP0BD[3]	T36
SP0BD[4]	V36
SP0BD[5]	W35
SP0BD[6]	W37
SP0BD[7]	V34
SP0BD[8]	L31
SP0BD[9]	N29
SP0BRSVD	R31
SP0BEP[0]	T34
SP0BEP[1]	R37
SP0BEP[2]	N37
SP0BLLC	N31
N/C	L35
SP0BSSO	T30
SP0BSTBN[0]	P34
SP0BSTBN[1]	P30
SP0BSTBP[0]	P36
SP0BSTBP[1]	P32
SP0BVREFH[0]	M34
SP0BVREFH[1]	U37



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
SP0BVREFH[2]	M30
SP0BVREFH[3]	U31
SP0BVREFL[0]	M36
SP0BVREFL[1]	U35
SP0BVREFL[2]	M32
SP0BVREFL[3]	U29
SP0GPIO[0]	AE26
SP0GPIO[1]	AF24
SP0PRES	N33
SP0SYNC	R33
SP0ZUPD[0]	U33
SP0ZUPD[1]	W33
SP1AD[0]	AH34
SP1AD[1]	AF36
SP1AD[10]	AD32
SP1AD[11]	AC29
SP1AD[12]	AA29
SP1AD[13]	Y30
SP1AD[14]	Y32
SP1AD[15]	AA31
SP1AD[2]	AD36
SP1AD[3]	AC35
SP1AD[4]	AA35
SP1AD[5]	Y36
SP1AD[6]	Y34
SP1AD[7]	AA37
SP1AD[8]	AH30
SP1AD[9]	AF32
SP1ARSVD	AD30
SP1AEP[0]	AC37
SP1AEP[1]	AD34
SP1AEP[2]	AF34
SP1ALLC	AF30
N/C	AH36
SP1ASSO	AC31
SP1ASTBN[0]	AE37
SP1ASTBN[1]	AE31
SP1ASTBP[0]	AE35
SP1ASTBP[1]	AE29

Signal	Ball Number
SP1AVREFH[0]	AG37
SP1AVREFH[1]	AB34
SP1AVREFH[2]	AG31
SP1AVREFH[3]	AB30
SP1AVREFL[0]	AG35
SP1AVREFL[1]	AB36
SP1AVREFL[2]	AG29
SP1AVREFL[3]	AB32
SP1BD[0]	AJ37
SP1BD[1]	AL35
SP1BD[10]	AN29
SP1BD[11]	AP32
SP1BD[12]	AT32
SP1BD[13]	AU31
SP1BD[14]	AU29
SP1BD[15]	AT30
SP1BD[2]	AN37
SP1BD[3]	AN35
SP1BD[4]	AR35
SP1BD[5]	AU33
SP1BD[6]	AT34
SP1BD[7]	AR33
SP1BD[8]	AJ31
SP1BD[9]	AL29
SP1BRSVD	AN31
SP1BEP[0]	AN33
SP1BEP[1]	AL37
SP1BEP[2]	AL33
SP1BLLC	AL31
N/C	AJ35
SP1BSSO	AP30
SP1BSTBN[0]	AM34
SP1BSTBN[1]	AM30
SP1BSTBP[0]	AM36
SP1BSTBP[1]	AM32
SP1BVREFH[0]	AK34
SP1BVREFH[1]	AP36
SP1BVREFH[2]	AK30
SP1BVREFH[3]	AR31



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
SP1BVREFL[0]	AK36
SP1BVREFL[1]	AP34
SP1BVREFL[2]	AK32
SP1BVREFL[3]	AR29
SP1GPIO[0]	AF27
SP1GPIO[1]	AE25
SP1PRES	AG33
SP1SYNC	AE33
SP1ZUPD[0]	AC33
SP1ZUPD[1]	AA33
330-Ohm P/D	Y28
330-Ohm P/D	AD28
330-Ohm P/D	Y27
SPDCLK	AH13
SPDDA	AG14
N/C	B27
N/C	A20
N/C	J27
N/C	J20
N/C	L27
N/C	K20
N/C	V27
N/C	V20
N/C	W13
STBN[0]#	C24
STBN[1]#	C17
STBN[2]#	H24
STBN[3]#	G17
STBN[4]#	M24
STBN[5]#	M17
STBN[6]#	U24
STBN[7]#	T17
STBP[0]#	B25
STBP[1]#	C18
STBP[2]#	G25
STBP[3]#	H18
STBP[4]#	L25
STBP[5]#	M18

Signal	Ball Number
STBP[6]#	T25
STBP[7]#	U18
TCK	AE9
330 ohm P/U	AJ11
TDI	AA9
TDIOANODE	AA13
TDIOCATHODE	AB13
TDO	AB9
TMS	W9
TND#	L6
TRDY#	F3
TRST#	AD9
VCC	AA14
VCC	AA16
VCC	AA18
VCC	AA20
VCC	AA22
VCC	AA24
VCC	AB11
VCC	AB15
VCC	AB17
VCC	AB19
VCC	AB21
VCC	AB23
VCC	AB27
VCC	AC9
VCC	AC14
VCC	AC16
VCC	AC18
VCC	AC20
VCC	AC22
VCC	AC24
VCC	AD15
VCC	AD17
VCC	AD19
VCC	AD21
VCC	AD23
VCC	AE11



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
VCC	AE14
VCC	AE16
VCC	AE18
VCC	AE20
VCC	AE22
VCC	AE24
VCC	AE27
VCC	AF9
VCC	AF23
VCC	AG13
VCC	AH11
VCC	AH19
VCC	AJ9
VCC	AJ14
VCC	AJ24
VCC	U9
VCC	W11
VCC	W14
VCC	W16
VCC	W18
VCC	W20
VCC	W22
VCC	W24
VCC	W27
VCC	Y9
VCC	Y15
VCC	Y17
VCC	Y19
VCC	Y21
VCC	Y23
VCC3.3I2C	AG12
VCC3.3LPC	AG20
VCC3.3LPC	AJ21
VCCACORE	AH26
VCCAFSB	AJ26
VCCASP	AG27
VCCRA ^a	AC3
VCCRA ^a	AC7
VCCRA ^a	AD2

Signal	Ball Number
VCCRA ^a	AD6
VCCRA ^a	AL16
VCCRA ^a	AM17
VCCRA ^a	AR16
VCCRA ^a	AT17
VCCRIO	AA4
VCCRIO	AA8
VCCRIO	AE3
VCCRIO	AE7
VCCRIO	AG16
VCCRIO	AJ3
VCCRIO	AJ7
VCCRIO	AJ16
VCCRIO	AK14
VCCRIO	AL18
VCCRIO	AL22
VCCRIO	AM2
VCCRIO	AM6
VCCRIO	AM11
VCCRIO	AM25
VCCRIO	AP14
VCCRIO	AR2
VCCRIO	AR6
VCCRIO	AR18
VCCRIO	AR22
VCCRIO	AT11
VCCRIO	AT25
VCCRIO	V2
VCCRIO	V6
VCCSP	AB29
VCCSP	AB33
VCCSP	AD31
VCCSP	AD35
VCCSP	AF29
VCCSP	AF33
VCCSP	AH31
VCCSP	AH35
VCCSP	AK29
VCCSP	AK33



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
VCCSP	AM31
VCCSP	AM35
VCCSP	AP29
VCCSP	AP33
VCCSP	AT35
VCCSP	B33
VCCSP	D31
VCCSP	D35
VCCSP	F29
VCCSP	F33
VCCSP	H31
VCCSP	H35
VCCSP	K29
VCCSP	K33
VCCSP	M31
VCCSP	M35
VCCSP	P29
VCCSP	P33
VCCSP	T31
VCCSP	T35
VCCSP	V29
VCCSP	V33
VCCSP	Y31
VCCSP	Y35
VSS	A6
VSS	A9
VSS	A12
VSS	A15
VSS	A18
VSS	A24
VSS	A27
VSS	A28
VSS	A30
VSS	A31
VSS	A32
VSS	A33
VSS	A34
VSS	A35
VSS	AA1
VSS	AC32
VSS	AC34
VSS	AC36

Signal	Ball Number
VSS	AA3
VSS	AA5
VSS	AA7
VSS	AA10
VSS	AA15
VSS	AA17
VSS	AA19
VSS	AA21
VSS	AA23
VSS	AG25
VSS	AA28
VSS	AA30
VSS	AA32
VSS	AA34
VSS	AA36
VSS	AB2
VSS	AB4
VSS	AB6
VSS	AB8
VSS	AB14
VSS	AB16
VSS	AB18
VSS	AB20
VSS	AB22
VSS	AB24
VSS	AB31
VSS	AB35
VSS	AB37
VSS	AC1
VSS	AC5
VSS	AC12
VSS	AC15
VSS	AC17
VSS	AC19
VSS	AC21
VSS	AC23
VSS	AC26
VSS	AC28
VSS	AC30
VSS	AF37
VSS	AG1
VSS	AG3



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
VSS	AD4
VSS	AD8
VSS	AD10
VSS	AD14
VSS	AD16
VSS	AD18
VSS	AD20
VSS	AD22
VSS	AD24
VSS	AD25
VSS	AD29
VSS	AD33
VSS	AD37
VSS	AE1
VSS	AE5
VSS	AE15
VSS	AE17
VSS	AE19
VSS	AE21
VSS	AE23
VSS	AE28
VSS	AE30
VSS	AE32
VSS	AE34
VSS	AE36
VSS	AF2
VSS	AF4
VSS	AF6
VSS	AF8
VSS	AF12
VSS	AF15
VSS	AF17
VSS	AF19
VSS	AF25
VSS	AF31
VSS	AF35
VSS	AK13
VSS	AK15
VSS	AK17
VSS	AK19
VSS	AK21
VSS	AK23

Signal	Ball Number
VSS	AG5
VSS	AG7
VSS	AG10
VSS	AG18
VSS	AG23
VSS	AG28
VSS	AG30
VSS	AG32
VSS	AG34
VSS	AG36
VSS	AH2
VSS	AH4
VSS	AH6
VSS	AH8
VSS	AH15
VSS	AH17
VSS	AH22
VSS	AH25
VSS	AH27
VSS	AH29
VSS	AH33
VSS	AH37
VSS	AJ1
VSS	AJ5
VSS	AJ12
VSS	AJ18
VSS	AJ30
VSS	AJ32
VSS	AJ34
VSS	AJ36
VSS	AK2
VSS	AK4
VSS	AK6
VSS	AK8
VSS	AK9
VSS	AK11
VSS	AN1
VSS	AN3
VSS	AN5
VSS	AN7
VSS	AN9
VSS	AN10



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
VSS	AK25
VSS	AK27
VSS	AK31
VSS	AK35
VSS	AK37
VSS	AL1
VSS	AL3
VSS	AL5
VSS	AL7
VSS	AL9
VSS	AL10
VSS	AL12
VSS	AL14
VSS	AL20
VSS	AL24
VSS	AL26
VSS	AL28
VSS	AL30
VSS	AL32
VSS	AL34
VSS	AL36
VSS	AM4
VSS	AM8
VSS	AM9
VSS	AM13
VSS	AM15
VSS	AM19
VSS	AM21
VSS	AM23
VSS	AM27
VSS	AM29
VSS	AM33
VSS	AM37
VSS	AR9
VSS	AR10
VSS	AR12
VSS	AR14
VSS	AR20
VSS	AR24
VSS	AR26
VSS	AR28
VSS	AR30
1	700

Signal	Ball Number
VSS	AN12
VSS	AN14
VSS	AN16
VSS	AN18
VSS	AN20
VSS	AN22
VSS	AN24
VSS	AN26
VSS	AN28
VSS	AN30
VSS	AN32
VSS	AN34
VSS	AN36
VSS	AP2
VSS	AP4
VSS	AP6
VSS	AP8
VSS	AP9
VSS	AP11
VSS	AP13
VSS	AP15
VSS	AP17
VSS	AP19
VSS	AP21
VSS	AP23
VSS	AP25
VSS	AP27
VSS	AP31
VSS	AP35
VSS	AP37
VSS	AR1
VSS	AR4
VSS	AR8
VSS	AU22
VSS	AU24
VSS	AU26
VSS	AU28
VSS	AU30
VSS	AU32
VSS	AU34
VSS	AU35
VSS	B2



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
VSS	AR32
VSS	AR34
VSS	AR36
VSS	AR37
VSS	AT2
VSS	AT3
VSS	AT5
VSS	AT7
VSS	AT9
VSS	AT13
VSS	AT15
VSS	AT19
VSS	AT21
VSS	AT23
VSS	AT27
VSS	AT29
VSS	AT31
VSS	AT33
VSS	AT36
VSS	AU3
VSS	AU4
VSS	AU6
VSS	AU8
VSS	AU9
VSS	AU10
VSS	AU12
VSS	AU14
VSS	AU16
VSS	AU18
VSS	AU20
VSS	D13
VSS	D15
VSS	D21
VSS	D24
VSS	D29
VSS	D33
VSS	D37
VSS	E1
VSS	E2
VSS	E8
VSS	E11
VSS	E17

VSS B5 VSS B11 VSS B14 VSS B20 VSS B23 VSS B29 VSS B31 VSS B32 VSS B34 VSS B36 VSS C1 VSS C1 VSS C10 VSS C16 VSS C19 VSS C30 VSS C32 VSS C34 VSS C36 VSS D1 VSS D12 VSS G30 VSS G34 VSS H1 VSS	Signal	Ball Number
VSS B13 VSS B20 VSS B23 VSS B29 VSS B31 VSS B32 VSS B34 VSS B36 VSS C1 VSS C1 VSS C10 VSS C16 VSS C16 VSS C25 VSS C30 VSS C32 VSS C34 VSS C36 VSS D1 VSS D6 VSS G30 VSS G32 VSS G34 VSS G34 VSS G34 VSS G36 VSS G36 VSS H1 VSS H15	VSS	B5
VSS B14 VSS B20 VSS B23 VSS B29 VSS B31 VSS B32 VSS B34 VSS B36 VSS C1 VSS C1 VSS C10 VSS C16 VSS C19 VSS C25 VSS C30 VSS C32 VSS C34 VSS C36 VSS D1 VSS D1 VSS D12 VSS G30 VSS G34 VSS G34 VSS G36 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B11
VSS B23 VSS B29 VSS B31 VSS B32 VSS B34 VSS B35 VSS B36 VSS C1 VSS C10 VSS C16 VSS C19 VSS C28 VSS C30 VSS C32 VSS C34 VSS C37 VSS D1 VSS D12 VSS G30 VSS G34 VSS G34 VSS G36 VSS G36 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B13
VSS B29 VSS B31 VSS B32 VSS B34 VSS B35 VSS B36 VSS C1 VSS C2 VSS C10 VSS C16 VSS C19 VSS C28 VSS C30 VSS C32 VSS C34 VSS C34 VSS C37 VSS D1 VSS D12 VSS G30 VSS G34 VSS G34 VSS G34 VSS G36 VSS G36 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B14
VSS B31 VSS B32 VSS B34 VSS B35 VSS B36 VSS C1 VSS C2 VSS C10 VSS C16 VSS C19 VSS C28 VSS C30 VSS C32 VSS C34 VSS C36 VSS C37 VSS D1 VSS D3 VSS D12 VSS G30 VSS G34 VSS G36 VSS G36 VSS G36 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B20
VSS B31 VSS B32 VSS B34 VSS B35 VSS C1 VSS C2 VSS C7 VSS C10 VSS C16 VSS C25 VSS C30 VSS C32 VSS C33 VSS C34 VSS C37 VSS C37 VSS D1 VSS D6 VSS G30 VSS G32 VSS G34 VSS G36 VSS G36 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B23
VSS B34 VSS B35 VSS B36 VSS C1 VSS C2 VSS C7 VSS C10 VSS C16 VSS C19 VSS C25 VSS C30 VSS C32 VSS C34 VSS C36 VSS C37 VSS D1 VSS D6 VSS D12 VSS G30 VSS G34 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B29
VSS B34 VSS B35 VSS C1 VSS C2 VSS C7 VSS C10 VSS C16 VSS C25 VSS C28 VSS C30 VSS C32 VSS C34 VSS C36 VSS C37 VSS D1 VSS D3 VSS D12 VSS G30 VSS G34 VSS G36 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B31
VSS B35 VSS B36 VSS C1 VSS C7 VSS C10 VSS C16 VSS C19 VSS C25 VSS C30 VSS C32 VSS C34 VSS C36 VSS C37 VSS D1 VSS D6 VSS D12 VSS G30 VSS G32 VSS G36 VSS G36 VSS H1 VSS H1 VSS H5	VSS	B32
VSS C1 VSS C2 VSS C7 VSS C10 VSS C16 VSS C19 VSS C25 VSS C30 VSS C32 VSS C34 VSS C36 VSS C37 VSS D1 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	B34
VSS C1 VSS C2 VSS C10 VSS C16 VSS C19 VSS C25 VSS C28 VSS C30 VSS C32 VSS C33 VSS C36 VSS C37 VSS D1 VSS D6 VSS D12 VSS G30 VSS G34 VSS G34 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B35
VSS C2 VSS C7 VSS C10 VSS C16 VSS C19 VSS C25 VSS C30 VSS C32 VSS C33 VSS C34 VSS C36 VSS C37 VSS D1 VSS D6 VSS D12 VSS G30 VSS G32 VSS G36 VSS G36 VSS H1 VSS H5	VSS	B36
VSS C7 VSS C10 VSS C16 VSS C19 VSS C25 VSS C30 VSS C32 VSS C33 VSS C34 VSS C36 VSS C37 VSS D1 VSS D3 VSS D12 VSS G30 VSS G34 VSS G36 VSS G36 VSS H1 VSS H5	VSS	C1
VSS C10 VSS C16 VSS C19 VSS C25 VSS C28 VSS C30 VSS C32 VSS C33 VSS C34 VSS C36 VSS C37 VSS D1 VSS D6 VSS D12 VSS G30 VSS G34 VSS G36 VSS G36 VSS H1 VSS H5	VSS	C2
VSS C16 VSS C19 VSS C25 VSS C28 VSS C30 VSS C32 VSS C33 VSS C34 VSS C36 VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G34 VSS G36 VSS G36 VSS H1 VSS H1 VSS H5	VSS	C7
VSS C19 VSS C25 VSS C30 VSS C32 VSS C33 VSS C34 VSS C36 VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C10
VSS C25 VSS C28 VSS C30 VSS C32 VSS C33 VSS C34 VSS C36 VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C16
VSS C28 VSS C30 VSS C32 VSS C33 VSS C34 VSS C36 VSS C37 VSS D1 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C19
VSS C30 VSS C32 VSS C33 VSS C34 VSS C36 VSS C37 VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C25
VSS C32 VSS C33 VSS C34 VSS C36 VSS C37 VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C28
VSS C33 VSS C34 VSS C36 VSS C37 VSS D1 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C30
VSS C34 VSS C36 VSS C37 VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C32
VSS C36 VSS C37 VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C33
VSS C37 VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C34
VSS D1 VSS D3 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C36
VSS D3 VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	C37
VSS D6 VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	D1
VSS D12 VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	D3
VSS G30 VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	D6
VSS G32 VSS G34 VSS G36 VSS H1 VSS H5	VSS	D12
VSS G34 VSS G36 VSS H1 VSS H5	VSS	G30
VSS G36 VSS H1 VSS H5	VSS	G32
VSS H1 VSS H5	VSS	G34
VSS H5	VSS	G36
VSS H5	VSS	H1
VSS H8		H5
, I = I	VSS	H8
VSS H14	VSS	H14
VSS H17	VSS	H17
VSS H23	VSS	H23
VSS H26	VSS	
VSS H29		



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
VSS	E20
VSS	E26
VSS	E28
VSS	E30
VSS	E32
VSS	E34
VSS	E36
VSS	F1
VSS	F4
VSS	F7
VSS	F13
VSS	F16
VSS	F22
VSS	F25
VSS	F31
VSS	F35
VSS	F37
VSS	G1
VSS	G2
VSS	G3
VSS	G9
VSS	G12
VSS	G13
VSS	G18
VSS	G21
VSS	G27
VSS	G28
VSS	L5
VSS	L11
VSS	L13
VSS	L14
VSS	L20
VSS	L23
VSS	L28
VSS	L30
VSS	L32
VSS	L34
VSS	L36
VSS	M1
VSS	M7
VSS	M10
VSS	M16

Signal	Ball Number
VSS	H33
VSS	H37
VSS	J1
VSS	J2
VSS	J4
VSS	J10
VSS	J13
VSS	J19
VSS	J22
VSS	J28
VSS	J30
VSS	J32
VSS	J34
VSS	J36
VSS	K1
VSS	K6
VSS	K9
VSS	K15
VSS	K18
VSS	K24
VSS	K27
VSS	K31
VSS	K35
VSS	K37
VSS	L1
VSS	L2
VSS	L3
VSS	P13
VSS	P17
VSS	P20
VSS	P26
VSS	P31
VSS	P35
VSS	P37
VSS	R1
VSS	R2
VSS	R5
VSS	R7
VSS	R16
VSS	R22
VSS	R25
VSS	R28



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
VSS	M19
VSS	M25
VSS	M29
VSS	M33
VSS	M37
VSS	N1
VSS	N2
VSS	N3
VSS	N6
VSS	N12
VSS	N13
VSS	N15
VSS	N21
VSS	N24
VSS	N28
VSS	N30
VSS	N32
VSS	N34
VSS	N36
VSS	P1
VSS	P2
VSS	P3
VSS	P8
VSS	P11
VSS	U28
VSS	U30
VSS	U32
VSS	U34
VSS	U36
VSS	V4
VSS	V8
VSS	V10
VSS	V13
VSS	V19
VSS	V22
VSS	V31
VSS	V35
VSS	V37
VSS	W1
VSS	W3
VSS	W5
VSS	W7

Signal	Ball Number
VSS	R30
VSS	R32
VSS	R34
VSS	R36
VSS	T1
VSS	T2
VSS	T3
VSS	Т9
VSS	T13
VSS	T18
VSS	T21
VSS	T27
VSS	T28
VSS	T29
VSS	T33
VSS	T37
VSS	U1
VSS	U3
VSS	U5
VSS	U7
VSS	U14
VSS	U17
VSS	U23
VSS	U26
VSS	Y26
VSS	Y29
VSS	Y33
VSS	Y37
VSSACORE	AG26
VSSAFSB	AJ27
VSSASP	AF26
VTTMK	A3
VTTMK	A13
VTTMK	A21
VTTMK	B8
VTTMK	B17
VTTMK	B26
VTTMK	B28
VTTMK	C4
VTTMK	C12
VTTMK	C13
VTTMK	C22



Table 10-2. SNC Signal-Ball Number (Continued)

Signal	Ball Number
VSS	W15
VSS	W17
VSS	W19
VSS	W21
VSS	W23
VSS	W28
VSS	W30
VSS	W32
VSS	W34
VSS	W36
VSS	Y2
VSS	Y4
VSS	Y6
VSS	Y8
VSS	Y12
VSS	Y14
VSS	Y16
VSS	Y18
VSS	Y20
VSS	Y22
VSS	Y24
VTTMK	J7
VTTMK	J16
VTTMK	J25
VTTMK	K2
VTTMK	K3
VTTMK	K12
VTTMK	K13
VTTMK	K21
VTTMK	K28
VTTMK	L8
VTTMK	L17
VTTMK	L26
VTTMK	M2
VTTMK	M4
VTTMK	M12
VTTMK	M13
VTTMK	M22
VTTMK	M28
VTTMK	N9
VTTMK	N18

Signal	Ball Number
VTTMK	N27
VTTMK	D2
VTTMK	D9
VTTMK	D18
VTTMK	D27
VTTMK	D28
VTTMK	E5
VTTMK	E13
VTTMK	E14
VTTMK	E23
VTTMK	F2
VTTMK	F10
VTTMK	F19
VTTMK	F28
VTTMK	G6
VTTMK	G15
VTTMK	G24
VTTMK	H2
VTTMK	H11
VTTMK	H13
VTTMK	H20
VTTMK	H28
VTTMK	V28
VTTMK	P5
VTTMK	P14
VTTMK	P23
VTTMK	P28
VTTMK	R10
VTTMK	R13
VTTMK	R19
VTTMK	T15
VTTMK	T24
VTTMK	U13
VTTMK	U20
VTTMK	V16
VTTMK	V25

a. Tied to VCC.

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Testability

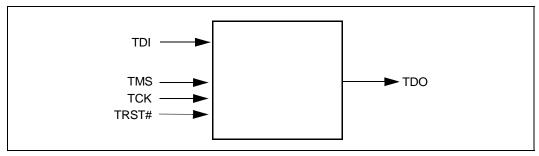
The SNC implements the Test Access Port (TAP) logic for testability purpose. The TAP complies with the IEEE 1149.1 (JTAG) specification. Basic Functionality of the 1149.1-compatible test logic is described here., but this document does not describe the IEEE 1149.1 standard in detail. For details of the IEEE 1149.1 Specification, the reader is referred to the published standard¹, and to other industry standard material on the subject.

For specific boundary scan chain information, please reference the Intel SNC Boundary Scan Descriptor Language (BSDL) Model.

11.1 **Test Access Port (TAP)**

Figure 11-1 illustrates the input and output signals for the TAP.

Figure 11-1. TAP Controller Signals



The TAP Logic 11.1.1

The TAP logic is accessed serially through 5 dedicated pins on each component shown in Table 11-1.

Table 11-1. TAP Signal Definitions

тск	TAP Clock Input.		
TMS	Test Mode Select. Controls the TAP finite state machine.		
TDI	Test Data Input. The serial input for test instructions and data.		
TDO	Test Data Output. The serial output for the test data.		
TRST#	Test Reset Input.		

TMS, TDI and TDO operate synchronously with TCK, which is independent of all other chipset clocks. TRST# is an asynchronous input signal. This 5-pin interface operates as defined in the 1149.1 specification.

ANSI/IEEE Std. 1149.1-1990 (including IEEE Std. 1149.1a-1993), "IEEE Standard Test Access Port and Boundary Scan Architecture," IEEE Press, Piscataway NJ, 1993.



A simplified block diagram of the TAP used in the this chipset components is shown in Figure 11-2. This TAP logic consists of a finite state machine controller, a serially-accessible instruction register, instruction decode logic, and data registers. The set of data registers includes those described in the 1149.1 standard (the bypass register, device ID register, etc.), plus chipset-specific additions. The private data registers used to control the test and debug features are not shown.

Boundary Scan Register **Device Identification BYPASS** Register **Control Signals** Instruction Decode / **TDO Mux** Control Logic TDI O Instruction Register TAP TMS O Controller TCK O Machine TRST# C TDO \bigcirc

Figure 11-2. Simplified Block Diagram of TAP Controller

11.1.2 Accessing the TAP Logic

The TAP is accessed through an IEEE 1149.1-compliant TAP controller finite state machine. This finite state machine, shown in Figure 11-3, contains a reset state, a run-test/idle state, and two major branches. These branches allow access either to the TAP Instruction Register or to one of the data registers. The TMS pin is used as the controlling input to traverse this finite state machine. TAP instructions and test data are loaded serially (in the Shift-IR and Shift-DR states, respectively) using the TDI pin. State transitions are made on the rising edge of TCK.

The following is a brief description of each of the states of the TAP controller state machine. Refer to the IEEE 1149.1 standard for detailed descriptions of the states and their operation.

- Test-Logic-Reset: In this state, the test logic is disabled so that the processor operates normally. In this state, the instruction in the Instruction Register is forced to IDCODE. Regardless of the original state of the TAP Finite State Machine (TAPFSM), it always enters Test-Logic-Reset when the TMS input is held asserted for at least five clocks. The controller also enters this state immediately when the TRST# pin is asserted, and automatically upon power-on. The TAPFSM cannot leave this state as long as the TRST# pin is held asserted.
- Run-Test/Idle: A controller state between scan operations. Once entered the controller will remain in this state as long as TMS is held low. In this state, activity in selected test logic occurs only in the presence of certain instructions. For instructions that do not cause functions to execute in this state, all test data registers selected by the current instructions retain their previous state.
- Select-IR-Scan: This is a temporary controller state in which all test data registers selected by the current instruction retain their previous state.



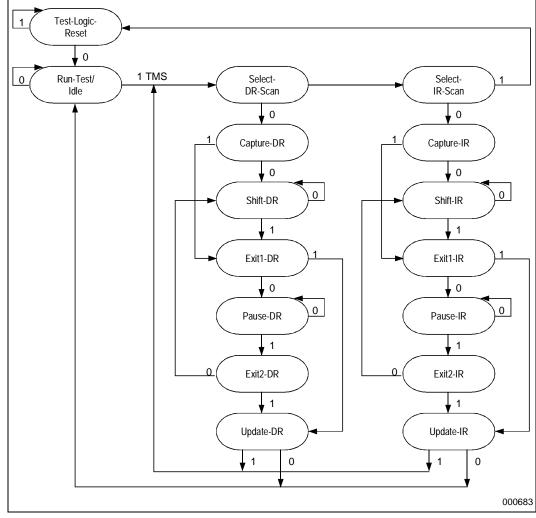


Figure 11-3. TAP Controller State Diagram

- Capture-IR: In this state, the shift register contained in the Instruction Register loads a fixed value (of which the two least significant bits are "01") on the rising edge of TCK. The parallel, latched output of the Instruction Register (current instruction) does not change in this state.
- **Shift-IR**: The shift register contained in the Instruction Register is connected between TDI and TDO and is shifted one stage toward its serial output on each rising edge of TCK. The output arrives at TDO on the falling edge of TCK. The current instruction does not change in this state.
- Exit-IR: This is a temporary state and the current instruction does not change in this state.
- Pause-IR: Allows shifting of the Instruction Register to be temporarily halted. The current instruction does not change in this state.
- Exit2-IR: This is a temporary state and the current instruction does not change in this state.
- **Update-IR**: The instruction which has been shifted into the Instruction Register is latched into the parallel output of the Instruction Register on the falling edge of TCK. Once the new instruction has been latched, it remains the current instruction until the next Update-IR (or until the TAPFSM is reset).



- **Select-DR-Scan**: This is a temporary controller state and all test data registers selected by the current instruction retain their previous values.
- Capture-DR: In this state, data may be parallel-loaded into test data registers selected by the current instruction on the rising edge of TCK. If a test data register selected by the current instruction does not have a parallel input, or if capturing is not required for the selected test, then the register retains its previous state.
- **Shift-DR**: The data register connected between TDI and TDO as a result of selection by the current instruction is shifted one stage toward its serial output on each rising edge of TCK. The output arrives at TDO on the falling edge of TCK. If the data register has a latched parallel output then the latch value does not change while new data is being shifted in.
- Exit1-DR: This is a temporary state and all data registers selected by the current instruction retain their previous values.
- Pause-DR: Allows shifting of the selected data register to be temporarily halted without stopping TCK. All registers selected by the current instruction retain their previous values.
- Exit2-DR: This is a temporary state and all registers selected by the current instruction retain their previous values.
- **Update-DR**: Some test data registers may be provided with latched parallel outputs to prevent changes in the parallel output while data is being shifted in the associated shift register path in response to certain instructions. Data is latched into the parallel output of these registers from the shift-register path on the falling edge of TCK.

11.2 Public TAP Instructions

Table 11-2 contains descriptions of the encoding and operation of the public TAP instructions. There are four 1149.1-defined instructions implemented in this chipset device. These instructions select from among three different TAP data registers – the boundary scan, device ID, and bypass registers. The public instructions can be executed with only the standard connection of the JTAG port pins. This means the only clock required will be TCK. Full details of the operation of these instructions can be found in the 1149.1 standard. The opcodes are 1149.1-compliant, and are consistent with the Intel-standard encodings.

A brief description of each instruction follows. For more thorough descriptions refer to the IEEE 1149.1 specification.

Table 11-2. Public TAP Instructions

Instruction	Encoding	Data Register Selected	Description
BYPASS	1111111	Bypass	The BYPASS command selects the Bypass Register, a single bit register connected between TDI and TDO pins. This allows more rapid movement of test data to and from other components in the system.
EXTEST	0000000	Boundary Scan	The EXTEST Instruction allows circuitry or wiring external to the devices to be tested. Boundary-Scan Register Cells at outputs are used to apply stimulus while Boundary-Scan Cells at input pins are used to capture data.



Table 11-2. Public TAP Instructions (Continued)

Instruction	Encoding	Data Register Selected	Description
			The SAMPLE/PRELOAD Instruction is used to allow scanning of the boundary-scan register without causing interference to the normal operation of the device. Two functions can be performed by use of the Sample/Preload Instruction.
SAMPLE/ PRELOAD	0000001	Boundary Scan	SAMPLE – allows a snapshot of the data flowing into & out of the device to be taken without affecting the normal operation of the device.
			PRELOAD – allows an initial pattern to be placed into the boundary-scan register cells. This allows initial known data to be present prior to the selection of another boundary-scan test operation.
IDCODE	0000010	IDCODE	The IDCODE instruction is forced into the parallel output latches of the instruction register during the Test-Logic-Reset Tap state. This allows the device identification register to be selected by manipulation of the broadcast TMS and TCK signals for testing purposes, as well as by a conventional instruction register scan operation.
CLAMP	0000100	Boundary Scan	This allows static "guarding values" to be set onto components that are not specifically being tested while maintaining the Bypass register as the serial path through the device.
HIGHZ	0001000	Boundary Scan	The HIGHZ Instruction is used to force all outputs of the device (except TDO) into a high impedance state. This instruction shall select the Bypass Register to be connected between TDI and TDO in the Shift-DR controller state.

11.3 Private TAP Instructions

Table 11-3 contains descriptions of the encoding and operation of the private, SNC TAP instructions.

Table 11-3. Private TAP instructions

Instruction	Binary	Hex	Description
JCONF Config Access	1000010	42	This instruction is used to read or write configuration registers in the chipset. Details of the bit definitions can be found in section (Config Access Register).

11.4 TAP registers

The following is a list of all test registers which can be accessed through the TAP.

1. Boundary Scan Register

The Boundary Scan register consists of several single-bit shift registers. The boundary scan register provides a shift register path from all the input to the output pins on the SNC. Data is transferred from TDI to TDO through the boundary scan register.

2. Bypass Register

The bypass register is a one-bit shift register that provides the minimal path length between



TDI and TDO. The bypass register is selected when no test operation is being performed by a component on the board. The bypass register loads a logic zero at the start of a scan cycle.

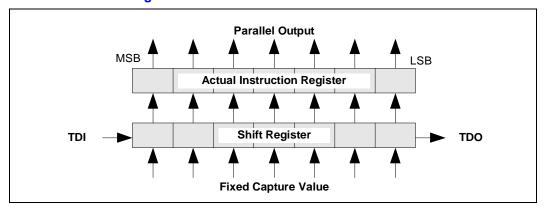
3. Device Identification (ID) Register

The device ID register contains the manufacturer's identification code, version number, and part number. The device ID register has a fixed length of 32 bits, as defined by the IEEE 1149.1 specification.

4. Instruction Register

This register consists of a 7-bit shift register (connected between TDI and TDO), and the actual instruction register (which is loaded in parallel from the shift register). The parallel output of the TAP instruction register goes to the TAP instruction decoder shown in **Figure 11-4**.

Figure 11-4. TAP Instruction Register



5. Configuration Access Register

This register allows SNC to access the configuration registers via the JTAG TAP. An acceptable configuration access chain format is shown.

Table 11-4. Example of Configuration Access Data Register Format

JCONF encode: 1000010				
Bit	Attr	Default	Description	
63:56	RW	00h	Data Byte3: MSB of the read/write data, Data[31:24]	
55:48	RW	00h	Data Byte2: Next MSB of the read/write data, Data[23:16]	
47:40	RW	00h	Data Byte1: Next LSB of the read/write data, Data[15:8]	
39:32	RW	00h	Data Byte0: LSB of the read/write data, Data[7:0]	
31:24	RW	00h	Register Address: Address of a register located in a device on a bus within a group of registers assign to a function.	
23:19	RW	00h	Device ID: PCI equivalent to uniquely identify a device on a bus.	
18:16	RW	000	Function Number: PCI equivalent of a function number to obtain access to register banks within a device.	
15:8	RW	00h	Bus Number: PCI equivalent of a bus number to recognize devices connected to this bus.	



Table 11-4. Example of Configuration Access Data Register Format (Continued)

JCONF encode: 1000010				
Bit	Attr	Default	Description	
7:4	RW	0h	Status: [7]: Error bit set when a config request returns a Hard Fail condition. [6:5]: Reserved [4]: Busy bit. Set when read or write operation is in progress.	
3:0	RW	Oh	Command: 0xxx = NOP used in polling the chain to determine if the unit is busy. 1001 = write byte 1010 = write word 1011 = write dword 1100 = read dword	

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